

PIC18F87J10 Family Data Sheet

64/80-Pin High-Performance,1-Mbit Flash Microcontrollers with nanoWatt Technology

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64/80-Pin, High-Performance, 1-Mbit Flash Microcontrollers with nanoWatt Technology

Special Microcontroller Features:

- Operating voltage range: 2.0V to 3.6V
- 5.5V tolerant input (digital pins only)
- · On-chip 2.5V regulator
- Low-power, high-speed CMOS Flash technology
- C compiler optimized architecture:
 - Optional extended instruction set designed to optimize re-entrant code
- · Priority levels for interrupts
- 8 x 8 Single-Cycle Hardware Multiplier
- Extended Watchdog Timer (WDT):
 - Programmable period from 4 ms to 131s
- Single-Supply In-Circuit Serial Programming[™] (ICSP[™]) via two pins
- In-Circuit Debug (ICD) with three Break points via two pins
- · Power-Managed modes:
 - Run: CPU on, peripherals on
 - Idle: CPU off, peripherals on
 - Sleep: CPU off, peripherals off

Flexible Oscillator Structure:

- Two Crystal modes, up to 40 MHz
- 4x Phase Lock Loop (PLL)
- Two External Clock modes, up to 40 MHz
- Internal 31 kHz oscillator
- Secondary oscillator using Timer1 @ 32 kHz
- Two-Speed Oscillator Start-up
- Fail-Safe Clock Monitor:
 - Allows for safe shutdown if peripheral clock stops

Peripheral Highlights:

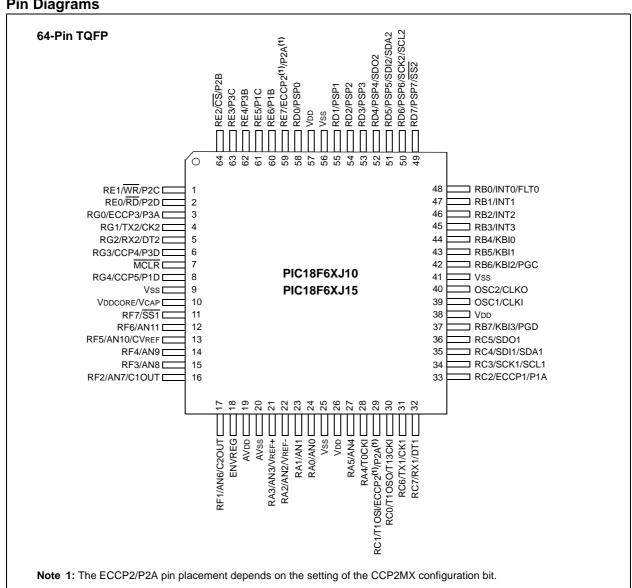
- High-current sink/source 25 mA/25 mA (PORTB and PORTC)
- · Four programmable external interrupts
- · Four input change interrupts
- Two Capture/Compare/PWM (CCP) modules
- Three Enhanced Capture/Compare/PWM (ECCP) modules:
 - One, two or four PWM outputs
 - Selectable polarity
 - Programmable dead time
 - Auto-Shutdown and Auto-Restart
- Two Master Synchronous Serial Port (MSSP) modules supporting 3-wire SPI[™] (all 4 modes) and I²C[™] Master and Slave modes
- Two Enhanced Addressable USART modules:
 - Supports RS-485, RS-232 and LIN 1.2
 - Auto-Wake-up on Start bit
 - Auto-Baud Detect
- 10-bit, up to 15-channel Analog-to-Digital Converter module (A/D):
 - Auto-acquisition capability
 - Conversion available during Sleep
 - Self-calibration feature
- · Dual analog comparators with input multiplexing

External Memory Bus (PIC18F8XJ10/8XJ15 only):

- · Address capability of up to 2 Mbytes
- · 8-bit or 16-bit interface
- · 12-bit, 16-bit and 20-bit Addressing modes

	Progi	ram Memory		SRAM Data Memory I/O (bytes)			MSSP				ors		Bus
Device	Flash (bytes)	# Single-Word Instructions	Memory			CCP/ ECCP (PWM)		SPI™	Master I ² C™	EUSART	Comparators	Timers 8/16-bit	External E
PIC18F65J10	32K	16384	2048	50	11	2/3	2	Υ	Υ	2	2	2/3	N
PIC18F65J15	48K	24576	2048	50	11	2/3	2	Υ	Υ	2	2	2/3	N
PIC18F66J10	64K	32768	2048	50	11	2/3	2	Υ	Υ	2	2	2/3	N
PIC18F66J15	96K	49152	3936	50	11	2/3	2	Υ	Υ	2	2	2/3	N
PIC18F67J10	128K	65536	3936	50	11	2/3	2	Υ	Υ	2	2	2/3	N
PIC18F85J10	32K	16384	2048	66	15	2/3	2	Υ	Υ	2	2	2/3	Υ
PIC18F85J15	48K	24576	2048	66	15	2/3	2	Υ	Υ	2	2	2/3	Υ
PIC18F86J10	64K	32768	2048	66	15	2/3	2	Υ	Y	2	2	2/3	Υ
PIC18F86J15	96K	49152	3936	66	15	2/3	2	Υ	Y	2	2	2/3	Υ
PIC18F87J10	128K	65536	3936	66	15	2/3	2	Υ	Υ	2	2	2/3	Υ

Pin Diagrams



Pin Diagrams (Continued)

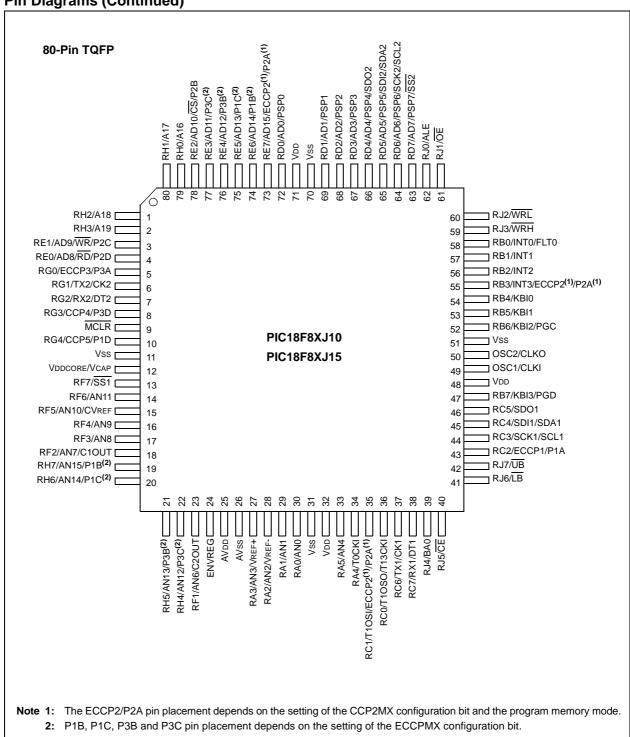


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1.0 DEVICE OVERVIEW

This document contains device specific information for the following devices:

- PIC18F65J10
- PIC18F85J10
- PIC18F65J15
- PIC18F85J15
- PIC18F66J10
- PIC18F86J10
- PIC18F66J15
- PIC18F86J15
- PIC18F67J10
- PIC18F87J10

This family introduces a new line of low-voltage devices with the main traditional advantage of all PIC18 microcontrollers – namely, high computational performance and a rich feature set – at an extremely competitive price point. These features make the PIC18F87J10 family a logical choice for many high-performance applications where cost is a primarily consideration.

1.1 Core Features

1.1.1 nanoWatt TECHNOLOGY

All of the devices in the PIC18F87J10 family incorporate a range of features that can significantly reduce power consumption during operation. Key items include:

- Alternate Run Modes: By clocking the controller from the Timer1 source or the internal RC oscillator, power consumption during code execution can be reduced by as much as 90%.
- Multiple Idle Modes: The controller can also run
 with its CPU core disabled but the peripherals still
 active. In these states, power consumption can be
 reduced even further, to as little as 4% of normal
 operation requirements.
- On-the-Fly Mode Switching: The power-managed modes are invoked by user code during operation, allowing the user to incorporate power-saving ideas into their application's software design.

1.1.2 OSCILLATOR OPTIONS AND FEATURES

All of the devices in the PIC18F87J10 family offer five different oscillator options, allowing users a range of choices in developing application hardware. These include:

- Two Crystal modes, using crystals or ceramic resonators.
- Two External Clock modes, offering the option of a divide-by-4 clock output.
- A Phase Lock Loop (PLL) frequency multiplier, available to the external oscillator modes which allows clock speeds of up to 40 MHz.
- An internal RC oscillator with a fixed 31-kHz output which provides an extremely low-power option for timing-insensitive applications.

The internal oscillator block provides a stable reference source that gives the family additional features for robust operation:

- Fail-Safe Clock Monitor: This option constantly
 monitors the main clock source against a reference
 signal provided by the internal oscillator. If a clock
 failure occurs, the controller is switched to the
 internal oscillator, allowing for continued low-speed
 operation or a safe application shutdown.
- Two-Speed Start-up: This option allows the internal oscillator to serve as the clock source from Power-on Reset, or wake-up from Sleep mode, until the primary clock source is available.

1.1.3 EXPANDED MEMORY

The PIC18F87J10 family provides ample room for application code, from 32 Kbytes to 128 Kbytes of code space. The Flash cells for program memory are rated to last up to 100 erase/write cycles. Data retention without refresh is conservatively estimated to be greater than 40 years.

The PIC18F87J10 family also provides plenty of room for dynamic application data, with up to 3936 bytes of data RAM.

1.1.4 EXTERNAL MEMORY BUS

In the unlikely event that 128 Kbytes of memory is inadequate for an application, the 80-pin members of the PIC18F87J10 family also implement an external memory bus. This allows the controller's internal program counter to address a memory space of up to 2 Mbytes, permitting a level of data access that few 8-bit devices can claim. This allows additional memory options, including:

- Using combinations of on-chip and external memory up to the 2-Mbyte limit
- Using external Flash memory for reprogrammable application code or large data tables
- Using external RAM devices for storing large amounts of variable data

1.1.5 EXTENDED INSTRUCTION SET

The PIC18F87J10 family implements the optional extension to the PIC18 instruction set, adding 8 new instructions and an Indexed Addressing mode. Enabled as a device configuration option, the extension has been specifically designed to optimize re-entrant application code originally developed in high-level languages, such as C.

1.1.6 EASY MIGRATION

Regardless of the memory size, all devices share the same rich set of peripherals, allowing for a smooth migration path as applications grow and evolve.

The consistent pinout scheme used throughout the entire family also aids in migrating to the next larger device. This is true when moving between the 64-pin members, between the 80-pin members, or even jumping from 64-pin to 80-pin devices.

The PIC18F87J10 family is also pin-compatible with other PIC18 families, such as the PIC18F8720 and PIC18F8722. This allows a new dimension to the evolution of applications, allowing developers to select different price points within Microchip's PIC18 portfolio while maintaining the same feature set.

1.2 Other Special Features

- Communications: The PIC18F87J10 family incorporates a range of serial communication peripherals, including 2 independent Enhanced USARTs and 2 Master SSP modules, capable of both SPI™ and I²C™ (Master and Slave) modes of operation. In addition, one of the general purpose I/O ports can be reconfigured as an 8-bit Parallel Slave Port for direct processor-to-processor communications.
- CCP Modules: All devices in the family incorporate two Capture/Compare/PWM (CCP) modules and three Enhanced CCP modules to maximize flexibility in control applications. Up to four different time bases may be used to perform several different operations at once. Each of the three ECCPs offers up to four PWM outputs, allowing for a total of 12 PWMs. The ECCPs also offer many beneficial features, including polarity selection, programmable dead time, auto-shutdown and restart and Half-Bridge and Full-Bridge Output modes.
- 10-Bit A/D Converter: This module incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period and thus, reducing code overhead.
- Extended Watchdog Timer (WDT): This
 enhanced version incorporates a 16-bit prescaler,
 allowing an extended time-out range that is stable
 across operating voltage and temperature. See
 Section 26.0 "Electrical Characteristics" for
 time-out periods.

1.3 Details on Individual Family Members

Devices in the PIC18F87J10 family are available in 64-pin and 80-pin packages. Block diagrams for the two groups are shown in Figure 1-1 and Figure 1-2.

The devices are differentiated from each other in four ways:

- Flash program memory (six sizes, ranging from 32 Kbytes for PIC18FX5J10 devices to 128 Kbytes for PIC18FXJ710).
- 2. Data RAM (2048 bytes for PIC18FX5J10/X5J15/X6J10 devices, 3936 bytes for PIC18FX6J15/X7J10 devices).
- 3. A/D channels (11 for 64-pin devices, 15 for 80-pin devices).
- 4. I/O ports (7 bidirectional ports on 64-pin devices, 9 bidirectional ports on 80-pin devices).

All other features for devices in this family are identical. These are summarized in Table 1-1 and Table 1-2.

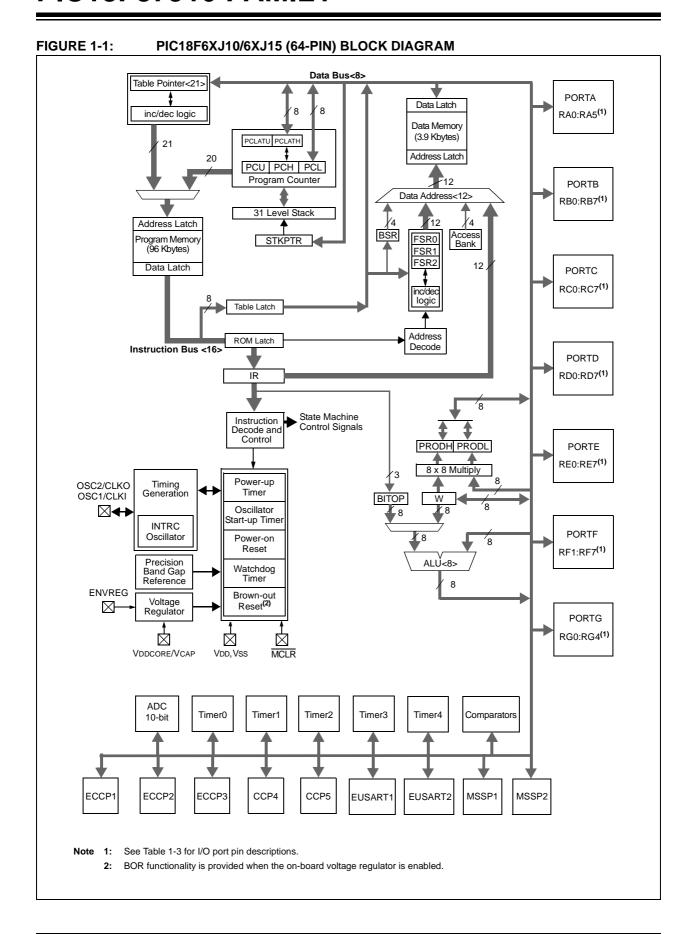
The pinouts for all devices are listed in Table 1-3 and Table 1-4.

TABLE 1-1: DEVICE FEATURES FOR THE PIC18F87J10 FAMILY (64-PIN DEVICES)

Features	PIC18F65J10 PIC18F65J1		PIC18F66J10	PIC18F66J15	PIC18F67J10			
Operating Frequency	DC – 40 MHz	DC – 40 MHz	DC – 40 MHz	DC – 40 MHz	DC – 40 MHz			
Program Memory (Bytes)	32K	48K	64K	96K	128K			
Program Memory (Instructions)	16384	24576	32768	49152	65536			
Data Memory (Bytes)	2048	2048	2048	3936	3936			
Interrupt Sources			26					
I/O Ports		Poi	ts A, B, C, D, E, F	- , G				
Timers	5							
Capture/Compare/PWM Modules	2							
Enhanced Capture/ Compare/PWM Modules			3					
Serial Communications		MSSP (2), Enhanced US	ART (2)				
Parallel Communications (PSP)			Yes					
10-Bit Analog-to-Digital Module	11 Input Channels							
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow, MCLR, WDT (PWRT, OST)							
Instruction Set	75 Instructions, 83 with Extended Instruction Set enabled							
Packages	64-pin TQFP							

TABLE 1-2: DEVICE FEATURES FOR THE PIC18F87J10 FAMILY (80-PIN DEVICES)

Features	PIC18F85J10	PIC18F85J15	PIC18F86J10	PIC18F86J15	PIC18F87J10			
Operating Frequency	DC – 40 MHz	DC – 40 MHz	DC – 40 MHz	DC – 40 MHz	DC – 40 MHz			
Program Memory (Bytes)	32K	48K	64K	96K	128K			
Program Memory (Instructions)	16384	24576	32768	49152	65536			
Data Memory (Bytes)	2048	2048	2048	3936	3936			
Interrupt Sources			26					
I/O Ports	Ports A, B, C, D, E, F, G, H, J							
Timers	5							
Capture/Compare/PWM Modules	2							
Enhanced Capture/ Compare/PWM Modules	3							
Serial Communications		MSSP (2), Enhanced US	ART (2)				
Parallel Communications (PSP)			Yes					
10-Bit Analog-to-Digital Module	15 Input Channels							
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow, MCLR, WDT (PWRT, OST)							
Instruction Set	75 Instructions, 83 with Extended Instruction Set enabled							
Packages	80-pin TQFP							



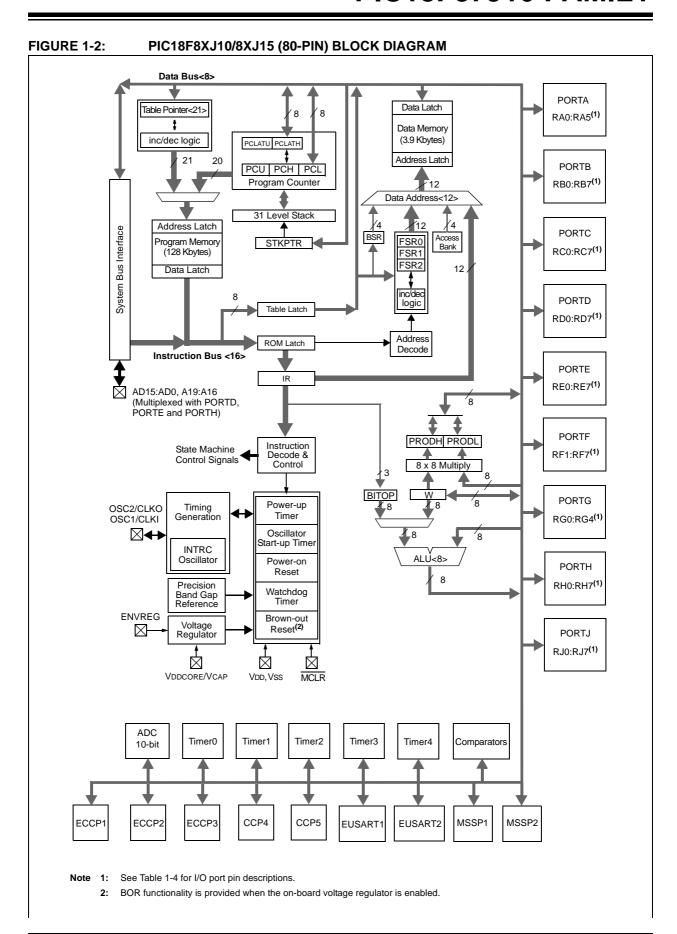


TABLE 1-3: PIC18F6XJ10/6XJ15 PINOUT I/O DESCRIPTIONS

Div Nove	Pin Number	Pin	Buffer	D
Pin Name	TQFP	Туре	Туре	Description
MCLR	7	I	ST	Master Clear (Reset) input. This pin is an active-low Reset to the device.
OSC1/CLKI OSC1	39	I	ST	Oscillator crystal or external clock input. Oscillator crystal input or external clock source input. ST buffer when configured in RC mode; CMOS otherwise.
CLKI		Ι	CMOS	External clock source input. Always associated with pin function OSC1. (See related OSC1/CLKI, OSC2/CLKO pins.)
OSC2/CLKO OSC2	40	0	_	Oscillator crystal or clock output. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
CLKO		0	_	In RC mode, OSC2 pin outputs CLKO which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
				PORTA is a bidirectional I/O port.
RA0/AN0 RA0 AN0	24	I/O I	TTL Analog	Digital I/O. Analog input 0.
RA1/AN1 RA1 AN1	23	I/O I	TTL Analog	Digital I/O. Analog input 1.
RA2/AN2/VREF- RA2 AN2 VREF-	22	I/O I I	TTL Analog Analog	Digital I/O. Analog input 2. A/D reference voltage (low) input.
RA3/AN3/VREF+ RA3 AN3 VREF+	21	I/O I I	TTL Analog Analog	Digital I/O. Analog input 3. A/D reference voltage (high) input.
RA4/T0CKI RA4 T0CKI	28	I/O I	ST ST	Digital I/O. Timer0 external clock input.
RA5/AN4 RA5 AN4	27	I/O I	TTL Analog	Digital I/O. Analog input 4.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input
I = Input O = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2/P2A when configuration bit CCP2MX is set.

TABLE 1-3: PIC18F6XJ10/6XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description		
Pin Name	TQFP	Туре	Туре	Description		
				PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.		
RB0/INT0/FLT0	48					
RB0		I/O	TTL	Digital I/O.		
INT0 FLT0		l	ST ST	External interrupt 0.		
		ļ	51	ECCP1/2/3 Fault input.		
RB1/INT1	47					
RB1		I/O	TTL	Digital I/O.		
INT1		ı	ST	External interrupt 1.		
RB2/INT2	46					
RB2		I/O	TTL	Digital I/O.		
INT2		ı	ST	External interrupt 2.		
RB3/INT3	45					
RB3		I/O	TTL	Digital I/O.		
INT3		I	ST	External interrupt 3.		
RB4/KBI0	44					
RB4		I/O	TTL	Digital I/O.		
KBI0		I	TTL	Interrupt-on-change pin.		
RB5/KBI1	43					
RB5		I/O	TTL	Digital I/O.		
KBI1		I	TTL	Interrupt-on-change pin.		
RB6/KBI2/PGC	42					
RB6		I/O	TTL	Digital I/O.		
KBI2		I	TTL	Interrupt-on-change pin.		
PGC		I/O	ST	In-Circuit Debugger and ICSP™ programming clock		
				pin.		
RB7/KBI3/PGD	37					
RB7		I/O	TTL	Digital I/O.		
KBI3		I	TTL	Interrupt-on-change pin.		
PGD		I/O	ST	In-Circuit Debugger and ICSP programming data pin.		

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

I = Input

O = Output

P = Power

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2/P2A when configuration bit CCP2MX is set.

TABLE 1-3: PIC18F6XJ10/6XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Name	Pin Number	Pin	Buffer	Description
Pin Name	TQFP	Туре	Туре	Description
				PORTC is a bidirectional I/O port.
RC0/T10SO/T13CKI RC0 T10SO T13CKI	30	I/O O I	ST — ST	Digital I/O. Timer1 oscillator output. Timer1/Timer3 external clock input.
RC1/T1OSI/ECCP2/P2A RC1 T1OSI ECCP2 ⁽¹⁾ P2A ⁽¹⁾	29	I/O I I/O O	ST CMOS ST	Digital I/O. Timer1 oscillator input. Capture 2 input/Compare 2 output/PWM 2 output. ECCP2 PWM output A.
RC2/ECCP1/P1A RC2 ECCP1 P1A	33	I/O I/O O	ST ST	Digital I/O. Capture 1 input/Compare 1 output/PWM 1 output. ECCP1 PWM output A.
RC3/SCK1/SCL1 RC3 SCK1 SCL1	34	I/O I/O I/O	ST ST ST	Digital I/O. Synchronous serial clock input/output for SPI™ mode. Synchronous serial clock input/output for I ² C™ mode.
RC4/SDI1/SDA1 RC4 SDI1 SDA1	35	I/O I I/O	ST ST ST	Digital I/O. SPI data in. I ² C data I/O.
RC5/SDO1 RC5 SDO1	36	I/O O	ST —	Digital I/O. SPI data out.
RC6/TX1/CK1 RC6 TX1 CK1	31	I/O O I/O	ST — ST	Digital I/O. EUSART1 asynchronous transmit. EUSART1 synchronous clock (see related RX1/DT1).
RC7/RX1/DT1 RC7 RX1 DT1	32	I/O I I/O	ST ST ST	Digital I/O. EUSART1 asynchronous receive. EUSART1 synchronous data (see related TX1/CK1).

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input
I = Input O = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2/P2A when configuration bit CCP2MX is set.

TABLE 1-3: PIC18F6XJ10/6XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Name	Pin Number	Pin	Buffer	Description
Pin Name	TQFP	Туре	Туре	Description
				PORTD is a bidirectional I/O port.
RD0/PSP0	58			
RD0		I/O	ST	Digital I/O.
PSP0		I/O	TTL	Parallel Slave Port data.
RD1/PSP1	55			
RD1		I/O	ST	Digital I/O.
PSP1		I/O	TTL	Parallel Slave Port data.
RD2/PSP2	54			
RD2		I/O	ST	Digital I/O.
PSP2		I/O	TTL	Parallel Slave Port data.
RD3/PSP3	53			
RD3	33	I/O	ST	Digital I/O.
PSP3		I/O	TTL	Parallel Slave Port data.
RD4/PSP4/SDO2	52			
RD4	32	I/O	ST	Digital I/O.
PSP4		I/O	TTL	Parallel Slave Port data.
SDO2		0		SPI™ data out.
RD5/PSP5/SDI2/SDA2	51			
RD5	0.	I/O	ST	Digital I/O.
PSP5		I/O	TTL	Parallel Slave Port data.
SDI2		I	ST	SPI data in.
SDA2		I/O	ST	I ² C™ data I/O.
RD6/PSP6/SCK2/SCL2	50			
RD6		I/O	ST	Digital I/O.
PSP6		I/O	TTL	Parallel Slave Port data.
SCK2		I/O	ST	Synchronous serial clock input/output for SPI mode.
SCL2		I/O	ST	Synchronous serial clock input/output for I ² C mode.
RD7/PSP7/SS2	49			
RD7		I/O	ST	Digital I/O.
PSP7		I/O	TTL	Parallel Slave Port data.
SS2		I	TTL	SPI slave select input.

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

I = Input

O = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2/P2A when configuration bit CCP2MX is set.

PIC18F6XJ10/6XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED) **TABLE 1-3:**

Din Name	Pin Number	Pin	Buffer	Description.
Pin Name	TQFP	Type Type		Description
				PORTE is a bidirectional I/O port.
RE0/RD/P2D RE0 RD P2D	2	I/O I O	ST TTL —	Digital I/O. Read control for Parallel Slave Port. ECCP2 PWM output D.
RE1/WR/P2C RE1 WR P2C	1	I/O I O	ST TTL —	Digital I/O. Write control for Parallel Slave Port. ECCP2 PWM output C.
RE2/CS/P2B RE2 CS P2B	64	I/O I O	ST TTL —	Digital I/O. Chip select control for Parallel Slave Port. ECCP2 PWM output B.
RE3/P3C RE3 P3C	63	I/O O	ST —	Digital I/O. ECCP3 PWM output C.
RE4/P3B RE4 P3B	62	I/O O	ST —	Digital I/O. ECCP3 PWM output B.
RE5/P1C RE5 P1C	61	I/O O	ST —	Digital I/O. ECCP1 PWM output C.
RE6/P1B RE6 P1B	60	I/O O	ST —	Digital I/O. ECCP1 PWM output B.
RE7/ECCP2/P2A RE7 ECCP2 ⁽²⁾ P2A ⁽²⁾	59	I/O I/O O	ST ST —	Digital I/O. Capture 2 input/Compare 2 output/PWM 2 output. ECCP2 PWM output A.

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input = Input = Output

= Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2/P2A when configuration bit CCP2MX is set.

TABLE 1-3: PIC18F6XJ10/6XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description			
FIII Name	TQFP	Type Type		Description			
				PORTF is a bidirectional I/O port.			
RF1/AN6/C2OUT RF1	17	I/O	ST	Digital I/O.			
AN6 C2OUT		I О	Analog —	Analog input 6. Comparator 2 output.			
RF2/AN7/C1OUT RF2	16	I/O	ST	Digital I/O.			
AN7 C1OUT		I О	Analog —	Analog input 7. Comparator 1 output.			
RF3/AN8 RF3 AN8	15	I/O I	ST Analog	Digital I/O. Analog input 8.			
RF4/AN9 RF4 AN9	14	I/O I	ST	Digital I/O. Analog input 9.			
RF5/AN10/CVREF RF5 AN10 CVREF	13	I/O I O	ST Analog	Digital I/O. Analog input 10. Comparator reference voltage output.			
RF6/AN11 RF6 AN11	12	I/O I	ST Analog	Digital I/O. Analog input 11.			
RF7/SS1 RF7 SS1	11	I/O I	ST TTL	Digital I/O. SPI™ slave select input.			

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

I = Input

O = Output

P = Power

OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2/P2A when configuration bit CCP2MX is set.

TABLE 1-3: PIC18F6XJ10/6XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Name	Pin Number	Pin	Buffer	Description
Pin Name	TQFP	Туре	Туре	Description
				PORTG is a bidirectional I/O port.
RG0/ECCP3/P3A RG0 ECCP3 P3A	3	I/O I/O O	ST ST —	Digital I/O. Capture 3 input/Compare 3 output/PWM 3 output. ECCP3 PWM output A.
RG1/TX2/CK2 RG1 TX2 CK2	4	I/O O I/O	ST — ST	Digital I/O. EUSART2 asynchronous transmit. EUSART2 synchronous clock (see related RX2/DT2).
RG2/RX2/DT2 RG2 RX2 DT2	5	I/O I I/O	ST ST ST	Digital I/O. EUSART2 asynchronous receive. EUSART2 synchronous data (see related TX2/CK2).
RG3/CCP4/P3D RG3 CCP4 P3D	6	I/O I/O O	ST ST	Digital I/O. Capture 4 input/Compare 4 output/PWM 4 output. ECCP3 PWM output D.
RG4/CCP5/P1D RG4 CCP5 P1D	8	I/O I/O O	ST ST	Digital I/O. Capture 5 input/Compare 5 output/PWM 5 output. ECCP1 PWM output D.
Vss	9, 25, 41, 56	Р	_	Ground reference for logic and I/O pins.
VDD	26, 38, 57	Р	_	Positive supply for peripheral digital logic and I/O pins.
AVss	20	Р	_	Ground reference for analog modules.
AVDD	19	Р	_	Positive supply for analog modules.
ENVREG	18	I	ST	Enable for on-chip voltage regulator.
VDDCORE/VCAP VDDCORE	10	Р	_	Core logic power or external filter capacitor connection. Positive supply for microcontroller core logic (regulator disabled).
VCAP		Р	_	External filter capacitor connection (regulator enabled).

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input I = Input O = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Default assignment for ECCP2/P2A when configuration bit CCP2MX is set.

TABLE 1-4: PIC18F8XJ10/8XJ15 PINOUT I/O DESCRIPTIONS

Din Nome	Pin Number	Pin	Buffer	Description
Pin Name	TQFP	Туре	Туре	Description
MCLR	9	I	ST	Master Clear (Reset) input. This pin is an active-low Reset to the device.
OSC1/CLKI OSC1	49	I	ST	Oscillator crystal or external clock input. Oscillator crystal input or external clock source input. ST buffer when configured in RC mode; CMOS otherwise.
CLKI		I	CMOS	External clock source input. Always associated with pin function OSC1. (See related OSC1/CLKI, OSC2/CLKO pins.)
OSC2/CLKO OSC2	50	0	_	Oscillator crystal or clock output. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
CLKO		0	_	In RC mode, OSC2 pin outputs CLKO which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
				PORTA is a bidirectional I/O port.
RA0/AN0 RA0 AN0	30	I/O I	TTL Analog	Digital I/O. Analog input 0.
RA1/AN1 RA1 AN1	29	I/O I	TTL Analog	Digital I/O. Analog input 1.
RA2/AN2/VREF- RA2 AN2 VREF-	28	I/O I	TTL Analog Analog	Digital I/O. Analog input 2. A/D reference voltage (low) input.
RA3/AN3/VREF+ RA3 AN3 VREF+	27	I/O I I	TTL Analog Analog	Digital I/O. Analog input 3. A/D reference voltage (high) input.
RA4/T0CKI RA4 T0CKI	34	I/O I	ST ST	Digital I/O. Timer0 external clock input.
RA5/AN4 RA5 AN4	33	I/O I	TTL Analog	Digital I/O. Analog input 4.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

I = Input

O = Output

P = Power

OD = Open-Drain (no P diode to VDD)

- 2: Default assignment for ECCP2/P2A for all devices in all operating modes (CCP2MX is set).
- 3: Default assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is set).
- 4: Alternate assignment for ECCP2/P2A when CCP2MX is cleared (Microcontroller mode).
- 5: Alternate assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is cleared).

TABLE 1-4: PIC18F8XJ10/8XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description
Pin Name	TQFP	Туре	Туре	Description
				PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.
RB0/INT0/FLT0 RB0 INT0 FLT0	58	I/O I I	TTL ST ST	Digital I/O. External interrupt 0. ECCP1/2/3 Fault input.
RB1/INT1 RB1 INT1	57	I/O I	TTL ST	Digital I/O. External interrupt 1.
RB2/INT2 RB2 INT2	56	I/O I	TTL ST	Digital I/O. External interrupt 2.
RB3/INT3/ECCP2/P2A RB3 INT3 ECCP2 ⁽¹⁾ P2A ⁽¹⁾	55	I/O I I/O O	TTL ST ST —	Digital I/O. External interrupt 3. Capture 2 input/Compare 2 output/PWM 2 output. ECCP2 PWM output A.
RB4/KBI0 RB4 KBI0	54	I/O I	TTL TTL	Digital I/O. Interrupt-on-change pin.
RB5/KBI1 RB5 KBI1	53	I/O I	TTL TTL	Digital I/O. Interrupt-on-change pin.
RB6/KBI2/PGC RB6 KBI2 PGC	52	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP™ programming clock pin.
RB7/KBI3/PGD RB7 KBI3 PGD	47	I/O /O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-Circuit Debugger and ICSP programming data pin.

Legend: TTL = TTL compatible input

= Power

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

I = Input

O = Output
OD = Open-Drain (no P diode to VDD)

Note 1: Alternate assignment for ECCP2/P2A when configuration bit CCP2MX is cleared (Extended Microcontroller mode).

2: Default assignment for ECCP2/P2A for all devices in all operating modes (CCP2MX is set).

3: Default assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is set).

4: Alternate assignment for ECCP2/P2A when CCP2MX is cleared (Microcontroller mode).

5: Alternate assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is cleared).

TABLE 1-4: PIC18F8XJ10/8XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Die Name	Pin Number	Pin	Buffer	Description.	
Pin Name	TQFP	Туре	Туре	Description	
				PORTC is a bidirectional I/O port.	
RC0/T10SO/T13CKI RC0 T10SO T13CKI	36	I/O O I	ST — ST	Digital I/O. Timer1 oscillator output. Timer1/Timer3 external clock input.	
RC1/T1OSI/ECCP2/P2A RC1 T1OSI ECCP2 ⁽²⁾ P2A ⁽²⁾	35	I/O I I/O O	ST CMOS ST	OS Timer1 oscillator input.	
RC2/ECCP1/P1A RC2 ECCP1 P1A	43	I/O I/O O	ST ST	Digital I/O. Capture 1 input/Compare 1 output/PWM 1 output. ECCP1 PWM output A.	
RC3/SCK1/SCL1 RC3 SCK1 SCL1	44	I/O I/O I/O	ST ST ST	Digital I/O. Synchronous serial clock input/output for SPI™ mode. Synchronous serial clock input/output for I ² C™ mode.	
RC4/SDI1/SDA1 RC4 SDI1 SDA1	45	I/O I I/O	ST ST ST	Digital I/O. SPI data in. I ² C data I/O.	
RC5/SDO1 RC5 SDO1	46	I/O O	ST —	Digital I/O. SPI data out.	
RC6/TX1/CK1 RC6 TX1 CK1	37	I/O O I/O	ST — ST	Digital I/O. EUSART1 asynchronous transmit. EUSART1 synchronous clock (see related RX1/DT1).	
RC7/RX1/DT1 RC7 RX1 DT1	38	I/O I I/O	ST ST ST	Digital I/O. EUSART1 asynchronous receive. EUSART1 synchronous data (see related TX1/CK1).	

Legend: TTL = TTL compatible input CMOS

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

I = Input

O = Output

P = Power

OD = Open-Drain (no P diode to VDD)

- 2: Default assignment for ECCP2/P2A for all devices in all operating modes (CCP2MX is set).
 - 3: Default assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is set).
 - 4: Alternate assignment for ECCP2/P2A when CCP2MX is cleared (Microcontroller mode).
 - 5: Alternate assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is cleared).

TABLE 1-4: PIC18F8XJ10/8XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Nome	Pin Number	Pin	Buffer	Donation.	
Pin Name	TQFP	Туре	Туре	Description	
RD0/AD0/PSP0 RD0 AD0	72	I/O I/O	ST TTL	PORTD is a bidirectional I/O port. Digital I/O. External memory address/data 0.	
PSP0 RD1/AD1/PSP1 RD1 AD1 PSP1	69	I/O I/O I/O	ST TTL TTL	Parallel Slave Port data. Digital I/O. External memory address/data 1. Parallel Slave Port data.	
RD2/AD2/PSP2 RD2 AD2 PSP2	68	I/O I/O I/O	ST TTL TTL	Digital I/O. External memory address/data 2. Parallel Slave Port data.	
RD3/AD3/PSP3 RD3 AD3 PSP3	67	I/O I/O I/O	ST TTL TTL	Digital I/O. External memory address/data 3. Parallel Slave Port data.	
RD4/AD4/PSP4/SDO2 RD4 AD4 PSP4 SDO2	66	I/O I/O I/O O	ST TTL TTL	Digital I/O. External memory address/data 4. Parallel Slave Port data. SPI™ data out.	
RD5/AD5/PSP5/ SDI2/SDA2 RD5 AD5 PSP5 SDI2 SDA2	65	I/O I/O I/O I	ST TTL TTL ST ST	Digital I/O. External memory address/data 5. Parallel Slave Port data. SPI data in. I ² C™ data I/O.	
RD6/AD6/PSP6/ SCK2/SCL2 RD6 AD6 PSP6 SCK2 SCL2	64	I/O I/O I/O I/O	ST TTL TTL ST ST	Digital I/O. External memory address/data 6. Parallel Slave Port data. Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I ² C mode.	
RD7/AD7/PSP7/SS2 RD7 AD7 PSP7 SS2	63	I/O I/O I/O	ST TTL TTL TTL	Digital I/O. External memory address/data 7. Parallel Slave Port data. SPI slave select input.	

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input = Input O = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Alternate assignment for ECCP2/P2A when configuration bit CCP2MX is cleared (Extended Microcontroller mode).

2: Default assignment for ECCP2/P2A for all devices in all operating modes (CCP2MX is set).

3: Default assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is set).

4: Alternate assignment for ECCP2/P2A when CCP2MX is cleared (Microcontroller mode).

5: Alternate assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is cleared).

TABLE 1-4: PIC18F8XJ10/8XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Nome	Pin Number	Pin	Buffer	Description.	
Pin Name	TQFP	Туре	Туре	Description	
RE0/AD8/RD/P2D RE0 AD8 RD P2D	4	I/O I/O I	ST TTL TTL	PORTE is a bidirectional I/O port. Digital I/O. External memory address/data 8. Read control for Parallel Slave Port. ECCR2 PWM output D	
RE1/AD9/WR/P2C RE1 AD9 WR P2C	3	I/O I/O I	ST TTL TTL	Digital I/O. External memory address/data 9. Write control for Parallel Slave Port. ECCP2 PWM output C.	
RE2/AD10/CS/P2B RE2 AD10 CS P2B	78	I/O I/O I O	ST TTL TTL	Digital I/O. External memory address/data 10. Chip select control for Parallel Slave Port. ECCP2 PWM output B.	
RE3/AD11/P3C RE3 AD11 P3C ⁽³⁾	77	I/O I/O O	ST TTL —	Digital I/O. External memory address/data 11. ECCP3 PWM output C.	
RE4/AD12/P3B RE4 AD12 P3B ⁽³⁾	76	I/O I/O O	ST TTL —	Digital I/O. External memory address/data 12. ECCP3 PWM output B.	
RE5/AD13/P1C RE5 AD13 P1C ⁽³⁾	75	I/O I/O O	ST TTL —	Digital I/O. External memory address/data 13. ECCP1 PWM output C.	
RE6/AD14/P1B RE6 AD14 P1B ⁽³⁾	74	I/O I/O O	ST TTL —	Digital I/O. External memory address/data 14. ECCP1 PWM output B.	
RE7/AD15/ECCP2/P2A RE7 AD15 ECCP2 ⁽⁴⁾ P2A ⁽⁴⁾	73	I/O I/O I/O O	ST TTL ST	Digital I/O. External memory address/data 15. Capture 2 input/Compare 2 output/PWM 2 output. ECCP2 PWM output A.	

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

I = Input

O = Output

P = Power

OD = Open-Drain (no P diode to VDD)

- 2: Default assignment for ECCP2/P2A for all devices in all operating modes (CCP2MX is set).
- 3: Default assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is set).
- 4: Alternate assignment for ECCP2/P2A when CCP2MX is cleared (Microcontroller mode).
- **5:** Alternate assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is cleared).

TABLE 1-4: PIC18F8XJ10/8XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description	
Pili Name	TQFP	Туре	Туре	Description	
				PORTF is a bidirectional I/O port.	
RF1/AN6/C2OUT RF1 AN6 C2OUT	23	I/O I O	ST Analog —	Digital I/O. Analog input 6. Comparator 2 output.	
RF2/AN7/C1OUT RF2 AN7 C1OUT	18	I/O I O	ST Analog —	Digital I/O. Analog input 7. Comparator 1 output.	
RF3/AN8 RF3 AN8	17	I/O I	ST Analog	Digital I/O. Analog input 8.	
RF4/AN9 RF4 AN9	16	I/O I	ST Analog	Digital I/O. Analog input 9.	
RF5/AN10/CVREF RF5 AN10 CVREF	15	I/O I O	ST Analog —	Digital I/O. Analog input 10. Comparator reference voltage output.	
RF6/AN11 RF6 AN11	14	I/O I	ST Analog	Digital I/O. Analog input 11.	
RF7/SS1 RF7 SS1	13	I/O I	ST TTL	Digital I/O. SPI™ slave select input.	

Legend: TTL = TTL compatible input

CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

= Input

O = Output

P = Power

OD = Open-Drain (no P diode to VDD)

- 2: Default assignment for ECCP2/P2A for all devices in all operating modes (CCP2MX is set).
- 3: Default assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is set).
- 4: Alternate assignment for ECCP2/P2A when CCP2MX is cleared (Microcontroller mode).
- 5: Alternate assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is cleared).

TABLE 1-4: PIC18F8XJ10/8XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin	Buffer	Description
Pili Name	TQFP	Туре	Туре	Description
				PORTG is a bidirectional I/O port.
RG0/ECCP3/P3A	5			
RG0		I/O	ST	Digital I/O.
ECCP3		I/O	ST	Capture 3 input/Compare 3 output/PWM 3 output.
P3A		0	TTL	ECCP3 PWM output A.
RG1/TX2/CK2	6			
RG1		I/O	ST	Digital I/O.
TX2		0	_	EUSART2 asynchronous transmit.
CK2		I/O	ST	EUSART2 synchronous clock (see related RX2/DT2).
RG2/RX2/DT2	7			
RG2	-	I/O	ST	Digital I/O.
RX2		I	ST	EUSART2 asynchronous receive.
DT2		I/O	ST	EUSART2 synchronous data (see related TX2/CK2).
RG3/CCP4/P3D	8			
RG3		I/O	ST	Digital I/O.
CCP4		I/O	ST	Capture 4 input/Compare 4 output/PWM 4 output.
P3D		0	TTL	ECCP3 PWM output D.
RG4/CCP5/P1D	10			
RG4		I/O	ST	Digital I/O.
CCP5		I/O	ST	Capture 5 input/Compare 5 output/PWM 5 output.
P1D		0	TTL	ECCP1 PWM output D.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input
I = Input O = Output

P = Power OD = Open-Drain (no P diode to VDD)

- 2: Default assignment for ECCP2/P2A for all devices in all operating modes (CCP2MX is set).
- 3: Default assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is set).
- **4:** Alternate assignment for ECCP2/P2A when CCP2MX is cleared (Microcontroller mode).
- 5: Alternate assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is cleared).

TABLE 1-4: PIC18F8XJ10/8XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Dia Nama	Pin Number	Pin	Buffer	Description.
Pin Name	TQFP	Туре	Туре	Description
				PORTH is a bidirectional I/O port.
RH0/A16 RH0 A16	79	I/O I/O	ST TTL	Digital I/O. External memory address/data 16.
RH1/A17 RH1 A17	80	I/O I/O	ST TTL	Digital I/O. External memory address/data 17.
RH2/A18 RH2 A18	1	I/O I/O	ST TTL	Digital I/O. External memory address/data 18.
RH3/A19 RH3 A19	2	I/O I/O	ST TTL	Digital I/O. External memory address/data 19.
RH4/AN12/P3C RH4 AN12 P3C ⁽⁵⁾	22	I/O I O	ST Analog —	Digital I/O. Analog input 12. ECCP3 PWM output C.
RH5/AN13/P3B RH5 AN13 P3B ⁽⁵⁾	21	I/O I O	ST Analog —	Digital I/O. Analog input 13. ECCP3 PWM output B.
RH6/AN14/P1C RH6 AN14 P1C ⁽⁵⁾	20	I/O I O	ST Analog —	Digital I/O. Analog input 14. ECCP1 PWM output C.
RH7/AN15/P1B RH7 AN15 P1B ⁽⁵⁾	19	I/O I O	ST Analog —	Digital I/O. Analog input 15. ECCP1 PWM output B.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input
I = Input O = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Alternate assignment for ECCP2/P2A when configuration bit CCP2MX is cleared (Extended Microcontroller mode).

2: Default assignment for ECCP2/P2A for all devices in all operating modes (CCP2MX is set).

3: Default assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is set).

4: Alternate assignment for ECCP2/P2A when CCP2MX is cleared (Microcontroller mode).

5: Alternate assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is cleared).

TABLE 1-4: PIC18F8XJ10/8XJ15 PINOUT I/O DESCRIPTIONS (CONTINUED)

Di. Nama	Pin Number	Pin	Buffer	B	
Pin Name	TQFP	Type	Туре	Description	
				PORTJ is a bidirectional I/O port.	
RJ0/ALE RJ0 ALE	62	I/O O	ST —	Digital I/O. External memory address latch enable.	
RJ1/OE RJ1 OE	61	I/O O	ST —	Digital I/O. External memory output enable.	
RJ2/WRL RJ2 WRL	60	I/O O	ST —	Digital I/O. External memory write low control.	
RJ3/WRH RJ3 WRH	59	I/O O	ST —	Digital I/O. External memory write high control.	
RJ4/BA0 RJ4 BA0	39	I/O O	ST —	Digital I/O. External memory byte address 0 control.	
RJ5/CE RJ5 CE	40	I/O O	ST —	Digital I/O External memory chip enable control.	
RJ6/LB RJ6 LB	41	I/O O	ST —	Digital I/O. External memory low byte control.	
RJ7/UB RJ7 UB	42	I/O O	ST —	Digital I/O. External memory high byte control.	
Vss	11, 31, 51, 70	Р	_	Ground reference for logic and I/O pins.	
VDD	32, 48, 71	Р	_	Positive supply for peripheral digital logic and I/O pins.	
AVss	26	Р	_	Ground reference for analog modules.	
AVDD	25	Р	_	Positive supply for analog modules.	
ENVREG	24	Ι	ST	Enable for on-chip voltage regulator.	
VDDCORE/VCAP VDDCORE	12	Р	_	Core logic power or external filter capacitor connection. Positive supply for microcontroller core logic (regulator disabled).	
VCAP		Р	_	External filter capacitor connection (regulator enabled).	

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input
I = Input O = Output

P = Power OD = Open-Drain (no P diode to VDD)

Note 1: Alternate assignment for ECCP2/P2A when configuration bit CCP2MX is cleared (Extended Microcontroller mode).

2: Default assignment for ECCP2/P2A for all devices in all operating modes (CCP2MX is set).

3: Default assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is set).

4: Alternate assignment for ECCP2/P2A when CCP2MX is cleared (Microcontroller mode).

5: Alternate assignments for P1B/P1C/P3B/P3C (ECCPMX configuration bit is cleared).

NOTES:

2.0 OSCILLATOR CONFIGURATIONS

2.1 Oscillator Types

The PIC18F87J10 family of devices can be operated in five different oscillator modes:

 HS High-Speed Crystal/Resonator
 HSPLL High-Speed Crystal/Resonator with Software PLL Control

 EC External Clock with Fosc/4 Output
 ECPLL External Clock with Software PLL Control

5. INTRC Internal 31 kHz Oscillator

Four of these are selected by the user by programming the FOSC2:FOSC0 configuration bits. The fifth mode (INTRC) may be invoked under software control; it can also be configured as the default mode on device Resets.

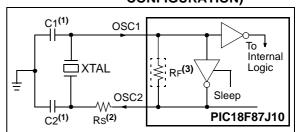
2.2 Crystal Oscillator/Ceramic Resonators (HS Modes)

In HS or HSPLL Oscillator modes, a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation. Figure 2-1 shows the pin connections.

The oscillator design requires the use of a parallel cut crystal.

Note: Use of a series cut crystal may give a frequency out of the crystal manufacturer's specifications.

FIGURE 2-1: CRYSTAL/CERAMIC RESONATOR OPERATION (HS OR HSPLL CONFIGURATION)



Note 1: See Table 2-1 and Table 2-2 for initial values of C1 and C2.

- **2:** A series resistor (Rs) may be required for AT strip cut crystals.
- 3: RF varies with the oscillator mode chosen.

TABLE 2-1: CAPACITOR SELECTION FOR CERAMIC RESONATORS

Typical Capacitor Values Used:							
Mode	Freq.	OSC1	OSC2				
HS	8.0 MHz 16.0 MHz	27 pF 22 pF	27 pF 22 pF				

Capacitor values are for design guidance only.

These capacitors were tested with the resonators listed below for basic start-up and operation. **These values are not optimized**.

Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application.

See the notes following Table 2-2 for additional information.

Resonators Used:
4.0 MHz
8.0 MHz
16.0 MHz

TABLE 2-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

Osc Type	Crystal Freq.	Typical Capacitor Values Tested:		
	rreq.	C1	C2	
HS	4 MHz	27 pF	27 pF	
	8 MHz	22 pF	22 pF	
	20 MHz	15 pF	15 pF	

Capacitor values are for design guidance only.

These capacitors were tested with the crystals listed below for basic start-up and operation. **These values are not optimized.**

Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application.

See the notes following this table for additional information.

Crystals Used:
4 MHz
8 MHz
20 MHz

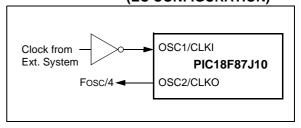
- **Note 1:** Higher capacitance increases the stability of oscillator but also increases the start-up time.
 - 2: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - **3:** Rs may be required to avoid overdriving crystals with low drive level specification.
 - **4:** Always verify oscillator performance over the VDD and temperature range that is expected for the application.

2.3 External Clock Input (EC Modes)

The EC and ECPLL Oscillator modes require an external clock source to be connected to the OSC1 pin. There is no oscillator start-up time required after a Power-on Reset or after an exit from Sleep mode.

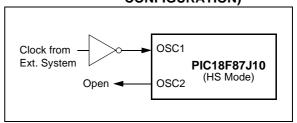
In the EC Oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 2-2 shows the pin connections for the EC Oscillator mode.

FIGURE 2-2: EXTERNAL CLOCK INPUT OPERATION (EC CONFIGURATION)



An external clock source may also be connected to the OSC1 pin in the HS mode, as shown in Figure 2-3. In this configuration, the divide-by-4 output on OSC2 is not available.

FIGURE 2-3: EXTERNAL CLOCK INPUT OPERATION (HS OSC CONFIGURATION)



2.4 PLL Frequency Multiplier

A Phase Locked Loop (PLL) circuit is provided as an option for users who want to use a lower frequency oscillator circuit, or to clock the device up to its highest rated frequency from a crystal oscillator. This may be useful for customers who are concerned with EMI due to high-frequency crystals, or users who require higher clock speeds from an internal oscillator. For these reasons, the HSPLL and ECPLL modes are available.

The HSPLL and ECPLL modes provide the ability to selectively run the device at 4 times the external oscillating source to produce frequencies up to 40 MHz. The PLL is enabled by setting the PLLEN bit in the OSCTUNE register (Register 2-1).

HSPLL or ECPLL (CONFIG2L) PLL Enable (OSCTUNE) Phase Comparator Fout Fout Fout Filter A VCO SYSCLK

REGISTER 2-1: OSCTUNE: PLL CONTROL REGISTER

U-0	R/W-0 ⁽¹⁾	U-0	U-0	U-0	U-0	U-0	U-0
_	PLLEN ⁽¹⁾	_	_	_	_		_
hit 7							hit 0

bit 7 Unimplemented: Read as '0'

bit 6 PLLEN: Frequency Multiplier PLL Enable bit (1)

1 = PLL enabled0 = PLL disabled

Note 1: Available only for ECPLL and HSPLL oscillator configurations; otherwise, this bit is

unavailable and read as '0'.

bit 5-0 Unimplemented: Read as '0'

2.5 Internal Oscillator Block

The PIC18F87J10 family of devices includes an internal oscillator source (INTRC) which provides a nominal 31 kHz output. The INTRC is enabled on device power-up and clocks the device during its configuration cycle until it enters operating mode. INTRC is also enabled if it is selected as the device clock source or if any of the following are enabled:

- · Fail-Safe Clock Monitor
- · Watchdog Timer
- · Two-Speed Start-up

These features are discussed in greater detail in Section 23.0 "Special Features of the CPU".

The INTRC can also be optionally configured as the default clock source on device start-up by setting the FOSC2 configuration bit. This is discussed in **Section 2.6.1 "Oscillator Control Register"**.

2.6 Clock Sources and Oscillator Switching

The PIC18F87J10 family includes a feature that allows the device clock source to be switched from the main oscillator to an alternate clock source. PIC18F87J10 family devices offer two alternate clock sources. When an alternate clock source is enabled, the various power-managed operating modes are available.

Essentially, there are three clock sources for these devices:

- · Primary oscillators
- · Secondary oscillators
- · Internal oscillator

The **primary oscillators** include the External Crystal and Resonator modes and the External Clock modes. The particular mode is defined by the FOSC2:FOSC0 configuration bits. The details of these modes are covered earlier in this chapter.

The **secondary oscillators** are those external sources not connected to the OSC1 or OSC2 pins. These sources may continue to operate even after the controller is placed in a power-managed mode.

PIC18F87J10 family devices offer the Timer1 oscillator as a secondary oscillator. This oscillator, in all power-managed modes, is often the time base for functions such as a real-time clock.

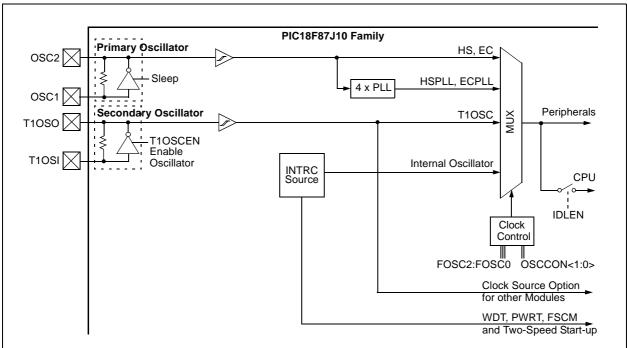
Most often, a 32.768 kHz watch crystal is connected between the RC0/T10S0/T13CKI and RC1/T10SI pins. Loading capacitors are also connected from each pin to ground.

The Timer1 oscillator is discussed in greater detail in Section 12.3 "Timer1 Oscillator".

In addition to being a primary clock source, the **internal oscillator** is available as a power-managed mode clock source. The INTRC source is also used as the clock source for several special features, such as the WDT and Fail-Safe Clock Monitor.

The clock sources for the PIC18F87J10 family devices are shown in Figure 2-5. See **Section 23.0 "Special Features of the CPU"** for Configuration register details.

FIGURE 2-5: PIC18F87J10 FAMILY CLOCK DIAGRAM



2.6.1 OSCILLATOR CONTROL REGISTER

The OSCCON register (Register 2-2) controls several aspects of the device clock's operation, both in full power operation and in power-managed modes.

The System Clock Select bits, SCS1:SCS0, select the clock source. The available clock sources are the primary clock (defined by the FOSC2:FOSC0 configuration bits), the secondary clock (Timer1 oscillator) and the internal oscillator. The clock source changes after one or more of the bits are written to, following a brief clock transition interval.

The OSTS (OSCCON<3>) and T1RUN (T1CON<6>) bits indicate which clock source is currently providing the device clock. The OSTS bit indicates that the Oscillator Start-up Timer (OST) has timed out and the primary clock is providing the device clock in primary clock modes. The T1RUN bit indicates when the Timer1 oscillator is providing the device clock in secondary clock modes. In power-managed modes, only one of these bits will be set at any time. If neither of these bits are set, the INTRC is providing the clock, or the internal oscillator has just started and is not yet stable.

The IDLEN bit determines if the device goes into Sleep mode or one of the Idle modes when the SLEEP instruction is executed.

The use of the flag and control bits in the OSCCON register is discussed in more detail in **Section 3.0** "Power-Managed Modes".

- Note 1: The Timer1 oscillator must be enabled to select the secondary clock source. The Timer1 oscillator is enabled by setting the T1OSCEN bit in the Timer1 Control register (T1CON<3>). If the Timer1 oscillator is not enabled, then any attempt to select a secondary clock source when executing a SLEEP instruction will be ignored.
 - 2: It is recommended that the Timer1 oscillator be operating and stable before executing the SLEEP instruction or a very long delay may occur while the Timer1 oscillator starts.

2.6.1.1 System Clock Selection and the FOSC2 Configuration Bit

The SCS bits are cleared on all forms of Reset. In the device's default configuration, this means the primary oscillator defined by FOSC1:FOSC0 (that is, one of the HC or EC modes) is used as the primary clock source on device Resets.

The default clock configuration on Reset can be changed with the FOSC2 configuration bit. The effect of this bit is to set the clock source selected when SCS1:SCS0 = 00. When FOSC2 = 1 (default), the oscillator source defined by FOSC1:FOSC0 is selected whenever SCS1:SCS0 = 00. When FOSC2 = 0, the INTRC oscillator is selected whenever SCS1:SCS2 = 00. Because the SCS bits are cleared on Reset, the FOSC2 setting also changes the default oscillator mode on Reset.

Regardless of the setting of FOSC2, INTRC will always be enabled on device power-up. It will serve as the clock source until the device has loaded its configuration values from memory. It is at this point that the FOSC configuration bits are read and the oscillator selection of operational mode is made.

Note that either the primary clock or the internal oscillator will have two bit setting options, at any given time, depending on the setting of FOSC2.

2.6.2 OSCILLATOR TRANSITIONS

PIC18F87J10 family devices contain circuitry to prevent clock "glitches" when switching between clock sources. A short pause in the device clock occurs during the clock switch. The length of this pause is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable.

Clock transitions are discussed in greater detail in Section 3.1.2 "Entering Power-Managed Modes".

REGISTER 2-2: OSCCON: OSCILLATOR CONTROL REGISTER

R/W-0	U-0	U-0	U-0	R-q ⁽¹⁾	U-0	R/W-0	R/W-0
IDLEN	_	_	_	OSTS	_	SCS1	SCS0
hit 7							

bit 7 bit 0

IDLEN: Idle Enable bit bit 7

> 1 = Device enters Idle mode on SLEEP instruction 0 = Device enters Sleep mode on SLEEP instruction

bit 6-4 Unimplemented: Read as '0'

bit 3 OSTS: Oscillator Start-up Time-out Status bit(1)

1 = Oscillator Start-up Timer time-out has expired; primary oscillator is running

0 = Oscillator Start-up Timer time-out is running; primary oscillator is not ready

Note 1: The Reset value is '0' when HS mode and Two-Speed Start-up are both enabled; otherwise, it is '1'.

bit 2 Unimplemented: Read as '0'

bit 1-0 SCS1:SCS0: System Clock Select bits

11 = Internal oscillator

10 = Primary oscillator

01 = Timer1 oscillator

When FOSC2 = 1:

00 = Primary oscillator

When FOSC2 = 0:

00 = Internal oscillator

Legend:

U = Unimplemented, read as '0' 'q' = Value determined by configuration -n = Value at POR R = Readable bit '0' = Bit is cleared W = Writable bit

2.7 **Effects of Power-Managed Modes** on the Various Clock Sources

When PRI_IDLE mode is selected, the designated primary oscillator continues to run without interruption. For all other power-managed modes, the oscillator using the OSC1 pin is disabled. The OSC1 pin (and OSC2 pin if used by the oscillator) will stop oscillating.

In Secondary Clock modes (SEC_RUN and SEC_IDLE), the Timer1 oscillator is operating and providing the device clock. The Timer1 oscillator may also run in all power-managed modes if required to clock Timer1 or Timer3.

In RC_RUN and RC_IDLE modes, the internal oscillator provides the device clock source. The 31 kHz INTRC output can be used directly to provide the clock and may be enabled to support various special features, regardless of the power-managed mode (see Section 23.2 "Watchdog Timer (WDT)" through Section 23.5 "Fail-Safe Clock Monitor" for more information on WDT, Fail-Safe Clock Monitor and Two-Speed Start-up).

If the Sleep mode is selected, all clock sources are stopped. Since all the transistor switching currents have been stopped, Sleep mode achieves the lowest current consumption of the device (only leakage

Enabling any on-chip feature that will operate during Sleep will increase the current consumed during Sleep. The INTRC is required to support WDT operation. The Timer1 oscillator may be operating to support a real-time clock. Other features may be operating that do not require a device clock source (i.e., SSP slave, PSP, INTn pins and others). Peripherals that may add significant current consumption are listed in Section 26.2 "DC Characteristics: Power-Down and Supply Current".

2.8 Power-up Delays

Power-up delays are controlled by two timers, so that no external Reset circuitry is required for most applications. The delays ensure that the device is kept in Reset until the device power supply is stable under normal circumstances and the primary clock is operating and stable. For additional information on power-up delays, see **Section 4.5** "Power-up Timer (PWRT)".

The first timer is the Power-up Timer (PWRT), which provides a fixed delay on power-up (parameter 33, Table 26-12). It is always enabled.

The second timer is the Oscillator Start-up Timer (OST), intended to keep the chip in Reset until the crystal oscillator is stable (HS modes). The OST does this by counting 1024 oscillator cycles before allowing the oscillator to clock the device.

There is a delay of interval TCSD (parameter 38, Table 26-12), following POR, while the controller becomes ready to execute instructions.

TABLE 2-3: OSC1 AND OSC2 PIN STATES IN SLEEP MODE

Oscillator Mode	OSC1 Pin	OSC2 Pin		
EC, ECPLL	Floating, pulled by external clock	At logic low (clock/4 output)		
HS, HSPLL	Feedback inverter disabled at quiescent voltage level	Feedback inverter disabled at quiescent voltage level		

Note: See Table 4-2 in Section 4.0 "Reset" for time-outs due to Sleep and MCLR Reset.

NOTES:

3.0 POWER-MANAGED MODES

The PIC18F87J10 family devices provide the ability to manage power consumption by simply managing clocking to the CPU and the peripherals. In general, a lower clock frequency and a reduction in the number of circuits being clocked constitutes lower consumed power. For the sake of managing power in an application, there are three primary modes of operation:

- Run mode
- Idle mode
- · Sleep mode

These modes define which portions of the device are clocked and at what speed. The Run and Idle modes may use any of the three available clock sources (primary, secondary or internal oscillator block); the Sleep mode does not use a clock source.

The power-managed modes include several power-saving features offered on previous PICmicro® devices. One is the clock switching feature, offered in other PIC18 devices, allowing the controller to use the Timer1 oscillator in place of the primary oscillator. Also included is the Sleep mode, offered by all PICmicro devices, where all device clocks are stopped.

3.1 Selecting Power-Managed Modes

Selecting a power-managed mode requires two decisions: if the CPU is to be clocked or not and which clock source is to be used. The IDLEN bit (OSCCON<7>) controls CPU clocking, while the SCS1:SCS0 bits (OSCCON<1:0>) select the clock source. The individual modes, bit settings, clock sources and affected modules are summarized in Table 3-1.

3.1.1 CLOCK SOURCES

The SCS1:SCS0 bits allow the selection of one of three clock sources for power-managed modes. They are:

- the primary clock, as defined by the FOSC2:FOSC0 configuration bits
- the secondary clock (Timer1 oscillator)
- the internal oscillator

3.1.2 ENTERING POWER-MANAGED MODES

Switching from one power-managed mode to another begins by loading the OSCCON register. The SCS1:SCS0 bits select the clock source and determine which Run or Idle mode is to be used. Changing these bits causes an immediate switch to the new clock source, assuming that it is running. The switch may also be subject to clock transition delays. These are discussed in **Section 3.1.3 "Clock Transitions and Status Indicators"** and subsequent sections.

Entry to the power-managed Idle or Sleep modes is triggered by the execution of a SLEEP instruction. The actual mode that results depends on the status of the IDLEN bit.

Depending on the current mode and the mode being switched to, a change to a power-managed mode does not always require setting all of these bits. Many transitions may be done by changing the oscillator select bits, or changing the IDLEN bit, prior to issuing a SLEEP instruction. If the IDLEN bit is already configured correctly, it may only be necessary to perform a SLEEP instruction to switch to the desired mode.

TABLE 3-1: POWER-MANAGED MODES

	OSCCON bits		Module Clocking		A . II . II . O . II . I . O . III . O .	
Mode	IDLEN<7>(1)	SCS1:SCS0<1:0>	CPU	Peripherals	Available Clock and Oscillator Source	
Sleep	0	N/A	Off	Off	None – All clocks are disabled	
PRI_RUN	N/A	10	Clocked		Primary – HS, EC, HSPLL, ECPLL; this is the normal full power execution mode.	
SEC_RUN	N/A	01	Clocked	Clocked	Secondary – Timer1 Oscillator	
RC_RUN	N/A	11	Clocked	Clocked	Internal Oscillator	
PRI_IDLE	1	10	Off	Clocked	Primary – HS, EC, HSPLL, ECPLL	
SEC_IDLE	1	01	Off	Clocked	Secondary – Timer1 Oscillator	
RC_IDLE	1	11	Off	Clocked	Internal Oscillator	

Note 1: IDLEN reflects its value when the SLEEP instruction is executed.

3.1.3 CLOCK TRANSITIONS AND STATUS INDICATORS

The length of the transition between clock sources is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable.

Two bits indicate the current clock source and its status: OSTS (OSCCON<3>) and T1RUN (T1CON<6>). In general, only one of these bits will be set while in a given power-managed mode. When the OSTS bit is set, the primary clock is providing the device clock. When the T1RUN bit is set, the Timer1 oscillator is providing the clock. If neither of these bits is set, INTRC is clocking the device.

Note: Executing a SLEEP instruction does not necessarily place the device into Sleep mode. It acts as the trigger to place the controller into either the Sleep mode or one of the Idle modes, depending on the setting of the IDLEN bit.

3.1.4 MULTIPLE SLEEP COMMANDS

The power-managed mode that is invoked with the SLEEP instruction is determined by the setting of the IDLEN bit at the time the instruction is executed. If another SLEEP instruction is executed, the device will enter the power-managed mode specified by IDLEN at that time. If IDLEN has changed, the device will enter the new power-managed mode specified by the new setting.

3.2 Run Modes

In the Run modes, clocks to both the core and peripherals are active. The difference between these modes is the clock source.

3.2.1 PRI RUN MODE

The PRI_RUN mode is the normal, full power execution mode of the microcontroller. This is also the default mode upon a device Reset unless Two-Speed Start-up is enabled (see Section 23.4 "Two-Speed Start-up" for details). In this mode, the OSTS bit is set. (see Section 2.6.1 "Oscillator Control Register").

3.2.2 SEC_RUN MODE

The SEC_RUN mode is the compatible mode to the "clock switching" feature offered in other PIC18 devices. In this mode, the CPU and peripherals are clocked from the Timer1 oscillator. This gives users the option of lower power consumption while still using a high-accuracy clock source.

SEC_RUN mode is entered by setting the SCS1:SCS0 bits to '01'. The device clock source is switched to the Timer1 oscillator (see Figure 3-1), the primary oscillator is shut-down, the T1RUN bit (T1CON<6>) is set and the OSTS bit is cleared.

Note: The Timer1 oscillator should already be running prior to entering SEC_RUN mode. If the T1OSCEN bit is not set when the SCS1:SCS0 bits are set to '01', entry to SEC_RUN mode will not occur. If the Timer1 oscillator is enabled, but not yet running, device clocks will be delayed until the oscillator has started. In such situations, initial oscillator operation is far from stable and unpredictable operation may

On transitions from SEC_RUN mode to PRI_RUN, the peripherals and CPU continue to be clocked from the Timer1 oscillator while the primary clock is started. When the primary clock becomes ready, a clock switch back to the primary clock occurs (see Figure 3-2). When the clock switch is complete, the T1RUN bit is cleared, the OSTS bit is set and the primary clock is providing the clock. The IDLEN and SCS bits are not affected by the wake-up; the Timer1 oscillator continues to run.

FIGURE 3-1: TRANSITION TIMING FOR ENTRY TO SEC_RUN MODE

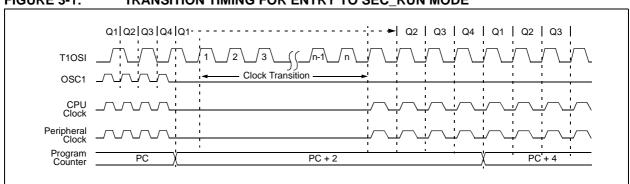
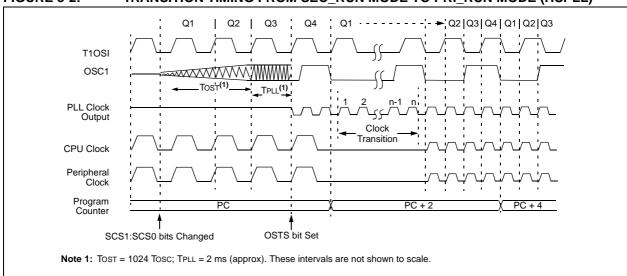


FIGURE 3-2: TRANSITION TIMING FROM SEC_RUN MODE TO PRI_RUN MODE (HSPLL)



3.2.3 RC_RUN MODE

In RC_RUN mode, the CPU and peripherals are clocked from the internal oscillator; the primary clock is shut-down. This mode provides the best power conservation of all the Run modes, while still executing code. It works well for user applications which are not highly timing sensitive or do not require high-speed clocks at all times.

This mode is entered by setting SCS to '11'. When the clock source is switched to the INTRC (see Figure 3-3), the primary oscillator is shut-down and the OSTS bit is cleared.

On transitions from RC_RUN mode to PRI_RUN mode, the device continues to be clocked from the INTRC while the primary clock is started. When the primary clock becomes ready, a clock switch to the primary clock occurs (see Figure 3-4). When the clock switch is complete, the OSTS bit is set and the primary clock is providing the device clock. The IDLEN and SCS bits are not affected by the switch. The INTRC source will continue to run if either the WDT or the Fail-Safe Clock Monitor is enabled.



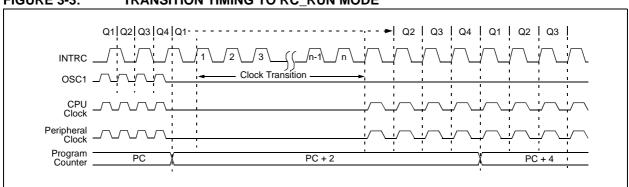
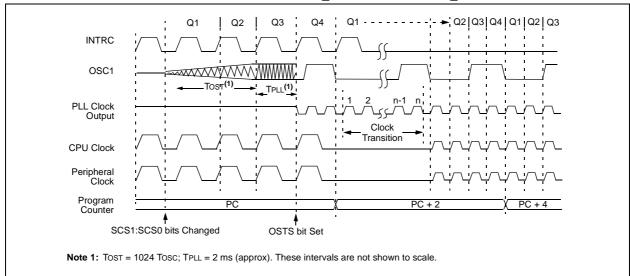


FIGURE 3-4: TRANSITION TIMING FROM RC_RUN MODE TO PRI_RUN MODE



3.3 Sleep Mode

The power-managed Sleep mode is identical to the legacy Sleep mode offered in all other PICmicro devices. It is entered by clearing the IDLEN bit (the default state on device Reset) and executing the SLEEP instruction. This shuts down the selected oscillator (Figure 3-5). All clock source status bits are cleared.

Entering the Sleep mode from any other mode does not require a clock switch. This is because no clocks are needed once the controller has entered Sleep. If the WDT is selected, the INTRC source will continue to operate. If the Timer1 oscillator is enabled, it will also continue to run.

When a wake event occurs in Sleep mode (by interrupt, Reset or WDT time-out), the device will not be clocked until the clock source selected by the SCS1:SCS0 bits becomes ready (see Figure 3-6), or it will be clocked from the internal oscillator if either the Two-Speed Start-up or the Fail-Safe Clock Monitor are enabled (see Section 23.0 "Special Features of the CPU"). In either case, the OSTS bit is set when the primary clock is providing the device clocks. The IDLEN and SCS bits are not affected by the wake-up.

3.4 Idle Modes

The Idle modes allow the controller's CPU to be selectively shut-down while the peripherals continue to operate. Selecting a particular Idle mode allows users to further manage power consumption.

If the IDLEN bit is set to a '1' when a SLEEP instruction is executed, the peripherals will be clocked from the clock source selected using the SCS1:SCS0 bits; however, the CPU will not be clocked. The clock source status bits are not affected. Setting IDLEN and executing a SLEEP instruction provides a quick method of switching from a given Run mode to its corresponding Idle mode.

If the WDT is selected, the INTRC source will continue to operate. If the Timer1 oscillator is enabled, it will also continue to run.

Since the CPU is not executing instructions, the only exits from any of the Idle modes are by interrupt, WDT time-out or a Reset. When a wake event occurs, CPU execution is delayed by an interval of TCSD (parameter 38, Table 26-12) while it becomes ready to execute code. When the CPU begins executing code, it resumes with the same clock source for the current Idle mode. For example, when waking from RC_IDLE mode, the internal oscillator block will clock the CPU and peripherals (in other words, RC_RUN mode). The IDLEN and SCS bits are not affected by the wake-up.

While in any Idle mode or the Sleep mode, a WDT time-out will result in a WDT wake-up to the Run mode currently specified by the SCS1:SCS0 bits.

FIGURE 3-5: TRANSITION TIMING FOR ENTRY TO SLEEP MODE

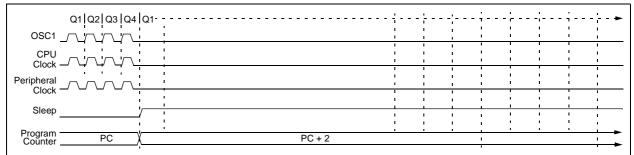
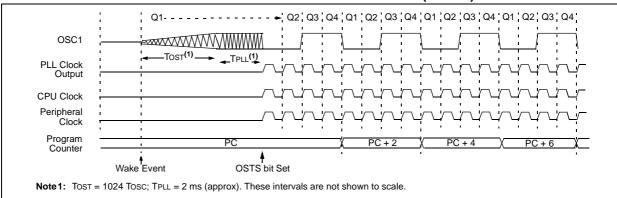


FIGURE 3-6: TRANSITION TIMING FOR WAKE FROM SLEEP (HSPLL)



3.4.1 PRI_IDLE MODE

This mode is unique among the three Low-Power Idle modes, in that it does not disable the primary device clock. For timing sensitive applications, this allows for the fastest resumption of device operation with its more accurate primary clock source, since the clock source does not have to "warm up" or transition from another oscillator.

PRI_IDLE mode is entered from PRI_RUN mode by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, set IDLEN first, then set the SCS bits to '10' and execute SLEEP. Although the CPU is disabled, the peripherals continue to be clocked from the primary clock source specified by the FOSC1:FOSC0 configuration bits. The OSTS bit remains set (see Figure 3-7).

When a wake event occurs, the CPU is clocked from the primary clock source. A delay of interval TCSD is required between the wake event and when code execution starts. This is required to allow the CPU to become ready to execute instructions. After the wake-up, the OSTS bit remains set. The IDLEN and SCS bits are not affected by the wake-up (see Figure 3-8).

3.4.2 SEC_IDLE MODE

In SEC_IDLE mode, the CPU is disabled but the peripherals continue to be clocked from the Timer1 oscillator. This mode is entered from SEC_RUN by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, set IDLEN first, then set SCS1:SCS0 to '01' and execute SLEEP. When the clock source is switched to the Timer1 oscillator, the primary oscillator is shut-down, the OSTS bit is cleared and the T1RUN bit is set.

When a wake event occurs, the peripherals continue to be clocked from the Timer1 oscillator. After an interval of TCSD following the wake event, the CPU begins executing code being clocked by the Timer1 oscillator. The IDLEN and SCS bits are not affected by the wake-up; the Timer1 oscillator continues to run (see Figure 3-8).

Note: The Timer1 oscillator should already be running prior to entering SEC_IDLE mode. If the T1OSCEN bit is not set when the SLEEP instruction is executed, the SLEEP instruction will be ignored and entry to SEC_IDLE mode will not occur. If the Timer1 oscillator is enabled, but not yet running, peripheral clocks will be delayed until the oscillator has started. In such situations, initial oscillator operation is far from stable and unpredictable operation may result.



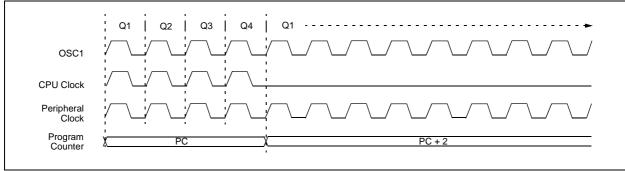
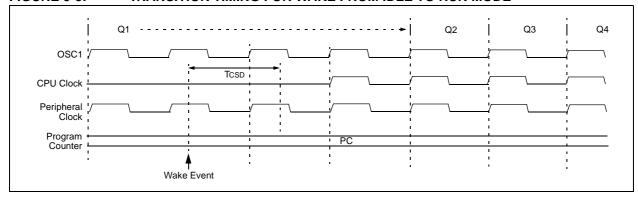


FIGURE 3-8: TRANSITION TIMING FOR WAKE FROM IDLE TO RUN MODE



3.4.3 RC_IDLE MODE

In RC_IDLE mode, the CPU is disabled but the peripherals continue to be clocked from the internal oscillator. This mode allows for controllable power conservation during Idle periods.

From RC_RUN, this mode is entered by setting the IDLEN bit and executing a SLEEP instruction. If the device is in another Run mode, first set IDLEN, then clear the SCS bits and execute SLEEP. When the clock source is switched to the INTRC, the primary oscillator is shut-down and the OSTS bit is cleared.

When a wake event occurs, the peripherals continue to be clocked from the INTRC. After a delay of Tcsp following the wake event, the CPU begins executing code being clocked by the INTRC. The IDLEN and SCS bits are not affected by the wake-up. The INTRC source will continue to run if either the WDT or the Fail-Safe Clock Monitor is enabled.

3.5 Exiting Idle and Sleep Modes

An exit from Sleep mode, or any of the Idle modes, is triggered by an interrupt, a Reset or a WDT time-out. This section discusses the triggers that cause exits from power-managed modes. The clocking subsystem actions are discussed in each of the power-managed modes sections (see Section 3.2 "Run Modes", Section 3.3 "Sleep Mode" and Section 3.4 "Idle Modes").

3.5.1 EXIT BY INTERRUPT

Any of the available interrupt sources can cause the device to exit from an Idle mode, or the Sleep mode, to a Run mode. To enable this functionality, an interrupt source must be enabled by setting its enable bit in one of the INTCON or PIE registers. The exit sequence is initiated when the corresponding interrupt flag bit is set.

On all exits from Idle or Sleep modes by interrupt, code execution branches to the interrupt vector if the GIE/GIEH bit (INTCON<7>) is set. Otherwise, code execution continues or resumes without branching (see **Section 9.0 "Interrupts"**).

A fixed delay of interval TCSD following the wake event is required when leaving Sleep and Idle modes. This delay is required for the CPU to prepare for execution. Instruction execution resumes on the first clock cycle following this delay.

3.5.2 EXIT BY WDT TIME-OUT

A WDT time-out will cause different actions depending on which power-managed mode the device is in when the time-out occurs.

If the device is not executing code (all Idle modes and Sleep mode), the time-out will result in an exit from the power-managed mode (see Section 3.2 "Run Modes" and Section 3.3 "Sleep Mode"). If the device is executing code (all Run modes), the time-out will result in a WDT Reset (see Section 23.2 "Watchdog Timer (WDT)").

The WDT timer and postscaler are cleared by one of the following events:

- executing a SLEEP or CLRWDT instruction
- the loss of a currently selected clock source (if the Fail-Safe Clock Monitor is enabled)

3.5.3 EXIT BY RESET

Exiting an Idle or Sleep mode by Reset automatically forces the device to run from the INTRC.

3.5.4 EXIT WITHOUT AN OSCILLATOR START-UP DELAY

Certain exits from power-managed modes do not invoke the OST at all. There are two cases:

- PRI_IDLE mode where the primary clock source is not stopped; and
- the primary clock source is either the EC or ECPLL mode.

In these instances, the primary clock source either does not require an oscillator start-up delay, since it is already running (PRI_IDLE), or normally does not require an oscillator start-up delay (EC). However, a fixed delay of interval TCSD following the wake event is still required when leaving Sleep and Idle modes to allow the CPU to prepare for execution. Instruction execution resumes on the first clock cycle following this delay.

NOTES:

4.0 RESET

The PIC18F87J10 family of devices differentiate between various kinds of Reset:

- a) Power-on Reset (POR)
- b) MCLR Reset during normal operation
- c) MCLR Reset during power-managed modes
- d) Watchdog Timer (WDT) Reset (during execution)
- e) Brown-out Reset (BOR)
- f) RESET Instruction
- g) Stack Full Reset
- h) Stack Underflow Reset

This section discusses Resets generated by MCLR, POR and BOR and covers the operation of the various start-up timers. Stack Reset events are covered in Section 5.1.6.4 "Stack Full and Underflow Resets". WDT Resets are covered in Section 23.2 "Watchdog Timer (WDT)".

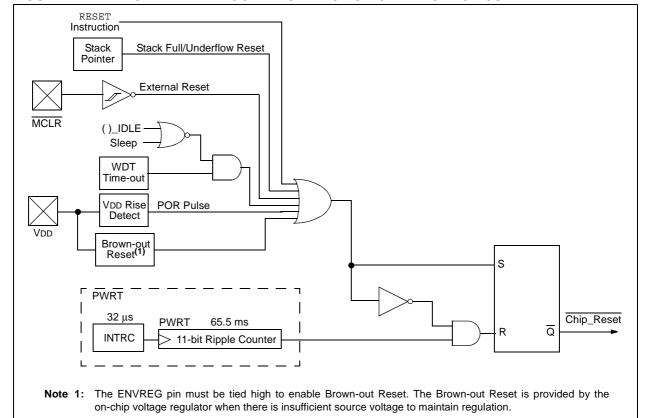
A simplified block diagram of the On-Chip Reset Circuit is shown in Figure 4-1.

4.1 RCON Register

Device Reset events are tracked through the RCON register (Register 4-1). The lower five bits of the register indicate that a specific Reset event has occurred. In most cases, these bits can only be set by the event and must be cleared by the application after the event. The state of these flag bits, taken together, can be read to indicate the type of Reset that just occurred. This is described in more detail in **Section 4.6 "Reset State of Registers"**.

The RCON register also has a control bit for setting interrupt priority (IPEN). Interrupt priority is discussed in **Section 9.0 "Interrupts"**.

FIGURE 4-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



REGISTER 4-1: RCON: RESET CONTROL REGISTER

-	1::-							
Ĭ	IPEN	_	_	RI	TO	PD	POR	BOR
	R/W-0	U-0	U-0	R/W-1	R-1	R-1	R/W-0	R/W-0

bit 7 bit 0

- bit 7 IPEN: Interrupt Priority Enable bit
 - 1 = Enable priority levels on interrupts
 - 0 = Disable priority levels on interrupts (PIC16CXXX Compatibility mode)
- bit 6-5 Unimplemented: Read as '0'
- bit 4 RI: RESET Instruction Flag bit
 - 1 = The RESET instruction was not executed (set by firmware only)
 - 0 = The RESET instruction was executed causing a device Reset (must be set in software after a Brown-out Reset occurs)
- bit 3 TO: Watchdog Time-out Flag bit
 - 1 = Set by power-up, CLRWDT instruction or SLEEP instruction
 - 0 = A WDT time-out occurred
- bit 2 PD: Power-Down Detection Flag bit
 - 1 = Set by power-up or by the CLRWDT instruction
 - 0 = Set by execution of the SLEEP instruction
- bit 1 POR: Power-on Reset Status bit
 - 1 = A Power-on Reset has not occurred (set by firmware only)
 - 0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)
- bit 0 BOR: Brown-out Reset Status bit
 - 1 = A Brown-out Reset has not occurred (set by firmware only)
 - 0 = A Brown-out Reset occurred (must be set in software after a Brown-out Reset occurs)

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- **Note 1:** It is recommended that the $\overline{\mathsf{POR}}$ bit be set after a Power-on Reset has been detected, so that subsequent Power-on Resets may be detected.
 - 2: If the on-chip voltage regulator is disabled, BOR remains '0' at all times. See Section 4.4.1 "Detecting BOR" for more information.
 - 3: Brown-out Reset is said to have occurred when BOR is '0' and POR is '1' (assuming that POR was set to '1' by software immediately after POR).

4.2 Master Clear (MCLR)

The MCLR pin provides a method for triggering a hard external Reset of the device. A Reset is generated by holding the pin low. PIC18 extended microcontroller devices have a noise filter in the MCLR Reset path which detects and ignores small pulses.

The MCLR pin is not driven low by any internal Resets, including the WDT.

4.3 Power-on Reset (POR)

A Power-on Reset condition is generated on-chip whenever VDD rises above a certain threshold. This allows the device to start in the initialized state when VDD is adequate for operation.

To take advantage of the POR circuitry, tie the \overline{MCLR} pin through a resistor (1 k Ω to 10 k Ω) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset delay. A minimum rise rate for VDD is specified (parameter D004). For a slow rise time, see Figure 4-2.

When the device starts normal operation (i.e., exits the Reset condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in Reset until the operating conditions are met.

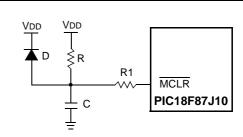
POR events are captured by the POR bit (RCON<1>). The state of the bit is set to '0' whenever a POR occurs; it does not change for any other Reset event. POR is not reset to '1' by any hardware event. To capture multiple events, the user manually resets the bit to '1' in software following any POR.

4.4 Brown-out Reset (BOR)

The PIC18F87J10 family of devices incorporate a simple BOR function when the internal regulator is enabled (ENVREG pin is tied to VDD). Any drop of VDD below VBOR (parameter D005) for greater than time TBOR (parameter 35) will reset the device. A Reset may or may not occur if VDD falls below VBOR for less than TBOR. The chip will remain in Brown-out Reset until VDD rises above VBOR.

Once a BOR has occurred, the Power-up Timer will keep the chip in Reset for TPWRT (parameter 33). If VDD drops below VBOR while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be initialized. Once VDD rises above VBOR, the Power-up Timer will execute the additional time delay.

FIGURE 4-2: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



- Note 1: External Power-on Reset circuit is required only if the VDD power-up slope is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.
 - 2: $R < 40 \text{ k}\Omega$ is recommended to make sure that the voltage drop across R does not violate the device's electrical specification.
 - 3: $R1 \ge 1$ k Ω will limit any current flowing into \overline{MCLR} from external capacitor C, in the event of \overline{MCLR}/VPP pin breakdown, due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

4.4.1 DETECTING BOR

The BOR bit always resets to '0' on any BOR or POR event. This makes it difficult to determine if a BOR event has occurred just by reading the state of BOR alone. A more reliable method is to simultaneously check the state of both POR and BOR. This assumes that the POR bit is reset to '1' in software immediately after any POR event. If BOR is '0' while POR is '1', it can be reliably assumed that a BOR event has occurred.

If the voltage regulator is disabled, Brown-out Reset functionality is disabled. In this case, the \overline{BOR} bit cannot be used to determine a BOR event. The \overline{BOR} bit is still cleared by a POR event.

4.5 Power-up Timer (PWRT)

PIC18F87J10 family devices incorporate an on-chip Power-up Timer (PWRT) to help regulate the Power-on Reset process. The PWRT is always enabled. The main function is to ensure that the device voltage is stable before code is executed.

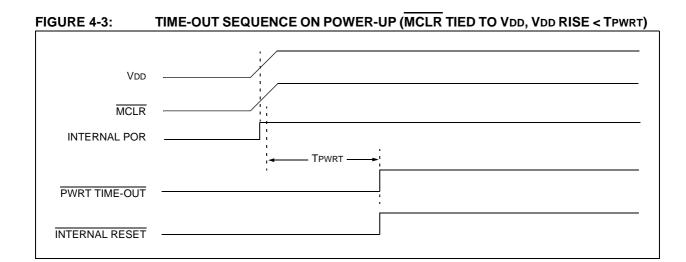
The Power-up Timer (PWRT) of the PIC18F87J10 family devices is an 11-bit counter which uses the INTRC source as the clock input. This yields an approximate time interval of 2048 x 32 μ s = 65.6 ms. While the PWRT is counting, the device is held in Reset.

The power-up time delay depends on the INTRC clock and will vary from chip to chip due to temperature and process variation. See DC parameter 33 for details.

4.5.1 TIME-OUT SEQUENCE

If enabled, the PWRT time-out is invoked after the POR pulse has cleared. The total time-out will vary based on the status of the PWRT. Figure 4-3, Figure 4-4, Figure 4-5 and Figure 4-6 all depict time-out sequences on power-up with the Power-up Timer enabled.

Since the time-outs occur from the POR pulse, if MCLR is kept low long enough, the PWRT will expire. Bringing MCLR high will begin execution immediately (Figure 4-5). This is useful for testing purposes, or to synchronize more than one PIC18FXXXX device operating in parallel.



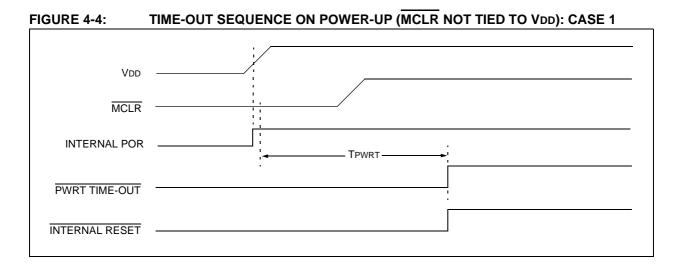


FIGURE 4-5: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2

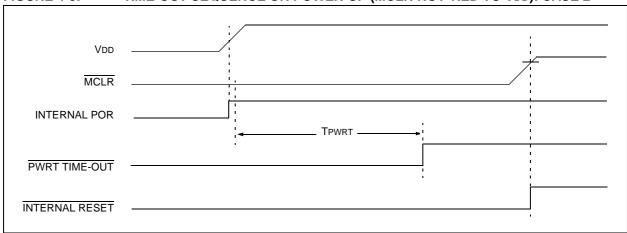
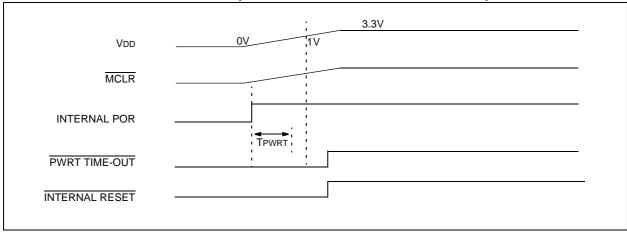


FIGURE 4-6: SLOW RISE TIME (MCLR TIED TO VDD, VDD RISE > TPWRT)



4.6 Reset State of Registers

Most registers are unaffected by a Reset. Their status is unknown on POR and unchanged by all other Resets. The other registers are forced to a "Reset state" depending on the type of Reset that occurred.

Most registers are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation. Status bits from the RCON register, \overline{RI} , \overline{TO} , \overline{PD} , \overline{POR} and \overline{BOR} , are set or cleared differently in different Reset situations, as indicated in Table 4-1. These bits are used in software to determine the nature of the Reset.

Table 4-2 describes the Reset states for all of the Special Function Registers. These are categorized by Power-on and Brown-out Resets, Master Clear and WDT Resets and WDT wake-ups.

TABLE 4-1: STATUS BITS, THEIR SIGNIFICANCE AND THE INITIALIZATION CONDITION FOR RCON REGISTER

Condition	Program		RCON Register				STKPTR Register	
Condition	Counter ⁽¹⁾	RI	TO	PD	POR	BOR	STKFUL	STKUNF
Power-on Reset	0000h	1	1	1	0	0	0	0
RESET Instruction	0000h	0	u	u	u	u	u	u
Brown-out	0000h	1	1	1	u	0	u	u
MCLR during power-managed Run modes	0000h	u	1	u	u	u	u	u
MCLR during power-managed Idle modes and Sleep mode	0000h	u	1	0	u	u	u	u
WDT Time-out during Full Power or power-managed Run modes	0000h	u	0	u	u	u	u	u
MCLR during Full Power Execution	0000h	u	u	u	u	u	u	u
Stack Full Reset (STVREN = 1)	0000h	u	u	u	u	u	1	u
Stack Underflow Reset (STVREN = 1)	0000h	u	u	u	u	u	u	1
Stack Underflow Error (not an actual Reset, STVREN = 0)	0000h	u	u	u	u	u	u	1
WDT Time-out during power-managed Idle or Sleep modes	PC + 2	u	0	0	u	u	u	u
Interrupt Exit from power-managed modes	PC + 2	u	u	0	u	u	u	u

Legend: u = unchanged

Note 1: When the wake-up is due to an interrupt and the GIEH or GIEL bits are set, the PC is loaded with the interrupt vector (0008h or 0018h).

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS

Register	Applicable Devices	Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
TOSU	PIC18F6XJ1X PIC18F8XJ1X	0 0000	0 0000	0 uuuu (1)
TOSH	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu(1)
TOSL	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu ⁽¹⁾
STKPTR	PIC18F6XJ1X PIC18F8XJ1X	00-0 0000	uu-0 0000	uu-u uuuu(1)
PCLATU	PIC18F6XJ1X PIC18F8XJ1X	0 0000	0 0000	u uuuu
PCLATH	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
PCL	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	PC + 2 ⁽²⁾
TBLPTRU	PIC18F6XJ1X PIC18F8XJ1X	00 0000	00 0000	uu uuuu
TBLPTRH	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
TBLPTRL	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
TABLAT	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
PRODH	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
PRODL	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
INTCON	PIC18F6XJ1X PIC18F8XJ1X	0000 000x	0000 000u	uuuu uuuu ⁽³⁾
INTCON2	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	uuuu uuuu ⁽³⁾
INTCON3	PIC18F6XJ1X PIC18F8XJ1X	1100 0000	1100 0000	uuuu uuuu ⁽³⁾
INDF0	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
POSTINC0	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
POSTDEC0	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
PREINC0	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
PLUSW0	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
FSR0H	PIC18F6XJ1X PIC18F8XJ1X	xxxx	uuuu	uuuu
FSR0L	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
WREG	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF1	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
POSTINC1	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
POSTDEC1	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
PREINC1	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
PLUSW1	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
FSR1H	PIC18F6XJ1X PIC18F8XJ1X	xxxx	uuuu	uuuu
FSR1L	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
BSR	PIC18F6XJ1X PIC18F8XJ1X	0000	0000	uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

- 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- 4: See Table 4-1 for Reset value for specific condition.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices	Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
INDF2	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
POSTINC2	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
POSTDEC2	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
PREINC2	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
PLUSW2	PIC18F6XJ1X PIC18F8XJ1X	N/A	N/A	N/A
FSR2H	PIC18F6XJ1X PIC18F8XJ1X	xxxx	uuuu	uuuu
FSR2L	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
STATUS	PIC18F6XJ1X PIC18F8XJ1X	x xxxx	u uuuu	u uuuu
TMR0H	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
TMR0L	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
T0CON	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	uuuu uuuu
OSCCON	PIC18F6XJ1X PIC18F8XJ1X	0 q-00	0 d-00	u q-uu
WDTCON	PIC18F6XJ1X PIC18F8XJ1X	0	0	u
RCON ⁽⁴⁾	PIC18F6XJ1X PIC18F8XJ1X	01 1100	0q qquu	uu qquu
TMR1H	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR1L	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
T1CON	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	u0uu uuuu	uuuu uuuu
TMR2	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
PR2	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	1111 1111
T2CON	PIC18F6XJ1X PIC18F8XJ1X	-000 0000	-000 0000	-uuu uuuu
SSP1BUF	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
SSP1ADD	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
SSP1STAT	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
SSP1CON1	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
SSP1CON2	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
ADRESH	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADRESL	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADCON0	PIC18F6XJ1X PIC18F8XJ1X	0-00 0000	0-00 0000	u-uu uuuu
ADCON1	PIC18F6XJ1X PIC18F8XJ1X	00 0000	00 0000	uu uuuu
ADCON2	PIC18F6XJ1X PIC18F8XJ1X	0-00 0000	0-00 0000	u-uu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

- 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
- 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
- 4: See Table 4-1 for Reset value for specific condition.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices	Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
CCPR1H	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1L	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
CCPR2H	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR2L	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP2CON	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
CCPR3H	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR3L	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP3CON	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
ECCP1AS	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
CVRCON	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
CMCON	PIC18F6XJ1X PIC18F8XJ1X	0000 0111	0000 0111	uuuu uuuu
TMR3H	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR3L	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
T3CON	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	uuuu uuuu	uuuu uuuu
PSPCON	PIC18F6XJ1X PIC18F8XJ1X	0000	0000	uuuu
SPBRG1	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
RCREG1	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
TXREG1	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
TXSTA1	PIC18F6XJ1X PIC18F8XJ1X	0000 0010	0000 0010	uuuu uuuu
RCSTA1	PIC18F6XJ1X PIC18F8XJ1X	0000 000x	0000 000x	uuuu uuuu
IPR3	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	uuuu uuuu
PIR3	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu ⁽³⁾
PIE3	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
IPR2	PIC18F6XJ1X PIC18F8XJ1X	11 1-11	11 1-11	uu u-uu
PIR2	PIC18F6XJ1X PIC18F8XJ1X	00 0-00	00 0-00	uu u-uu ⁽³⁾
PIE2	PIC18F6XJ1X PIC18F8XJ1X	00 0-00	00 0-00	uu u-uu
IPR1	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	uuuu uuuu
PIR1	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu ⁽³⁾
PIE1	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
MEMCON	PIC18F6XJ1X PIC18F8XJ1X	0-0000	0-0000	u-uuuu
OSCTUNE	PIC18F6XJ1X PIC18F8XJ1X	-0	-0	-u

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

- **Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
 - 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - 4: See Table 4-1 for Reset value for specific condition.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices	Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
TRISJ	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	uuuu uuuu
TRISH	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	uuuu uuuu
TRISG	PIC18F6XJ1X PIC18F8XJ1X	1 1111	1 1111	u uuuu
TRISF	PIC18F6XJ1X PIC18F8XJ1X	1111 111-	1111 111-	uuuu uuu-
TRISE	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	uuuu uuuu
TRISD	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	uuuu uuuu
TRISC	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	uuuu uuuu
TRISB	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	uuuu uuuu
TRISA	PIC18F6XJ1X PIC18F8XJ1X	11 1111	11 1111	uu uuuu
LATJ	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATH	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATG	PIC18F6XJ1X PIC18F8XJ1X	x xxxx	u uuuu	u uuuu
LATF	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxx-	uuuu uuu-	uuuu uuu-
LATE	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATD	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATC	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATB	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATA	PIC18F6XJ1X PIC18F8XJ1X	xx xxxx	uu uuuu	uu uuuu
PORTJ	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTH	PIC18F6XJ1X PIC18F8XJ1X	0000 xxxx	uuuu uuuu	uuuu uuuu
PORTG	PIC18F6XJ1X PIC18F8XJ1X	111x xxxx	111u uuuu	uuuu uuuu
PORTF	PIC18F6XJ1X PIC18F8XJ1X	x000 000-	x000 000-	uuuu uuu-
PORTE	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTD	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTC	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTB	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTA	PIC18F6XJ1X PIC18F8XJ1X	0x 0000	0u 0000	uu uuuu
SPBRGH1	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
BAUDCON1	PIC18F6XJ1X PIC18F8XJ1X		01-0 0-00	uu-u u-uu
SPBRG2	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
BAUDCON2	PIC18F6XJ1X PIC18F8XJ1X	01-0 0-00	01-0 0-00	uu-u u-uu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

- **Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
 - 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - 4: See Table 4-1 for Reset value for specific condition.

TABLE 4-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices	Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
ECCP1DEL	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
TMR4	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
PR4	PIC18F6XJ1X PIC18F8XJ1X	1111 1111	1111 1111	1111 1111
T4CON	PIC18F6XJ1X PIC18F8XJ1X	-000 0000	-000 0000	-uuu uuuu
CCPR4H	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR4L	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP4CON	PIC18F6XJ1X PIC18F8XJ1X	00 0000	00 0000	uu uuuu
CCPR5H	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR5L	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP5CON	PIC18F6XJ1X PIC18F8XJ1X	00 0000	00 0000	uu uuuu
SPBRG2	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
RCREG2	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
TXREG2	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
TXSTA2	PIC18F6XJ1X PIC18F8XJ1X	0000 0010	0000 0010	uuuu uuuu
RCSTA2	PIC18F6XJ1X PIC18F8XJ1X	0000 000x	0000 000x	uuuu uuuu
ECCP3AS	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
ECCP3DEL	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
ECCP2AS	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
ECCP2DEL	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
SSP2BUF	PIC18F6XJ1X PIC18F8XJ1X	xxxx xxxx	uuuu uuuu	uuuu uuuu
SSP2ADD	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
SSP2STAT	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
SSP2CON1	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu
SSP2CON2	PIC18F6XJ1X PIC18F8XJ1X	0000 0000	0000 0000	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', <math>q = value depends on condition. Shaded cells indicate conditions do not apply for the designated device.

- **Note 1:** When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.
 - 2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).
 - 3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).
 - 4: See Table 4-1 for Reset value for specific condition.

NOTES:

5.0 MEMORY ORGANIZATION

There are two types of memory in PIC18 Flash microcontroller devices:

- · Program Memory
- Data RAM

As Harvard architecture devices, the data and program memories use separate busses; this allows for concurrent access of the two memory spaces.

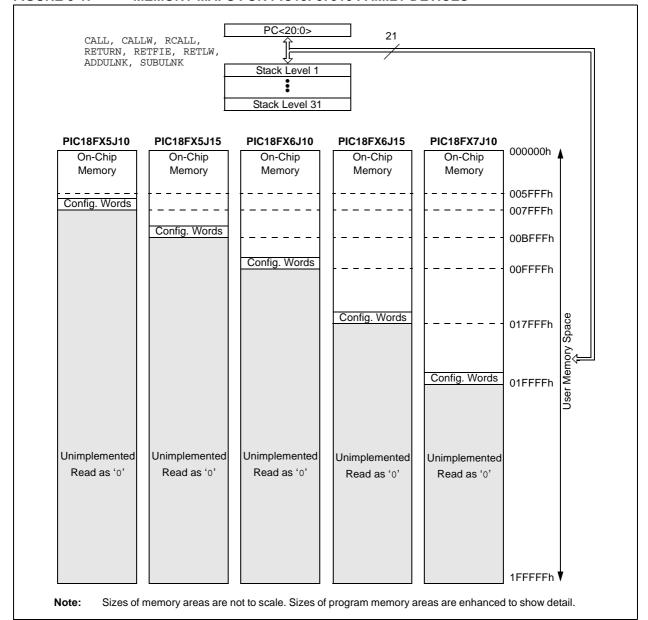
Additional detailed information on the operation of the Flash program memory is provided in **Section 6.0** "**Program Memory**".

5.1 Program Memory Organization

PIC18 microcontrollers implement a 21-bit program counter which is capable of addressing a 2-Mbyte program memory space. Accessing a location between the upper boundary of the physically implemented memory and the 2-Mbyte address will return all '0's (a NOP instruction).

The entire PIC18F87J10 family offers a range of on-chip Flash program memory sizes, from 32 Kbytes (up to 16,384 single-word instructions) to 128 Kbytes (65,536 single-word instructions). The program memory maps for individual family members are shown in Figure 5-3.

FIGURE 5-1: MEMORY MAPS FOR PIC18F87J10 FAMILY DEVICES



5.1.1 HARD MEMORY VECTORS

All PIC18 devices have a total of three hard-coded return vectors in their program memory space. The Reset vector address is the default value to which the program counter returns on all device Resets; it is located at 0000h.

PIC18 devices also have two interrupt vector addresses for the handling of high priority and low priority interrupts. The high priority interrupt vector is located at 0008h and the low priority interrupt vector is at 0018h. Their locations in relation to the program memory map are shown in Figure 5-2.

FIGURE 5-2:

HARD VECTOR AND CONFIGURATION WORD LOCATIONS FOR PIC18F87J10 FAMILY DEVICES

DEVICE	.5
Donat Vastar	00006
Reset Vector	0000h
High Priority Interrupt Vector	0008h
Low Priority Interrupt Vector	0018h
On-Chip Program Memory	
<u> </u>	(Top of Momory 7)
Flash Configuration Words	(Top of Memory-7) (Top of Memory)
Read '0'	
ricad o	
	1FFFFFh
egend: (Top of Memory) repre	esents upper boundary

of on-chip program memory space (see Figure 5-1 for device-specific values). Shaded area represents unimplemented memory. Areas are not shown to scale.

5.1.2 FLASH CONFIGURATION WORDS

Because the PIC18F87J10 family devices do not have persistent configuration memory, the top four words of on-chip program memory are reserved for configuration information. On Reset, the configuration information is copied into the Configuration registers.

The Configuration Words are stored in their program memory location in numerical order, starting with the lower byte of CONFIG1 at the lowest address and ending with the upper byte of CONFIG4. For these devices, only Configuration Words, CONFIG1 through CONFIG3, are used; CONFIG4 is reserved. The actual addresses of the Flash Configuration Word for devices in the PIC18F87J10 family are shown in Table 5-1. Their location in the memory map is shown with the other memory vectors in Figure 5-2.

Additional details on the device Configuration Words are provided in **Section 23.1 "Configuration Bits"**.

TABLE 5-1: FLASH CONFIGURATION WORD FOR PIC18F87J10 FAMILY DEVICES

Device	Program Device Memory (Kbytes)		
PIC18F65J10	32	7FF8h to 7FFFh	
PIC18F85J10	32	777011 (0 777711	
PIC18F65J15	- 48	BFF8h to BFFFh	
PIC18F85J15		BIT OIL TO BITTII	
PIC18F66J10	64	FFF8h to FFFFh	
PIC18F86J10	04	FFF6II to FFFFII	
PIC18F66J15	96	17FF8h to to	
PIC18F86J15	90	17FFFh	
PIC18F67J10	128	1FFF8h to to	
PIC18F87J10	120	1FFFFh	

5.1.3 PIC18F8XJ10/8XJ15 PROGRAM MEMORY MODES

The 80-pin devices in this family can address up to a total of 2 Mbytes of program memory. This is achieved through the external memory bus. There are two distinct operating modes available to the controllers:

- Microcontroller (MC)
- Extended Microcontroller (EMC)

The program memory mode is determined by setting the EMB configuration bits (CONFIG3L<5:4>), as shown in Register 5-1. (See also **Section 23.1** "**Configuration Bits**" for additional details on the device configuration bits.)

The program memory modes operate as follows:

 The Microcontroller Mode accesses only on-chip Flash memory. Attempts to read above the top of on-chip memory causes a read of all '0's (a NOP instruction).

The Microcontroller mode is also the only operating mode available to 64-pin devices.

 The Extended Microcontroller Mode allows access to both internal and external program memories as a single block. The device can access its entire on-chip program memory; above this, the device accesses external program memory up to the 2-Mbyte program space limit. Execution automatically switches between the two memories as required.

The setting of the EMB configuration bits also controls the address bus width of the external memory bus. This is covered in more detail in **Section 7.0 "External Memory Bus"**.

In all modes, the microcontroller has complete access to data RAM.

Figure 5-3 compares the memory maps of the different program memory modes. The differences between on-chip and external memory access limitations are more fully explained in Table 5-2.

REGISTER 5-1: CONFIG3L: CONFIGURATION REGISTER 3 LOW

R/WO-1	R/WO-1	R/WO-0	R/WO-0	R/WO-0	U-0	U-0	U-0
WAIT	BW	EMB1	EMB0	EASHFT	_	_	_
bit 7							bit 0

bit 7 WAIT: External Bus Wait Enable bit

1 = Wait states on the external bus are disabled

0 = Wait states on the external bus are enabled and selected by MEMCON<5:4>

bit 6 BW: Data Bus Width Select bit

1 = 16-Bit Data Width modes

0 = 8-Bit Data Width modes

bit 5-4 **EMB1:EMB0:** External Memory Bus Configuration bits

11 = Extended Microcontroller mode, 20-bit address width for external bus

10 = Extended Microcontroller mode, 16-bit address width for external bus

01 = Extended Microcontroller mode, 12-bit address width for external bus

00 = Microcontroller mode, external bus disabled

bit 3 **EASHFT:** External Address Bus Shift Enable bit

1 = Address shifting enabled – external address bus is shifted to start at 000000h

0 = Address shifting disabled - external address bus reflects the PC value

bit 2-0 Unimplemented: Read as '0'

Legend:

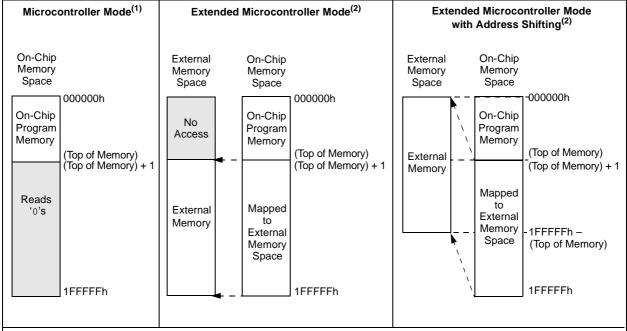
R = Readable bit WO = Write-Once bit U = Unimplemented bit, read as '0'
-n = Value after erase '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

5.1.4 EXTENDED MICROCONTROLLER MODE AND ADDRESS SHIFTING

By default, devices in Extended Microcontroller mode directly present the program counter value on the external address bus for those addresses in the range of the external memory space. In practical terms, this means addresses in the external memory device below the top of on-chip memory are unavailable.

To avoid this, the Extended Microcontroller mode implements an address shifting option to enable automatic address translation. In this mode, addresses presented on the external bus are shifted down by the size of the on-chip program memory and are remapped to start at 0000h. This allows the complete use of the external memory device's memory space.

FIGURE 5-3: MEMORY MAPS FOR PIC18F87J10 FAMILY PROGRAM MEMORY MODES



Legend: (Top of Memory) represents upper boundary of on-chip program memory space (see Figure 5-1 for device-specific values). Shaded areas represent unimplemented or inaccessible areas, depending on the mode.

Note 1: This mode is the only available mode on 64-pin devices and the default on 80-pin devices.

2: These modes are only available on 80-pin devices.

TABLE 5-2: MEMORY ACCESS FOR PIC18F8XJ10/8XJ15 PROGRAM MEMORY MODES

	Intern	al Program Me	emory	External Program Memory			
Operating Mode	Execution From	Table Read From	Table Write To	Execution From	Table Read From	Table Write To	
Microcontroller	Yes	Yes	No	No Access	No Access	No Access	
Extended Microcontroller	Yes	Yes	No	Yes	Yes	Yes	

5.1.5 PROGRAM COUNTER

The Program Counter (PC) specifies the address of the instruction to fetch for execution. The PC is 21 bits wide and is contained in three separate 8-bit registers. The low byte, known as the PCL register, is both readable and writable. The high byte, or PCH register, contains the PC<15:8> bits; it is not directly readable or writable. Updates to the PCH register are performed through the PCLATH register. The upper byte is called PCU. This register contains the PC<20:16> bits; it is also not directly readable or writable. Updates to the PCU register are performed through the PCLATU register.

The contents of PCLATH and PCLATU are transferred to the program counter by any operation that writes PCL. Similarly, the upper two bytes of the program counter are transferred to PCLATH and PCLATU by an operation that reads PCL. This is useful for computed offsets to the PC (see **Section 5.1.8.1 "Computed GOTO"**).

The PC addresses bytes in the program memory. To prevent the PC from becoming misaligned with word instructions, the Least Significant bit of PCL is fixed to a value of '0'. The PC increments by 2 to address sequential instructions in the program memory.

The CALL, RCALL, GOTO and program branch instructions write to the program counter directly. For these instructions, the contents of PCLATH and PCLATU are not transferred to the program counter.

5.1.6 RETURN ADDRESS STACK

The return address stack allows any combination of up to 31 program calls and interrupts to occur. The PC is pushed onto the stack when a CALL or RCALL instruction is executed, or an interrupt is Acknowledged. The PC value is pulled off the stack on a RETURN, RETLW or a RETFIE instruction (and on ADDULNK and SUBULNK instructions if the extended instruction set is enabled). PCLATU and PCLATH are not affected by any of the RETURN or CALL instructions.

The stack operates as a 31-word by 21-bit RAM and a 5-bit Stack Pointer, STKPTR. The stack space is not part of either program or data space. The Stack Pointer is readable and writable and the address on the top of the stack is readable and writable through the Top-of-Stack Special File Registers. Data can also be pushed to, or popped from the stack, using these registers.

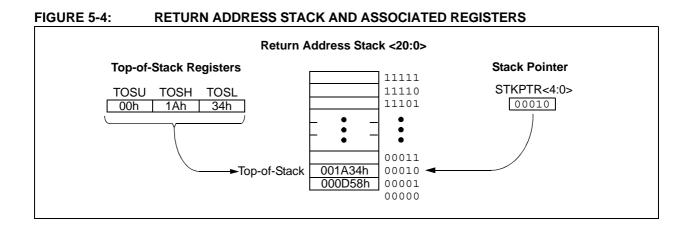
A CALL type instruction causes a push onto the stack; the Stack Pointer is first incremented and the location pointed to by the Stack Pointer is written with the contents of the PC (already pointing to the instruction following the CALL). A RETURN type instruction causes a pop from the stack; the contents of the location pointed to by the STKPTR are transferred to the PC and then the Stack Pointer is decremented.

The Stack Pointer is initialized to '00000' after all Resets. There is no RAM associated with the location corresponding to a Stack Pointer value of '00000'; this is only a Reset value. Status bits indicate if the stack is full or has overflowed, or has underflowed.

5.1.6.1 Top-of-Stack Access

Only the top of the return address stack (TOS) is readable and writable. A set of three registers, TOSU:TOSH:TOSL, hold the contents of the stack location pointed to by the STKPTR register (Figure 5-4). This allows users to implement a software stack if necessary. After a CALL, RCALL or interrupt (and ADDULNK and SUBULNK instructions if the extended instruction set is enabled), the software can read the pushed value by reading TOSU:TOSH:TOSL registers. These values can be placed on a user-defined software stack. At return time, software can return these values to TOSU:TOSH:TOSL and do a return.

The user must disable the global interrupt enable bits while accessing the stack to prevent inadvertent stack corruption.



5.1.6.2 Return Stack Pointer (STKPTR)

The STKPTR register (Register 5-2) contains the Stack Pointer value, the STKFUL (Stack Full) status bit and the STKUNF (Stack Underflow) status bits. The value of the Stack Pointer can be 0 through 31. The Stack Pointer increments before values are pushed onto the stack and decrements after values are popped off the stack. On Reset, the Stack Pointer value will be zero. The user may read and write the Stack Pointer value. This feature can be used by a Real-Time Operating System (RTOS) for return stack maintenance.

After the PC is pushed onto the stack 31 times (without popping any values off the stack), the STKFUL bit is set. The STKFUL bit is cleared by software or by a POR.

The action that takes place when the stack becomes full depends on the state of the STVREN (Stack Overflow Reset Enable) configuration bit. (Refer to Section 23.1 "Configuration Bits" for a description of the device configuration bits.) If STVREN is set (default), the 31st push will push the (PC + 2) value onto the stack, set the STKFUL bit and reset the device. The STKFUL bit will remain set and the Stack Pointer will be set to zero.

If STVREN is cleared, the STKFUL bit will be set on the 31st push and the Stack Pointer will increment to 31. Any additional pushes will not overwrite the 31st push and STKPTR will remain at 31.

When the stack has been popped enough times to unload the stack, the next pop will return a value of zero to the PC and sets the STKUNF bit, while the Stack Pointer remains at zero. The STKUNF bit will remain set until cleared by software or until a POR occurs.

Note: Returning a value of zero to the PC on an underflow has the effect of vectoring the program to the Reset vector, where the stack conditions can be verified and appropriate actions can be taken. This is not the same as a Reset, as the contents of the SFRs are not affected.

5.1.6.3 PUSH and POP Instructions

Since the Top-of-Stack is readable and writable, the ability to push values onto the stack and pull values off the stack, without disturbing normal program execution, is a desirable feature. The PIC18 instruction set includes two instructions, PUSH and POP, that permit the TOS to be manipulated under software control. TOSU, TOSH and TOSL can be modified to place data or a return address on the stack.

The PUSH instruction places the current PC value onto the stack. This increments the Stack Pointer and loads the current PC value onto the stack.

The POP instruction discards the current TOS by decrementing the Stack Pointer. The previous value pushed onto the stack then becomes the TOS value.

REGISTER 5-2: STKPTR: STACK POINTER REGISTER

R/C-0	R/C-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
STKFUL ⁽¹⁾	STKUNF ⁽¹⁾	_	SP4	SP3	SP2	SP1	SP0	Ī
bit 7							bit 0	-

bit 7 **STKFUL:** Stack Full Flag bit⁽¹⁾

1 = Stack became full or overflowed

0 = Stack has not become full or overflowed

bit 6 STKUNF: Stack Underflow Flag bit⁽¹⁾

1 = Stack underflow occurred

0 = Stack underflow did not occur

bit 5 Unimplemented: Read as '0'

bit 4-0 **SP4:SP0:** Stack Pointer Location bits

Note 1: Bit 7 and bit 6 are cleared by user software or by a POR.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	C = Clearable only bit
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

5.1.6.4 Stack Full and Underflow Resets

Device Resets on stack overflow and stack underflow conditions are enabled by setting the STVREN bit in Configuration Register 4L. When STVREN is set, a full or underflow will set the appropriate STKFUL or STKUNF bit and then cause a device Reset. When STVREN is cleared, a full or underflow condition will set the appropriate STKFUL or STKUNF bit, but not cause a device Reset. The STKFUL or STKUNF bits are cleared by the user software or a Power-on Reset.

5.1.7 FAST REGISTER STACK

A Fast Register Stack is provided for the STATUS, WREG and BSR registers, to provide a "fast return" option for interrupts. This stack is only one level deep and is neither readable nor writable. It is loaded with the current value of the corresponding register when the processor vectors for an interrupt. All interrupt sources will push values into the stack registers. The values in the registers are then loaded back into the working registers if the RETFIE, FAST instruction is used to return from the interrupt.

If both low and high priority interrupts are enabled, the stack registers cannot be used reliably to return from low priority interrupts. If a high priority interrupt occurs while servicing a low priority interrupt, the stack register values stored by the low priority interrupt will be overwritten. In these cases, users must save the key registers in software during a low priority interrupt.

If interrupt priority is not used, all interrupts may use the fast register stack for returns from interrupt. If no interrupts are used, the Fast Register Stack can be used to restore the STATUS, WREG and BSR registers at the end of a subroutine call. To use the Fast Register Stack for a subroutine call, a CALL label, FAST instruction must be executed to save the STATUS, WREG and BSR registers to the Fast Register Stack. A RETURN, FAST instruction is then executed to restore these registers from the Fast Register Stack.

Example 5-1 shows a source code example that uses the Fast Register Stack during a subroutine call and return.

EXAMPLE 5-1: FAST REGISTER STACK CODE EXAMPLE

CALL SUB1, FAST	;STATUS, WREG, BSR ;SAVED IN FAST REGISTER ;STACK
SUB1 •	
RETURN FAST	;RESTORE VALUES SAVED ;IN FAST REGISTER STACK

5.1.8 LOOK-UP TABLES IN PROGRAM MEMORY

There may be programming situations that require the creation of data structures, or look-up tables, in program memory. For PIC18 devices, look-up tables can be implemented in two ways:

- Computed GOTO
- Table Reads

5.1.8.1 Computed GOTO

A computed GOTO is accomplished by adding an offset to the program counter. An example is shown in Example 5-2.

A look-up table can be formed with an ADDWF PCL instruction and a group of RETLW $\,\mathrm{nn}$ instructions. The W register is loaded with an offset into the table before executing a call to that table. The first instruction of the called routine is the ADDWF PCL instruction. The next instruction executed will be one of the RETLW $\,\mathrm{nn}$ instructions, that returns the value ' $\,\mathrm{nn}$ ' to the calling function.

The offset value (in WREG) specifies the number of bytes that the program counter should advance and should be multiples of 2 (LSb = 0).

In this method, only one data byte may be stored in each instruction location and room on the return address stack is required.

EXAMPLE 5-2: COMPUTED GOTO USING AN OFFSET VALUE

	MOVF	OFFSET,	W
	CALL	TABLE	
ORG	nn00h		
TABLE	ADDWF	PCL	
	RETLW	nnh	
	RETLW	nnh	
	RETLW	nnh	
	•		
	•		

5.1.8.2 Table Reads

A better method of storing data in program memory allows two bytes of data to be stored in each instruction location.

Look-up table data may be stored two bytes per program word while programming. The Table Pointer (TBLPTR) specifies the byte address and the Table Latch (TABLAT) contains the data that is read from the program memory. Data is transferred from program memory one byte at a time.

Table read operation is discussed further in Section 6.1 "Table Reads and Table Writes".

5.2 PIC18 Instruction Cycle

5.2.1 CLOCKING SCHEME

The microcontroller clock input, whether from an internal or external source, is internally divided by four to generate four non-overlapping quadrature clocks (Q1, Q2, Q3 and Q4). Internally, the program counter is incremented on every Q1; the instruction is fetched from the program memory and latched into the instruction register during Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow are shown in Figure 5-5.

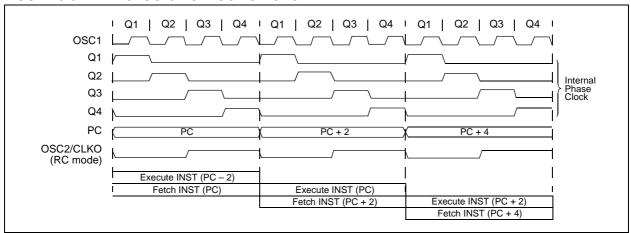
5.2.2 INSTRUCTION FLOW/PIPELINING

An "Instruction Cycle" consists of four Q cycles, Q1 through Q4. The instruction fetch and execute are pipelined in such a manner that a fetch takes one instruction cycle, while the decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g., GOTO), then two cycles are required to complete the instruction (Example 5-3).

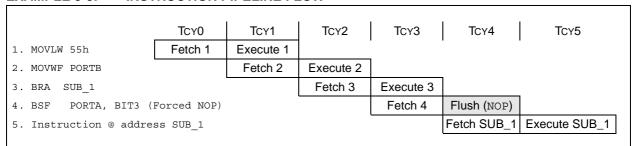
A fetch cycle begins with the Program Counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the Instruction Register (IR) in cycle Q1. This instruction is then decoded and executed during the Q2, Q3 and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).





EXAMPLE 5-3: INSTRUCTION PIPELINE FLOW



All instructions are single cycle, except for any program branches. These take two cycles since the fetch instruction is "flushed" from the pipeline while the new instruction is being fetched and then executed.

5.2.3 INSTRUCTIONS IN PROGRAM MEMORY

The program memory is addressed in bytes. Instructions are stored as two bytes or four bytes in program memory. The Least Significant Byte of an instruction word is always stored in a program memory location with an even address (LSB = 0). To maintain alignment with instruction boundaries, the PC increments in steps of 2 and the LSB will always read '0' (see **Section 5.1.5** "**Program Counter**").

Figure 5-6 shows an example of how instruction words are stored in the program memory.

The CALL and GOTO instructions have the absolute program memory address embedded into the instruction. Since instructions are always stored on word boundaries, the data contained in the instruction is a word address. The word address is written to PC<20:1> which accesses the desired byte address in program memory. Instruction #2 in Figure 5-6 shows how the instruction, GOTO 0006h, is encoded in the program memory. Program branch instructions, which encode a relative address offset, operate in the same manner. The offset value stored in a branch instruction represents the number of single-word instructions that the PC will be offset by. Section 24.0 "Instruction Set Summary" provides further details of the instruction set.

FIGURE 5-6: INSTRUCTIONS IN PROGRAM MEMORY

FIGURE 5-6: INST	KUCTIOI	15 IN PRO	ואאוט	N IVILIVION	!	
				LSB = 1	LSB = 0	Word Address ↓
	Program N	•				000000h
	Byte Locat	tions \rightarrow				000002h
						000004h
						000006h
Instruction 1:	MOVLW	055h		0Fh	55h	000008h
Instruction 2:	GOTO	0006h		EFh	03h	00000Ah
				F0h	00h	00000Ch
Instruction 3:	MOVFF	123h, 45	6h	C1h	23h	00000Eh
				F4h	56h	000010h
						000012h
						000014h

5.2.4 TWO-WORD INSTRUCTIONS

The standard PIC18 instruction set has four two-word instructions: CALL, MOVFF, GOTO and LSFR. In all cases, the second word of the instructions always has '1111' as its four Most Significant bits; the other 12 bits are literal data, usually a data memory address.

The use of '1111' in the 4 MSbs of an instruction specifies a special form of NOP. If the instruction is executed in proper sequence – immediately after the first word – the data in the second word is accessed

and used by the instruction sequence. If the first word is skipped for some reason and the second word is executed by itself, a NOP is executed instead. This is necessary for cases when the two-word instruction is preceded by a conditional instruction that changes the PC. Example 5-4 shows how this works.

Note: See Section 5.5 "Program Memory and the Extended Instruction Set" for information on two-word instructions in the extended instruction set.

EXAMPLE 5-4: TWO-WORD INSTRUCTIONS

CASE 1:		
Object Code	Source Code	
0110 0110 0000 0000	TSTFSZ REG1	; is RAM location 0?
1100 0001 0010 0011	MOVFF REG1, REG2	; No, skip this word
1111 0100 0101 0110		; Execute this word as a NOP
0010 0100 0000 0000	ADDWF REG3	; continue code
CASE 2:		
Object Code	Source Code	
0110 0110 0000 0000	TSTFSZ REG1	; is RAM location 0?
1100 0001 0010 0011	MOVFF REG1, REG2	; Yes, execute this word
1111 0100 0101 0110		; 2nd word of instruction
0010 0100 0000 0000	ADDWF REG3	; continue code

5.3 Data Memory Organization

Note:

The operation of some aspects of data memory are changed when the PIC18 extended instruction set is enabled. See Section 5.6 "Data Memory and the Extended Instruction Set" for more information.

The data memory in PIC18 devices is implemented as static RAM. Each register in the data memory has a 12-bit address, allowing up to 4096 bytes of data memory. The memory space is divided into as many as 16 banks that contain 256 bytes each. The PIC18FX5J10/X5J15/X6J10 devices, with up to 64 Kbytes of program memory, implement 8 complete banks for a total of 2048 bytes. PIC18FX6J15 and PIC18FX7J10 devices, with 96 or 128 Kbytes of program memory, implement all available banks and provide 3936 bytes of data memory available to the user. Figure 5-7 and Figure 5-8 show the data memory organization for the devices.

The data memory contains Special Function Registers (SFRs) and General Purpose Registers (GPRs). The SFRs are used for control and status of the controller and peripheral functions, while GPRs are used for data storage and scratchpad operations in the user's application. Any read of an unimplemented location will read as '0's.

The instruction set and architecture allow operations across all banks. The entire data memory may be accessed by Direct, Indirect or Indexed Addressing modes. Addressing modes are discussed later in this section.

To ensure that commonly used registers (SFRs and select GPRs) can be accessed in a single cycle, PIC18 devices implement an Access Bank. This is a 256-byte memory space that provides fast access to SFRs and the lower portion of GPR Bank 0 without using the BSR. **Section 5.3.2 "Access Bank"** provides a detailed description of the Access RAM.

5.3.1 BANK SELECT REGISTER

Large areas of data memory require an efficient addressing scheme to make rapid access to any address possible. Ideally, this means that an entire address does not need to be provided for each read or write operation. For PIC18 devices, this is accomplished with a RAM banking scheme. This divides the memory space into 16 contiguous banks of 256 bytes. Depending on the instruction, each location can be addressed directly by its full 12-bit address, or an 8-bit low-order address and a 4-bit bank pointer.

Most instructions in the PIC18 instruction set make use of the bank pointer, known as the Bank Select Register (BSR). This SFR holds the 4 Most Significant bits of a location's address; the instruction itself includes the 8 Least Significant bits. Only the four lower bits of the BSR are implemented (BSR3:BSR0). The upper four bits are unused; they will always read '0' and cannot be written to. The BSR can be loaded directly by using the MOVLB instruction.

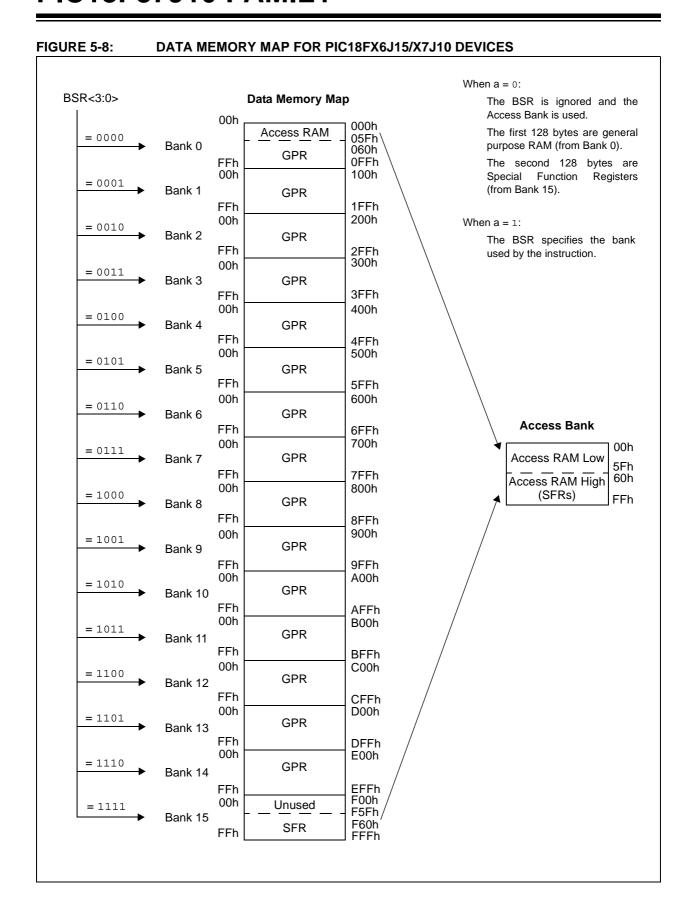
The value of the BSR indicates the bank in data memory; the 8 bits in the instruction show the location in the bank and can be thought of as an offset from the bank's lower boundary. The relationship between the BSR's value and the bank division in data memory is shown in Figure 5-9.

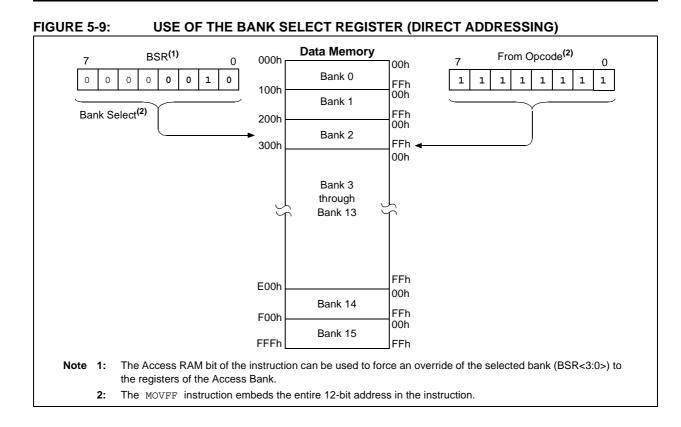
Since up to 16 registers may share the same low-order address, the user must always be careful to ensure that the proper bank is selected before performing a data read or write. For example, writing what should be program data to an 8-bit address of F9h, while the BSR is 0Fh, will end up resetting the program counter.

While any bank can be selected, only those banks that are actually implemented can be read or written to. Writes to unimplemented banks are ignored, while reads from unimplemented banks will return '0's. Even so, the STATUS register will still be affected as if the operation was successful. The data memory map in Figure 5-7 indicates which banks are implemented.

In the core PIC18 instruction set, only the MOVFF instruction fully specifies the 12-bit address of the source and target registers. This instruction ignores the BSR completely when it executes. All other instructions include only the low-order address as an operand and must use either the BSR or the Access Bank to locate their target registers.

FIGURE 5-7: DATA MEMORY MAP FOR PIC18FX5J10/X5J15/X6J10 DEVICES When a = 0: BSR<3:0> **Data Memory Map** The BSR is ignored and the Access Bank is used. 00h 000h Access RAM The first 128 bytes are general 05Fh = 0000 Bank 0 purpose RAM (from Bank 0). 060h **GPR** FFh 0FFh The second 128 bytes are 00h 100h Special Function Registers = 0001(from Bank 15). Bank 1 **GPR** FFh 1FFh 200h 00h When a = 1: = 0010 Bank 2 **GPR** The BSR specifies the bank FFh 2FFh used by the instruction. 300h 00h = 0011Bank 3 **GPR** FFh 3FFh 00h 400h = 0100 Bank 4 **GPR** FFh 4FFh 00h 500h = 0101 **GPR** Bank 5 FFh 5FFh 00h 600h = 0110 **GPR** Bank 6 FFh 6FFh 00h 700h **Access Bank** = 0111 **GPR** Bank 7 00h FFh 7FFh Access RAM Low 00h 800h 5Fh Access RAM High 60h (SFRs) FFh =1000Bank 8 Unused to Read as '0' = 1110 Bank 14 EFFh F00h FFh 00h = 1111 Unused F5Fh Bank 15 F60h **SFR** FFh





5.3.2 ACCESS BANK

While the use of the BSR with an embedded 8-bit address allows users to address the entire range of data memory, it also means that the user must always ensure that the correct bank is selected. Otherwise, data may be read from or written to the wrong location. This can be disastrous if a GPR is the intended target of an operation, but an SFR is written to instead. Verifying and/or changing the BSR for each read or write to data memory can become very inefficient.

To streamline access for the most commonly used data memory locations, the data memory is configured with an Access Bank, which allows users to access a mapped block of memory without specifying a BSR. The Access Bank consists of the first 96 bytes of memory (00h-5Fh) in Bank 0 and the last 160 bytes of memory (60h-FFh) in Block 15. The lower half is known as the "Access RAM" and is composed of GPRs. This upper half is where the device's SFRs are mapped. These two areas are mapped contiguously in the Access Bank and can be addressed in a linear fashion by an 8-bit address (Figure 5-7).

The Access Bank is used by core PIC18 instructions that include the Access RAM bit (the 'a' parameter in the instruction). When 'a' is equal to '1', the instruction uses the BSR and the 8-bit address included in the opcode for the data memory address. When 'a' is '0', however, the instruction is forced to use the Access Bank address map; the current value of the BSR is ignored entirely.

Using this "forced" addressing allows the instruction to operate on a data address in a single cycle without updating the BSR first. For 8-bit addresses of 80h and above, this means that users can evaluate and operate on SFRs more efficiently. The Access RAM below 60h is a good place for data values that the user might need to access rapidly, such as immediate computational results or common program variables. Access RAM also allows for faster and more code efficient context saving and switching of variables.

The mapping of the Access Bank is slightly different when the extended instruction set is enabled (XINST configuration bit = 1). This is discussed in more detail in Section 5.6.3 "Mapping the Access Bank in Indexed Literal Offset Mode".

5.3.3 GENERAL PURPOSE REGISTER FILE

PIC18 devices may have banked memory in the GPR area. This is data RAM which is available for use by all instructions. GPRs start at the bottom of Bank 0 (address 000h) and grow upwards towards the bottom of the SFR area. GPRs are not initialized by a Power-on Reset and are unchanged on all other Resets

5.3.4 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFRs) are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. SFRs start at the top of data memory (FFFh) and extend downward to occupy more than the top half of Bank 15 (F60h to FFFh). A list of these registers is given in Table 5-3 and Table 5-4.

The SFRs can be classified into two sets: those associated with the "core" device functionality (ALU, Resets and interrupts) and those related to the peripheral functions. The Reset and interrupt registers are described in their respective chapters, while the ALU's STATUS register is described later in this section. Registers related to the operation of the peripheral features are described in the chapter for that peripheral.

The SFRs are typically distributed among the peripherals whose functions they control. Unused SFR locations are unimplemented and read as '0's.

TABLE 5-3: SPECIAL FUNCTION REGISTER MAP FOR PIC18F87J10 FAMILY DEVICES

Address	Name	Address	Name	Address	Name	Address	Name	Address	Name
FFFh	TOSU	FDFh	INDF2 ⁽¹⁾	FBFh	CCPR1H	F9Fh	IPR1	F7Fh	SPBRGH1
FFEh	TOSH	FDEh	POSTINC2 ⁽¹⁾	FBEh	CCPR1L	F9Eh	PIR1	F7Eh	BAUDCON1
FFDh	TOSL	FDDh	POSTDEC2 ⁽¹⁾	FBDh	CCP1CON	F9Dh	PIE1	F7Dh	SPBRGH2
FFCh	STKPTR	FDCh	PREINC2 ⁽¹⁾	FBCh	CCPR2H	F9Ch	MEMCON ⁽³⁾	F7Ch	BAUDCON2
FFBh	PCLATU	FDBh	PLUSW2 ⁽¹⁾	FBBh	CCPR2L	F9Bh	OSCTUNE	F7Bh	(2)
FFAh	PCLATH	FDAh	FSR2H	FBAh	CCP2CON	F9Ah	TRISJ ⁽³⁾	F7Ah	(2)
FF9h	PCL	FD9h	FSR2L	FB9h	CCPR3H	F99h	TRISH ⁽³⁾	F79h	ECCP1DEL
FF8h	TBLPTRU	FD8h	STATUS	FB8h	CCPR3L	F98h	TRISG	F78h	TMR4
FF7h	TBLPTRH	FD7h	TMR0H	FB7h	CCP3CON	F97h	TRISF	F77h	PR4
FF6h	TBLPTRL	FD6h	TMR0L	FB6h	ECCP1AS	F96h	TRISE	F76h	T4CON
FF5h	TABLAT	FD5h	T0CON	FB5h	CVRCON	F95h	TRISD	F75h	CCPR4H
FF4h	PRODH	FD4h	(2)	FB4h	CMCON	F94h	TRISC	F74h	CCPR4L
FF3h	PRODL	FD3h	OSCCON	FB3h	TMR3H	F93h	TRISB	F73h	CCP4CON
FF2h	INTCON	FD2h	(2)	FB2h	TMR3L	F92h	TRISA	F72h	CCPR5H
FF1h	INTCON2	FD1h	WDTCON	FB1h	T3CON	F91h	LATJ ⁽³⁾	F71h	CCPR5L
FF0h	INTCON3	FD0h	RCON	FB0h	PSPCON	F90h	LATH ⁽³⁾	F70h	CCP5CON
FEFh	INDF0 ⁽¹⁾	FCFh	TMR1H	FAFh	SPBRG1	F8Fh	LATG	F6Fh	SPBRG2
FEEh	POSTINCO ⁽¹⁾	FCEh	TMR1L	FAEh	RCREG1	F8Eh	LATF	F6Eh	RCREG2
FEDh	POSTDEC0 ⁽¹⁾	FCDh	T1CON	FADh	TXREG1	F8Dh	LATE	F6Dh	TXREG2
FECh	PREINC0 ⁽¹⁾	FCCh	TMR2	FACh	TXSTA1	F8Ch	LATD	F6Ch	TXSTA2
FEBh	PLUSW0 ⁽¹⁾	FCBh	PR2	FABh	RCSTA1	F8Bh	LATC	F6Bh	RCSTA2
FEAh	FSR0H	FCAh	T2CON	FAAh	(2)	F8Ah	LATB	F6Ah	ECCP3AS
FE9h	FSR0L	FC9h	SSP1BUF	FA9h	(2)	F89h	LATA	F69h	ECCP3DEL
FE8h	WREG	FC8h	SSP1ADD	FA8h	(2)	F88h	PORTJ ⁽³⁾	F68h	ECCP2AS
FE7h	INDF1 ⁽¹⁾	FC7h	SSP1STAT	FA7h	(2)	F87h	PORTH ⁽³⁾	F67h	ECCP2DEL
FE6h	POSTINC1 ⁽¹⁾	FC6h	SSP1CON1	FA6h	(2)	F86h	PORTG	F66h	SSP2BUF
FE5h	POSTDEC1 ⁽¹⁾	FC5h	SSP1CON2	FA5h	IPR3	F85h	PORTF	F65h	SSP2ADD
FE4h	PREINC1 ⁽¹⁾	FC4h	ADRESH	FA4h	PIR3	F84h	PORTE	F64h	SSP2STAT
FE3h	PLUSW1 ⁽¹⁾	FC3h	ADRESL	FA3h	PIE3	F83h	PORTD	F63h	SSP2CON1
FE2h	FSR1H	FC2h	ADCON0	FA2h	IPR2	F82h	PORTC	F62h	SSP2CON2
FE1h	FSR1L	FC1h	ADCON1	FA1h	PIR2	F81h	PORTB	F61h	(2)
FE0h	BSR	FC0h	ADCON2	FA0h	PIE2	F80h	PORTA	F60h	(2)

Note 1: This is not a physical register.

- 2: Unimplemented registers are read as '0'.
- 3: This register is not available on 64-pin devices.

TABLE 5-4: REGISTER FILE SUMMARY (PIC18F87J10 FAMILY)

Filename	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page:
TOSU	_	_	_	Top-of-Stack	Upper Byte (T	0 0000	49, 59			
TOSH	Top-of-Stack High Byte (TOS<15:8>)							0000 0000	49, 59	
TOSL		Low Byte (TO							0000 0000	49, 59
STKPTR	STKFUL	STKUNF	_	Return Stack	Pointer				00-0 0000	49, 60
PCLATU	_	_	bit 21 ⁽¹⁾	Holding Regi	ster for PC<20):16>			0 0000	49, 59
PCLATH	Holding Regi	ster for PC<15							0000 0000	49, 59
PCL	PC Low Byte	(PC<7:0>)							0000 0000	49, 59
TBLPTRU	_	_	bit 21	Program Mei	mory Table Po	inter Upper By	te (TBLPTR<	20:16>)	00 0000	49, 82
TBLPTRH	Program Mer	mory Table Poi	inter High Byte	e (TBLPTR<15	5:8>)			<u> </u>	0000 0000	49, 82
TBLPTRL	Program Mer	mory Table Poi	inter Low Byte	(TBLPTR<7:0	0>)				0000 0000	49, 82
TABLAT	Program Mer	mory Table Lat	ch		<u> </u>				0000 0000	49, 82
PRODH	Product Regi	ster High Byte							xxxx xxxx	49, 97
PRODL	Product Regi	ster Low Byte							xxxx xxxx	49, 97
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INTOIF	RBIF	0000 000x	49, 101
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	1111 1111	49, 102
INTCON3	INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF	1100 0000	49, 103
INDF0		l .					l .		N/A	49, 75
POSTINC0		Uses contents of FSR0 to address data memory – value of FSR0 not changed (not a physical register) Uses contents of FSR0 to address data memory – value of FSR0 post-incremented (not a physical register)							N/A	49, 76
POSTDEC0	Uses contents of FSR0 to address data memory – value of FSR0 post-decremented (not a physical register)							,	N/A	49, 76
PREINC0	Uses contents of FSR0 to address data memory – value of FSR0 pre-incremented (not a physical register)							<u> </u>	N/A	49, 76
PLUSW0		ts of FSR0 to a 0 offset by W	address data n	nemory – valu	e of FSR0 pre	-incremented	(not a physical	l register) –	N/A	49, 76
FSR0H	_	_	_	_	Indirect Data	Memory Addr	ess Pointer 0	High	xxxx	49, 75
FSR0L	Indirect Data	Memory Addr	ess Pointer 0 I	Low Byte					xxxx xxxx	49, 75
WREG	Working Reg	ister							xxxx xxxx	49
INDF1	Uses content	ts of FSR1 to a	address data n	nemory – valu	e of FSR1 not	changed (not	a physical reg	ister)	N/A	49, 75
POSTINC1	Uses content	ts of FSR1 to a	address data n	nemory – valu	e of FSR1 pos	t-incremented	(not a physica	al register)	N/A	49, 76
POSTDEC1	Uses content	ts of FSR1 to a	address data n	nemory – valu	e of FSR1 pos	t-decremente	d (not a physic	al register)	N/A	49, 76
PREINC1	Uses content	ts of FSR1 to a	address data n	nemory – valu	e of FSR1 pre	-incremented	(not a physical	l register)	N/A	49, 76
PLUSW1		ts of FSR1 to a 1 offset by W	address data n	nemory – valu	e of FSR1 pre	-incremented	(not a physical	l register) –	N/A	49, 76
FSR1H	_	_	_	_	Indirect Data	Memory Addr	ess Pointer 1	High Byte	xxxx	49, 75
FSR1L	Indirect Data	Memory Addr	ess Pointer 1 l	Low Byte					xxxx xxxx	49, 75
BSR	_	_	_	_	Bank Select	Register			0000	49, 64
INDF2	Uses content	ts of FSR2 to a	address data n	nemory – valu	e of FSR2 not	changed (not	a physical reg	ister)	N/A	50, 75
POSTINC2	Uses content	ts of FSR2 to a	address data n	nemory – valu	e of FSR2 pos	t-incremented	(not a physica	al register)	N/A	50, 76
POSTDEC2	Uses content	ts of FSR2 to a	address data n	nemory – valu	e of FSR2 pos	t-decremente	d (not a physic	al register)	N/A	50, 76
PREINC2	Uses content	ts of FSR2 to a	address data n	nemory – valu	e of FSR2 pre	-incremented	(not a physical	register)	N/A	50, 76
PLUSW2		ts of FSR2 to a 2 offset by W	address data n	nemory – valu	e of FSR2 pre	-incremented	(not a physical	l register) –	N/A	50, 76
FSR2H	_	_	_	_	Indirect Data	Memory Addr	ess Pointer 2	High Byte	xxxx	50, 75
FSR2L	Indirect Data	Memory Addr	ess Pointer 2 l	Low Byte	-				xxxx xxxx	50, 75
STATUS	_	_	_	N	OV	Z	DC	С	x xxxx	50, 73

Legend:

x = unknown, u = unchanged, - = unimplemented, q = value depends on condition

Note 1: Bit 21 of the PC is only available in Serial Programming modes.

- 2: These bits and/or registers are only available in 80-pin devices; otherwise, they are unimplemented and read as '0'. Reset values are shown for 80-pin devices.
- 3: This register and its bits are not implemented in 64-pin devices. In 80-pin devices, the bits are unwritable and read as '0' in Microcontroller mode.
- 4: The PLLEN bit is available only when either ECPLL or HSPLL Oscillator modes are selected; otherwise, the bit is read as '0'.
- **5:** Reset value is '0' when Two-Speed Start-up is enabled and '1' if disabled.

TABLE 5-4: REGISTER FILE SUMMARY (PIC18F87J10 FAMILY) (CONTINUED)

Filename	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page:
TMR0H	Timer0 Regis	ter High Byte							0000 0000	50, 143
TMR0L	Timer0 Regis	ter Low Byte							xxxx xxxx	50, 143
T0CON	TMR00N	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0	1111 1111	50, 141
OSCCON	IDLEN	I	I	ı	OSTS ⁽⁵⁾	I	SCS1	SCS0	0 q-00	32, 50
WDTCON	_	_	-	_	-	-	_	SWDTEN	0	50, 273
RCON	IPEN	_	-	RI	TO	PD	POR	BOR	01 1100	44, 50, 113
TMR1H	Timer1 Regis	ter High Byte							xxxx xxxx	50, 149
TMR1L	Timer1 Regis	ter Low Byte							xxxx xxxx	50, 149
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	0000 0000	50, 145
TMR2	Timer2 Regis	ter							0000 0000	50, 152
PR2	Timer2 Perio	d Register							1111 1111	50, 152
T2CON	-	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	50, 151
SSP1BUF	MSSP1 Rece	eive Buffer/Tra	nsmit Register	ſ					xxxx xxxx	50, 184, 193
SSP1ADD	MSSP1 Addr	ess Register (l ² C™ Slave m	ode), MSSP1	Baud Rate Re	load Register	(I ² C Master m	iode)	0000 0000	50, 193
SSP1STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000 0000	50, 184, 194
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	50, 185, 195
SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	50, 196
ADRESH	A/D Result R	egister High B	yte						xxxx xxxx	50, 255
ADRESL	A/D Result R	egister Low B	/te	,			1	•	xxxx xxxx	50, 255
ADCON0	ADCAL	_	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON	0-00 0000	50, 247
ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	00 0000	50, 248
ADCON2	ADFM	_	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0	0-00 0000	50, 249
CCPR1H	Capture/Com	pare/PWM Re	egister 1 High	Byte					xxxx xxxx	51, 182
CCPR1L	Capture/Com	pare/PWM Re	egister 1 Low E	Byte					xxxx xxxx	51, 182
CCP1CON	P1M1	P1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	0000 0000	51, 167
CCPR2H	Capture/Com	pare/PWM Re	egister 2 High	Byte					xxxx xxxx	51, 182
CCPR2L	Capture/Com	pare/PWM Re	egister 2 Low E	Byte					xxxx xxxx	51, 182
CCP2CON	P2M1	P2M0	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	0000 0000	51, 167
CCPR3H	Capture/Com	pare/PWM Re	egister 1 High	Byte					xxxx xxxx	51, 182
CCPR3L	Capture/Com	pare/PWM Re	egister 1 Low E	Byte					xxxx xxxx	51, 182
CCP3CON	P3M1	P3M0	DC3B1	DC3B0	CCP3M3	CCP3M2	CCP3M1	CCP3M0	0000 0000	51, 167
ECCP1AS	ECCP1ASE	ECCP1AS2	ECCP1AS1	ECCP1AS0	PSS1AC1	PSS1AC0	PSS1BD1 ⁽²⁾	PSS1BD0 ⁽²⁾	0000 0000	51, 179
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	0000 0000	51, 263
CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	0000 0111	51, 257
TMR3H	Timer3 Regis	ter High Byte							xxxx xxxx	51, 155
TMR3L	Timer3 Regis	ter Low Byte							xxxx xxxx	51, 155
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON	0000 0000	51, 153
PSPCON	IBF	OBF	IBOV	PSPMODE	_	_	_	_	0000	51, 139

 $\textbf{Legend:} \qquad x = \text{unknown, } u = \text{unchanged, } - = \text{unimplemented, } q = \text{value depends on condition}$

Note 1: Bit 21 of the PC is only available in Serial Programming modes.

^{2:} These bits and/or registers are only available in 80-pin devices; otherwise, they are unimplemented and read as '0'. Reset values are shown for 80-pin devices.

^{3:} This register and its bits are not implemented in 64-pin devices. In 80-pin devices, the bits are unwritable and read as '0' in Microcontroller mode.

^{4:} The PLLEN bit is available only when either ECPLL or HSPLL Oscillator modes are selected; otherwise, the bit is read as '0'.

^{5:} Reset value is '0' when Two-Speed Start-up is enabled and '1' if disabled.

TABLE 5-4: REGISTER FILE SUMMARY (PIC18F87J10 FAMILY) (CONTINUED)

Filename	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page:
SPBRG1	EUSART1 Ba	aud Rate Gene	erator Registe	r Low Byte					0000 0000	51, 229
RCREG1	EUSART1 R	eceive Registe	er						0000 0000	51, 237, 238
TXREG1	EUSART1 Tr	ansmit Regist	er						xxxx xxxx	51, 235, 236
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010	51, 226
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	51, 227
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	1111 1111	51, 112
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	0000 0000	51, 106
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	0000 0000	51, 109
IPR2	OSCFIP	CMIP	I	_	BCL1IP	_	TMR3IP	CCP2IP	11 1-11	51, 111
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	TMR3IF	CCP2IF	00 0-00	51, 105
PIE2	OSCFIE	CMIE	_	_	BCL1IE	_	TMR3IE	CCP2IE	00 0-00	51, 108
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	1111 1111	51, 110
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	0000 0000	51, 104
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	0000 0000	51, 107
MEMCON ⁽³⁾	EBDIS	_	WAIT1	WAIT0	_	_	WM1	WM0	0-0000	51, 86
OSCTUNE		PLLEN ⁽⁴⁾	_	_	_	_	_	_	-0	29, 51
TRISJ ⁽²⁾	TRISJ7	TRISJ6	TRISJ5	TRISJ4	TRISJ3	TRISJ2	TRISJ1	TRISJ0	1111 1111	52, 137
TRISH ⁽²⁾	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	1111 1111	52, 135
TRISG				TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	1 1111	52, 133
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	-	1111 111-	52, 131
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	1111 1111	52, 129
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	1111 1111	52, 126
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	1111 1111	52, 123
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111	52, 120
TRISA			TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	11 1111	52, 117
LATJ ⁽²⁾	LATJ7	LATJ6	LATJ5	LATJ4	LATJ3	LATJ2	LATJ1	LATJ0	xxxx xxxx	52, 137
LATH ⁽²⁾	LATH7	LATH6	LATH5	LATH4	LATH3	LATH2	LATH1	LATH0	xxxx xxxx	52, 135
LATG				LATG4	LATG3	LATG2	LATG1	LATG0	x xxxx	52, 133
LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	_	xxxx xxx-	52, 131
LATE	LATE7	LATE6	LATE5	LATE4	LATE3	LATE2	LATE1	LATE0	xxxx xxxx	52, 129
LATD	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0	xxxx xxxx	52, 126
LATC	LATC7	LATC6	LATC5	LATC4	LATC3	LATC2	LATC1	LATC0	xxxx xxxx	52, 123
LATB	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	xxxx xxxx	52, 120
LATA		_	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	xx xxxx	52, 117
PORTJ ⁽²⁾	RJ7	RJ6	RJ5	RJ4	RJ3	RJ2	RJ1	RJ0	xxxx xxxx	52, 137
PORTH ⁽²⁾	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	0000 xxxx	52, 135
PORTG	RDPU	REPU	RJPU ⁽²⁾	RG4	RG3	RG2	RG1	RG0	111x xxxx	52, 133
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	x000 000-	52, 131
PORTE	RE7	RE6	RE5	RE4	RE3	RE2	RE1	RE0	xxxx xxxx	52, 129
PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	xxxx xxxx	52, 126
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	52, 123
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	52, 120
PORTA	_	_	RA5	RA4	RA3	RA2	RA1	RA0	0x 0000	52, 117

Legend:

x = unknown, u = unchanged, - = unimplemented, q = value depends on condition

te 1: Bit 21 of the PC is only available in Serial Programming modes.

^{2:} These bits and/or registers are only available in 80-pin devices; otherwise, they are unimplemented and read as '0'. Reset values are shown for 80-pin devices.

^{3:} This register and its bits are not implemented in 64-pin devices. In 80-pin devices, the bits are unwritable and read as '0' in Microcontroller mode.

^{4:} The PLLEN bit is available only when either ECPLL or HSPLL Oscillator modes are selected; otherwise, the bit is read as '0'.

^{5:} Reset value is '0' when Two-Speed Start-up is enabled and '1' if disabled.

TABLE 5-4: REGISTER FILE SUMMARY (PIC18F87J10 FAMILY) (CONTINUED)

Filename	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page:
SPBRGH1	EUSART1 Ba	aud Rate Gene	erator Registe	r High Byte					0000 0000	52, 229
BAUDCON1	ABDOVF	RCMT	_	SCKP	BRG16	_	WUE	ABDEN	01-0 0-00	52, 228
SPBRGH2	EUSART2 Ba	aud Rate Gene	erator Registe	r High Byte					0000 0000	52, 229
BAUDCON2	ABDOVF	RCMT	_	SCKP	BRG16	_	WUE	ABDEN	01-0 0-00	52, 228
ECCP1DEL	P1RSEN	P1DC6	P1DC5	P1DC4	P1DC3	P1DC2	P1DC1	P1DC0	0000 0000	53, 178
TMR4	Timer4 Regis	ster							0000 0000	53, 158
PR4	Timer4 Perio	d Register							1111 1111	53, 158
T4CON	_	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	-000 0000	53, 157
CCPR4H	Capture/Com	pare/PWM Re	egister 4 High	Byte					xxxx xxxx	53, 160
CCPR4L	Capture/Com	pare/PWM Re	egister 4 Low I	Byte					xxxx xxxx	53, 160
CCP4CON	_	_	DC4B1	DC4B0	CCP4M3	CCP4M2	CCP4M1	CCP4M0	00 0000	53, 159
CCPR5H	Capture/Com	pare/PWM Re	egister 5 High	Byte				•	xxxx xxxx	53, 160
CCPR5L	Capture/Com	pare/PWM Re	egister 5 Low I	Byte					xxxx xxxx	53, 160
CCP5CON	_	_	DC5B1	DC5B0	CCP5M3	CCP5M2	CCP5M1	CCP5M0	00 0000	53, 159
SPBRG2	EUSART2 Ba	aud Rate Gene	erator Registe	r Low Byte				•	0000 0000	53, 229
RCREG2	EUSART2 R	eceive Registe	er						0000 0000	53, 237, 238
TXREG2	EUSART2 Tr	ansmit Regist	er						0000 0000	53, 235, 236
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010	53, 226
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	53, 227
ECCP3AS	ECCP3ASE	ECCP3AS2	ECCP3AS1	ECCP3AS0	PSS3AC1	PSS3AC0	PSS3BD1	PSS3BD0	0000 0000	53, 179
ECCP3DEL	P3RSEN	P3DC6	P3DC5	P3DC4	P3DC3	P3DC2	P3DC1	P3DC0	0000 0000	53, 178
ECCP2AS	ECCP2ASE	ECCP2AS2	ECCP2AS1	ECCP2AS0	PSS2AC1	PSS2AC0	PSS2BD1	PSS2BD0	0000 0000	53, 179
ECCP2DEL	P2RSEN	P2DC6	P2DC5	P2DC4	P2DC3	P2DC2	P2DC1	P2DC0	0000 0000	53, 178
SSP2BUF						53, 184, 193				
SSP2ADD	MSSP2 Addr	ess Register (I ² C™ Slave m	node), MSSP2	Baud Rate Re	load Register	(I ² C Master m	node)	0000 0000	53, 193
SSP2STAT	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	0000 0000	53, 184, 194
SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	53, 185, 195
SSP2CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	53, 196

 $\textbf{Legend:} \qquad x = \text{unknown, } u = \text{unchanged, } - = \text{unimplemented, } q = \text{value depends on condition}$

Note 1: Bit 21 of the PC is only available in Serial Programming modes.

^{2:} These bits and/or registers are only available in 80-pin devices; otherwise, they are unimplemented and read as '0'. Reset values are shown for 80-pin devices.

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^{4:} The PLLEN bit is available only when either ECPLL or HSPLL Oscillator modes are selected; otherwise, the bit is read as '0'.

^{5:} Reset value is '0' when Two-Speed Start-up is enabled and '1' if disabled.

5.3.5 STATUS REGISTER

The STATUS register, shown in Register 5-3, contains the arithmetic status of the ALU. The STATUS register can be the operand for any instruction, as with any other register. If the STATUS register is the destination for an instruction that affects the Z, DC, C, OV or N bits, then the write to these five bits is disabled.

These bits are set or cleared according to the device logic. Therefore, the result of an instruction with the STATUS register as destination may be different than intended. For example, CLRF STATUS will set the Z bit but leave the other bits unchanged. The STATUS

register then reads back as '000u u1uu'. It is recommended, therefore, that only BCF, BSF, SWAPF, MOVFF and MOVWF instructions are used to alter the STATUS register because these instructions do not affect the Z, C, DC, OV or N bits in the STATUS register.

For other instructions not affecting any Status bits, see the instruction set summaries in Table 24-2 and Table 24-3.

Note: The C and DC bits operate as a borrow and digit borrow bit respectively, in subtraction.

REGISTER 5-3: STATUS REGISTER

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
_	_	_	N	OV	Z	DC	С
bit 7							bit 0

bit 7-5 Unimplemented: Read as '0'

bit 4 N: Negative bit

This bit is used for signed arithmetic (2's complement). It indicates whether the result was negative (ALU MSB = 1).

- 1 = Result was negative
- 0 = Result was positive
- bit 3 **OV:** Overflow bit

This bit is used for signed arithmetic (2's complement). It indicates an overflow of the 7-bit magnitude which causes the sign bit (bit 7) to change state.

- 1 = Overflow occurred for signed arithmetic (in this arithmetic operation)
- 0 = No overflow occurred
- bit 2 Z: Zero bit
 - 1 = The result of an arithmetic or logic operation is zero
 - 0 = The result of an arithmetic or logic operation is not zero
- bit 1 **DC:** Digit carry/borrow bit

For ADDWF, ADDLW, SUBLW and SUBWF instructions:

- 1 = A carry-out from the 4th low-order bit of the result occurred
- 0 = No carry-out from the 4th low-order bit of the result

Note: For borrow, the polarity is reversed. A subtraction is executed by adding the 2's complement of the second operand. For rotate (RRF, RLF) instructions, this bit is loaded with either bit 4 or bit 3 of the source register.

bit 0 C: Carry/borrow bit

For ADDWF, ADDLW, SUBLW and SUBWF instructions:

- 1 = A carry-out from the Most Significant bit of the result occurred
- 0 = No carry-out from the Most Significant bit of the result occurred

Note: For borrow, the polarity is reversed. A subtraction is executed by adding the 2's complement of the second operand. For rotate (RRF, RLF) instructions, this bit is loaded with either the high or low-order bit of the source register.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

5.4 Data Addressing Modes

Note:

The execution of some instructions in the core PIC18 instruction set are changed when the PIC18 extended instruction set is enabled. See Section 5.6 "Data Memory and the Extended Instruction Set" for more information.

While the program memory can be addressed in only one way – through the program counter – information in the data memory space can be addressed in several ways. For most instructions, the addressing mode is fixed. Other instructions may use up to three modes, depending on which operands are used and whether or not the extended instruction set is enabled.

The addressing modes are:

- Inherent
- Literal
- Direct
- Indirect

An additional addressing mode, Indexed Literal Offset, is available when the extended instruction set is enabled (XINST configuration bit = 1). Its operation is discussed in greater detail in **Section 5.6.1 "Indexed Addressing with Literal Offset"**.

5.4.1 INHERENT AND LITERAL ADDRESSING

Many PIC18 control instructions do not need any argument at all; they either perform an operation that globally affects the device, or they operate implicitly on one register. This addressing mode is known as Inherent Addressing. Examples include SLEEP, RESET and DAW.

Other instructions work in a similar way, but require an additional explicit argument in the opcode. This is known as Literal Addressing mode, because they require some literal value as an argument. Examples include ADDLW and MOVLW, which respectively add or move a literal value to the W register. Other examples include CALL and GOTO, which include a 20-bit program memory address.

5.4.2 DIRECT ADDRESSING

Direct addressing specifies all or part of the source and/or destination address of the operation within the opcode itself. The options are specified by the arguments accompanying the instruction.

In the core PIC18 instruction set, bit-oriented and byte-oriented instructions use some version of direct addressing by default. All of these instructions include some 8-bit literal address as their Least Significant Byte. This address specifies either a register address in one of the banks of data RAM (Section 5.3.3 "General"

Purpose Register File"), or a location in the Access Bank (Section 5.3.2 "Access Bank") as the data source for the instruction.

The Access RAM bit 'a' determines how the address is interpreted. When 'a' is '1', the contents of the BSR (Section 5.3.1 "Bank Select Register") are used with the address to determine the complete 12-bit address of the register. When 'a' is '0', the address is interpreted as being a register in the Access Bank. Addressing that uses the Access RAM is sometimes also known as Direct Forced Addressing mode.

A few instructions, such as MOVFF, include the entire 12-bit address (either source or destination) in their op codes. In these cases, the BSR is ignored entirely.

The destination of the operation's results is determined by the destination bit 'd'. When 'd' is '1', the results are stored back in the source register, overwriting its original contents. When 'd' is '0', the results are stored in the W register. Instructions without the 'd' argument have a destination that is implicit in the instruction; their destination is either the target register being operated on, or the W register.

5.4.3 INDIRECT ADDRESSING

Indirect addressing allows the user to access a location in data memory without giving a fixed address in the instruction. This is done by using File Select Registers (FSRs) as pointers to the locations to be read or written to. Since the FSRs are themselves located in RAM as Special File Registers, they can also be directly manipulated under program control. This makes FSRs very useful in implementing data structures such as tables and arrays in data memory.

The registers for indirect addressing are also implemented with Indirect File Operands (INDFs) that permit automatic manipulation of the pointer value with auto-incrementing, auto-decrementing, or offsetting with another value. This allows for efficient code using loops, such as the example of clearing an entire RAM bank in Example 5-5. It also enables users to perform indexed addressing and other stack pointer operations for program memory in data memory.

EXAMPLE 5-5: HOW TO CLEAR RAM
(BANK 1) USING
INDIRECT ADDRESSING

	LFSR	FSR0, 100h	;	
NEXT	CLRF	POSTINC0	;	Clear INDF
			;	register then
			;	inc pointer
	BTFSS	FSROH, 1	;	All done with
			;	Bank1?
	BRA	NEXT	;	NO, clear next
CONTINU	JE		;	YES, continue

5.4.3.1 FSR Registers and the INDF Operand

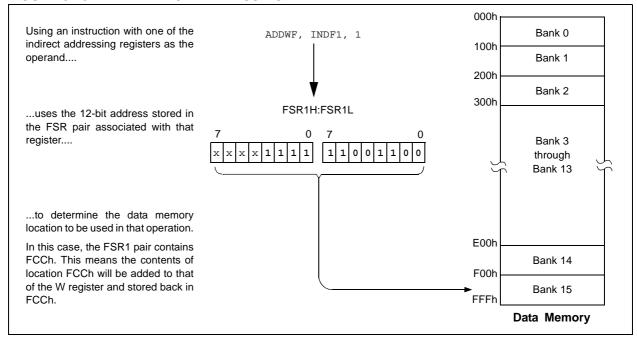
At the core of indirect addressing are three sets of registers: FSR0, FSR1 and FSR2. Each represents a pair of 8-bit registers, FSRnH and FSRnL. The four upper bits of the FSRnH register are not used, so each FSR pair holds a 12-bit value. This represents a value that can address the entire range of the data memory in a linear fashion. The FSR register pairs, then, serve as pointers to data memory locations.

Indirect addressing is accomplished with a set of Indirect File Operands, INDF0 through INDF2. These can be thought of as "virtual" registers: they are mapped in

the SFR space but are not physically implemented. Reading or writing to a particular INDF register actually accesses its corresponding FSR register pair. A read from INDF1, for example, reads the data at the address indicated by FSR1H:FSR1L. Instructions that use the INDF registers as operands actually use the contents of their corresponding FSR as a pointer to the instruction's target. The INDF operand is just a convenient way of using the pointer.

Because indirect addressing uses a full 12-bit address, data RAM banking is not necessary. Thus, the current contents of the BSR and the Access RAM bit have no effect on determining the target address.

FIGURE 5-10: INDIRECT ADDRESSING



5.4.3.2 FSR Registers and POSTINC, POSTDEC, PREINC and PLUSW

In addition to the INDF operand, each FSR register pair also has four additional indirect operands. Like INDF, these are "virtual" registers that cannot be indirectly read or written to. Accessing these registers actually accesses the associated FSR register pair, but also performs a specific action on its stored value. They are:

- POSTDEC: accesses the FSR value, then automatically decrements it by '1' afterwards
- POSTINC: accesses the FSR value, then automatically increments it by '1' afterwards
- PREINC: increments the FSR value by '1', then uses it in the operation
- PLUSW: adds the signed value of the W register (range of -127 to 128) to that of the FSR and uses the new value in the operation

In this context, accessing an INDF register uses the value in the FSR registers without changing them. Similarly, accessing a PLUSW register gives the FSR value offset by the value in the W register; neither value is actually changed in the operation. Accessing the other virtual registers changes the value of the FSR registers.

Operations on the FSRs with POSTDEC, POSTINC and PREINC affect the entire register pair; that is, roll-overs of the FSRnL register from FFh to 00h carry over to the FSRnH register. On the other hand, results of these operations do not change the value of any flags in the STATUS register (e.g., Z, N, OV, etc.).

The PLUSW register can be used to implement a form of indexed addressing in the data memory space. By manipulating the value in the W register, users can reach addresses that are fixed offsets from pointer addresses. In some applications, this can be used to implement some powerful program control structure, such as software stacks, inside of data memory.

5.4.3.3 Operations by FSRs on FSRs

Indirect addressing operations that target other FSRs or virtual registers represent special cases. For example, using an FSR to point to one of the virtual registers will not result in successful operations. As a specific case, assume that FSR0H:FSR0L contains FE7h, the address of INDF1. Attempts to read the value of the INDF1, using INDF0 as an operand, will return 00h. Attempts to write to INDF1, using INDF0 as the operand, will result in a NOP.

On the other hand, using the virtual registers to write to an FSR pair may not occur as planned. In these cases, the value will be written to the FSR pair but without any incrementing or decrementing. Thus, writing to INDF2 or POSTDEC2 will write the same value to the FSR2H:FSR2L.

Since the FSRs are physical registers mapped in the SFR space, they can be manipulated through all direct operations. Users should proceed cautiously when working on these registers, particularly if their code uses indirect addressing.

Similarly, operations by indirect addressing are generally permitted on all other SFRs. Users should exercise the appropriate caution that they do not inadvertently change settings that might affect the operation of the device.

5.5 Program Memory and the Extended Instruction Set

The operation of program memory is unaffected by the use of the extended instruction set.

Enabling the extended instruction set adds five additional two-word commands to the existing PIC18 instruction set: ADDFSR, CALLW, MOVSF, MOVSS and SUBFSR. These instructions are executed as described in **Section 5.2.4** "Two-Word Instructions".

5.6 Data Memory and the Extended Instruction Set

Enabling the PIC18 extended instruction set (XINST configuration bit = 1) significantly changes certain aspects of data memory and its addressing. Specifically, the use of the Access Bank for many of the core PIC18 instructions is different; this is due to the introduction of a new addressing mode for the data memory space. This mode also alters the behavior of indirect addressing using FSR2 and its associated operands.

What does not change is just as important. The size of the data memory space is unchanged, as well as its linear addressing. The SFR map remains the same. Core PIC18 instructions can still operate in both Direct and Indirect Addressing mode; inherent and literal instructions do not change at all. Indirect addressing with FSR0 and FSR1 also remain unchanged.

5.6.1 INDEXED ADDRESSING WITH LITERAL OFFSET

Enabling the PIC18 extended instruction set changes the behavior of indirect addressing using the FSR2 register pair and its associated file operands. Under the proper conditions, instructions that use the Access Bank – that is, most bit-oriented and byte-oriented instructions – can invoke a form of indexed addressing using an offset specified in the instruction. This special addressing mode is known as Indexed Addressing with Literal Offset, or Indexed Literal Offset mode.

When using the extended instruction set, this addressing mode requires the following:

- The use of the Access Bank is forced ('a' = 0);
 and
- The file address argument is less than or equal to 5Fh.

Under these conditions, the file address of the instruction is not interpreted as the lower byte of an address (used with the BSR in direct addressing) or as an 8-bit address in the Access Bank. Instead, the value is interpreted as an offset value to an address pointer specified by FSR2. The offset and the contents of FSR2 are added to obtain the target address of the operation.

5.6.2 INSTRUCTIONS AFFECTED BY INDEXED LITERAL OFFSET MODE

Any of the core PIC18 instructions that can use direct addressing are potentially affected by the Indexed Literal Offset Addressing mode. This includes all byte-oriented and bit-oriented instructions, or almost one-half of the standard PIC18 instruction set. Instructions that only use Inherent or Literal Addressing modes are unaffected.

Additionally, byte-oriented and bit-oriented instructions are not affected if they use the Access Bank (Access RAM bit is '1') or include a file address of 60h or above. Instructions meeting these criteria will continue to execute as before. A comparison of the different possible addressing modes when the extended instruction set is enabled is shown in Figure 5-11.

Those who desire to use byte-oriented or bit-oriented instructions in the Indexed Literal Offset mode should note the changes to assembler syntax for this mode. This is described in more detail in **Section 24.2.1** "Extended Instruction Syntax".

FIGURE 5-11: COMPARING ADDRESSING OPTIONS FOR BIT-ORIENTED AND BYTE-ORIENTED INSTRUCTIONS (EXTENDED INSTRUCTION SET ENABLED)

EXAMPLE INSTRUCTION: ADDWF, f, d, a (Opcode: 0010 01da fffff fffff)

When a = 0 and $f \ge 60h$:

The instruction executes in Direct Forced mode. 'f' is interpreted as a location in the Access RAM between 060h and FFFh. This is the same as locations F60h to FFFh (Bank 15) of data memory.

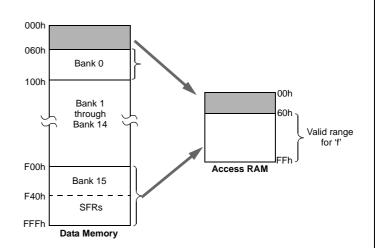
Locations below 060h are not available in this addressing mode.

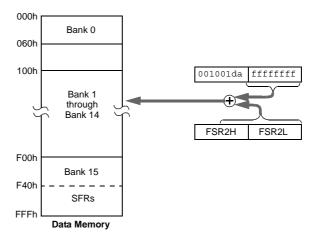
When a = 0 and $f \le 5Fh$:

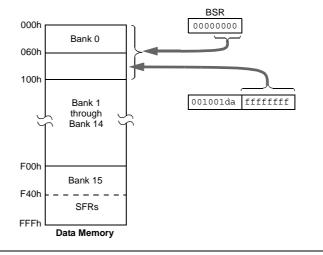
The instruction executes in Indexed Literal Offset mode. 'f' is interpreted as an offset to the address value in FSR2. The two are added together to obtain the address of the target register for the instruction. The address can be anywhere in the data memory space.

When a = 1 (all values of f):

The instruction executes in Direct mode (also known as Direct Long mode). 'f' is interpreted as a location in one of the 16 banks of the data memory space. The bank is designated by the Bank Select Register (BSR). The address can be in any implemented bank in the data memory space.







5.6.3 MAPPING THE ACCESS BANK IN INDEXED LITERAL OFFSET MODE

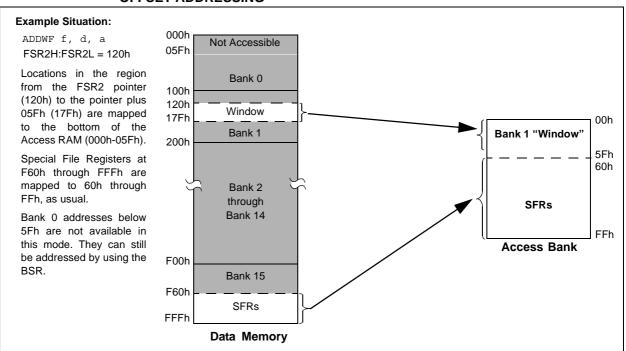
The use of Indexed Literal Offset Addressing mode effectively changes how the lower part of Access RAM (00h to 5Fh) is mapped. Rather than containing just the contents of the bottom part of Bank 0, this mode maps the contents from Bank 0 and a user-defined "window" that can be located anywhere in the data memory space. The value of FSR2 establishes the lower boundary of the addresses mapped into the window, while the upper boundary is defined by FSR2 plus 95 (5Fh). Addresses in the Access RAM above 5Fh are mapped as previously described (see **Section 5.3.2 "Access Bank"**). An example of Access Bank remapping in this addressing mode is shown in Figure 5-12.

Remapping of the Access Bank applies *only* to operations using the Indexed Literal Offset mode. Operations that use the BSR (Access RAM bit is '1') will continue to use direct addressing as before. Any indirect or indexed operation that explicitly uses any of the indirect file operands (including FSR2) will continue to operate as standard indirect addressing. Any instruction that uses the Access Bank, but includes a register address of greater than 05Fh, will use direct addressing and the normal Access Bank map.

5.6.4 BSR IN INDEXED LITERAL OFFSET MODE

Although the Access Bank is remapped when the extended instruction set is enabled, the operation of the BSR remains unchanged. Direct addressing, using the BSR to select the data memory bank, operates in the same manner as previously described.

FIGURE 5-12: REMAPPING THE ACCESS BANK WITH INDEXED LITERAL OFFSET ADDRESSING



NOTES:

6.0 PROGRAM MEMORY

For the PIC18F87J10 family of devices, the on-chip program memory is implemented as read-only memory. It is readable over the entire VDD range during normal operation; it cannot be written to or erased. Reads from program memory are executed one byte at a time.

PIC18F8XJ10/8XJ15 (80-pin) devices also implement the ability to read, write to and execute code from external memory devices, using the external memory bus. In this implementation, external memory is used as an extension beyond the upper boundary of the on-chip program memory space. The operation of the physical interface is discussed in **Section 7.0** "External Memory Bus".

In all devices, a value written to the program memory space does not need to be a valid instruction. Executing a program memory location that forms an invalid instruction results in a NOP.

6.1 Table Reads and Table Writes

To read and write to the program memory space, there are two operations that allow the processor to move bytes between the program memory space and the data RAM: Table Read (TBLRD) and Table Write (TBLWT).

The program memory space is 16 bits wide, while the data RAM space is 8 bits wide. Table reads and table writes move data between these two memory spaces through an 8-bit register (TABLAT).

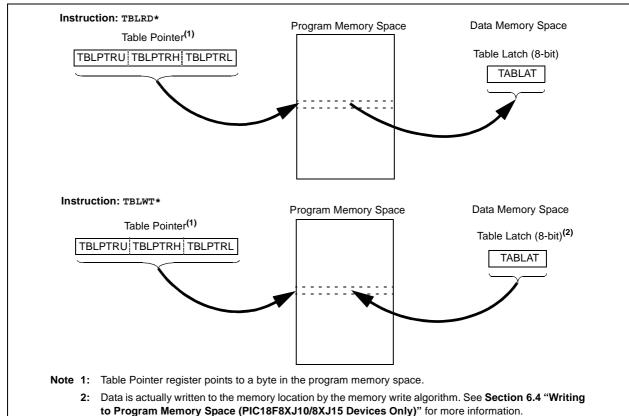
Table read operations retrieve data from program memory and place it into the data RAM space. Table write operations place data from the data memory space on the external data bus. The actual process of writing the data to the particular memory device is determined by the requirements of the device itself. Figure 6-1 shows the table operations as they relate to program memory and data RAM.

Table operations work with byte entities. A table block containing data, rather than program instructions, is not required to be word-aligned. Therefore, a table block can start and end at any byte address. If a table write is being used to write executable code into an external program memory, program instructions will need to be word-aligned.

Note: For 64-pin devices, if the TBLWT instruction is used to attempt a write to the program memory space, it will have no effect. Execution will take two instruction cycles but effectively result in a NOP.

The TBLWT instruction is still available during In-Circuit Serial Programming (ICSP).

FIGURE 6-1: TABLE READ AND TABLE WRITE OPERATIONS



6.2 Control Registers

Two control registers are used in conjunction with the TBLRD and TBLWT instructions: the TABLAT register and the TBLPTR register set.

6.2.1 TABLE LATCH REGISTER (TABLAT)

The Table Latch (TABLAT) is an 8-bit register mapped into the SFR space. The Table Latch register is used to hold 8-bit data during data transfers between the program memory space and data RAM.

6.2.2 TABLE POINTER REGISTER (TBLPTR)

The Table Pointer register (TBLPTR) addresses a byte within the program memory. It is comprised of three SFR registers: Table Pointer Upper Byte, Table Pointer High Byte and Table Pointer Low Byte (TBLPTRU:TBLPTRH:TBLPTRL). Only the lower six bits of TBLPTRU are used with TBLPTRH and TBLPTRL, to form a 22-bit wide pointer.

The contents of TBLPTR indicate a location in program memory space. The low-order 21 bits allow the device to address the full 2 Mbytes of program memory space. The 22nd bit allows access to the configuration space, including the device ID, user ID locations and the configuration bits.

The TBLPTR register set is updated when executing a TBLRD or TBLWT operation in one of four ways, based on the instruction's arguments. These are detailed in Table 6-1. These operations on the TBLPTR only affect the low-order 21 bits.

When a TBLRD or TBLWT is executed, all 22 bits of the TBLPTR determine which address in the program memory space is to be read or written to.

TABLE 6-1: TABLE POINTER
OPERATIONS WITH TBLRD
AND TBLWT INSTRUCTIONS

Example	Operation on Table Pointer
TBLRD* TBLWT*	TBLPTR is not modified
TBLRD*+ TBLWT*+	TBLPTR is incremented after the read/write
TBLRD*- TBLWT*-	TBLPTR is decremented after the read/write
TBLRD+* TBLWT+*	TBLPTR is incremented before the read/write

6.3 Reading the Flash Program Memory

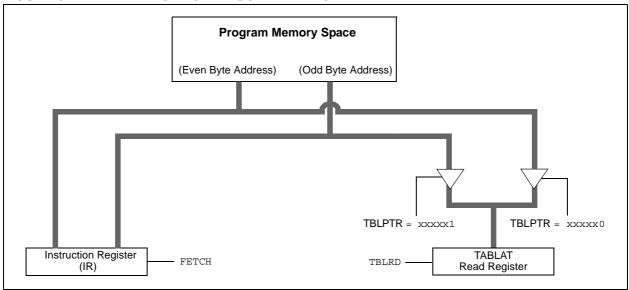
The TBLRD instruction is used to retrieve data from the program memory space and places it into data RAM. Table reads from program memory are performed one byte at a time.

TBLPTR points to a byte address in program space. Executing TBLRD places the byte pointed to into TABLAT.

The internal program memory is typically organized by words. The Least Significant bit of the address selects between the high and low bytes of the word. Figure 6-2 shows the interface between the internal program memory and the TABLAT.

A typical method for reading data from program memory is shown in Example 6-1.

FIGURE 6-2: READS FROM PROGRAM MEMORY



EXAMPLE 6-1: READING A FLASH PROGRAM MEMORY WORD

```
MOVLW
                   CODE ADDR UPPER
                                              ; Load TBLPTR with the base
                                              ; address of the word
           MOVWF
                   TBLPTRU
           MOVLW
                   CODE ADDR HIGH
           MOVWF
                   TBLPTRH
           MOVLW
                   CODE ADDR LOW
           MOVWF
                   TBLPTRL
READ_WORD
           TBLRD*+
                                              ; read into TABLAT and increment
                   TARLAT. W
           MOVE
                                              ; get data
           MOVWF
                  WORD EVEN
           TRI-RD*+
                                              ; read into TABLAT and increment
           MOVFW
                  TABLAT, W
                                              ; get data
           MOVF
                   WORD ODD
```

6.4 Writing to Program Memory Space (PIC18F8XJ10/8XJ15 Devices Only)

The table write operation outputs the contents of the TBLPTR and TABLAT registers to the external address and data busses of the external memory interface. Depending on the program memory mode selected, the operation may target any byte address in the device's memory space. What happens to this data depends largely on the external memory device being used.

For PIC18 devices with Enhanced Flash memory, a single algorithm is used for writing to the on-chip program array. In the case of external devices, however, the algorithm is determined by the type of memory device and its requirements. In some cases, a specific instruction sequence must be sent before data can be written or erased. Address and data demultiplexing, chip select operation and write time requirements must all be considered in creating the appropriate code.

The connection of the data and address busses to the memory device are dictated by the interface being used, the data bus width and the target device. When using a 16-bit data path, the algorithm must take into account the width of the target memory.

Another important consideration is the write time requirement of the target device. If this is longer than the time that a TBLWT operation makes data available on the interface, the algorithm must be adjusted to lengthen this time. It may be possible, for example, to buy enough time by increasing the length of the wait state on table operations.

In all cases, it is important to remember that instructions in the program memory space are word-aligned, with the Least Significant bit always being written to an even-numbered address (LSb = 0). If data is being stored in the program memory space, word alignment of the data is not required.

A complete overview of interface algorithms is beyond the scope of this data sheet. The best place for timing and instruction sequence requirements is the data sheet of the memory device in question. For additional information algorithm design for the external memory interface, refer to Microchip application note AN869, "External Memory Interfacing Techniques for the PIC18F8XXX" (DS00869).

6.4.1 WRITE VERIFY

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

6.4.2 UNEXPECTED TERMINATION OF WRITE OPERATION

If a write is terminated by an unplanned event, such as loss of power or an unexpected Reset, the memory location just programmed should be verified and reprogrammed if needed. If the application writes to external memory on a frequent basis, it may be necessary to implement an error trapping routine to handle these unplanned events.

6.5 Erasing External Memory (PIC18F8XJ10/8XJ15 Devices Only)

Erasure is implemented in different ways on different devices. In many cases, it is possible to erase all or part of the memory by issuing a specific command. In some devices, it may be necessary to write '0's to the locations to be erased. For specific information, consult the data sheet for the memory device in question.

6.6 Writing and Erasing On-Chip Program Memory (ICSP Mode)

While the on-chip program memory is read-only in normal operating mode, it can be written to and erased as a function of In-Circuit Serial Programming (ICSP). In this mode, the TBLWT operation is used in all devices to write to blocks of 64 bytes (32 words) at one time. Write blocks are boundary-aligned with the code protection blocks. Special commands are used to erase one or more code blocks of the program memory, or the entire device.

6.7 Flash Program Operation During Code Protection

See Section 23.6 "Program Verification and Code Protection" for details on code protection of Flash program memory.

TABLE 6-2: REGISTERS ASSOCIATED WITH FLASH PROGRAM MEMORY

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
TBLPTRU	_	_	bit 21	Program Me	mory Table F	Pointer Uppe	r Byte (TBLP	TR<20:16>)	49
TBPLTRH	Program N	Memory Ta	ble Pointe	le Pointer High Byte (TBLPTR<15:8>)					49
TBLPTRL	Program N	rogram Memory Table Pointer Low Byte (TBLPTR<7:0>)				49			
TABLAT	Program N	Program Memory Table Latch					49		

Legend: — = unimplemented, read as '0'. Shaded cells are not used during program memory access.

7.0 EXTERNAL MEMORY BUS

Note: The external memory bus is not implemented on 64-pin devices.

The external memory bus allows the device to access external memory devices (such as Flash, EPROM, SRAM, etc.) as program or data memory. It supports both 8 and 16-bit Data Width modes and three address widths of up to 20 bits.

The bus is implemented with 28 pins, multiplexed across four I/O ports. Three ports (PORTD, PORTE and PORTH) are multiplexed with the address/data bus for a total of 20 available lines, while PORTJ is multiplexed with the bus control signals.

A list of the pins and their functions is provided in Table 7-1.

TABLE 7-1: PIC18F8XJ10/8XJ15 EXTERNAL BUS – I/O PORT FUNCTIONS

Name	Port	Bit	External Memory Bus Function
RD0/AD0	PORTD	0	Address bit 0 or Data bit 0
RD1/AD1	PORTD	1	Address bit 1 or Data bit 1
RD2/AD2	PORTD	2	Address bit 2 or Data bit 2
RD3/AD3	PORTD	3	Address bit 3 or Data bit 3
RD4/AD4	PORTD	4	Address bit 4 or Data bit 4
RD5/AD5	PORTD	5	Address bit 5 or Data bit 5
RD6/AD6	PORTD	6	Address bit 6 or Data bit 6
RD7/AD7	PORTD	7	Address bit 7 or Data bit 7
RE0/AD8	PORTE	0	Address bit 8 or Data bit 8
RE1/AD9	PORTE	1	Address bit 9 or Data bit 9
RE2/AD10	PORTE	2	Address bit 10 or Data bit 10
RE3/AD11	PORTE	3	Address bit 11 or Data bit 11
RE4/AD12	PORTE	4	Address bit 12 or Data bit 12
RE5/AD13	PORTE	5	Address bit 13 or Data bit 13
RE6/AD14	PORTE	6	Address bit 14 or Data bit 14
RE7/AD15	PORTE	7	Address bit 15 or Data bit 15
RH0/A16	PORTH	0	Address bit 16
RH1/A17	PORTH	1	Address bit 17
RH2/A18	PORTH	2	Address bit 18
RH3/A19	PORTH	3	Address bit 19
RJ0/ALE	PORTJ	0	Address Latch Enable (ALE) Control pin
RJ1/OE	PORTJ	1	Output Enable (OE) Control pin
RJ2/WRL	PORTJ	2	Write Low (WRL) Control pin
RJ3/WRH	PORTJ	3	Write High (WRH) Control pin
RJ4/BA0	PORTJ	4	Byte Address bit 0 (BA0)
RJ5/CE	PORTJ	5	Chip Enable (CE) Control pin
RJ6/LB	PORTJ	6	Lower Byte Enable (LB) Control pin
RJ7/UB	PORTJ	7	Upper Byte Enable (UB) Control pin

Note: For the sake of clarity, only I/O port and external bus assignments are shown here. One or more additional multiplexed features may be available on some pins.

7.1 External Memory Bus Control

The operation of the interface is controlled by the MEMCON register (Register 7-1). This register is available in all program memory operating modes except Microcontroller mode. In this mode, the register is disabled and cannot be written to.

The EBDIS bit (MEMCON<7>) controls the operation of the bus and related port functions. Clearing EBDIS enables the interface and disables the I/O functions of the ports, as well as any other functions multiplexed to those pins. Setting the bit enables the I/O ports and other functions, but allows the interface to override everything else on the pins when an external memory operation is required. By default, the external bus is always enabled and disables all other I/O.

The operation of the EBDIS bit is also influenced by the program memory mode being used. This is discussed in more detail in Section 7.5 "Program Memory Modes and the External Memory Bus".

The WAIT bits allow for the addition of wait states to external memory operations. The use of these bits is discussed in **Section 7.3 "Wait States"**.

The WM bits select the particular operating mode used when the bus is operating in 16-bit Data Width mode. These are discussed in more detail in **Section 7.6** "16-bit Data Width Modes". These bits have no effect when an 8-bit Data Width mode is selected.

REGISTER 7-1: MEMCON: EXTERNAL MEMORY BUS CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0
EBDIS	_	WAIT1	WAIT0	_	_	WM1	WM0
hit7							hit∩

- bit 7 EBDIS: External Bus Disable bit
 - 1 = External bus enabled when microcontroller accesses external memory; otherwise, all external bus drivers are mapped as I/O ports
 - 0 = External bus always enabled, I/O ports are disabled
- bit 6 Unimplemented: Read as '0'
- bit 5-4 WAIT1:WAIT0: Table Reads and Writes Bus Cycle Wait Count bits
 - 11 = Table reads and writes will wait 0 TcY
 - 10 = Table reads and writes will wait 1 TcY
 - 01 = Table reads and writes will wait 2 TCY
 - 00 = Table reads and writes will wait 3 TcY
- bit 3-2 **Unimplemented**: Read as '0'
- bit 1-0 WM1:WM0: TBLWT Operation with 16-bit Data Bus Width Select bits
 - $\mathtt{1x} = \mathsf{Word} \; \mathsf{Write} \; \mathsf{mode} : \mathsf{TABLAT0} \; \mathsf{and} \; \mathsf{TABLAT1} \; \mathsf{word} \; \mathsf{output}, \; \overline{\mathsf{WRH}} \; \mathsf{active} \; \mathsf{when} \; \mathsf{TABLAT1} \; \mathsf{written}$
 - 01 = Byte Select mode: TABLAT data copied on both MSB and LSB, WRH and (UB or LB) will activate
 - 00 = Byte Write mode: TABLAT data copied on both MSB and LSB, WRH or WRL will activate

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	l bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

7.2 Address and Data Width

The PIC18F87J10 family of devices can be independently configured for different address and data widths on the same memory bus. Both address and data width are set by configuration bits in the CONFIG3L register. As configuration bits, this means that these options can only be configured by programming the device and are not controllable in software.

The BW bit selects an 8-bit or 16-bit data bus width. Setting this bit (default) selects a data width of 16 bits.

The EMB1:EMB0 bits determine both the program memory operating mode and the address bus width. The available options are 20-bit (default), 16-bit and 12-bit, as well as Microcontroller mode (external bus disabled). Selecting a 16-bit or 12-bit width makes a corresponding number of high-order lines available for I/O functions; these pins are no longer affected by the setting of the EBDIS bit. For example, selecting a 16-bit Address mode (EMB1:EMB0 = 10) disables A19:A16 and allows PORTH<3:0> to function without interruptions from the bus. Using the smaller address widths allows users to tailor the memory bus to the size of the external memory space for a particular design while freeing up pins for dedicated I/O operation.

Because the EMB bits have the effect of disabling pins for memory bus operations, it is important to always select an address width at least equal to the data width. If a 12-bit address width is used with a 16-bit data width, the upper four bits of data will not be available on the bus.

All combinations of address and data widths require multiplexing of address and data information on the same lines. The address and data multiplexing, as well as I/O ports made available by the use of smaller address widths, are summarized in Table 7-2.

7.2.1 ADDRESS SHIFTING ON THE EXTERNAL BUS

By default, the address presented on the external bus is the value of the PC. In practical terms, this means that addresses in the external memory device below the top of on-chip memory are unavailable to the microcontroller. To access these physical locations, the glue logic between the microcontroller and the external memory must somehow translate addresses.

To simplify the interface, the external bus offers an extension of Extended Microcontroller mode that automatically performs address shifting. This feature is controlled by the EASHFT configuration bit. Setting this bit offsets addresses on the bus by the size of the microcontroller's on-chip program memory and sets the bottom address at 0000h. This allows the device to use the entire range of physical addresses of the external memory.

7.2.2 21-BIT ADDRESSING

As an extension of 20-bit address width operation, the external memory bus can also fully address a 2-Mbyte memory space. This is done by using the Bus Address Bit 0 (BA0) control line as the Least Significant bit of the address. The $\overline{\text{UB}}$ and $\overline{\text{LB}}$ control signals may also be used with certain memory devices to select the upper and lower bytes within a 16-bit wide data word.

This addressing mode is available in both 8-bit and certain 16-bit data width modes. Additional details are provided in Section 7.6.3 "16-Bit Byte Select Mode" and Section 7.7 "8-bit Mode".

TABLE 7-2: ADDRESS AND DATA LINES FOR DIFFERENT ADDRESS AND DATA WIDTHS

Data Width	Address Width	Multiplexed Data and Address Lines (and Corresponding Ports)	Address-Only Lines (and Corresponding Ports)	Ports Available for I/O
	12-bit		AD11:AD8 (PORTE<3:0>)	PORTE<7:4>, All of PORTH
8-bit	16-bit	AD7:AD0 (PORTD<7:0>)	AD15:AD8 (PORTE<7:0>)	All of PORTH
	20-bit	(. 55,	A19:A16, AD15:AD8 (PORTH<3:0>, PORTE<7:0>)	
	16-bit	AD15:AD0		All of PORTH
16-bit	20-bit	(PORTD<7:0>, PORTE<7:0>)	A19:A16 (PORTH<3:0>)	

7.3 Wait States

While it may be assumed that external memory devices will operate at the microcontroller clock rate, this is often not the case. In fact, many devices require longer times to write or retrieve data than the time allowed by the execution of table read or table write operations.

To compensate for this, the external memory bus can be configured to add a fixed delay to each table operation using the bus. Wait states are enabled by setting the WAIT configuration bit. When enabled, the amount of delay is set by the WAIT1:WAIT0 bits (MEMCON<5:4>). The delay is based on multiples of microcontroller instruction cycle time and are added following the instruction cycle when the table operation is executed. The range is from no delay to 3 Tcy (default value).

7.4 Port Pin Weak Pull-ups

With the exception of the upper address lines, A19:A16, the pins associated with the external memory bus are equipped with weak pull-ups. The pull-ups are controlled by the upper three bits of the PORTG register. They are named RDPU, REPU and RJPU and control pull-ups on PORTD, PORTE and PORTJ, respectively. Setting one of these bits enables the corresponding pull-ups for that port. All pull-ups are disabled by default on all device Resets.

7.5 Program Memory Modes and the External Memory Bus

The PIC18F87J10 family of devices are capable of operating in one of two program memory modes, using combinations of on-chip and external program memory. The functions of the multiplexed port pins depend on the program memory mode selected, as well as the setting of the EBDIS bit.

In **Microcontroller Mode**, the bus is not active and the pins have their port functions only. Writes to the MEMCOM register are not permitted. The Reset value of EBDIS ('0') is ignored and EMB pins behave as I/O ports.

In **Extended Microcontroller Mode**, the external program memory bus shares I/O port functions on the pins. When the device is fetching or doing table read/table write operations on the external program memory space, the pins will have the external bus function.

If the device is fetching and accessing internal program memory locations only, the EBDIS control bit will change the pins from external memory to I/O port functions. When EBDIS = 0, the pins function as the external bus. When EBDIS = 1, the pins function as I/O ports.

If the device fetches or accesses external memory while EBDIS = 1, the pins will switch to external bus. If the EBDIS bit is set by a program executing from external memory, the action of setting the bit will be delayed until the program branches into the internal memory. At that time, the pins will change from external bus to I/O ports

If the device is executing out of internal memory when EBDIS = 0, the memory bus address/data and control pins will not be active. They will go to a state where the active address/data pins are tri-state; the \overline{CE} , \overline{OE} , \overline{WRH} , \overline{WRL} , \overline{UB} and \overline{LB} signals are '1' and ALE and BA0 are '0'. Note that only those pins associated with the current address width are forced to tri-state; the other pins continue to function as I/O. In the case of 16-bit address width, for example, only AD<15:0> (PORTD and PORTE) are affected; A19:A16 (PORTH<3:0>) continue to function as I/O.

In all external memory modes, the bus takes priority over any other peripherals that may share pins with it. This includes the Parallel Slave Port and serial communications modules which would otherwise take priority over the I/O port.

7.6 16-bit Data Width Modes

In 16-bit Data Width mode, the external memory interface can be connected to external memories in three different configurations:

- 16-bit Byte Write
- 16-bit Word Write
- 16-bit Byte Select

The configuration to be used is determined by the WM1:WM0 bits in the MEMCON register (MEMCON<1:0>). These three different configurations allow the designer maximum flexibility in using both 8-bit and 16-bit devices with 16-bit data.

For all 16-bit modes, the Address Latch Enable (ALE) pin indicates that the address bits AD<15:0> are available on the external memory interface bus. Following the address latch, the Output Enable signal $\overline{(OE)}$ will enable both bytes of program memory at once to form a 16-bit instruction word. The Chip Enable signal $\overline{(CE)}$ is active at any time that the microcontroller accesses external memory, whether reading or writing; it is inactive (asserted high) whenever the device is in Sleep mode.

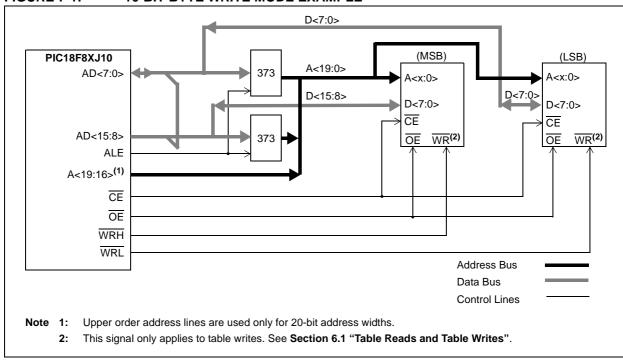
In Byte Select mode, JEDEC standard Flash memories will require BA0 for the byte address line and one I/O line to select between Byte and Word mode. The other 16-bit modes do not need BA0. JEDEC standard static RAM memories will use the $\overline{\text{UB}}$ or $\overline{\text{LB}}$ signals for byte selection

7.6.1 16-BIT BYTE WRITE MODE

Figure 7-1 shows an example of 16-bit Byte Write mode for PIC18F87J10 family devices. This mode is used for two separate 8-bit memories connected for 16-bit operation. This generally includes basic EPROM and Flash devices. It allows table writes to byte-wide external memories.

During a TBLWT instruction cycle, the TABLAT data is presented on the upper and <u>lower bytes</u> of the AD15:AD0 bus. The appropriate WRH or WRL control line is strobed on the LSb of the TBLPTR.

FIGURE 7-1: 16-BIT BYTE WRITE MODE EXAMPLE



7.6.2 16-BIT WORD WRITE MODE

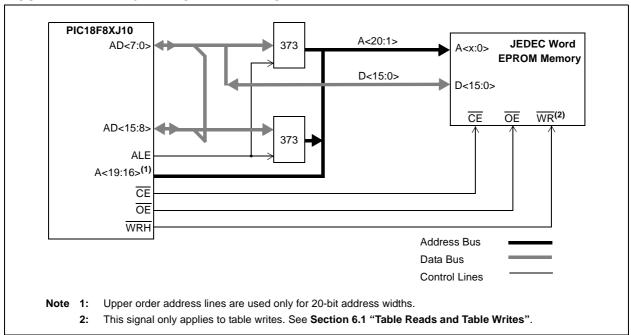
Figure 7-2 shows an example of 16-bit Word Write mode for PIC18F65J10 devices. This mode is used for word-wide memories which include some of the EPROM and Flash-type memories. This mode allows opcode fetches and table reads from all forms of 16-bit memory and table writes to any type of word-wide external memories. This method makes a distinction between TBLWT cycles to even or odd addresses.

During a TBLWT cycle to an even address (TBLPTR<0> = 0), the TABLAT data is transferred to a holding latch and the external address data bus is tri-stated for the data portion of the bus cycle. No write signals are activated.

During a TBLWT cycle to an odd address (TBLPTR<0> = 1), the TABLAT data is presented on the upper byte of the AD15:AD0 bus. The contents of the holding latch are presented on the lower byte of the AD15:AD0 bus.

The $\overline{\text{WRH}}$ signal is strobed for each write cycle; the $\overline{\text{WRL}}$ pin is unused. The signal on the BA0 pin indicates the LSb of the TBLPTR, but it is left unconnected. Instead, the $\overline{\text{UB}}$ and $\overline{\text{LB}}$ signals are active to select both bytes. The obvious limitation to this method is that the table write must be done in pairs on a specific word boundary to correctly write a word location.

FIGURE 7-2: 16-BIT WORD WRITE MODE EXAMPLE



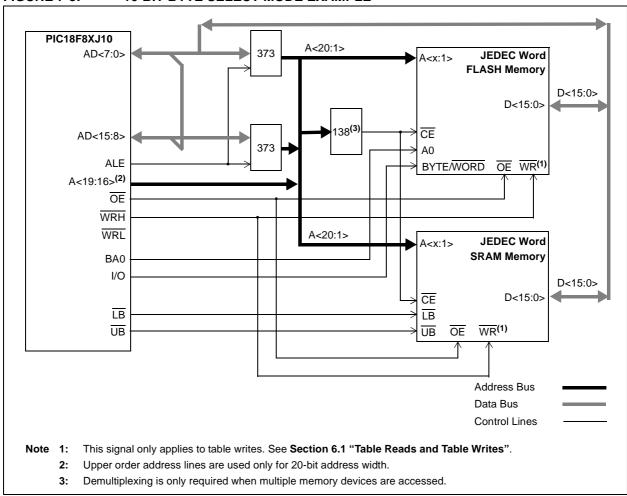
7.6.3 16-BIT BYTE SELECT MODE

Figure 7-3 shows an example of 16-bit Byte Select mode. This mode allows table write operations to word-wide external memories with byte selection capability. This generally includes both word-wide Flash and SRAM devices.

During a <code>TBLWT</code> cycle, the TABLAT data is presented on the upper and lower byte of the AD15:AD0 bus. The \overline{WRH} signal is strobed for each write cycle; the \overline{WRL} pin is not used. The BA0 or $\overline{UB/LB}$ signals are used to select the byte to be written, based on the Least Significant bit of the TBLPTR register.

Flash and SRAM devices use different control signal combinations to implement Byte Select mode. JEDEC standard Flash memories require that a controller I/O port pin be connected to the memory's BYTE/WORD pin to provide the select signal. They also use the BAO signal from the controller as a byte address. JEDEC standard static RAM memories, on the other hand, use the UB or LB signals to select the byte.

FIGURE 7-3: 16-BIT BYTE SELECT MODE EXAMPLE



7.6.4 16-BIT MODE TIMING

The presentation of control signals on the external memory bus is different for the various operating modes. Typical signal timing diagrams are shown in Figure 7-4 and Figure 7-5.

FIGURE 7-4: EXTERNAL MEMORY BUS TIMING FOR TBLRD (EXTENDED MICROCONTROLLER MODE)

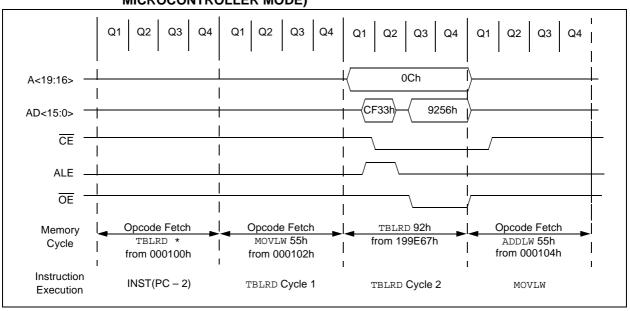
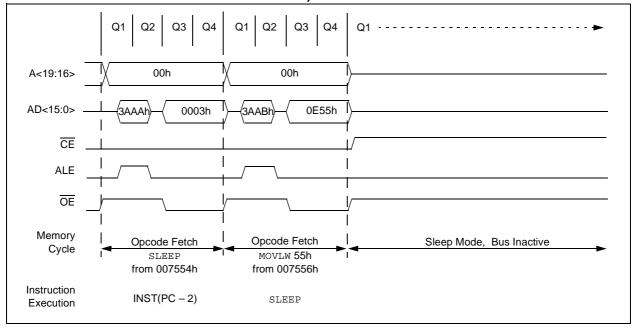


FIGURE 7-5: EXTERNAL MEMORY BUS TIMING FOR SLEEP (EXTENDED MICROCONTROLLER MODE)



7.7 8-bit Mode

In 8-bit Data Width mode, the external memory bus operates only in Multiplexed mode; that is, data shares the 8 Least Significant bits of the address bus.

Figure 7-6 shows an example of 8-bit Multiplexed mode for 80-pin devices. This mode is used for a single 8-bit memory connected for 16-bit operation. The instructions will be fetched as two 8-bit bytes on a shared data/address bus. The two bytes are sequentially fetched within one instruction cycle (TcY). Therefore, the designer must choose external memory devices according to timing calculations based on 1/2 TcY (2 times the instruction rate). For proper memory speed selection, glue logic propagation delay times must be considered, along with setup and hold times.

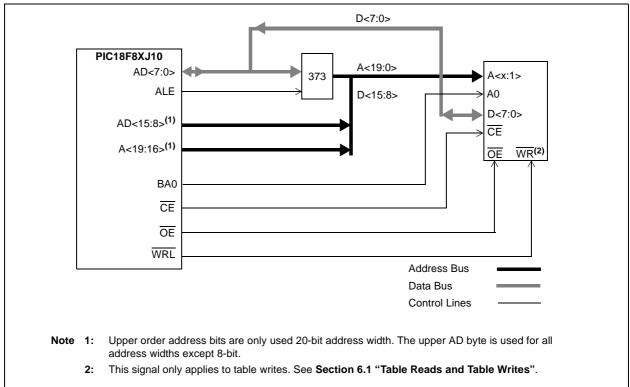
The Address Latch Enable (ALE) pin indicates that the address bits AD<15:0> are available on the external memory interface bus. The Output Enable signal (OE)

will enable one byte of program memory for a portion of the instruction cycle, then BA0 will change and the second byte will be enabled to form the 16-bit instruction word. The Least Significant bit of the address, BA0, must be connected to the memory devices in this mode. The Chip Enable signal (CE) is active at any time that the microcontroller accesses external memory, whether reading or writing; it is inactive (asserted high) whenever the device is in Sleep mode.

This generally includes basic EPROM and Flash devices. It allows table writes to byte-wide external memories.

During a TBLWT instruction cycle, the TABLAT data is presented on the upper and lower bytes of the AD15:AD0 bus. The appropriate level of the BA0 control line is strobed on the LSb of the TBLPTR.





7.7.1 8-BIT MODE TIMING

The presentation of control signals on the external memory bus is different for the various operating modes. Typical signal timing diagrams are shown in Figure 7-7 and Figure 7-8.

FIGURE 7-7: EXTERNAL MEMORY BUS TIMING FOR TBLRD (EXTENDED MICROCONTROLLER MODE)

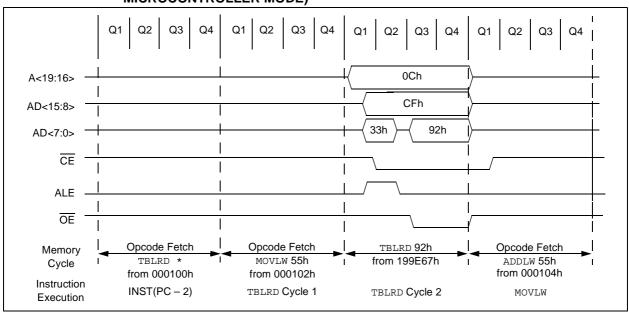
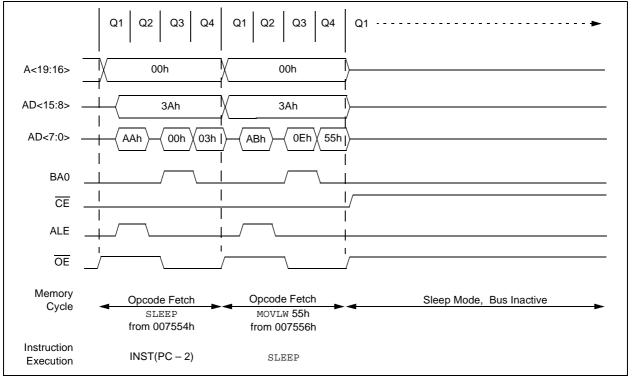


FIGURE 7-8: EXTERNAL MEMORY BUS TIMING FOR SLEEP (EXTENDED MICROCONTROLLER MODE)



7.8 Operation in Power-Managed Modes

In alternate power-managed Run modes, the external bus continues to operate normally. If a clock source with a lower speed is selected, bus operations will run at that speed. In these cases, excessive access times for the external memory may result if wait states have been enabled and added to external memory operations. If operations in a lower power Run mode are anticipated, users should provide in their applications for adjusting memory access times at the lower clock speeds.

In Sleep and Idle modes, the microcontroller core does not need to access data; bus operations are suspended. The state of the external bus is frozen, with the address/data pins and most of the control pins holding at the same state they were in when the mode was invoked. The only potential changes are the CE, LB and UB pins, which are held at logic high.

NOTES:

8.0 8 x 8 HARDWARE MULTIPLIER

8.1 Introduction

All PIC18 devices include an 8 x 8 hardware multiplier as part of the ALU. The multiplier performs an unsigned operation and yields a 16-bit result that is stored in the product register pair, PRODH:PRODL. The multiplier's operation does not affect any flags in the STATUS register.

Making multiplication a hardware operation allows it to be completed in a single instruction cycle. This has the advantages of higher computational throughput and reduced code size for multiplication algorithms and allows the PIC18 devices to be used in many applications previously reserved for digital signal processors. A comparison of various hardware and software multiply operations, along with the savings in memory and execution time, is shown in Table 8-1.

8.2 Operation

Example 8-1 shows the instruction sequence for an 8×8 unsigned multiplication. Only one instruction is required when one of the arguments is already loaded in the WREG register.

Example 8-2 shows the sequence to do an 8 x 8 signed multiplication. To account for the sign bits of the arguments, each argument's Most Significant bit (MSb) is tested and the appropriate subtractions are done.

EXAMPLE 8-1: 8 x 8 UNSIGNED MULTIPLY ROUTINE

MULWF ARG2 ; ARG1 * ARG2 -> ; PRODH:PRODL	MOVF	ARG1, W	;
; PRODH:PRODL	MULWF	ARG2	; ARG1 * ARG2 ->
			; PRODH:PRODL

EXAMPLE 8-2: 8 x 8 SIGNED MULTIPLY ROUTINE

```
MOVF
       ARG1. W
MULWF
       ARG2
                   ; ARG1 * ARG2 ->
                   ; PRODH:PRODL
BTFSC
       ARG2, SB
                   ; Test Sign Bit
SUBWF
       PRODH, F
                   ; PRODH = PRODH
                              - ARG1
MOVF
       ARG2, W
BTFSC
       ARG1, SB
                   ; Test Sign Bit
                   ; PRODH = PRODH
SUBWF
       PRODH, F
                              - ARG2
```

TABLE 8-1: PERFORMANCE COMPARISON FOR VARIOUS MULTIPLY OPERATIONS

		Program	Cycles	Time			
Routine	Multiply Method	Memory (Words)	(Max)	@ 40 MHz	@ 10 MHz	@ 4 MHz	
9 v 9 unsigned	Without hardware multiply	13	69	6.9 μs	27.6 μs	69 μs	
8 x 8 unsigned	Hardware multiply	1	1	100 ns	400 ns	1 μs	
0 0	Without hardware multiply	33	91	9.1 μs	36.4 μs	91 μs	
8 x 8 signed	Hardware multiply	6	6	600 ns	2.4 μs	6 μs	
16 x 16 unsigned	Without hardware multiply	21	242	24.2 μs	96.8 μs	242 μs	
16 x 16 unsigned	Hardware multiply	28	28	2.8 μs	11.2 μs	28 μs	
16 x 16 signed	Without hardware multiply	52	254	25.4 μs	102.6 μs	254 μs	
To x to signed	Hardware multiply	35	40	4.0 μs	16.0 μs	40 μs	

Example 8-3 shows the sequence to do a 16 x 16 unsigned multiplication. Equation 8-1 shows the algorithm that is used. The 32-bit result is stored in four registers (RES3:RES0).

EQUATION 8-1: 16 x 16 UNSIGNED MULTIPLICATION ALGORITHM

```
RES3:RES0 = ARG1H:ARG1L • ARG2H:ARG2L

= (ARG1H • ARG2H • 2<sup>16</sup>) +

(ARG1H • ARG2L • 2<sup>8</sup>) +

(ARG1L • ARG2H • 2<sup>8</sup>) +

(ARG1L • ARG2L)
```

EXAMPLE 8-3: 16 x 16 UNSIGNED MULTIPLY ROUTINE

```
MOVE
        ARG1L, W
MULWF
        ARG2L
                       : ARG1L * ARG2L->
                       ; PRODH: PRODL
MOVFF
       PRODH, RES1
MOVFF
       PRODL, RESO
MOVF
       ARG1H, W
                       ; ARG1H * ARG2H->
       ARG2H
MULWF
                       ; PRODH:PRODL
MOVFF
       PRODH, RES3
MOVFF
       PRODL, RES2
                       ;
MOVF
       ARG1L, W
MULWF
       ARG2H
                       ; ARG1L * ARG2H->
                       ; PRODH: PRODL
MOVF
        PRODL, W
                       ; Add cross
       RES1, F
ADDWF
       PRODH, W
                       ; products
ADDWFC RES2, F
CLRF
        WREG
ADDWFC RES3, F
       ARG1H, W
MOVF
       ARG2L
                       ; ARG1H * ARG2L->
MULWF
                       ; PRODH: PRODL
MOVF
        PRODL, W
ADDWF
       RES1, F
                       ; Add cross
MOVE
        PRODH, W
                       ; products
       RES2, F
ADDWFC
CLRF
        WREG
ADDWFC RES3, F
```

Example 8-4 shows the sequence to do a 16 x 16 signed multiply. Equation 8-2 shows the algorithm used. The 32-bit result is stored in four registers (RES3:RES0). To account for the sign bits of the arguments, the MSb for each argument pair is tested and the appropriate subtractions are done.

EQUATION 8-2: 16 x 16 SIGNED MULTIPLICATION ALGORITHM

```
RES3:RES0 = ARG1H:ARG1L • ARG2H:ARG2L

= (ARG1H • ARG2H • 2^{16}) +

(ARG1H • ARG2L • 2^{8}) +

(ARG1L • ARG2H • 2^{8}) +

(ARG1L • ARG2L) +

(-1 • ARG2H < 7 > • ARG1H:ARG1L • 2^{16}) +

(-1 • ARG1H < 7 > • ARG2H:ARG2L • 2^{16})
```

EXAMPLE 8-4: 16 x 16 SIGNED MULTIPLY ROUTINE

```
MOVF
           ARG1L, W
                         ; ARG1L * ARG2L ->
   MULWF
           ARG2L
                         ; PRODH: PRODL
           PRODH, RES1
   MOVEE
   MOVFF
           PRODL, RESO
   MOVF
           ARG1H, W
   MULWF
           ARG2H
                         ; ARG1H * ARG2H ->
                         ; PRODH:PRODL
   MOVFF
           PRODH, RES3
   MOVFF
           PRODL, RES2
           ARG1L, W
   MOVF
   MULWF
           ARG2H
                         ; ARG1L * ARG2H ->
                         ; PRODH: PRODL
   MOVF
           PRODL, W
   ADDWF
           RES1, F
                         ; Add cross
           PRODH, W
                         ; products
   MOVF
   ADDWFC
           RES2, F
   CLRF
           WREG
   ADDWFC RES3, F
           ARG1H, W
   MOVF
                         ; ARG1H * ARG2L ->
   MULWF
           ARG2L
                         ; PRODH:PRODL
   MOVF
           PRODL, W
           RES1, F
                         ; Add cross
   ADDWF
           PRODH, W
   MOVF
                         ; products
   ADDWFC RES2, F
   CLRF
           WREG
   ADDWFC RES3, F
   BTFSS
           ARG2H, 7
                         ; ARG2H:ARG2L neg?
           SIGN ARG1
                         ; no, check ARG1
   BRA
           ARG1L, W
   MOVF
   SUBWE
           RES2
   MOVF
           ARG1H, W
   SUBWFB
          RES3
SIGN ARG1
           ARG1H, 7
   BTFSS
                         ; ARG1H:ARG1L neg?
   BRA
           CONT CODE
                         ; no, done
   MOVE
           ARG2L, W
   SUBWF
           RES2
   MOVF
           ARG2H, W
   SUBWFB
          RES3
CONT_CODE
   :
```

9.0 INTERRUPTS

Members of the PIC18F87J10 family of devices have multiple interrupt sources and an interrupt priority feature that allows most interrupt sources to be assigned a high priority level or a low priority level. The high priority interrupt vector is at 0008h and the low priority interrupt vector is at 0018h. High priority interrupt events will interrupt any low priority interrupts that may be in progress.

There are thirteen registers which are used to control interrupt operation. These registers are:

- RCON
- INTCON
- INTCON2
- INTCON3
- PIR1, PIR2, PIR3
- PIE1, PIE2, PIE3
- IPR1, IPR2, IPR3

It is recommended that the Microchip header files supplied with MPLAB® IDE be used for the symbolic bit names in these registers. This allows the assembler/compiler to automatically take care of the placement of these bits within the specified register.

In general, interrupt sources have three bits to control their operation. They are:

- Flag bit to indicate that an interrupt event
 occurred.
- Enable bit that allows program execution to branch to the interrupt vector address when the flag bit is set
- Priority bit to select high priority or low priority

The interrupt priority feature is enabled by setting the IPEN bit (RCON<7>). When interrupt priority is enabled, there are two bits which enable interrupts globally. Setting the GIEH bit (INTCON<7>) enables all interrupts that have the priority bit set (high priority). Setting the GIEL bit (INTCON<6>) enables all interrupts that have the priority bit cleared (low priority). When the interrupt flag, enable bit and appropriate global interrupt enable bit are set, the interrupt will vector immediately to address 0008h or 0018h, depending on the priority bit setting. Individual interrupts can be disabled through their corresponding enable bits.

When the IPEN bit is cleared (default state), the interrupt priority feature is disabled and interrupts are compatible with PICmicro® mid-range devices. In Compatibility mode, the interrupt priority bits for each source have no effect. INTCON<6> is the PEIE bit which enables/disables all peripheral interrupt sources. INTCON<7> is the GIE bit which enables/disables all interrupt sources. All interrupts branch to address 0008h in Compatibility mode.

When an interrupt is responded to, the global interrupt enable bit is cleared to disable further interrupts. If the IPEN bit is cleared, this is the GIE bit. If interrupt priority levels are used, this will be either the GIEH or GIEL bit. High priority interrupt sources can interrupt a low priority interrupt. Low priority interrupts are not processed while high priority interrupts are in progress.

The return address is pushed onto the stack and the PC is loaded with the interrupt vector address (0008h or 0018h). Once in the Interrupt Service Routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bits must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

The "return from interrupt" instruction, RETFIE, exits the interrupt routine and sets the GIE bit (GIEH or GIEL if priority levels are used) which re-enables interrupts.

For external interrupt events, such as the INT pins or the PORTB input change interrupt, the interrupt latency will be three to four instruction cycles. The exact latency is the same for one or two-cycle instructions. Individual interrupt flag bits are set regardless of the status of their corresponding enable bit or the GIE bit.

Note: Do not use the MOVFF instruction to modify any of the interrupt control registers while **any** interrupt is enabled. Doing so may cause erratic microcontroller behavior.

FIGURE 9-1: PIC18F87J10 FAMILY INTERRUPT LOGIC TMR0IF TMR0IE TMR0IP Wake-up if in Idle or Sleep modes RBIF RBIE RBIE RBIP INTOIF INTOIE INT1IF INT1IE INT1IP INT2IF INT2IE INT2IP Interrupt to CPU Vector to Location 0008h PIR1<7:0> PIE1<7:0> IPR1<7:0> INT3IF INT3IE INT3IP GIEH/GIE PIR2<7:6, 3:0> ___ PIE2<7:6, 3:0> ___ IPR2<7:6, 3:0> ___ IPEN -PIR3<7, 0> PIE3<7, 0> IPR3<7, 0> IPEN GIEL/PEIE IPEN -High Priority Interrupt Generation Low Priority Interrupt Generation PIR1<7:0> PIE1<7:0> IPR1<7:0> PIR2<7:6, 3:0> PIE2<7:6, 3:0> IPR2<7:6, 3:0> Interrupt to CPU Vector to Location 0018h TMR0IF — TMR0IE — TMR0IP — IPEN-PIR3<7, 0> PIE3<7, 0> IPR3<7, 0> RBIF — RBIE — RBIP GIEH/GIE INT1IF INT1IE INT1IP INT2IF INT2IE INT2IP INT3IF INT3IE INT3IP

9.1 INTCON Registers

The INTCON registers are readable and writable registers which contain various enable, priority and flag bits

Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

REGISTER 9-1: INTCON: INTERRUPT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF
bit 7							bit 0

Note:

bit 7 GIE/GIEH: Global Interrupt Enable bit

When IPEN = 0:

- 1 = Enables all unmasked interrupts
- 0 = Disables all interrupts

When IPEN = 1:

- 1 = Enables all high priority interrupts
- 0 = Disables all interrupts
- bit 6 PEIE/GIEL: Peripheral Interrupt Enable bit

When IPEN = 0:

- 1 = Enables all unmasked peripheral interrupts
- 0 = Disables all peripheral interrupts

When IPEN = 1:

- 1 = Enables all low priority peripheral interrupts
- 0 = Disables all low priority peripheral interrupts
- bit 5 **TMR0IE:** TMR0 Overflow Interrupt Enable bit
 - 1 = Enables the TMR0 overflow interrupt
 - 0 = Disables the TMR0 overflow interrupt
- bit 4 INT0IE: INT0 External Interrupt Enable bit
 - 1 = Enables the INT0 external interrupt
 - 0 = Disables the INT0 external interrupt
- bit 3 RBIE: RB Port Change Interrupt Enable bit
 - 1 = Enables the RB port change interrupt
 - 0 = Disables the RB port change interrupt
- bit 2 TMR0IF: TMR0 Overflow Interrupt Flag bit
 - 1 = TMR0 register has overflowed (must be cleared in software)
 - 0 = TMR0 register did not overflow
- bit 1 INT0IF: INT0 External Interrupt Flag bit
 - 1 = The INT0 external interrupt occurred (must be cleared in software)
 - 0 = The INTO external interrupt did not occur
- bit 0 RBIF: RB Port Change Interrupt Flag bit
 - 1 = At least one of the RB7:RB4 pins changed state (must be cleared in software)
 - 0 = None of the RB7:RB4 pins have changed state

Note: A mismatch condition will continue to set this bit. Reading PORTB will end the mismatch condition and allow the bit to be cleared.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	l bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 9-2: INTCON2: INTERRUPT CONTROL REGISTER 2

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP
–							

bit 7 bit 0

bit 7 RBPU: PORTB Pull-up Enable bit

1 = All PORTB pull-ups are disabled

0 = PORTB pull-ups are enabled by individual port latch values

bit 6 INTEDG0: External Interrupt 0 Edge Select bit

1 = Interrupt on rising edge

0 = Interrupt on falling edge

bit 5 INTEDG1: External Interrupt 1 Edge Select bit

1 = Interrupt on rising edge

0 = Interrupt on falling edge

bit 4 INTEDG2: External Interrupt 2 Edge Select bit

1 = Interrupt on rising edge

0 = Interrupt on falling edge

bit 3 INTEDG3: External Interrupt 3 Edge Select bit

1 = Interrupt on rising edge

0 = Interrupt on falling edge

bit 2 TMR0IP: TMR0 Overflow Interrupt Priority bit

1 = High priority

0 = Low priority

bit 1 INT3IP: INT3 External Interrupt Priority bit

1 = High priority

0 = Low priority

bit 0 RBIP: RB Port Change Interrupt Priority bit

1 = High priority

0 = Low priority

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

REGISTER 9-3: INTCON3: INTERRUPT CONTROL REGISTER 3

R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF
127							

bit 7 bit 0

bit 7 INT2IP: INT2 External Interrupt Priority bit

1 = High priority

0 = Low priority

bit 6 INT1IP: INT1 External Interrupt Priority bit

1 = High priority

0 = Low priority

bit 5 INT3IE: INT3 External Interrupt Enable bit

1 = Enables the INT3 external interrupt

0 = Disables the INT3 external interrupt

bit 4 INT2IE: INT2 External Interrupt Enable bit

1 = Enables the INT2 external interrupt0 = Disables the INT2 external interrupt

bit 3 INT1IE: INT1 External Interrupt Enable bit

1 = Enables the INT1 external interrupt

0 = Disables the INT1 external interrupt

bit 2 INT3IF: INT3 External Interrupt Flag bit

1 = The INT3 external interrupt occurred (must be cleared in software)

0 = The INT3 external interrupt did not occur

bit 1 INT2IF: INT2 External Interrupt Flag bit

1 = The INT2 external interrupt occurred (must be cleared in software)

0 = The INT2 external interrupt did not occur

bit 0 INT1IF: INT1 External Interrupt Flag bit

1 = The INT1 external interrupt occurred (must be cleared in software)

0 = The INT1 external interrupt did not occur

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

9.2 PIR Registers

The PIR registers contain the individual flag bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are three Peripheral Interrupt Request (Flag) registers (PIR1, PIR2, PIR3).

- **Note 1:** Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the Global Interrupt Enable bit, GIE (INTCON<7>).
 - 2: User software should ensure the appropriate interrupt flag bits are cleared prior to enabling an interrupt and after servicing that interrupt.

REGISTER 9-4: PIR1: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 1

bit 7							bit 0
PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF
R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0

- bit 7 PSPIF: Parallel Slave Port Read/Write Interrupt Flag bit
 - 1 = A read or a write operation has taken place (must be cleared in software)
 - 0 = No read or write has occurred
- bit 6 ADIF: A/D Converter Interrupt Flag bit
 - 1 = An A/D conversion completed (must be cleared in software)
 - 0 = The A/D conversion is not complete
- bit 5 RC1IF: EUSART1 Receive Interrupt Flag bit
 - 1 = The EUSART1 receive buffer, RCREGx, is full (cleared when RCREGx is read)
 - 0 = The EUSART1 receive buffer is empty
- bit 4 **TX1IF:** EUSART1 Transmit Interrupt Flag bit
 - 1 = The EUSART1 transmit buffer, TXREGx, is empty (cleared when TXREGx is written)
 - 0 = The EUSART1 transmit buffer is full
- bit 3 SSP1IF: Master Synchronous Serial Port 1 Interrupt Flag bit
 - 1 = The transmission/reception is complete (must be cleared in software)
 - 0 = Waiting to transmit/receive
- bit 2 **CCP1IF:** ECCP1 Interrupt Flag bit

Capture mode:

- 1 = A TMR1/TMR3 register capture occurred (must be cleared in software)
- 0 = No TMR1/TMR3 register capture occurred

Compare mode:

- 1 = A TMR1/TMR3 register compare match occurred (must be cleared in software)
- 0 = No TMR1/TMR3 register compare match occurred

PWM mode:

Unused in this mode.

- bit 1 TMR2IF: TMR2 to PR2 Match Interrupt Flag bit
 - 1 = TMR2 to PR2 match occurred (must be cleared in software)
 - 0 = No TMR2 to PR2 match occurred
- bit 0 TMR1IF: TMR1 Overflow Interrupt Flag bit
 - 1 = TMR1 register overflowed (must be cleared in software)
 - 0 = TMR1 register did not overflow

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented b	oit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 9-5: PIR2: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 2

OSCFIF	CMIF	_		BCL1IF	_	TMR3IF	CCP2IF
R/W-0	R/W-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0

bit 7 bit 0

bit 7 OSCFIF: Oscillator Fail Interrupt Flag bit

1 = Device oscillator failed, clock input has changed to INTOSC (must be cleared in software)

0 = Device clock operating

bit 6 CMIF: Comparator Interrupt Flag bit

1 = Comparator input has changed (must be cleared in software)

0 = Comparator input has not changed

bit 5-4 Unimplemented: Read as '0'

bit 3 **BCL1IF:** Bus Collision Interrupt Flag bit (MSSP1 module)

1 = A bus collision occurred (must be cleared in software)

0 = No bus collision occurred

bit 2 Unimplemented: Read as '0'

bit 1 TMR3IF: TMR3 Overflow Interrupt Flag bit

1 = TMR3 register overflowed (must be cleared in software)

0 = TMR3 register did not overflow

bit 0 CCP2IF: ECCP2 Interrupt Flag bit

Capture mode:

1 = A TMR1/TMR3 register capture occurred (must be cleared in software)

0 = No TMR1/TMR3 register capture occurred

Compare mode:

1 = A TMR1/TMR3 register compare match occurred (must be cleared in software)

0 = No TMR1/TMR3 register compare match occurred

PWM mode:

Unused in this mode.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

PIR3: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 3 **REGISTER 9-6:**

R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF
bit 7							bit 0

- bit 7 SSP2IF: Master Synchronous Serial Port 2 Interrupt Flag bit
 - 1 = The transmission/reception is complete (must be cleared in software)
 - 0 = Waiting to transmit/receive
- bit 6 BCL2IF: Bus Collision Interrupt Flag bit (MSSP2 module)
 - 1 = A bus collision occurred (must be cleared in software)
 - 0 = No bus collision occurred
- bit 5 RC2IF: EUSART2 Receive Interrupt Flag bit
 - 1 = The EUSART2 receive buffer, RCREGx, is full (cleared when RCREGx is read)
 - 0 = The EUSART2 receive buffer is empty
- bit 4 TX2IF: EUSART2 Transmit Interrupt Flag bit
 - 1 = The EUSART2 transmit buffer, TXREGx, is empty (cleared when TXREGx is written)
 - 0 = The EUSART2 transmit buffer is full
- bit 3 TMR4IF: TMR4 to PR4 Match Interrupt Flag bit
 - 1 = TMR4 to PR4 match occurred (must be cleared in software)
 - 0 = No TMR4 to PR4 match occurred
- bit 2 CCP5IF: CCP5 Interrupt Flag bit

Capture mode:

- 1 = A TMR1/TMR3 register capture occurred (must be cleared in software)
- 0 = No TMR1/TMR3 register capture occurred

Compare mode:

- 1 = A TMR1/TMR3 register compare match occurred (must be cleared in software)
- 0 = No TMR1/TMR3 register compare match occurred

PWM mode:

Unused in this mode.

bit 1 CCP4IF: CCP4 Interrupt Flag bit

Capture mode:

- 1 = A TMR1/TMR3 register capture occurred (must be cleared in software)
- 0 = No TMR1/TMR3 register capture occurred

Compare mode:

- 1 = A TMR1/TMR3 register compare match occurred (must be cleared in software)
- 0 = No TMR1/TMR3 register compare match occurred

Unused in this mode.

bit 0 **CCP3IF:** ECCP3 Interrupt Flag bit

Capture mode:

- 1 = A TMR1/TMR3 register capture occurred (must be cleared in software)
- 0 = No TMR1/TMR3 register capture occurred

Compare mode:

- 1 = A TMR1/TMR3 register compare match occurred (must be cleared in software)
- 0 = No TMR1/TMR3 register compare match occurred

PWM mode:

Unused in this mode.

L	ea	eı	าด	ŀ

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

9.3 PIE Registers

The PIE registers contain the individual enable bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are three Peripheral Interrupt Enable registers (PIE1, PIE2, PIE3). When IPEN = 0, the PEIE bit must be set to enable any of these peripheral interrupts.

REGISTER 9-7: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE
bit 7							bit 0

1 = Enables the PSP read/write interrupt

0 = Disables the PSP read/write interrupt

bit 6 ADIE: A/D Converter Interrupt Enable bit

1 = Enables the A/D interrupt

0 = Disables the A/D interrupt

bit 5 RC1IE: EUSART1 Receive Interrupt Enable bit

1 = Enables the EUSART1 receive interrupt

0 = Disables the EUSART1 receive interrupt

bit 4 **TX1IE:** EUSART1 Transmit Interrupt Enable bit

1 = Enables the EUSART1 transmit interrupt

0 = Disables the EUSART1 transmit interrupt

bit 3 SSP1IE: Master Synchronous Serial Port 1 Interrupt Enable bit

1 = Enables the MSSP1 interrupt

0 = Disables the MSSP1 interrupt

bit 2 CCP1IE: ECCP1 Interrupt Enable bit

1 = Enables the ECCP1 interrupt

0 = Disables the ECCP1 interrupt

bit 1 TMR2IE: TMR2 to PR2 Match Interrupt Enable bit

1 = Enables the TMR2 to PR2 match interrupt

0 = Disables the TMR2 to PR2 match interrupt

bit 0 TMR1IE: TMR1 Overflow Interrupt Enable bit

1 = Enables the TMR1 overflow interrupt

0 = Disables the TMR1 overflow interrupt

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 9-8: PIE2: PERIPHERAL INTERRUPT ENABLE REGISTER 2

R/W-0	R/W-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0
OSCFIE	CMIE	_	_	BCL1IE	_	TMR3IE	CCP2IE

bit 7 bit 0

bit 7 OSCFIE: Oscillator Fail Interrupt Enable bit

1 = Enabled0 = Disabled

bit 6 CMIE: Comparator Interrupt Enable bit

1 = Enabled
0 = Disabled

bit 5-4 **Unimplemented:** Read as '0'

bit 3 BCL1IE: Bus Collision Interrupt Enable bit (MSSP1 module)

1 = Enabled
0 = Disabled

bit 2 Unimplemented: Read as '0'

bit 1 TMR3IE: TMR3 Overflow Interrupt Enable bit

1 =Enabled 0 =Disabled

bit 0 CCP2IE: ECCP2 Interrupt Enable bit

1 = Enabled
0 = Disabled

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 9-9: PIE3: PERIPHERAL INTERRUPT ENABLE REGISTER 3

R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE
bit 7							bit 0

bit 7

bit 7 SSP2IE: Master Synchronous Serial Port 2 Interrupt Enable bit

1 = Enabled

0 = Disabled

BCL2IE: Bus Collision Interrupt Enable bit (MSSP2 module) bit 6

1 = Enabled

0 = Disabled

RC2IE: EUSART2 Receive Interrupt Enable bit bit 5

1 = Enabled

0 = Disabled

bit 4 TX2IE: EUSART2 Transmit Interrupt Enable bit

1 = Enabled

0 = Disabled

TMR4IE: TMR4 to PR4 Match Interrupt Enable bit bit 3

1 = Enabled

0 = Disabled

bit 2 CCP5IE: CCP5 Interrupt Enable bit

1 = Enabled

0 = Disabled

bit 1 CCP4IE: CCP4 Interrupt Enable bit

1 = Enabled

0 = Disabled

CCP3IE: ECCP3 Interrupt Enable bit bit 0

1 = Enabled

0 = Disabled

Legend:

U = Unimplemented bit, read as '0' R = Readable bit W = Writable bit

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

9.4 IPR Registers

The IPR registers contain the individual priority bits for the peripheral interrupts. Due to the number of peripheral interrupt sources, there are three Peripheral Interrupt Priority registers (IPR1, IPR2, IPR3). Using the priority bits requires that the Interrupt Priority Enable (IPEN) bit be set.

REGISTER 9-10: IPR1: PERIPHERAL INTERRUPT PRIORITY REGISTER 1

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP
bit 7							bit 0

bit 7 PSPIP: Parallel Slave Port Read/Write Interrupt Priority bit

1 = High priority0 = Low priority

bit 6 ADIP: A/D Converter Interrupt Priority bit

1 = High priority0 = Low priority

bit 5 RC1IP: EUSART1 Receive Interrupt Priority bit

1 = High priority0 = Low priority

bit 4 **TX1IP:** EUSART1 Transmit Interrupt Priority bit

1 = High priority0 = Low priority

bit 3 SSP1IP: Master Synchronous Serial Port 1 Interrupt Priority bit

1 = High priority
0 = Low priority

bit 2 CCP1IP: ECCP1 Interrupt Priority bit

1 = High priority0 = Low priority

bit 1 TMR2IP: TMR2 to PR2 Match Interrupt Priority bit

1 = High priority0 = Low priority

bit 0 TMR1IP: TMR1 Overflow Interrupt Priority bit

1 = High priority0 = Low priority

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 9-11: IPR2: PERIPHERAL INTERRUPT PRIORITY REGISTER 2

R/W-1	R/W1	U-0	U-0	R/W-1	U-0	R/W-1	R/W-1
OSCFIP	CMIP	1	_	BCL1IP	_	TMR3IP	CCP2IP

bit 7 bit 0

bit 7 OSCFIP: Oscillator Fail Interrupt Priority bit

1 = High priority0 = Low priority

bit 6 **CMIP:** Comparator Interrupt Priority bit

1 = High priority0 = Low priority

bit 5-4 **Unimplemented:** Read as '0'

bit 3 **BCL1IP:** Bus Collision Interrupt Priority bit (MSSP1 module)

1 = High priority0 = Low priority

bit 2 Unimplemented: Read as '0'

bit 1 TMR3IP: TMR3 Overflow Interrupt Priority bit

1 = High priority0 = Low priority

bit 0 CCP2IP: ECCP2 Interrupt Priority bit

1 = High priority0 = Low priority

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 9-12: IPR3: PERIPHERAL INTERRUPT PRIORITY REGISTER 3

–							
SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1

bit 7 bit 0

bit 7 SSP2IP: Master Synchronous Serial Port 2 Interrupt Priority bit

1 = High priority0 = Low priority

bit 6 BCL2IP: Bus Collision Interrupt Priority bit (MSSP2 module)

1 = High priority0 = Low priority

bit 5 RC2IP: EUSART2 Receive Interrupt Priority bit

1 = High priority0 = Low priority

bit 4 TX2IP: EUSART2 Transmit Interrupt Priority bit

1 = High priority0 = Low priority

bit 3 TMR4IE: TMR4 to PR4 Interrupt Priority bit

1 = High priority0 = Low priority

bit 2 CCP5IP: CCP5 Interrupt Priority bit

1 = High priority0 = Low priority

bit 1 CCP4IP: CCP4 Interrupt Priority bit

1 = High priority0 = Low priority

bit 0 CCP3IP: ECCP3 Interrupt Priority bit

1 = High priority0 = Low priority

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

9.5 RCON Register

The RCON register contains bits used to determine the cause of the last Reset or wake-up from Idle or Sleep modes. RCON also contains the bit that enables interrupt priorities (IPEN).

REGISTER 9-13: RCON: RESET CONTROL REGISTER

R/W-0	U-0	U-0	R/W-1	R-1	R-1	R/W-0	R/W-0
IPEN	_	_	RI	TO	PD	POR	BOR
bit 7							bit 0

bit 7 IPEN: Interrupt Priority Enable bit

1 = Enable priority levels on interrupts

0 = Disable priority levels on interrupts (PIC16CXXX Compatibility mode)

bit 6-5 Unimplemented: Read as '0'

bit 4 RI: RESET Instruction Flag bit

For details of bit operation, see Register 4-1.

bit 3 **TO:** Watchdog Timer Time-out Flag bit

For details of bit operation, see Register 4-1.

bit 2 PD: Power-Down Detection Flag bit

For details of bit operation, see Register 4-1.

bit 1 POR: Power-on Reset Status bit

For details of bit operation, see Register 4-1.

bit 0 BOR: Brown-out Reset Status bit

For details of bit operation, see Register 4-1.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

9.6 INTn Pin Interrupts

External interrupts on the RB0/INT0, RB1/INT1, RB2/INT2 and RB3/INT3 pins are edge-triggered. If the corresponding INTEDGx bit in the INTCON2 register is set (= 1), the interrupt is triggered by a rising edge; if the bit is clear, the trigger is on the falling edge. When a valid edge appears on the RBx/INTx pin, the corresponding flag bit, INTxIF, is set. This interrupt can be disabled by clearing the corresponding enable bit, INTxIE. Flag bit, INTxIF, must be cleared in software in the Interrupt Service Routine before re-enabling the interrupt.

All external interrupts (INT0, INT1, INT2 and INT3) can wake-up the processor from the power-managed modes if bit INTxIE was set prior to going into power-managed modes. If the Global Interrupt Enable bit, GIE, is set, the processor will branch to the interrupt vector following wake-up.

Interrupt priority for INT1, INT2 and INT3 is determined by the value contained in the interrupt priority bits, INT1IP (INTCON3<6>), INT2IP (INTCON3<7>) and INT3IP (INTCON2<1>). There is no priority bit associated with INT0. It is always a high priority interrupt source.

9.7 TMR0 Interrupt

In 8-bit mode (which is the default), an overflow in the TMR0 register (FFh \rightarrow 00h) will set flag bit, TMR0IF. In 16-bit mode, an overflow in the TMR0H:TMR0L register pair (FFFFh \rightarrow 0000h) will set TMR0IF. The interrupt can be enabled/disabled by setting/clearing enable bit, TMR0IE (INTCON<5>). Interrupt priority for Timer0 is determined by the value contained in the interrupt priority bit, TMR0IP (INTCON2<2>). See **Section 11.0** "**Timer0 Module**" for further details on the Timer0 module.

9.8 PORTB Interrupt-on-Change

An input change on PORTB<7:4> sets flag bit, RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit, RBIE (INTCON<3>). Interrupt priority for PORTB interrupt-on-change is determined by the value contained in the interrupt priority bit, RBIP (INTCON2<0>).

9.9 Context Saving During Interrupts

During interrupts, the return PC address is saved on the stack. Additionally, the WREG, STATUS and BSR registers are saved on the fast return stack. If a fast return from interrupt is not used (see **Section 5.3** "**Data Memory Organization**"), the user may need to save the WREG, STATUS and BSR registers on entry to the Interrupt Service Routine. Depending on the user's application, other registers may also need to be saved. Example 9-1 saves and restores the WREG, STATUS and BSR registers during an Interrupt Service Routine.

EXAMPLE 9-1: SAVING STATUS, WREG AND BSR REGISTERS IN RAM

```
; W TEMP is in virtual bank
MOVWE
         м темр
MOVFF
         STATUS, STATUS TEMP
                                       ; STATUS TEMP located anywhere
         BSR, BSR TEMP
                                       ; BSR TMEP located anywhere
MOVEE
; USER ISR CODE
MOVFF
         BSR_TEMP, BSR
                                       ; Restore BSR
MOVE
         W TEMP, W
                                       ; Restore WREG
         STATUS TEMP, STATUS
MOVFF
                                       : Restore STATUS
```

10.0 I/O PORTS

Depending on the device selected and features enabled, there are up to nine ports available. Some pins of the I/O ports are multiplexed with an alternate function from the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

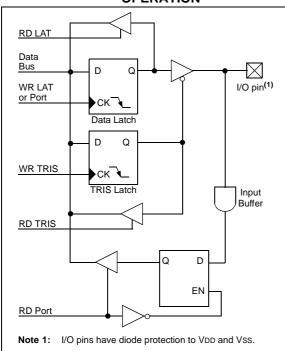
Each port has three registers for its operation. These registers are:

- TRIS register (data direction register)
- Port register (reads the levels on the pins of the device)
- LAT register (output latch)

The Data Latch (LAT register) is useful for read-modify-write operations on the value that the I/O pins are driving.

A simplified model of a generic I/O port, without the interfaces to other peripherals, is shown in Figure 10-1.

FIGURE 10-1: GENERIC I/O PORT OPERATION



10.1 I/O Port Pin Capabilities

When developing an application, the capabilities of the port pins must be considered. Outputs on some pins have higher output drive strength than others. Similarly, some pins can tolerate higher than VDD input levels.

10.1.1 PIN OUTPUT DRIVE

The output pin drive strengths vary for groups of pins intended to meet the needs for a variety of applications. PORTB and PORTC are designed to drive higher loads, such as LEDs. The external memory interface ports (PORTD, PORTE and PORTJ) are designed to drive medium loads. All other ports are designed for small loads, typically indication only. Table 10-1 summarizes the output capabilities. Refer to **Section 26.0** "Electrical Characteristics" for more details.

TABLE 10-1: OUTPUT DRIVE LEVELS

Port	Drive	Description
PORTA	Minimum	Intended for indication.
PORTF		
PORTG		
PORTH ⁽¹⁾		
PORTD	Medium	Sufficient drive levels for
PORTE		external memory interfacing
PORTJ ⁽¹⁾		as well as indication.
PORTB	High	Suitable for direct LED drive
PORTC		levels.

Note 1: These ports are not available on 64-pin devices.

INPUT PINS AND VOLTAGE 10.1.2 **CONSIDERATIONS**

The voltage tolerance of pins used as device inputs is dependent on the pin's input function. Pins that are used as digital only inputs are able to handle DC voltages up to 5.5V, a level typical for digital logic circuits. In contrast, pins that also have analog input functions of any kind can only tolerate voltages up to VDD. Voltage excursions beyond VDD on these pins should be avoided. Table 10-2 summarizes the input capabilities. Refer to Section 26.0 "Electrical Characteristics" for more details.

TABLE 10-2: INPUT VOLTAGE LEVELS

Port or Pin	Tolerated Input	Description
PORTA<5:0>	VDD	Only VDD input levels
PORTC<1:0>		tolerated.
PORTF<6:1>		
PORTH<7:4>(1)		
PORTB<7:0>	5.5V	Tolerates input levels
PORTC<7:2>		above VDD, useful for
PORTD<7:0>		most standard logic.
PORTE<7:0>		
PORTF<7>		
PORTG<4:0>		
PORTH<3:0> ⁽¹⁾		
PORTJ<7:0>(1)		

Note 1: These ports are not available on 64-pin devices.

10.2 PORTA, TRISA and **LATA Registers**

PORTA is a 6-bit wide, bidirectional port. The corresponding data direction register is TRISA. Setting a TRISA bit (= 1) will make the corresponding PORTA pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISA bit (= 0) will make the corresponding PORTA pin an output (i.e., put the contents of the output latch on the selected pin).

Reading the PORTA register reads the status of the pins, whereas writing to it, will write to the port latch.

The Data Latch register (LATA) is also memory mapped. Read-modify-write operations on the LATA register read and write the latched output value for PORTA.

The RA4 pin is multiplexed with the Timer0 module clock input to become the RA4/T0CKI pin. The other PORTA pins are multiplexed with the analog VREF+ and VREF- inputs. The operation of pins RA5:RA0 as A/D converter inputs is selected by clearing or setting the PCFG3:PCFG0 control bits in the ADCON1 register.

RA5 and RA3:RA0 are configured as analog inputs on any Reset and are read as '0'. RA4 is configured as a digital input.

The RA4/T0CKI pin is a Schmitt Trigger input. All other PORTA pins have TTL input levels and full CMOS output drivers.

The TRISA register controls the direction of the PORTA pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs.

EXAMPLE 10-1: INITIALIZING PORTA

CLRF	PORTA	; Initialize PORTA by
		; clearing output
		; data latches
CLRF	LATA	; Alternate method
		; to clear output
		; data latches
MOVLW	07h	; Configure A/D
MOVWF	ADCON1	; for digital inputs
MOVWF	07h	; Configure comparators
MOVWF	CMCON	; for digital input
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISA	; Set RA<3:0> as inputs
		; RA<5:4> as outputs

TABLE 10-3: PORTA FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RA0/AN0	RA0	0	0	DIG	LATA<0> data output; not affected by analog input.
		1	I	TTL	PORTA<0> data input; disabled when analog input enabled.
	AN0		I	ANA	A/D input channel 0. Default input configuration on POR; does not affect digital output.
RA1/AN1	RA1	0	0	DIG	LATA<1> data output; not affected by analog input.
		1	I	TTL	PORTA<1> data input; disabled when analog input enabled.
	AN1		I	ANA	A/D input channel 1. Default input configuration on POR; does not affect digital output.
RA2/AN2/VREF-	RA2	0	0	DIG	LATA<2> data output; not affected by analog input. Disabled when CVREF output enabled.
		1	I	TTL	PORTA<2> data input. Disabled when analog functions enabled; disabled when CVREF output enabled.
	AN2	1	I	ANA	A/D input channel 2 and Comparator C2+ input. Default input configuration on POR; not affected by analog output.
	VREF-	1	I	ANA	A/D and Comparator low reference voltage input.
RA3/AN3/VREF+	RA3	0	0	DIG	LATA<3> data output; not affected by analog input.
		1	I	TTL	PORTA<3> data input; disabled when analog input enabled.
	AN3	1	I	ANA	A/D input channel 3. Default input configuration on POR.
	VREF+	1	I	ANA	A/D high reference voltage input.
RA4/T0CKI	RA4	0	0	DIG	LATA<4> data output.
		1	I	ST	PORTA<4> data input; default configuration on POR.
	T0CKI	х	I	ST	Timer0 clock input.
RA5/AN4	RA5	0	0	DIG	LATA<5> data output; not affected by analog input.
		1	I	TTL	PORTA<5> data input; disabled when analog input enabled.
	AN4	1	ı	ANA	A/D input channel 4. Default configuration on POR.

Legend: PWR = Power Supply, O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 10-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTA	_	_	RA5	RA4	RA3	RA2	RA1	RA0	52
LATA	_	_	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	52
TRISA	_	_	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	52
ADCON1	_	1	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	50

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTA.

10.3 PORTB, TRISB and LATB Registers

PORTB is an 8-bit wide, bidirectional port. The corresponding data direction register is TRISB. Setting a TRISB bit (= 1) will make the corresponding PORTB pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISB bit (= 0) will make the corresponding PORTB pin an output (i.e., put the contents of the output latch on the selected pin). All pins on PORTB are digital only and tolerate voltages up to 5.5V.

The Data Latch register (LATB) is also memory mapped. Read-modify-write operations on the LATB register read and write the latched output value for PORTB.

EXAMPLE 10-2: INITIALIZING PORTB

CLRF	PORTB	; Initialize PORTB by
		; clearing output
		; data latches
CLRF	LATB	; Alternate method
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISB	; Set RB<3:0> as inputs
		; RB<5:4> as outputs
		; RB<7:6> as inputs

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is performed by clearing bit RBPU (INTCON2<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on a Power-on Reset.

Four of the PORTB pins (RB7:RB4) have an interrupt-on-change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB7:RB4 pin configured as an output is excluded from the interrupt-on-change comparison). The input pins (of RB7:RB4) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB7:RB4 are ORed together to generate the RB Port Change Interrupt with Flag bit, RBIF (INTCON<0>).

This interrupt can wake the device from power-managed modes. The user, in the Interrupt Service Routine, can clear the interrupt in the following manner:

- Any read or write of PORTB (except with the MOVFF (ANY), PORTB instruction). This will end the mismatch condition.
- b) Clear flag bit RBIF.

A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition and allow flag bit RBIF to be cleared.

The interrupt-on-change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt-on-change feature. Polling of PORTB is not recommended while using the interrupt-on-change feature.

For 80-pin devices, RB3 can be configured as the alternate peripheral pin for the ECCP2 module and Enhanced PWM output 2A by clearing the CCP2MX configuration bit. This applies only to 80-pin devices operating in Extended Microcontroller mode. If the device is in Microcontroller mode, the alternate assignment for ECCP2 is RE7. As with other ECCP2 configurations, the user must ensure that the TRISB<3> bit is set appropriately for the intended operation.

TABLE 10-5: PORTB FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description			
RB0/INT0/FLT0	RB0	0	0	DIG	LATB<0> data output.			
		1	I	TTL	PORTB<0> data input; weak pull-up when RBPU bit is cleared.			
	INT0	1	I	ST	External interrupt 0 input.			
	FLT0	1	I	ST	Enhanced PWM Fault input (ECCP1 module); enabled in software.			
RB1/INT1	RB1	0	0	DIG	LATB<1> data output.			
		1	Ι	TTL	PORTB<1> data input; weak pull-up when RBPU bit is cleared.			
	INT1	1	I	ST	External interrupt 1 input.			
RB2/INT2	RB2	0	0	DIG	LATB<2> data output.			
		1	I	TTL	PORTB<2> data input; weak pull-up when RBPU bit is cleared.			
	INT2	1	I	ST	External interrupt 2 input.			
RB3/INT3/	RB3	0	0	DIG	LATB<3> data output.			
ECCP2/P2A		1	I	TTL	PORTB<3> data input; weak pull-up when RBPU bit is cleared.			
	INT3	1	I	ST	External interrupt 3 input.			
	ECCP2 ⁽¹⁾	0	0	DIG	CCP2 Compare output and CCP2 PWM output; takes priority over port data.			
		1	I	ST	CCP2 Capture input.			
	P2A ⁽¹⁾	0	0	DIG	ECCP2 Enhanced PWM output, channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.			
RB4/KBI0	RB4	0	0	DIG	LATB<4> data output.			
		1	I	TTL	PORTB<4> data input; weak pull-up when RBPU bit is cleared.			
	KBI0		I	TTL	Interrupt on pin change.			
RB5/KBI1	RB5	0	0	DIG	LATB<5> data output.			
		1	I	TTL	PORTB<5> data input; weak pull-up when RBPU bit is cleared.			
	KBI1		I	TTL	Interrupt on pin change.			
RB6/KBI2/PGC	RB6	0	0	DIG	LATB<6> data output.			
		1	ı	TTL	PORTB<6> data input; weak pull-up when RBPU bit is cleared.			
	KBI2	1	I	TTL	Interrupt on pin change.			
	PGC	х	ı	ST	Serial execution (ICSP™) clock input for ICSP and ICD operation. (2)			
RB7/KBI3/PGD RB7 0 O DIG LATB<7> data output.		LATB<7> data output.						
		1	I	TTL	PORTB<7> data input; weak pull-up when RBPU bit is cleared.			
	KBI3	1	I	TTL	Interrupt on pin change.			
	PGD	х	0	DIG	Serial execution data output for ICSP and ICD operation. (2)			
		х	I	ST	Serial execution data input for ICSP and ICD operation. (2)			

Legend: PWR = Power Supply, O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Alternate assignment for ECCP2/P2A when the CCP2MX configuration bit is cleared (Extended Microcontroller mode, 80-pin devices only). Default assignment is RC1.

^{2:} All other pin functions are disabled when ICSP or ICD are enabled.

TABLE 10-6: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	52
LATB	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	52
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	52
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	49
INTCON3	INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF	49

Legend: Shaded cells are not used by PORTB.

10.4 PORTC, TRISC and LATC Registers

PORTC is an 8-bit wide, bidirectional port. The corresponding data direction register is TRISC. Setting a TRISC bit (= 1) will make the corresponding PORTC pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISC bit (= 0) will make the corresponding PORTC pin an output (i.e., put the contents of the output latch on the selected pin). Only PORTC pins RC2 through RC7 are digital only pins and can tolerate input voltages up to 5.5V.

The Data Latch register (LATC) is also memory mapped. Read-modify-write operations on the LATC register read and write the latched output value for PORTC.

PORTC is multiplexed with several peripheral functions (Table 10-7). The pins have Schmitt Trigger input buffers. RC1 is normally configured by configuration bit CCP2MX as the default peripheral pin for the ECCP2 module and enhanced PWM output P2A (default state, CCP2MX = 1).

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTC pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. The user should refer to the corresponding peripheral section for the correct TRIS bit settings.

Note: These pins are configured as digital inputs on any device Reset.

The contents of the TRISC register are affected by peripheral overrides. Reading TRISC always returns the current contents, even though a peripheral device may be overriding one or more of the pins.

EXAMPLE 10-3: INITIALIZING PORTC

CLRF	PORTC	; Initialize PORTC by ; clearing output : data latches
CLRF	LATC	; Alternate method ; to clear output
		; data latches
MOVLW	0CFh	<pre>; Value used to : initialize data</pre>
		; direction
MOVWF	TRISC	; Set RC<3:0> as inputs
		; RC<5:4> as outputs ; RC<7:6> as inputs

TABLE 10-7: PORTC FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description			
RC0/T1OSO/	RC0	0	0	DIG	LATC<0> data output.			
T13CKI		1	-	ST	PORTC<0> data input.			
	T10S0	х	0	ANA	Timer1 oscillator output; enabled when Timer1 oscillator enabled. Disables digital I/O.			
	T13CKI	1	-	ST	Timer1/Timer3 counter input.			
RC1/T1OSI/	RC1	0	0	DIG	LATC<1> data output.			
ECCP2/P2A		1	ı	ST	PORTC<1> data input.			
	T1OSI	х	_	ANA	digital I/O.			
	ECCP2 ⁽¹⁾	0	0	DIG	CCP2 Compare output and CCP2 PWM output; takes priority over port data.			
		1		ST	CCP2 Capture input.			
	P2A ⁽¹⁾	0	0	DIG	ECCP2 Enhanced PWM output, channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.			
RC2/ECCP1/	RC2	0	0	DIG	LATC<2> data output.			
P1A		1		ST	PORTC<2> data input.			
	ECCP1	0	0	DIG	CCP1 Compare output and CCP1 PWM output; takes priority over port data.			
		1	-	ST	CCP1 Capture input.			
	P1A	0	0	DIG	ECCP1 Enhanced PWM output, channel A. May be configured for tri-state during Enhanced PWM shutdown events. Takes priority over port data.			
RC3/SCK1/	RC3	0	0	DIG	LATC<3> data output.			
SCL1		1	I	ST	PORTC<3> data input.			
	SCK1	0	0	DIG	SPI™ clock output (MSSP1 module); takes priority over port data.			
		1		ST	SPI clock input (MSSP1 module).			
	SCL1	SCL1 0 O DIG I ² C™ clock output (MSSP1 module); tal		I ² C™ clock output (MSSP1 module); takes priority over port data.				
		1	- 1	ST	I ² C clock input (MSSP1 module); input type depends on module setting.			
RC4/SDI1/	RC4	0	0	DIG	LATC<4> data output.			
SDA1		1	-	ST	PORTC<4> data input.			
	SDI1	1	- 1	ST	SPI data input (MSSP1 module).			
	SDA1	1	0	DIG	I ² C data output (MSSP1 module); takes priority over port data.			
		1	I	ST	I ² C data input (MSSP1 module); input type depends on module setting.			
RC5/SDO1	RC5	0	0	DIG	LATC<5> data output.			
		1	I	ST	PORTC<5> data input.			
	SDO1	0	0	DIG	SPI data output (MSSP1 module); takes priority over port data.			
RC6/TX1/CK1	RC6	0	0	DIG	LATC<6> data output.			
		1	I	ST	PORTC<6> data input.			
	TX1	1	0	DIG	Synchronous serial data output (EUSART1 module); takes priority over port data.			
	CK1	1	0	DIG	Synchronous serial data input (EUSART1 module). User must configure as an input.			
		1	I	ST	Synchronous serial clock input (EUSART1 module).			
RC7/RX1/DT1	RC7	0	0	DIG	LATC<7> data output.			
		1	ı	ST	PORTC<7> data input.			
	RX1	1	I	ST	Asynchronous serial receive data input (EUSART1 module).			
	DT1	1	0	DIG	Synchronous serial data output (EUSART1 module); takes priority over port data.			
		1	I	ST	Synchronous serial data input (EUSART1 module). User must configure as an input.			

Legend: PWR = Power Supply, O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Default assignment for ECCP2/P2A when CCP2MX configuration bit is set.

TABLE 10-8: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	52
LATC	LATC7	LATBC6	LATC5	LATCB4	LATC3	LATC2	LATC1	LATC0	52
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	52

Legend: Shaded cells are not used by PORTC.

10.5 PORTD, TRISD and LATD Registers

PORTD is an 8-bit wide, bidirectional port. The corresponding data direction register is TRISD. Setting a TRISD bit (= 1) will make the corresponding PORTD pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISD bit (= 0) will make the corresponding PORTD pin an output (i.e., put the contents of the output latch on the selected pin). All pins on PORTD are digital only and tolerate voltages up to 5.5V.

The Data Latch register (LATD) is also memory mapped. Read-modify-write operations on the LATD register read and write the latched output value for PORTD.

All pins on PORTD are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

Note: These pins are configured as digital inputs on any device Reset.

On 80-pin devices, PORTD is multiplexed with the system bus as part of the external memory interface. I/O port and other functions are only available when the interface is disabled, by setting the EBDIS bit (MEMCON<7>). When the interface is enabled, PORTD is the low-order byte of the multiplexed address/data bus (AD7:AD0). The TRISD bits are also overridden.

Each of the PORTD pins has a weak internal pull-up. The pull-ups are provided to keep the inputs at a known state for the external memory interface while powering up. A single control bit can turn off all the pull-ups. This is performed by clearing bit RDPU (PORTG<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on all device Resets.

PORTD can also be configured to function as an 8-bit wide, parallel microprocessor port by setting the PSPMODE control bit (PSPCON<4>). In this mode, parallel port data takes priority over other digital I/O (but not the external memory interface). When the parallel port is active, the input buffers are TTL. For more information, refer to **Section 10.11 "Parallel Slave Port"**.

EXAMPLE 10-4: INITIALIZING PORTD

CLRF	PORTD	; Initialize PORTD by
		; clearing output
		; data latches
CLRF	LATD	; Alternate method
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISD	; Set RD<3:0> as inputs
		; RD<5:4> as outputs
		; RD<7:6> as inputs

TABLE 10-9: PORTD FUNCTIONS

Pin Name	Function	TRIS Setting	1/0	I/O Type	Description
RD0/AD0/PSP0	RD0	0	0	DIG	LATD<0> data output.
	•	1	I	ST	PORTD<0> data input.
	AD0 ⁽²⁾	х	0	DIG	External memory interface, address/data bit 0 output.(1)
	•	х	I	TTL	External memory interface, data bit 0 input.(1)
	PSP0		0	DIG	PSP read output data (LATD<0>); takes priority over port data.
	•		I	TTL	PSP write data input.
RD1/AD1/PSP1	RD1	0	0	DIG	LATD<1> data output.
	·	1	I	ST	PORTD<1> data input.
	AD1 ⁽²⁾	х	0	DIG	External memory interface, address/data bit 1 output. (1)
	·	х	I	TTL	External memory interface, data bit 1 input. (1)
	PSP1	х	0	DIG	PSP read output data (LATD<1>); takes priority over port data.
	•	х	I	TTL	PSP write data input.
RD2/AD2/PSP2	RD2	0	0	DIG	LATD<2> data output.
	·	1	I	ST	PORTD<2> data input.
	AD2 ⁽²⁾	х	0	DIG	External memory interface, address/data bit 2 output. (1)
	•	х	I	TTL	External memory interface, data bit 2 input. (1)
	PSP2	х	0	DIG	PSP read output data (LATD<2>); takes priority over port data.
		х	I	TTL	PSP write data input.
RD3/AD3/PSP3	RD3	0	0	DIG	LATD<3> data output.
	•	1	I	ST	PORTD<3> data input.
	AD3 ⁽²⁾	х	0	DIG	External memory interface, address/data bit 3 output. (1)
	•	х	I	TTL	External memory interface, data bit 3 input. (1)
	PSP3	х	0	DIG	PSP read output data (LATD<3>); takes priority over port data.
	•	х	I	TTL	PSP write data input.
RD4/AD4/	RD4	0	0	DIG	LATD<4> data output.
PSP4/SDO2	•	1	I	ST	PORTD<4> data input.
	AD4 ⁽²⁾	х	0	DIG	External memory interface, address/data bit 4 output. (1)
	•	х	I	TTL	External memory interface, data bit 4 input. (1)
	PSP4	х	0	DIG	PSP read output data (LATD<4>); takes priority over port data.
	•	х	ı	TTL	PSP write data input.
	SDO2	0	0	DIG	SPI™ data output (MSSP2 module); takes priority over port data.
RD5/AD5/	RD5	0	0	DIG	LATD<5> data output.
PSP5/SDI2/		1	I	ST	PORTD<5> data input.
SDA2	AD5 ⁽²⁾	х	0	DIG	External memory interface, address/data bit 5 output. (1)
	•	х	I	TTL	External memory interface, data bit 5 input. ⁽¹⁾
ļ	PSP5	х	0	DIG	PSP read output data (LATD<5>); takes priority over port data.
	•	х	I	TTL	PSP write data input.
ļ	SDI2	1	I	ST	SPI data input (MSSP2 module).
	SDA2	1	0	DIG	I ² C™ data output (MSSP2 module); takes priority over port data.
		1	I	ST	I ² C data input (MSSP2 module); input type depends on module setting.

Legend: PWR = Power Supply, O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: External memory interface I/O takes priority over all other digital and PSP I/O.

2: Available on 80-pin devices only.

TABLE 10-9: PORTD FUNCTIONS (CONTINUED)

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RD6/AD6/	RD6	0	0	DIG	LATD<6> data output.
PSP6/SCK2/		1	ı	ST	PORTD<6> data input.
SCL2	AD6 ⁽²⁾	х	0	DIG-3	External memory interface, address/data bit 6 output. (1)
		х	I	TTL	External memory interface, data bit 6 input. (1)
	PSP6	х	0	DIG	PSP read output data (LATD<6>); takes priority over port data.
		х	I	TTL	PSP write data input.
	SCK1	0	0	DIG	SPI™ clock output (MSSP2 module); takes priority over port data.
		1	I	ST	SPI clock input (MSSP2 module).
	SCL1	0	0	DIG	I ² C™ clock output (MSSP2 module); takes priority over port data.
		1	I	ST	I ² C clock input (MSSP2 module); input type depends on module setting.
RD7/AD7/	RD7	0	0	DIG	LATD<7> data output.
PSP7/SS2		1	I	ST	PORTD<7> data input.
	AD7 ⁽²⁾	х	0	DIG	External memory interface, address/data bit 7 output. (1)
		х	ı	TTL	External memory interface, data bit 7 input. ⁽¹⁾
	PSP7	х	0	DIG	PSP read output data (LATD<7>); takes priority over port data.
		х		TTL	PSP write data input.
	SS2	х	1	TTL	Slave select input for SSP (MSSP2 module).

Legend: PWR = Power Supply, O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: External memory interface I/O takes priority over all other digital and PSP I/O.

2: Available on 80-pin devices only.

TABLE 10-10: SUMMARY OF REGISTERS ASSOCIATED WITH PORTD

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	52
LATD	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0	52
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	52
PORTG	RDPU	REPU	RJPU ⁽¹⁾	RG4	RG3	RG2	RG1	RG0	52

Legend: Shaded cells are not used by PORTD.

Note 1: Unimplemented on 64-pin devices; read as '0'.

10.6 PORTE, TRISE and LATE Registers

PORTE is a 7-bit wide, bidirectional port. The corresponding data direction register is TRISE. Setting a TRISE bit (= 1) will make the corresponding PORTE pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISE bit (= 0) will make the corresponding PORTE pin an output (i.e., put the contents of the output latch on the selected pin). All pins on PORTE are digital only and tolerate voltages up to 5.5V.

The Data Latch register (LATE) is also memory mapped. Read-modify-write operations on the LATE register read and write the latched output value for PORTE.

All pins on PORTE are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

Note: These pins are configured as digital inputs on any device Reset.

On 80-pin devices, PORTE is multiplexed with the system bus as part of the external memory interface. I/O port and other functions are only available when the interface is disabled, by setting the EBDIS bit (MEMCON<7>). When the interface is enabled, PORTE is the high-order byte of the multiplexed address/data bus (AD15:AD8). The TRISE bits are also overridden.

Each of the PORTE pins has a weak internal pull-up. The pull-ups are provided to keep the inputs at a known state for the external memory interface while powering up. A single control bit can turn off all the pull-ups. This is performed by clearing bit REPU (PORTG<6>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on any device Reset.

PORTE is also multiplexed with Enhanced PWM outputs B and C for ECCP1 and ECCP3 and outputs B, C and D for ECCP2. For all devices, their default assignments are on PORTE<6:3>. On 80-pin devices, the multiplexing for the outputs of ECCP1 and ECCP3 is controlled by the ECCPMX configuration bit. Clearing this bit reassigns the P1B/P1C and P3B/P3C outputs to PORTH.

For devices operating in Microcontroller mode, pin RE7 can be configured as the alternate peripheral pin for the ECCP2 module and Enhanced PWM output 2A. This is done by clearing the CCP2MX configuration bit.

When the Parallel Slave Port is active on PORTD, three of the PORTE pins (RE0, RE1 and RE2) are configured as digital control inputs for the port. The control functions are summarized in Table 10-11. The reconfiguration occurs automatically when the PSPMODE control bit (PSPCON<4>) is set. Users must still make certain the corresponding TRISE bits are set to configure these pins as digital inputs.

EXAMPLE 10-5: INITIALIZING PORTE

CLRF	PORTE	; Initialize PORTE by ; clearing output
CLRF	LATE	<pre>; data latches ; Alternate method ; to clear output</pre>
MOVLW	03h	; data latches ; Value used to : initialize data
MOVWF	TRISE	; direction ; Set RE<1:0> as inputs ; RE<7:2> as outputs

TABLE 10-11: PORTE FUNCTIONS

Pin Name	Function	TRIS Setting	1/0	I/O Type	Description					
RE0/AD8/RD/	RE0	0	0	DIG	LATE<0> data output.					
P2D		1	I	ST	PORTE<0> data input.					
	AD8 ⁽³⁾	х	0	DIG	External memory interface, address/data bit 8 output. (2)					
		х	I	TTL	External memory interface, data bit 8 input. (2)					
	RD	1	I	TTL	Parallel Slave Port read enable control input.					
	P2D	0	0	DIG	and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.					
RE1/AD9/WR/	RE1	0	0	DIG	LATE<1> data output.					
P2C		1	I	ST	PORTE<1> data input.					
	AD9 ⁽³⁾	х	0	DIG	External memory interface, address/data bit 9 output. (2)					
		х	I	TTL	External memory interface, data bit 9 input.(2)					
	WR	1	I	TTL	Parallel Slave Port write enable control input.					
	P2C	0								
RE2/AD10/CS/	RE2	0	0	DIG	LATE<2> data output.					
P2B		1	I	ST	PORTE<2> data input.					
	AD10 ⁽³⁾	х	0	DIG	External memory interface, address/data bit 10 output.(2)					
		х	I	TTL	External memory interface, data bit 10 input. (2)					
	CS	1	I	TTL	Parallel Slave Port chip select control input.					
	P2B	0	0	DIG	ECCP2 Enhanced PWM output, channel B; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.					
RE3/AD11/	RE3	0	0	DIG	LATE<3> data output.					
P3C		1	I	ST	PORTE<3> data input.					
	AD11 ⁽³⁾	х	0	DIG	External memory interface, address/data bit 11 output.(2)					
		х	I	TTL	External memory interface, data bit 11 input. (2)					
	P3C ⁽¹⁾	0	0	DIG	ECCP3 Enhanced PWM output, channel C; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.					
RE4/AD12/	RE4	0	0	DIG	LATE<4> data output.					
P3B		1	I	ST	PORTE<4> data input.					
	AD12 ⁽³⁾	х	0	DIG	External memory interface, address/data bit 12 output. (2)					
		х	I	TTL	External memory interface, data bit 12 input. (2)					
	P3B ⁽¹⁾ 0 O DIG ECCP3 Enhanced PWM output, cha PSP data. May be configured for tri-		ECCP3 Enhanced PWM output, channel B; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.							
RE5/AD13/	RE5	0	0	DIG	LATE<5> data output.					
P1C		1	I	ST	PORTE<5> data input.					
	AD13 ⁽³⁾	х	0	DIG	External memory interface, address/data bit 13 output. (2)					
		х	I	TTL	External memory interface, data bit 13 input. (2)					
	P1C ⁽¹⁾	0	0	DIG	ECCP1 Enhanced PWM output, channel C; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.					

Legend: PWR = Power Supply, O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Default assignments for P1B/P1C and P3B/P3C when ECCPMX configuration bit is set (80-pin devices only).

- 2: External memory interface I/O takes priority over all other digital and PSP I/O.
- 3: Available on 80-pin devices only.
- 4: Alternate assignment for ECCP2/P2A when CCP2MX configuration bit is cleared (all devices in Microcontroller mode).

TABLE 10-11: PORTE FUNCTIONS (CONTINUED)

					- /		
Pin Name	Function	TRIS Setting	1/0	I/O Type	Description		
RE6/AD14/	RE6	0	0	DIG	LATE<6> data output.		
P1B		1	I	ST	PORTE<6> data input.		
	AD14 ⁽³⁾	х	0	DIG	External memory interface, address/data bit 14 output. (2)		
		х	I	TTL	External memory interface, data bit 14 input. (2)		
	P1B ⁽¹⁾	0	0	DIG	ECCP1 Enhanced PWM output, channel B; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.		
RE7/AD15/	RE7	0	0	DIG	LATE<7> data output.		
ECCP2/P2A		1	I	ST	PORTE<7> data input.		
	AD15 ⁽³⁾	х	0	DIG	External memory interface, address/data bit 15 output. (2)		
	•	х	I	TTL	External memory interface, data bit 15 input. (2)		
	ECCP2 ⁽⁴⁾	0	0	DIG	CCP2 compare output and CCP2 PWM output; takes priority over port data.		
	•	1	I	ST	CCP2 capture input.		
	P2A ⁽⁴⁾	0	0	DIG	ECCP2 Enhanced PWM output, channel A; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.		

Legend: PWR = Power Supply, O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Default assignments for P1B/P1C and P3B/P3C when ECCPMX configuration bit is set (80-pin devices only).

- 2: External memory interface I/O takes priority over all other digital and PSP I/O.
- 3: Available on 80-pin devices only.
- 4: Alternate assignment for ECCP2/P2A when CCP2MX configuration bit is cleared (all devices in Microcontroller mode).

TABLE 10-12: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTE	RE7	RE6	RE5	RE4	RE3	RE2	RE1	RE0	52
LATE	LATE7	LATE6	LATE5	LATE4	LATE3	LATE2	LATE1	LATE0	52
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	52
PORTG	RDPU	REPU	RJPU ⁽¹⁾	RG4	RG3	RG2	RG1	RG0	52

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTE.

Note 1: Unimplemented on 64-pin devices; read as '0'.

10.7 PORTF, LATF and TRISF Registers

PORTF is a 7-bit wide, bidirectional port. The corresponding data direction register is TRISF. Setting a TRISF bit (= 1) will make the corresponding PORTF pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISF bit (= 0) will make the corresponding PORTF pin an output (i.e., put the contents of the output latch on the selected pin). Only pin 7 of PORTF has no analog input; it is the only pin that can tolerate voltages up to 5.5V.

The Data Latch register (LATF) is also memory mapped. Read-modify-write operations on the LATF register read and write the latched output value for PORTF.

All pins on PORTF are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

PORTF is multiplexed with several analog peripheral functions, including the A/D converter and comparator inputs, as well as the comparator outputs. Pins RF2 through RF6 may be used as comparator inputs or outputs by setting the appropriate bits in the CMCON register. To use RF3:RF6 as digital inputs, it is also necessary to turn off the comparators.

- **Note 1:** On device Resets, pins RF6:RF1 are configured as analog inputs and are read as '0'.
 - 2: To configure PORTF as digital I/O, turn off comparators and set ADCON1 value.

EXAMPLE 10-6: INITIALIZING PORTF

```
CLRF
       PORTF
               ; Initialize PORTF by
               ; clearing output
               ; data latches
CLRF
       T.ATF
               ; Alternate method
               ; to clear output
               ; data latches
MOVLW
       07h
MOVWF
       CMCON
              ; Turn off comparators
MOVLW
       OFh:
MOVWF
       ADCON1 ; Set PORTF as digital I/O
M.TVOM
       OCEh
              ; Value used to
               ; initialize data
               ; direction
MOVWF
       TRISF
              ; Set RF3:RF1 as inputs
               ; RF5:RF4 as outputs
               ; RF7:RF6 as inputs
```

TABLE 10-13: PORTF FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RF1/AN6/	RF1	0	0	DIG	LATF<1> data output; not affected by analog input.
C2OUT	•	1	I	ST	PORTF<1> data input; disabled when analog input enabled.
	AN6	1	I	ANA	A/D input channel 6. Default configuration on POR.
	C2OUT	0	0	DIG	Comparator 2 output; takes priority over port data.
RF2/AN7/	RF2	0	0	DIG	LATF<2> data output; not affected by analog input.
C1OUT	•	1	I	ST	PORTF<2> data input; disabled when analog input enabled.
	AN7	1	I	ANA	A/D input channel 7. Default configuration on POR.
	C1OUT	0	0	TTL	Comparator 1 output; takes priority over port data.
RF3/AN8	RF3	0	0	DIG	LATF<3> data output; not affected by analog input.
	•	1	I	ST	PORTF<3> data input; disabled when analog input enabled.
	AN8	1	I	ANA	A/D input channel 8 and Comparator C2+ input. Default input configuration on POR; not affected by analog output.
RF4/AN9	RF4	0	0	DIG	LATF<4> data output; not affected by analog input.
		1	I	ST	PORTF<4> data input; disabled when analog input enabled.
	AN9	1	I	ANA	A/D input channel 9 and Comparator C2- input. Default input configuration on POR; does not affect digital output.
RF5/AN10/ CVREF	RF5	0	0	DIG	LATF<5> data output; not affected by analog input. Disabled when CVREF output enabled.
		1	I	ST	PORTF<5> data input; disabled when analog input enabled. Disabled when CVREF output enabled.
	AN10	1	I	ANA	A/D input channel 10 and Comparator C1+ input. Default input configuration on POR.
	CVREF	х	0	ANA	Comparator voltage reference output. Enabling this feature disables digital I/O.
RF6/AN11	RF6	0	0	DIG	LATF<6> data output; not affected by analog input.
	•	1	I	ST	PORTF<6> data input; disabled when analog input enabled.
	AN11	1	-	ANA	A/D input channel 11 and Comparator C1- input. Default input configuration on POR; does not affect digital output.
RF7/SS1	RF7	0	0	DIG	LATF<7> data output.
		1	I	ST	PORTF<7> data input.
	SS1	1	I	TTL	Slave select input for SSP (MSSP1 module).

Legend: PWR = Power Supply, O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 10-14: SUMMARY OF REGISTERS ASSOCIATED WITH PORTF

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	52
LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	_	52
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	52
ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	50
CMCON	C2OUT	C10UT	C2INV	C1INV	CIS	CM2	CM1	CM0	51
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	51

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTF.

10.8 PORTG, TRISG and LATG Registers

PORTG is a 5-bit wide, bidirectional port. The corresponding data direction register is TRISG. Setting a TRISG bit (= 1) will make the corresponding PORTG pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISG bit (= 0) will make the corresponding PORTG pin an output (i.e., put the contents of the output latch on the selected pin). All pins on PORTG are digital only and tolerate voltages up to 5.5V.

The Data Latch register (LATG) is also memory mapped. Read-modify-write operations on the LATG register read and write the latched output value for PORTG.

PORTG is multiplexed with EUSART2 functions (Table 10-15). PORTG pins have Schmitt Trigger input buffers

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTG pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. The user should refer to the corresponding peripheral section for the correct TRIS bit settings. The pin override value is not loaded into the TRIS register. This allows read-modify-write of the TRIS register without concern due to peripheral overrides.

Although the port is only five bits wide, PORTG<7:5> bits are still implemented. These are used to control the weak pull-ups on the I/O ports associated with the external memory bus (PORTD, PORTE and PORTJ). Setting these bits enables the pull-ups. Since these are control bits and are not associated with port I/O, the corresponding TRISG and LATG bits are not implemented.

EXAMPLE 10-7: INITIALIZING PORTG

CLRF	PORTG	; Initialize PORTG by ; clearing output
GT DE	LATG	; data latches
CLRF	LAIG	; Alternate method
		; to clear output
		; data latches
MOVLW	04h	; Value used to
		; initialize data
		; direction
MOVWF	TRISG	; Set RG1:RG0 as outputs
		; RG2 as input
		; RG4:RG3 as inputs

TABLE 10-15: PORTG FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RG0/ECCP3/	RG0	0	0	DIG	LATG<0> data output.
P3A		1	1	ST	PORTG<0> data input.
	ECCP3		0	DIG	CCP3 Compare and PWM output; takes priority over port data.
			I	ST	CCP3 Capture input.
	P3A	0	0	DIG	ECCP3 Enhanced PWM output, channel A; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.
RG1/TX2/CK2	R21	0	0	DIG	LATG<1> data output.
		1	I	ST	PORTG<1> data input.
	TX2	1	0	DIG	Synchronous serial data output (EUSART2 module); takes priority over port data.
	CK2	1	0	DIG	Synchronous serial data input (EUSART2 module). User must configure as an input.
		1	1	ST	Synchronous serial clock input (EUSART2 module).
RG2/RX2/DT2	RG2	0	0	DIG	LATG<2> data output.
		1	-	ST	PORTG<2> data input.
	RX2	1		ST	Asynchronous serial receive data input (EUSART2 module).
	DT2	1	0	DIG	Synchronous serial data output (EUSART2 module); takes priority over port data.
		1	I	ST	Synchronous serial data input (EUSART2 module). User must configure as an input.
RG3/CCP4/	RG3	0	0	DIG	LATG<3> data output.
P3D		1	- 1	ST	PORTG<3> data input.
	CCP4	0	0	DIG	CCP4 Compare output and CCP4 PWM output; takes priority over port data.
		1	1	ST	CCP4 Capture input.
	P3D	0	0	DIG	ECCP3 Enhanced PWM output, channel D; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.
RG4/CCP5/	RG4	0	0	DIG	LATG<4> data output.
P1D		1	1	ST	PORTG<4> data input.
	CCP5	0	0	DIG	CCP5 Compare output and CCP5 PWM output; takes priority over port data.
		1	I	ST	CCP5 Capture input.
	P1D	0	0	DIG	ECCP1 Enhanced PWM output, channel D; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.

Legend: PWR = Power Supply, O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 10-16: SUMMARY OF REGISTERS ASSOCIATED WITH PORTG

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTG	RDPU	REPU	RJPU ⁽¹⁾	RG4	RG3	RG2	RG1	RG0	52
LATG	_	_	_	LATG4	LATG3	LATG2	LATG1	LATG0	52
TRISG	_	_	_	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	52

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTG.

Note 1: Unimplemented on 64-pin devices; read as '0'.

10.9 PORTH, LATH and TRISH Registers

Note: PORTH is available only on 80-pin devices.

PORTH is an 8-bit wide, bidirectional I/O port. The corresponding data direction register is TRISH. Setting a TRISH bit (= 1) will make the corresponding PORTH pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISH bit (= 0) will make the corresponding PORTH pin an output (i.e., put the contents of the output latch on the selected pin). PORTH pins <3:0> are digital only and tolerate voltages up to 5.5V.

The Data Latch register (LATH) is also memory mapped. Read-modify-write operations on the LATH register read and write the latched output value for PORTH.

All pins on PORTH are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

When the external memory interface is enabled, four of the PORTH pins function as the high-order address lines for the interface. The address output from the interface takes priority over other digital I/O. The corresponding TRISH bits are also overridden.

PORTH pins RH4 through RH7 are multiplexed with analog converter inputs. The operation of these pins as analog inputs is selected by clearing or setting the PCFG3:PCFG0 control bits in the ADCON1 register.

PORTH can also be configured as the alternate Enhanced PWM output channels B and C for the ECCP1 and ECCP3 modules. This is done by clearing the ECCPMX configuration bit.

EXAMPLE 10-8: INITIALIZING PORTH

CLRF	PORTH	; Initialize PORTH by ; clearing output
		. 2 -
		; data latches
CLRF	LATH	; Alternate method
		; to clear output
		; data latches
MOVLW	0Fh	; Configure PORTH as
MOVWF	ADCON1	; digital I/O
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISH	; Set RH3:RH0 as inputs
		; RH5:RH4 as outputs
		; RH7:RH6 as inputs

TABLE 10-17: PORTH FUNCTIONS

Pin Name	Function	TRIS Setting	1/0	I/O Type	Description
RH0/A16	RH0	0	0	DIG	LATH<0> data output.
		1	I	ST	PORTH<0> data input.
	A16	х	0	DIG	External memory interface, address line 16. Takes priority over port data.
RH1/A17	RH1	0	0	DIG	LATH<1> data output.
		1	I	ST	PORTH<1> data input.
	A17	х	0	DIG	External memory interface, address line 17. Takes priority over port data.
RH2/A18	RH2	0	0	DIG	LATH<2> data output.
		1	I	ST	PORTH<2> data input.
	A18	х	0	DIG	External memory interface, address line 18. Takes priority over port data.
RH3/A19	RH3	0	0	DIG	LATH<3> data output.
		1	I	ST	PORTH<3> data input.
	A19	х	0	DIG	External memory interface, address line 19. Takes priority over port data.
RH4/AN12/P3C	RH4	0	0	DIG	LATH<4> data output.
		1	I	ST	PORTH<4> data input.
	AN12		I	ANA	A/D input channel 12. Default input configuration on POR; does not affect digital output.
	P3C ⁽¹⁾	0	0	DIG	ECCP3 Enhanced PWM output, channel C; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.
RH5/AN13/P3B	RH5	0	0	DIG	LATH<5> data output.
		1	I	ST	PORTH<5> data input.
	AN13		I	ANA	A/D input channel 13. Default input configuration on POR; does not affect digital output.
	P3B ⁽¹⁾	0	0	DIG	ECCP3 Enhanced PWM output, channel B; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.
RH6/AN14/P1C	RH6	0	0	DIG	LATH<6> data output.
		1	I	ST	PORTH<6> data input.
	AN14		I	ANA	A/D input channel 14. Default input configuration on POR; does not affect digital output.
	P1C ⁽¹⁾	0	0	DIG	ECCP1 Enhanced PWM output, channel C; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.
RH7/AN15/P1B	RH7	0	0	DIG	LATH<7> data output.
		1	I	ST	PORTH<7> data input.
	AN15		I	ANA	A/D input channel 15. Default input configuration on POR; does not affect digital output.
	P1B ⁽¹⁾	0	0	DIG	ECCP1 Enhanced PWM output, channel B; takes priority over port and PSP data. May be configured for tri-state during Enhanced PWM shutdown events.

Legend: PWR = Power Supply, O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: Alternate assignments for P1B/P1C and P3B/P3C when ECCPMX configuration bit is cleared. Default assignments are PORTE<6:3>.

TABLE 10-18: SUMMARY OF REGISTERS ASSOCIATED WITH PORTH

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTH	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	52
LATH	LATH7	LATH6	LATH5	LATH4	LATH3	LATH2	LATH1	LATH0	52
TRISH	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	52

10.10 PORTJ, TRISJ and LATJ Registers

Note: PORTJ is available only on 80-pin devices.

PORTJ is an 8-bit wide, bidirectional port. The corresponding data direction register is TRISJ. Setting a TRISJ bit (= 1) will make the corresponding PORTJ pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISJ bit (= 0) will make the corresponding PORTJ pin an output (i.e., put the contents of the output latch on the selected pin). All pins on PORTJ are digital only and tolerate voltages up to 5.5V.

The Data Latch register (LATJ) is also memory mapped. Read-modify-write operations on the LATJ register read and write the latched output value for PORTJ.

All pins on PORTJ are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

Note: These pins are configured as digital inputs on any device Reset.

When the external memory interface is enabled, all of the PORTJ pins function as control outputs for the interface. This occurs automatically when the interface is enabled by clearing the EBDIS control bit (MEMCON<7>). The TRISJ bits are also overridden.

Each of the PORTJ pins has a weak internal pull-up. The pull-ups are provided to keep the inputs at a known state for the external memory interface while powering up. A single control bit can turn off all the pull-ups. This is performed by clearing bit RJPU (PORTG<5>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on any device Reset.

EXAMPLE 10-9: INITIALIZING PORTJ

CLRF	PORTJ	; Initialize PORTG by
		; clearing output : data latches
CLRF	LATJ	; Alternate method
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISJ	; Set RJ3:RJ0 as inputs
		; RJ5:RJ4 as output
		; RJ7:RJ6 as inputs

TABLE 10-19: PORTJ FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RJ0/ALE	RJ0	0	0	DIG	LATJ<0> data output.
		1	I	ST	PORTJ<0> data input.
	ALE	х	0	DIG	External memory interface address latch enable control output; takes priority over digital I/O.
RJ1/OE	RJ1	0	0	DIG	LATJ<1> data output.
		1	I	ST	PORTJ<1> data input.
	ŌE	х	0	DIG	External memory interface output enable control output; takes priority over digital I/O.
RJ2/WRL	RJ2	0	0	DIG	LATJ<2> data output.
		1	I	ST	PORTJ<2> data input.
	WRL	х	0	DIG	External memory bus write low byte control; takes priority over digital I/O.
RJ3/WRH	RJ3	0	0	DIG	LATJ<3> data output.
		1	ı	ST	PORTJ<3> data input.
	WRH	WRH x O DIG External memory interface write high byte control over digital I/O.		External memory interface write high byte control output; takes priority over digital I/O.	
RJ4/BA0	RJ4	0	0	DIG	LATJ<4> data output.
		1	I	ST	PORTJ<4> data input.
	BA0	х	0	DIG	External memory interface byte address 0 control output; takes priority over digital I/O.
RJ5/CE	RJ5	0	0	DIG	LATJ<5> data output.
		1	I	ST	PORTJ<5> data input.
	CE	х	0	DIG	External memory interface chip enable control output; takes priority over digital I/O.
RJ6/LB	RJ6	0	0	DIG	LATJ<6> data output.
		1	I	ST	PORTJ<6> data input.
	LB	TB x O DIG External memory interface lower by priority over digital I/O.		External memory interface lower byte enable control output; takes priority over digital I/O.	
RJ7/UB	RJ7	0	0	DIG	LATJ<7> data output.
		1	I	ST	PORTJ<7> data input.
	ÜB	х	0	DIG	External memory interface upper byte enable control output; takes priority over digital I/O.

Legend: PWR = Power Supply, O = Output, I = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

TABLE 10-20: SUMMARY OF REGISTERS ASSOCIATED WITH PORTJ

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTJ	RJ7	RJ6	RJ5	RJ4	RJ3	RJ2	RJ1	RJ0	52
LATJ	LATJ7	LATJ6	LATJ5	LATJ4	LATJ3	LATJ2	LATJ1	LATJ0	52
TRISJ	TRISJ7	TRISJ6	TRISJ5	TRISJ4	TRISJ3	TRISJ2	TRISJ1	TRISJ0	52
PORTG	RDPU	REPU	RJPU	RG4	RG3	RG2	RG1	RG0	52

10.11 Parallel Slave Port

PORTD can also function as an 8-bit wide Parallel Slave Port, or microprocessor port, when control bit PSPMODE (PSPCON<4>) is set. It is asynchronously readable and writable by the external world through RD control input pin, RE0/RD and WR control input pin, RE1/WR.

Note: For 80-pin devices, the Parallel Slave Port is available only in Microcontroller mode.

The PSP can directly interface to an 8-bit microprocessor data bus. The external microprocessor can read or write the PORTD latch as an 8-bit latch. Setting bit PSPMODE enables port pin RE0/RD to be the RD input, RE1/WR to be the WR input and RE2/CS to be the CS (Chip Select) input. For this functionality, the corresponding data direction bits of the TRISE register (TRISE<2:0>) must be configured as inputs (set).

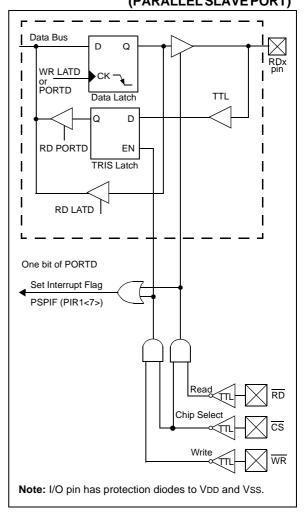
A write to the PSP occurs when both the $\overline{\text{CS}}$ and $\overline{\text{WR}}$ lines are first detected low and ends when either are detected high. The PSPIF and IBF flag bits are both set when the write ends.

A read from the PSP occurs when both the \overline{CS} and \overline{RD} lines are first detected low. The data in PORTD is read out and the OBF bit is set. If the user writes new data to PORTD to set OBF, the data is immediately read out; however, the OBF bit is not set.

When either the $\overline{\text{CS}}$ or $\overline{\text{RD}}$ lines are detected high, the PORTD pins return to the input state and the PSPIF bit is set. User applications should wait for PSPIF to be set before servicing the PSP; when this happens, the IBF and OBF bits can be polled and the appropriate action taken.

The timing for the control signals in Write and Read modes is shown in Figure 10-3 and Figure 10-4, respectively.

FIGURE 10-2: PORTD AND PORTE
BLOCK DIAGRAM
(PARALLEL SLAVE PORT)



REGISTER 10-1: PSPCON: PARALLEL SLAVE PORT CONTROL REGISTER

R-0	R-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
IBF	OBF	IBOV	PSPMODE	_	_	_	_
bit 7							bit 0

bit 7 IBF: Input Buffer Full Status bit

1 = A word has been received and is waiting to be read by the CPU

0 = No word has been received

bit 6 OBF: Output Buffer Full Status bit

1 = The output buffer still holds a previously written word

0 = The output buffer has been read

bit 5 IBOV: Input Buffer Overflow Detect bit

1 = A write occurred when a previously input word has not been read (must be cleared in software)

0 = No overflow occurred

bit 4 **PSPMODE:** Parallel Slave Port Mode Select bit

1 = Parallel Slave Port mode0 = General Purpose I/O mode

bit 3-0 Unimplemented: Read as '0'

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

FIGURE 10-3: PARALLEL SLAVE PORT WRITE WAVEFORMS

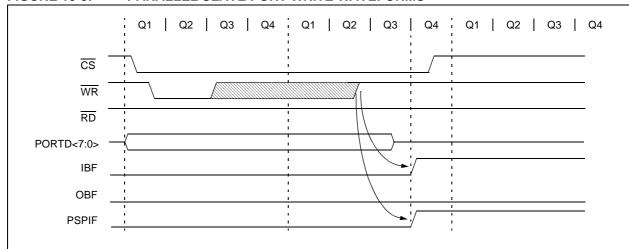


FIGURE 10-4: PARALLEL SLAVE PORT READ WAVEFORMS

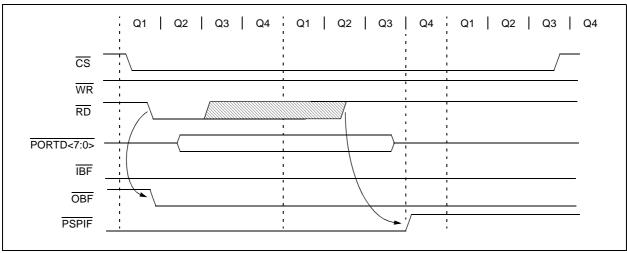


TABLE 10-21: REGISTERS ASSOCIATED WITH PARALLEL SLAVE PORT

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	52
LATD	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0	52
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	52
PORTE	RE7	RE6	RE5	RE4	RE3	RE2	RE1	RE0	52
LATE	LATE7	LATE6	LATE5	LATE4	LATE3	LATE2	LATE1	LATE0	52
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	52
PSPCON	IBF	OBF	IBOV	PSPMODE	_	_	_	_	51
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Parallel Slave Port.

11.0 TIMERO MODULE

The Timer0 module incorporates the following features:

- Software selectable operation as a timer or counter in both 8-bit or 16-bit modes
- · Readable and writable registers
- Dedicated 8-bit, software programmable prescaler
- · Selectable clock source (internal or external)
- · Edge select for external clock
- · Interrupt-on-overflow

The T0CON register (Register 11-1) controls all aspects of the module's operation, including the prescale selection. It is both readable and writable.

A simplified block diagram of the Timer0 module in 8-bit mode is shown in Figure 11-1. Figure 11-2 shows a simplified block diagram of the Timer0 module in 16-bit mode.

REGISTER 11-1: TOCON: TIMERO CONTROL REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
TMR00N	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0
bit 7							bit 0

- bit 7 TMR00N: Timer0 On/Off Control bit
 - 1 = Enables Timer0
 - 0 = Stops Timer0
- bit 6 T08BIT: Timer0 8-bit/16-bit Control bit
 - 1 = Timer0 is configured as an 8-bit timer/counter
 - 0 = Timer0 is configured as a 16-bit timer/counter
- bit 5 TOCS: Timer0 Clock Source Select bit
 - 1 = Transition on T0CKI pin
 - 0 = Internal instruction cycle clock (CLKO)
- bit 4 T0SE: Timer0 Source Edge Select bit
 - 1 = Increment on high-to-low transition on T0CKI pin
 - 0 = Increment on low-to-high transition on T0CKI pin
- bit 3 **PSA**: Timer0 Prescaler Assignment bit
 - 1 = Tlmer0 prescaler is not assigned. Timer0 clock input bypasses prescaler.
 - 0 = Timer0 prescaler is assigned. Timer0 clock input comes from prescaler output.
- bit 2-0 TOPS2:TOPS0: Timer0 Prescaler Select bits
 - 111 = 1:256 Prescale value
 - 110 = 1:128 Prescale value
 - 101 = 1:64 Prescale value
 - 100 = 1:32 Prescale value 011 = 1:16 Prescale value
 - 010 = 1:8 Prescale value
 - 010 = 1.6 Flescale value
 - 001 = 1:4 Prescale value 000 = 1:2 Prescale value

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

11.1 Timer0 Operation

Timer0 can operate as either a timer or a counter; the mode is selected with the ToCS bit (ToCON<5>). In Timer mode (ToCS = 0), the module increments on every clock by default unless a different prescaler value is selected (see **Section 11.3 "Prescaler"**). If the TMR0 register is written to, the increment is inhibited for the following two instruction cycles. The user can work around this by writing an adjusted value to the TMR0 register.

The Counter mode is selected by setting the T0CS bit (= 1). In this mode, Timer0 increments either on every rising or falling edge of pin RA4/T0CKI. The incrementing edge is determined by the Timer0 Source Edge Select bit, T0SE (T0CON<4>); clearing this bit selects the rising edge. Restrictions on the external clock input are discussed below.

An external clock source can be used to drive Timer0; however, it must meet certain requirements to ensure that the external clock can be synchronized with the internal phase clock (Tosc). There is a delay between synchronization and the onset of incrementing the timer/counter.

11.2 Timer0 Reads and Writes in 16-Bit Mode

TMR0H is not the actual high byte of Timer0 in 16-bit mode. It is actually a buffered version of the real high byte of Timer0 which is not directly readable nor writable (refer to Figure 11-2). TMR0H is updated with the contents of the high byte of Timer0 during a read of TMR0L. This provides the ability to read all 16 bits of Timer0 without having to verify that the read of the high and low byte were valid, due to a rollover between successive reads of the high and low byte.

Similarly, a write to the high byte of Timer0 must also take place through the TMR0H Buffer register. The high byte is updated with the contents of TMR0H when a write occurs to TMR0L. This allows all 16 bits of Timer0 to be updated at once.

FIGURE 11-1: TIMERO BLOCK DIAGRAM (8-BIT MODE)

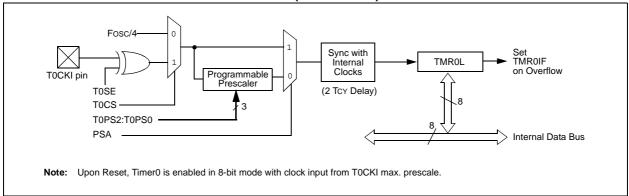
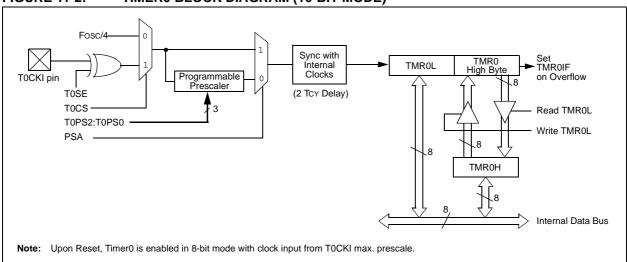


FIGURE 11-2: TIMERO BLOCK DIAGRAM (16-BIT MODE)



11.3 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module. The prescaler is not directly readable or writable. Its value is set by the PSA and T0PS2:T0PS0 bits (T0CON<2:0>) which determine the prescaler assignment and prescale ratio.

Clearing the PSA bit assigns the prescaler to the Timer0 module. When it is assigned, prescale values from 1:2 through 1:256 in power-of-2 increments are selectable.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., CLRF TMR0, MOVWF TMR0, BSF TMR0, etc.) clear the prescaler count.

Note: Writing to TMR0 when the prescaler is assigned to Timer0 will clear the prescaler count but will not change the prescaler assignment.

11.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control and can be changed "on-the-fly" during program execution.

11.4 Timer0 Interrupt

The TMR0 interrupt is generated when the TMR0 register overflows from FFh to 00h in 8-bit mode, or from FFFFh to 0000h in 16-bit mode. This overflow sets the TMR0IF flag bit. The interrupt can be masked by clearing the TMR0IE bit (INTCON<5>). Before re-enabling the interrupt, the TMR0IF bit must be cleared in software by the Interrupt Service Routine.

Since Timer0 is shut down in Sleep mode, the TMR0 interrupt cannot awaken the processor from Sleep.

TABLE 11-1: REGISTERS ASSOCIATED WITH TIMERO

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
TMR0L	Timer0 Register Low Byte								
TMR0H	Timer0 Reg	ister High By	/te						50
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
T0CON	TMR0ON	TMROON TO8BIT TOCS TOSE PSA TOPS2 TOPS1 TOPS0							
TRISA	_	_	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	52

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Timer0.

NOTES:

12.0 TIMER1 MODULE

The Timer1 timer/counter module incorporates these features:

- Software selectable operation as a 16-bit timer or counter
- Readable and writable 8-bit registers (TMR1H and TMR1L)
- Selectable clock source (internal or external) with device clock or Timer1 oscillator internal options
- Interrupt-on-overflow
- · Reset on CCP Special Event Trigger
- · Device clock status flag (T1RUN)

A simplified block diagram of the Timer1 module is shown in Figure 12-1. A block diagram of the module's operation in Read/Write mode is shown in Figure 12-2.

The module incorporates its own low-power oscillator to provide an additional clocking option. The Timer1 oscillator can also be used as a low-power clock source for the microcontroller in power-managed operation.

Timer1 can also be used to provide Real-Time Clock (RTC) functionality to applications with only a minimal addition of external components and code overhead.

Timer1 is controlled through the T1CON Control register (Register 12-1). It also contains the Timer1 Oscillator Enable bit (T1OSCEN). Timer1 can be enabled or disabled by setting or clearing control bit, TMR1ON (T1CON<0>).

REGISTER 12-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RD16	T1RUN	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N
bit 7							bit 0

- bit 7 RD16: 16-Bit Read/Write Mode Enable bit
 - 1 = Enables register read/write of Tlmer1 in one 16-bit operation
 - 0 = Enables register read/write of Timer1 in two 8-bit operations
- bit 6 T1RUN: Timer1 System Clock Status bit
 - 1 = Device clock is derived from Timer1 oscillator
 - 0 = Device clock is derived from another source
- bit 5-4 T1CKPS1:T1CKPS0: Timer1 Input Clock Prescale Select bits
 - 11 = 1:8 Prescale value
 - 10 = 1:4 Prescale value
 - 01 = 1:2 Prescale value
 - 00 = 1:1 Prescale value
- bit 3 T10SCEN: Timer1 Oscillator Enable bit
 - 1 = Timer1 oscillator is enabled
 - 0 = Timer1 oscillator is shut off

The oscillator inverter and feedback resistor are turned off to eliminate power drain.

bit 2 T1SYNC: Timer1 External Clock Input Synchronization Select bit

When TMR1CS = 1:

- 1 = Do not synchronize external clock input
- 0 = Synchronize external clock input

When TMR1CS = 0:

This bit is ignored. Timer1 uses the internal clock when TMR1CS = 0.

- bit 1 TMR1CS: Timer1 Clock Source Select bit
 - 1 = External clock from pin RC0/T10SO/T13CKI (on the rising edge)
 - 0 = Internal clock (Fosc/4)
- bit 0 TMR1ON: Timer1 On bit
 - 1 = Enables Timer1
 - 0 = Stops Timer1

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

12.1 Timer1 Operation

Timer1 can operate in one of these modes:

- Timer
- Synchronous Counter
- Asynchronous Counter

The operating mode is determined by the clock select bit, TMR1CS (T1CON<1>). When TMR3CS is cleared (= 0), Timer1 increments on every internal instruction

cycle (Fosc/4). When the bit is set, Timer1 increments on every rising edge of the Timer1 external clock input or the Timer1 oscillator, if enabled.

When Timer1 is enabled, the RC1/T1OSI and RC0/T1OSO/T13CKI pins become inputs. This means the values of TRISC<1:0> are ignored and the pins are read as '0'.

FIGURE 12-1: TIMER1 BLOCK DIAGRAM

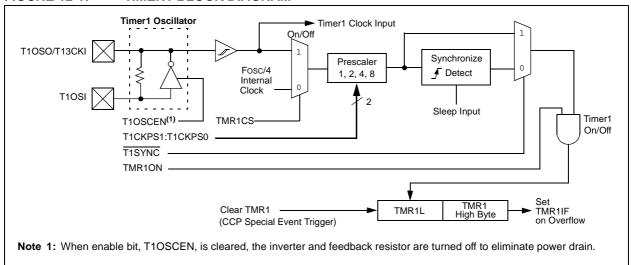
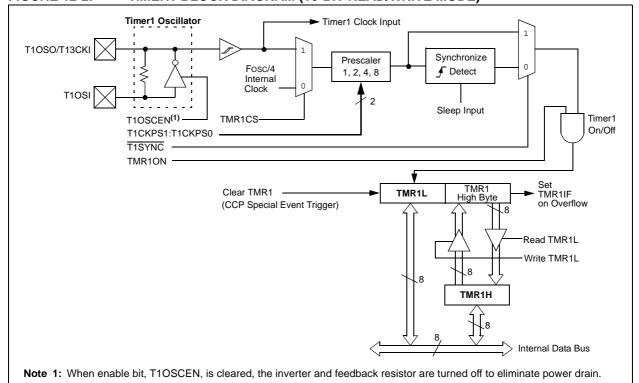


FIGURE 12-2: TIMER1 BLOCK DIAGRAM (16-BIT READ/WRITE MODE)



12.2 Timer1 16-Bit Read/Write Mode

Timer1 can be configured for 16-bit reads and writes (see Figure 12-2). When the RD16 control bit (T1CON<7>) is set, the address for TMR1H is mapped to a buffer register for the high byte of Timer1. A read from TMR1L will load the contents of the high byte of Timer1 into the Timer1 High Byte Buffer register. This provides the user with the ability to accurately read all 16 bits of Timer1 without having to determine whether a read of the high byte, followed by a read of the low byte, has become invalid due to a rollover between reads.

A write to the high byte of Timer1 must also take place through the TMR1H Buffer register. The Timer1 high byte is updated with the contents of TMR1H when a write occurs to TMR1L. This allows a user to write all 16 bits to both the high and low bytes of Timer1 at once.

The high byte of Timer1 is not directly readable or writable in this mode. All reads and writes must take place through the Timer1 High Byte Buffer register. Writes to TMR1H do not clear the Timer1 prescaler. The prescaler is only cleared on writes to TMR1L.

12.3 Timer1 Oscillator

An on-chip crystal oscillator circuit is incorporated between pins T1OSI (input) and T1OSO (amplifier output). It is enabled by setting the Timer1 Oscillator Enable bit, T1OSCEN (T1CON<3>). The oscillator is a low-power circuit rated for 32 kHz crystals. It will continue to run during all power-managed modes. The circuit for a typical LP oscillator is shown in Figure 12-3. Table 12-1 shows the capacitor selection for the Timer1 oscillator.

The user must provide a software time delay to ensure proper start-up of the Timer1 oscillator.

FIGURE 12-3: EXTERNAL

COMPONENTS FOR THE

TIMER1 LP OSCILLATOR

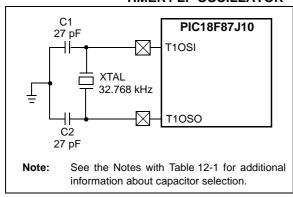


TABLE 12-1: CAPACITOR SELECTION FOR THETIMER OSCILLATOR^(2,3,4)

Oscillator Type	Freq.	C1	C2
LP	32 kHz	27 pF ⁽¹⁾	27 pF ⁽¹⁾

- Note 1: Microchip suggests these values as a starting point in validating the oscillator circuit.
 - **2:** Higher capacitance increases the stability of the oscillator but also increases the start-up time.
 - 3: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - **4:** Capacitor values are for design guidance only.

12.3.1 USING TIMER1 AS A CLOCK SOURCE

The Timer1 oscillator is also available as a clock source in power-managed modes. By setting the clock select bits, SCS1:SCS0 (OSCCON<1:0>), to '01', the device switches to SEC_RUN mode; both the CPU and peripherals are clocked from the Timer1 oscillator. If the IDLEN bit (OSCCON<7>) is cleared and a SLEEP instruction is executed, the device enters SEC_IDLE mode. Additional details are available in **Section 3.0** "Power-Managed Modes".

Whenever the Timer1 oscillator is providing the clock source, the Timer1 system clock status flag, T1RUN (T1CON<6>), is set. This can be used to determine the controller's current clocking mode. It can also indicate the clock source being currently used by the Fail-Safe Clock Monitor. If the Clock Monitor is enabled and the Timer1 oscillator fails while providing the clock, polling the T1RUN bit will indicate whether the clock is being provided by the Timer1 oscillator or another source.

12.3.2 LOW-POWER TIMER1 OPTION

The Timer1 oscillator can operate at two distinct levels of power consumption based on device configuration. When the LPT1OSC configuration bit is set, the Timer1 oscillator operates in a low-power mode. When LPT1OSC is not set, Timer1 operates at a higher power level. Power consumption for a particular mode is relatively constant regardless of the device's operating mode. The default Timer1 configuration is the higher power mode.

As the low-power Timer1 mode tends to be more sensitive to interference, high noise environments may cause some oscillator instability. The low-power option is, therefore, best suited for low noise applications where power conservation is an important design consideration.

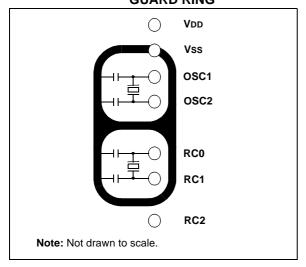
12.3.3 TIMER1 OSCILLATOR LAYOUT CONSIDERATIONS

The Timer1 oscillator circuit draws very little power during operation. Due to the low-power nature of the oscillator, it may also be sensitive to rapidly changing signals in close proximity.

The oscillator circuit, shown in Figure 12-3, should be located as close as possible to the microcontroller. There should be no circuits passing within the oscillator circuit boundaries other than Vss or VDD.

If a high-speed circuit must be located near the oscillator (such as the ECCP1 pin in Output Compare or PWM mode, or the primary oscillator using the OSC2 pin), a grounded guard ring around the oscillator circuit, as shown in Figure 12-4, may be helpful when used on a single-sided PCB or in addition to a ground plane.

FIGURE 12-4: OSCILLATOR CIRCUIT
WITH GROUNDED
GUARD RING



12.4 Timer1 Interrupt

The TMR1 register pair (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The Timer1 interrupt, if enabled, is generated on overflow which is latched in interrupt flag bit, TMR1IF (PIR1<0>). This interrupt can be enabled or disabled by setting or clearing the Timer1 Interrupt Enable bit, TMR1IE (PIE1<0>).

12.5 Resetting Timer1 Using the ECCP Special Event Trigger

If ECCP1 or ECCP2 is configured to use Timer1 and to generate a Special Event Trigger in Compare mode (CCPxM3:CCPxM0 = 1011), this signal will reset Timer3. The trigger from ECCP2 will also start an A/D conversion if the A/D module is enabled (see **Section 17.2.1 "Special Event Trigger"** for more information).

The module must be configured as either a timer or a synchronous counter to take advantage of this feature. When used this way, the CCPRH:CCPRL register pair effectively becomes a period register for Timer1.

If Timer1 is running in Asynchronous Counter mode, this Reset operation may not work.

In the event that a write to Timer1 coincides with a Special Event Trigger, the write operation will take precedence.

Note: The Special Event Triggers from the ECCPx module will not set the TMR1IF interrupt flag bit (PIR1<0>).

12.6 Using Timer1 as a Real-Time Clock

Adding an external LP oscillator to Timer1 (such as the one described in **Section 12.3 "Timer1 Oscillator"** above) gives users the option to include RTC functionality to their applications. This is accomplished with an inexpensive watch crystal to provide an accurate time base and several lines of application code to calculate the time. When operating in Sleep mode and using a battery or supercapacitor as a power source, it can completely eliminate the need for a separate RTC device and battery backup.

The application code routine, RTCisr, shown in Example 12-1, demonstrates a simple method to increment a counter at one-second intervals using an Interrupt Service Routine. Incrementing the TMR1 register pair to overflow triggers the interrupt and calls the routine which increments the seconds counter by one. Additional counters for minutes and hours are incremented as the previous counter overflows.

Since the register pair is 16 bits wide, counting up to overflow the register directly from a 32.768 kHz clock would take 2 seconds. To force the overflow at the required one-second intervals, it is necessary to preload it; the simplest method is to set the MSb of TMR1H with a BSF instruction. Note that the TMR1L register is never preloaded or altered; doing so may introduce cumulative error over many cycles.

For this method to be accurate, Timer1 must operate in Asynchronous mode and the Timer1 overflow interrupt must be enabled (PIE1<0> = 1), as shown in the routine, RTCinit. The Timer1 oscillator must also be enabled and running at all times.

EXAMPLE 12-1: IMPLEMENTING A REAL-TIME CLOCK USING A TIMER1 INTERRUPT SERVICE

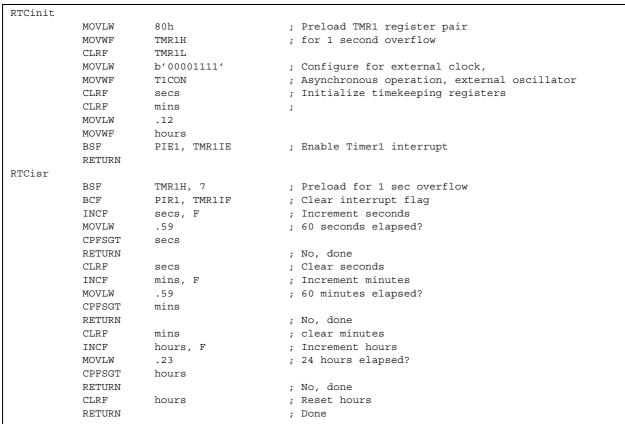


TABLE 12-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
TMR1L	Timer1 Reg	gister Low By	/te						50
TMR1H	Timer1 Register High Byte								50
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	50

Legend: Shaded cells are not used by the Timer1 module.

NOTES:

13.0 TIMER2 MODULE

The Timer2 timer module incorporates the following features:

- 8-bit timer and period registers (TMR2 and PR2, respectively)
- · Readable and writable (both registers)
- Software programmable prescaler (1:1, 1:4 and 1:16)
- Software programmable postscaler (1:1 through 1:16)
- Interrupt on TMR2-to-PR2 match
- Optional use as the shift clock for the MSSP module

The module is controlled through the T2CON register (Register 13-1) which enables or disables the timer and configures the prescaler and postscaler. Timer2 can be shut off by clearing control bit, TMR2ON (T2CON<2>), to minimize power consumption.

A simplified block diagram of the module is shown in Figure 13-1.

13.1 Timer2 Operation

In normal operation, TMR2 is incremented from 00h on each clock (Fosc/4). A 4-bit counter/prescaler on the clock input gives direct input, divide-by-4 and divide-by-16 prescale options; these are selected by the prescaler control bits, T2CKPS1:T2CKPS0 (T2CON<1:0>). The value of TMR2 is compared to that of the period register, PR2, on each clock cycle. When the two values match, the comparator generates a match signal as the timer output. This signal also resets the value of TMR2 to 00h on the next cycle and drives the output counter/postscaler (see Section 13.2 "Timer2 Interrupt").

The TMR2 and PR2 registers are both directly readable and writable. The TMR2 register is cleared on any device Reset, while the PR2 register initializes at FFh. Both the prescaler and postscaler counters are cleared on the following events:

- · a write to the TMR2 register
- · a write to the T2CON register
- any device Reset (Power-on Reset, MCLR Reset, Watchdog Timer Reset or Brown-out Reset)

TMR2 is not cleared when T2CON is written.

REGISTER 13-1: T2CON: TIMER2 CONTROL REGISTER

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0
bit 7							bit 0

bit 7 Unimplemented: Read as '0'

bit 6-3 T20UTPS3:T20UTPS0: Timer2 Output Postscale Select bits

0000 = 1:1 Postscale 0001 = 1:2 Postscale

•

•

• 1111 = 1:16 Postscale

bit 2 TMR2ON: Timer2 On bit

1 = Timer2 is on

0 = Timer2 is off

bit 1-0 T2CKPS1:T2CKPS0: Timer2 Clock Prescale Select bits

00 =Prescaler is 1 01 =Prescaler is 4 1x =Prescaler is 16

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

13.2 **Timer2 Interrupt**

Timer2 can also generate an optional device interrupt. The Timer2 output signal (TMR2-to-PR2 match) provides the input for the 4-bit output counter/postscaler. This counter generates the TMR2 match interrupt flag which is latched in TMR2IF (PIR1<1>). The interrupt is enabled by setting the TMR2 Match Interrupt Enable bit, TMR2IE (PIE1<1>).

A range of 16 postscale options (from 1:1 through 1:16 inclusive) can be selected with the postscaler control bits, T2OUTPS3:T2OUTPS0 (T2CON<6:3>).

Timer2 Output 13.3

The unscaled output of TMR2 is available primarily to the CCP modules, where it is used as a time base for operations in PWM mode.

Timer2 can be optionally used as the shift clock source for the MSSP module operating in SPI mode. Additional information is provided in Section 18.0 "Master Synchronous Serial Port (MSSP) Module".

FIGURE 13-1: TIMER2 BLOCK DIAGRAM

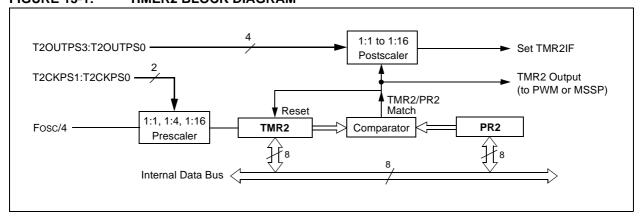


TABLE 13-1: REGISTERS ASSOCIATED WITH TIMER2 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
TMR2	Timer2 Reg	jister							50
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	50
PR2	Timer2 Peri	iod Register							50

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer2 module.

14.0 TIMER3 MODULE

The Timer3 timer/counter module incorporates these features:

- Software selectable operation as a 16-bit timer or counter
- Readable and writable 8-bit registers (TMR3H and TMR3L)
- Selectable clock source (internal or external) with device clock or Timer1 oscillator internal options
- Interrupt-on-overflow
- · Module Reset on CCP Special Event Trigger

A simplified block diagram of the Timer3 module is shown in Figure 14-1. A block diagram of the module's operation in Read/Write mode is shown in Figure 14-2.

The Timer3 module is controlled through the T3CON register (Register 14-1). It also selects the clock source options for the CCP and ECCP modules; see Section 16.1.1 "CCP Modules and Timer Resources" for more information.

REGISTER 14-1: T3CON: TIMER3 CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON
hit 7							hit ∩

- bit 7 RD16: 16-bit Read/Write Mode Enable bit
 - 1 = Enables register read/write of Timer3 in one 16-bit operation
 - 0 = Enables register read/write of Timer3 in two 8-bit operations
- bit 6,3 T3CCP2:T3CCP1: Timer3 and Timer1 to CCPx Enable bits
 - 11 = Timer3 and Timer4 are the clock sources for all CCP/ECCP modules
 - 10 = Timer3 and Timer4 are the clock sources for ECCP3, CCP4 and CCP5;

Timer1 and Timer2 are the clock sources for ECCP1 and ECCP2

01 = Timer3 and Timer4 are the clock sources for ECCP2, ECCP3, CCP4 and CCP5;

Timer1 and Timer2 are the clock sources for ECCP1

- 00 = Timer1 and Timer2 are the clock sources for all CCP/ECCP modules
- bit 5-4 T3CKPS1:T3CKPS0: Timer3 Input Clock Prescale Select bits
 - 11 = 1:8 Prescale value
 - 10 = 1:4 Prescale value
 - 01 = 1:2 Prescale value
 - 00 = 1:1 Prescale value
- bit 2 T3SYNC: Timer3 External Clock Input Synchronization Control bit

(Not usable if the device clock comes from Timer1/Timer3.)

When TMR3CS = 1:

- 1 = Do not synchronize external clock input
- 0 = Synchronize external clock input

When TMR3CS = 0:

This bit is ignored. Timer3 uses the internal clock when TMR3CS = 0.

- bit 1 TMR3CS: Timer3 Clock Source Select bit
 - 1 = External clock input from Timer1 oscillator or T13CKI (on the rising edge after the first falling edge)
 - 0 = Internal clock (Fosc/4)
- bit 0 TMR3ON: Timer3 On bit
 - 1 = Enables Timer3
 - 0 = Stops Timer3

Leg	end:
-----	------

R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

14.1 Timer3 Operation

Timer3 can operate in one of three modes:

- Timer
- Synchronous Counter
- · Asynchronous Counter

The operating mode is determined by the clock select bit, TMR3CS (T3CON<1>). When TMR3CS is cleared (= 0), Timer3 increments on every internal instruction cycle (Fosc/4). When the bit is set, Timer3 increments on every rising edge of the Timer1 external clock input or the Timer1 oscillator, if enabled.

As with Timer1, the RC1/T10SI and RC0/T10SO/T13CKI pins become inputs when the Timer1 oscillator is enabled. This means the values of TRISC<1:0> are ignored and the pins are read as '0'.

FIGURE 14-1: TIMER3 BLOCK DIAGRAM

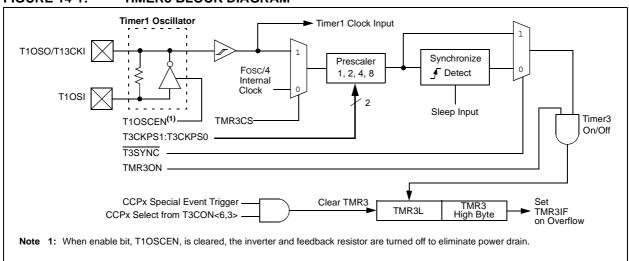
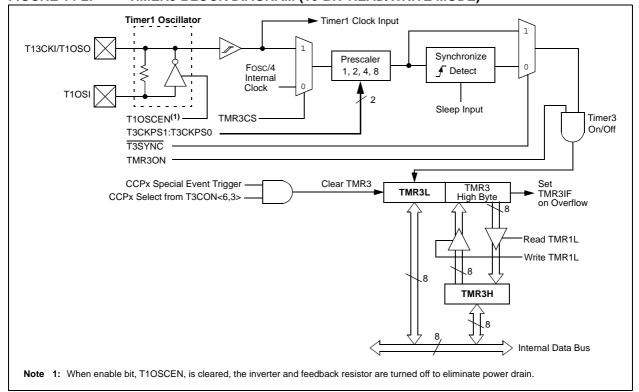


FIGURE 14-2: TIMER3 BLOCK DIAGRAM (16-BIT READ/WRITE MODE)



14.2 Timer3 16-Bit Read/Write Mode

Timer3 can be configured for 16-bit reads and writes (see Figure 14-2). When the RD16 control bit (T3CON<7>) is set, the address for TMR3H is mapped to a buffer register for the high byte of Timer3. A read from TMR3L will load the contents of the high byte of Timer3 into the Timer3 High Byte Buffer register. This provides the user with the ability to accurately read all 16 bits of Timer1 without having to determine whether a read of the high byte, followed by a read of the low byte, has become invalid due to a rollover between reads.

A write to the high byte of Timer3 must also take place through the TMR3H Buffer register. The Timer3 high byte is updated with the contents of TMR3H when a write occurs to TMR3L. This allows a user to write all 16 bits to both the high and low bytes of Timer3 at once.

The high byte of Timer3 is not directly readable or writable in this mode. All reads and writes must take place through the Timer3 High Byte Buffer register.

Writes to TMR3H do not clear the Timer3 prescaler. The prescaler is only cleared on writes to TMR3L.

14.3 Using the Timer1 Oscillator as the Timer3 Clock Source

The Timer1 internal oscillator may be used as the clock source for Timer3. The Timer1 oscillator is enabled by setting the T1OSCEN (T1CON<3>) bit. To use it as the Timer3 clock source, the TMR3CS bit must also be set. As previously noted, this also configures Timer3 to increment on every rising edge of the oscillator source.

The Timer1 oscillator is described in **Section 12.0** "Timer1 Module".

14.4 Timer3 Interrupt

The TMR3 register pair (TMR3H:TMR3L) increments from 0000h to FFFFh and overflows to 0000h. The Timer3 interrupt, if enabled, is generated on overflow and is latched in interrupt flag bit, TMR3IF (PIR2<1>). This interrupt can be enabled or disabled by setting or clearing the Timer3 Interrupt Enable bit, TMR3IE (PIE2<1>).

14.5 Resetting Timer3 Using the ECCP Special Event Trigger

If ECCP1 or ECCP2 is configured to use Timer3 and to generate a Special Event Trigger in Compare mode (CCPxM3:CCPxM0 = 1011), this signal will reset Timer3. The trigger from ECCP2 will also start an A/D conversion if the A/D module is enabled (see **Section 17.2.1 "Special Event Trigger"** for more information).

The module must be configured as either a timer or synchronous counter to take advantage of this feature. When used this way, the CCPRxH:CCPRxL register pair effectively becomes a period register for Timer3.

If Timer3 is running in Asynchronous Counter mode, the Reset operation may not work.

In the event that a write to Timer3 coincides with a Special Event Trigger from an ECCP module, the write will take precedence.

Note: The Special Event Triggers from the ECCPx module will not set the TMR3IF interrupt flag bit (PIR1<0>).

TABLE 14-1: REGISTERS ASSOCIATED WITH TIMER3 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	TMR3IF	CCP2IF	51
PIE2	OSCFIE	CMIE	_	_	BCL1IE	_	TMR3IE	CCP2IE	51
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	TMR3IP	CCP2IP	51
TMR3L	Timer3 Reg	gister Low By	yte						51
TMR3H	Timer3 Reg	gister High B	yte						51
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	50
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON	51

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer3 module.

NOTES:

15.0 TIMER4 MODULE

The Timer4 timer module has the following features:

- 8-bit timer register (TMR4)
- 8-bit period register (PR4)
- Readable and writable (both registers)
- Software programmable prescaler (1:1, 1:4, 1:16)
- Software programmable postscaler (1:1 to 1:16)
- · Interrupt on TMR4 match of PR4

Timer4 has a control register shown in Register 15-1. Timer4 can be shut off by clearing control bit, TMR4ON (T4CON<2>), to minimize power consumption. The prescaler and postscaler selection of Timer4 are also controlled by this register. Figure 15-1 is a simplified block diagram of the Timer4 module.

15.1 Timer4 Operation

Timer4 can be used as the PWM time base for the PWM mode of the CCP module. The TMR4 register is readable and writable and is cleared on any device Reset. The input clock (Fosc/4) has a prescale option of 1:1, 1:4 or 1:16, selected by control bits T4CKPS1:T4CKPS0 (T4CON<1:0>). The match output of TMR4 goes through a 4-bit postscaler (which gives a 1:1 to 1:16 scaling inclusive) to generate a TMR4 interrupt, latched in flag bit TMR4IF (PIR3<3>).

The prescaler and postscaler counters are cleared when any of the following occurs:

- a write to the TMR4 register
- · a write to the T4CON register
- any device Reset (Power-on Reset, MCLR Reset, Watchdog Timer Reset or Brown-out Reset)

TMR4 is not cleared when T4CON is written.

REGISTER 15-1: T4CON: TIMER4 CONTROL REGISTER

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0
bit 7	•		•	•		•	bit 0

bit 7 Unimplemented: Read as '0'

bit 6-3 **T40UTPS3:T40UTPS0**: Timer4 Output Postscale Select bits

0000 = 1:1 Postscale 0001 = 1:2 Postscale

•

.

1111 = 1:16 Postscale

bit 2 TMR4ON: Timer4 On bit

1 = Timer4 is on

0 = Timer4 is off

bit 1-0 T4CKPS1:T4CKPS0: Timer4 Clock Prescale Select bits

00 = Prescaler is 1

01 = Prescaler is 4

1x = Prescaler is 16

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

15.2 Timer4 Interrupt

The Timer4 module has an 8-bit period register, PR4, which is both readable and writable. Timer4 increments from 00h until it matches PR4 and then resets to 00h on the next increment cycle. The PR4 register is initialized to FFh upon Reset.

15.3 Output of TMR4

The output of TMR4 (before the postscaler) is used only as a PWM time base for the CCP modules. It is not used as a baud rate clock for the MSSP as is the Timer2 output.

FIGURE 15-1: TIMER4 BLOCK DIAGRAM

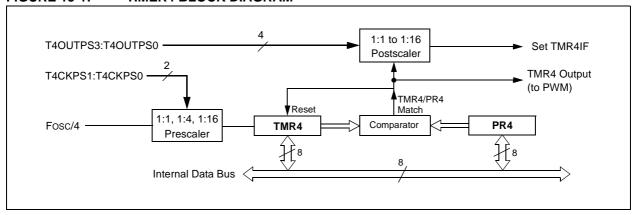


TABLE 15-1: REGISTERS ASSOCIATED WITH TIMER4 AS A TIMER/COUNTER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
TMR4	Timer4 Reg	gister							53
T4CON	— T40UTPS3 T40UTPS2 T40UTPS1 T40UTPS0 TMR40N T4CKPS1 T4CKPS0								53
PR4	Timer4 Per	iod Register					•	•	53

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer4 module.

16.0 CAPTURE/COMPARE/PWM (CCP) MODULES

Members of the PIC18F87J10 family of devices all have a total of five CCP (Capture/Compare/PWM) modules. Two of these (CCP4 and CCP5) implement standard Capture, Compare and Pulse-Width Modulation (PWM) modes and are discussed in this section. The other three modules (ECCP1, ECCP2, ECCP3) implement standard Capture and Compare modes, as well as Enhanced PWM modes. These are discussed in Section 17.0 "Enhanced Capture/Compare/PWM (ECCP) Module".

Each CCP/ECCP module contains a 16-bit register which can operate as a 16-bit Capture register, a 16-bit Compare register or a PWM Master/Slave Duty Cycle

register. For the sake of clarity, all CCP module operation in the following sections is described with respect to CCP4, but is equally applicable to CCP5.

Capture and Compare operations described in this chapter apply to all standard and Enhanced CCP modules. The operations of PWM mode, described in **Section 16.4 "PWM Mode"**, apply to CCP4 and CCP5 only.

Note: Throughout this section and Section 17.0
"Enhanced Capture/Compare/PWM (ECCP)
Module", references to register and bit names that may be associated with a specific CCP module are referred to generically by the use of 'x' or 'y' in place of the specific module number. Thus, "CCPxCON" might refer to the control register for ECCP1, ECCP2, ECCP3, CCP4 or CCP5.

REGISTER 16-1: CCPxCON: CCP CONTROL REGISTER (CCP4 AND CCP5)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	DCxB1	DCxB0	CCPxM3	CCPxM2	CCPxM1	CCPxM0
bit 7							hit 0

bit 7-6 Unimplemented: Read as '0'

bit 5-4 **DCxB1:DCxB0**: CCP Module x PWM Duty Cycle bit 1 and bit 0

Capture mode:

Unused.

Compare mode:

Unused.

PWM mode:

These bits are the two Least Significant bits (bit 1 and bit 0) of the 10-bit PWM duty cycle. The eight Most Significant bits (DCx9:DCx2) of the duty cycle are found in CCPRxL.

bit 3-0 CCPxM3:CCPxM0: CCP Module x Mode Select bits

0000 = Capture/Compare/PWM disabled (resets CCPx module)

0001 = Reserved

0010 = Compare mode, toggle output on match (CCPxIF bit is set)

0011 = Reserved

0100 = Capture mode, every falling edge

0101 = Capture mode, every rising edge

0110 = Capture mode, every 4th rising edge

0111 = Capture mode, every 16th rising edge

1000 = Compare mode; initialize CCP pin low; on compare match, force CCP pin high (CCPIF bit is set)

1001 = Compare mode; initialize CCP pin high; on compare match, force CCP pin low (CCPIF bit is set)

1010 = Compare mode; generate software interrupt on compare match (CCPIF bit is set, CCP pin reflects I/O state)

1011 = Reserved

11xx = PWM mode

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

16.1 CCP Module Configuration

Each Capture/Compare/PWM module is associated with a control register (generically, CCPxCON) and a data register (CCPRx). The data register, in turn, is comprised of two 8-bit registers: CCPRxL (low byte) and CCPRxH (high byte). All registers are both readable and writable.

16.1.1 CCP MODULES AND TIMER RESOURCES

The CCP/ECCP modules utilize Timers 1, 2, 3 or 4, depending on the mode selected. Timer1 and Timer3 are available to modules in Capture or Compare modes, while Timer2 and Timer4 are available for modules in PWM mode.

TABLE 16-1: CCP MODE – TIMER RESOURCE

CCP Mode	Timer Resource
Capture	Timer1 or Timer3
Compare	Timer1 or Timer3
PWM	Timer2 or Timer4

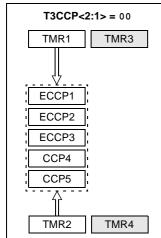
The assignment of a particular timer to a module is determined by the Timer-to-CCP enable bits in the T3CON register (Register 14-1, page 153). Depending on the configuration selected, up to four timers may be active at once, with modules in the same configuration (Capture/Compare or PWM) sharing timer resources. The possible configurations are shown in Figure 16-1.

16.1.2 ECCP2 PIN ASSIGNMENT

The pin assignment for ECCP2 (Capture input, Compare and PWM output) can change, based on device configuration. The CCP2MX configuration bit determines which pin ECCP2 is multiplexed to. By default, it is assigned to RC1 (CCP2MX = 1). If the configuration bit is cleared, ECCP2 is multiplexed with RE7 on 64-pin devices and RB3 or RE7 on 80-pin devices depending on mode setting.

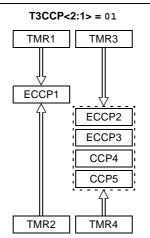
Changing the pin assignment of ECCP2 does not automatically change any requirements for configuring the port pin. Users must always verify that the appropriate TRIS register is configured correctly for ECCP2 operation regardless of where it is located.

FIGURE 16-1: CCP AND TIMER INTERCONNECT CONFIGURATIONS



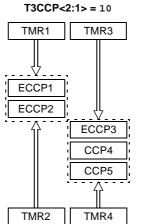
Timer1 is used for all Capture and Compare operations for all CCP modules. Timer2 is used for PWM operations for all CCP modules. Modules may share either timer resource as a common time base.

Timer3 and Timer4 are not available.



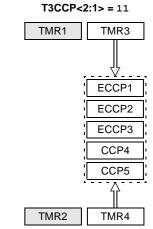
Timer1 and Timer2 are used for Capture and Compare or PWM operations for ECCP1 only (depending on selected mode).

All other modules use either Timer3 or Timer4. Modules may share either timer resource as a common time base if they are in Capture/Compare or PWM modes.



Timer1 and Timer2 are used for Capture and Compare or PWM operations for ECCP1 and ECCP2 only (depending on the mode selected for each module). Both modules may use a timer as a common time base if they are both in Capture/Compare or PWM modes.

The other modules use either Timer3 or Timer4. Modules may share either timer resource as a common time base if they are in Capture/Compare or PWM modes.



Timer3 is used for all Capture and Compare operations for all CCP modules. Timer4 is used for PWM operations for all CCP modules. Modules may share either timer resource as a common time base.

Timer1 and Timer2 are not available.

16.2 Capture Mode

In Capture mode, the CCPRxH:CCPRxL register pair captures the 16-bit value of the TMR1 or TMR3 registers when an event occurs on the corresponding CCPx pin. An event is defined as one of the following:

- · every falling edge
- · every rising edge
- · every 4th rising edge
- · every 16th rising edge

The event is selected by the mode select bits, CCPxM3:CCPxM0 (CCPxCON<3:0>). When a capture is made, the interrupt request flag bit, CCPxIF, is set; it must be cleared in software. If another capture occurs before the value in register CCPRx is read, the old captured value is overwritten by the new captured value.

16.2.1 CCP PIN CONFIGURATION

In Capture mode, the appropriate CCPx pin should be configured as an input by setting the corresponding TRIS direction bit.

Note: If RG4/CCP5 is configured as an output, a write to the port can cause a capture condition.

16.2.2 TIMER1/TIMER3 MODE SELECTION

The timers that are to be used with the capture feature (Timer1 and/or Timer3) must be running in Timer mode or Synchronized Counter mode. In Asynchronous Counter mode, the capture operation will not work. The timer to be used with each CCP module is selected in the T3CON register (see Section 16.1.1 "CCP Modules and Timer Resources").

16.2.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep the CCPxIE interrupt enable bit clear to avoid false interrupts. The interrupt flag bit, CCPxIF, should also be cleared following any such change in operating mode.

16.2.4 CCP PRESCALER

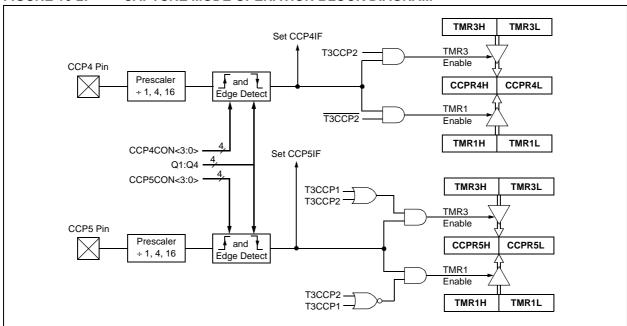
There are four prescaler settings in Capture mode. They are specified as part of the operating mode selected by the mode select bits (CCPxM3:CCPxM0). Whenever the CCP module is turned off or Capture mode is disabled, the prescaler counter is cleared. This means that any Reset will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared; therefore, the first capture may be from a non-zero prescaler. Example 16-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

EXAMPLE 16-1: CHANGING BETWEEN CAPTURE PRESCALERS (CCP5 SHOWN)

```
CLRF CCP5CON ; Turn CCP module off
MOVLW NEW_CAPT_PS ; Load WREG with the
; new prescaler mode
; value and CCP ON
MOVWF CCP5CON ; Load CCP5CON with
; this value
```

FIGURE 16-2: CAPTURE MODE OPERATION BLOCK DIAGRAM



16.3 Compare Mode

In Compare mode, the 16-bit CCPRx register value is constantly compared against either the TMR1 or TMR3 register pair value. When a match occurs, the CCPx pin can be:

- · driven high
- · driven low
- · toggled (high-to-low or low-to-high)
- remain unchanged (that is, reflects the state of the I/O latch)

The action on the pin is based on the value of the mode select bits (CCPxM3:CCPxM0). At the same time, the interrupt flag bit, CCPxIF, is set.

16.3.1 CCP PIN CONFIGURATION

The user must configure the CCPx pin as an output by clearing the appropriate TRIS bit.

Note: Clearing the CCP5CON register will force the RG4 compare output latch (depending on device configuration) to the default low level. This is not the PORTB or PORTC I/O data latch.

16.3.2 TIMER1/TIMER3 MODE SELECTION

Timer1 and/or Timer3 must be running in Timer mode or Synchronized Counter mode if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

16.3.3 SOFTWARE INTERRUPT MODE

When the Generate Software Interrupt mode is chosen (CCPxM3:CCPxM0 = 1010), the corresponding CCPx pin is not affected. Only a CCP interrupt is generated, if enabled and the CCPxIE bit is set.

FIGURE 16-3: COMPARE MODE OPERATION BLOCK DIAGRAM

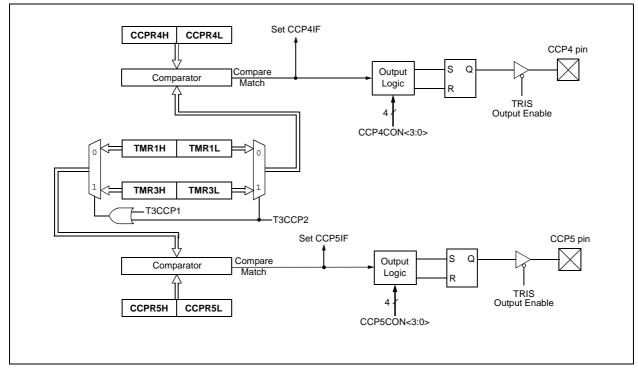


TABLE 16-2: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, TIMER1 AND TIMER3

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
RCON	IPEN	_	_	RI	TO	PD	POR	BOR	50
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	TMR3IF	CCP2IF	51
PIE2	OSCFIE	CMIE	_	_	BCL1IE	_	TMR3IE	CCP2IE	51
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	TMR3IP	CCP2IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
TRISG	_	_	1	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	52
TMR1L	Timer1 Reg	gister Low B	Syte						50
TMR1H	Timer1 Reg	gister High E	Byte						50
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	50
TMR3H	Timer3 Reg	gister High E	Byte						51
TMR3L	Timer3 Reg	gister Low B	Syte						51
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON	51
CCPR4L	Capture/Co	mpare/PWI	M Register	4 Low Byte					53
CCPR4H	Capture/Co	ompare/PWI	M Register 4	4 High Byte					53
CCPR5L	Capture/Compare/PWM Register 5 Low Byte								
CCPR5H	Capture/Co	ompare/PWI	M Register :	5 High Byte					53
CCP4CON	_	_	DC4B1	DC4B0	CCP4M3	CCP4M2	CCP4M1	CCP4M0	53
CCP5CON	_	_	DC5B1	DC5B0	CCP5M3	CCP5M2	CCP5M1	CCP5M0	53

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Capture/Compare, Timer1 or Timer3.

16.4 PWM Mode

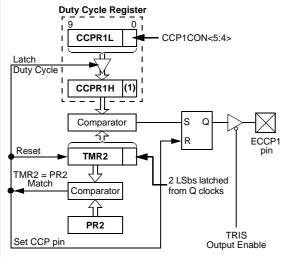
In Pulse-Width Modulation (PWM) mode, the CCPx pin produces up to a 10-bit resolution PWM output. Since the CCP4 and CCP5 pins are multiplexed with a PORTG data latch, the appropriate TRISG bit must be cleared to make the CCP4 or CCP5 pin an output.

Note: Clearing the CCP4CON or CCP5CON register will force the RG3 or RG4 output latch (depending on device configuration) to the default low level. This is not the PORTG I/O data latch.

Figure 16-4 shows a simplified block diagram of the CCP module in PWM mode.

For a step-by-step procedure on how to set up a CCP module for PWM operation, see **Section 16.4.3** "**Setup for PWM Operation**".

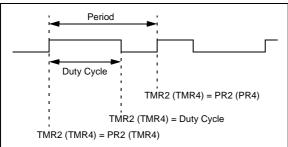
FIGURE 16-4: SIMPLIFIED PWM BLOCK DIAGRAM



Note 1: The two LSbs of the Duty Cycle register are held by a 2-bit latch that is part of the module's hardware. It is physically separate from the CCPR registers.

A PWM output (Figure 16-5) has a time base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

FIGURE 16-5: PWM OUTPUT



16.4.1 PWM PERIOD

The PWM period is specified by writing to the PR2 (PR4) register. The PWM period can be calculated using Equation 16-1:

EQUATION 16-1:

PWM Period = [(PR2) + 1] • 4 • Tosc • (TMR2 Prescale Value)

PWM frequency is defined as 1/[PWM period].

When TMR2 (TMR4) is equal to PR2 (PR4), the following three events occur on the next increment cycle:

- TMR2 (TMR4) is cleared
- The CCPx pin is set (exception: if PWM duty cycle = 0%, the CCPx pin will not be set)
- The PWM duty cycle is latched from CCPRxL into CCPRxH

Note: The Timer2 and Timer 4 postscalers (see Section 13.0 "Timer2 Module" and Section 15.0 "Timer4 Module") are not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

16.4.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPRxL register and to the CCPxCON<5:4> bits. Up to 10-bit resolution is available. The CCPRxL contains the eight MSbs and the CCPxCON<5:4> contains the two LSbs. This 10-bit value is represented by CCPRxL:CCPxCON<5:4>. Equation 16-2 is used to calculate the PWM duty cycle in time.

EQUATION 16-2:

PWM Duty Cycle = (CCPRxL:CCPxCON<5:4>) • Tosc • (TMR2 Prescale Value)

CCPRxL and CCPxCON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPRxH until after a match between PR2 (PR4) and TMR2 (TMR4) occurs (i.e., the period is complete). In PWM mode, CCPRxH is a read-only register.

The CCPRxH register and a 2-bit internal latch are used to double-buffer the PWM duty cycle. This double-buffering is essential for glitchless PWM operation.

When the CCPRxH and 2-bit latch match TMR2 (TMR4), concatenated with an internal 2-bit Q clock or 2 bits of the TMR2 (TMR4) prescaler, the CCPx pin is cleared.

The maximum PWM resolution (bits) for a given PWM frequency is given by Equation 16-3:

EQUATION 16-3:

PWM Resolution (max) =
$$\frac{\log(\frac{FOSC}{FPWM})}{\log(2)}$$
 bits

Note: If the PWM duty cycle value is longer than the PWM period, the CCPx pin will not be cleared.

16.4.3 SETUP FOR PWM OPERATION

The following steps should be taken when configuring the CCP module for PWM operation:

- 1. Set the PWM period by writing to the PR2 (PR4) register.
- 2. Set the PWM duty cycle by writing to the CCPRxL register and CCPxCON<5:4> bits.
- 3. Make the CCPx pin an output by clearing the appropriate TRIS bit.
- Set the TMR2 (TMR4) prescale value, then enable Timer2 (Timer4) by writing to T2CON (T4CON).
- 5. Configure the CCPx module for PWM operation.

TABLE 16-3: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 40 MHz

PWM Frequency	2.44 kHz	9.77 kHz	39.06 kHz	156.25 kHz	312.50 kHz	416.67 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	FFh	FFh	FFh	3Fh	1Fh	17h
Maximum Resolution (bits)	10	10	10	8	7	6.58

TABLE 16-4: REGISTERS ASSOCIATED WITH PWM, TIMER2 AND TIMER4

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
RCON	IPEN	_	_	RI	TO	PD	POR	BOR	50
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
TRISG	_	_	_	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	52
TMR2	Timer2 Reg	jister							50
PR2	Timer2 Peri	iod Register							50
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	50
TMR4	Timer4 Reg	jister							53
PR4	Timer4 Peri	iod Register							53
T4CON	_	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	53
CCPR4L	Capture/Co	mpare/PWN	1 Register 4	Low Byte					53
CCPR4H	Capture/Co	mpare/PWN	1 Register 4	High Byte					53
CCPR5L	Capture/Co	Capture/Compare/PWM Register 5 Low Byte							
CCPR5H	Capture/Co	Capture/Compare/PWM Register 5 High Byte							53
CCP4CON	_	_	DC4B1	DC4B0	CCP4M3	CCP4M2	CCP4M1	CCP4M0	53
CCP5CON	_	_	DC5B1	DC5B0	CCP5M3	CCP5M2	CCP5M1	CCP5M0	53

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PWM, Timer2 or Timer4.

17.0 ENHANCED CAPTURE/ COMPARE/PWM (ECCP) MODULE

In the PIC18F87J10 family of devices, three of the CCP modules are implemented as standard CCP modules with Enhanced PWM capabilities. These include the provision for 2 or 4 output channels, user-selectable polarity, dead-band control and automatic shutdown and restart. The Enhanced features are discussed in detail in **Section 17.4 "Enhanced PWM Mode"**. Capture, Compare and single-output PWM functions of the ECCP module are the same as described for the standard CCP module.

The control register for the Enhanced CCP module is shown in Register 17-1. It differs from the CCP4CON/CCP5CON registers in that the two Most Significant bits are implemented to control PWM functionality.

In addition to the expanded range of modes available through the Enhanced CCPxCON register, the ECCP modules each have two additional features associated with Enhanced PWM operation and auto-shutdown features. They are:

- ECCPxDEL (Dead-Band Delay)
- ECCPxAS (Auto-Shutdown Configuration)

REGISTER 17-1: CCPxCON: ENHANCED CCP CONTROL REGISTER (ECCP1/ECCP2/ECCP3)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PxM1	PxM0	DCxB1	DCxB0	CCPxM3	CCPxM2	CCPxM1	CCPxM0
bit 7							bit 0

bit 7-6 PxM1:PxM0: Enhanced PWM Output Configuration bits

If CCPxM3:CCPxM2 = 00, 01, 10:

xx = PxA assigned as Capture/Compare input/output; PxB, PxC, PxD assigned as port pins If CCPxM3:CCPxM2 = 11:

00 = Single output: PxA modulated; PxB, PxC, PxD assigned as port pins

01 = Full-bridge output forward: P1D modulated; P1A active; P1B, P1C inactive

10 = Half-bridge output: P1A, P1B modulated with dead-band control; P1C, P1D assigned as port pins

11 = Full-bridge output reverse: P1B modulated; P1C active; P1A, P1D inactive

bit 5-4 DCxB1:DCxB0: PWM Duty Cycle bit 1 and bit 0

Capture mode:

Unused.

Compare mode:

Unused.

PWM mode:

These bits are the two LSbs of the 10-bit PWM duty cycle. The eight MSbs of the duty cycle are found in CCPRxL.

bit 3-0 CCPxM3:CCPxM0: Enhanced CCP Mode Select bits

0000 = Capture/Compare/PWM off (resets ECCPx module)

0001 = Reserved

0010 = Compare mode, toggle output on match

0011 = Capture mode

0100 = Capture mode, every falling edge

0101 = Capture mode, every rising edge

0110 = Capture mode, every 4th rising edge

0111 = Capture mode, every 16th rising edge

1000 = Compare mode, initialize ECCP pin low, set output on compare match (set CCPxIF)

1001 = Compare mode, initialize ECCP pin high, clear output on compare match (set CCPxIF)

1010 = Compare mode, generate software interrupt only, ECCP pin reverts to I/O state

1011 = Compare mode, trigger special event (ECCP resets TMR1 or TMR3, sets CCPxIF bit, ECCP2 trigger also starts A/D conversion if A/D module is enabled)⁽¹⁾

1100 = PWM mode; PxA, PxC active-high; PxB, PxD active-high

1101 = PWM mode; PxA, PxC active-high; PxB, PxD active-low

1110 = PWM mode; PxA, PxC active-low; PxB, PxD active-high

1111 = PWM mode; PxA, PxC active-low; PxB, PxD active-low

Note 1: Implemented only for ECCP1 and ECCP2; same as '1010' for ECCP3.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

17.1 ECCP Outputs and Configuration

Each of the Enhanced CCP modules may have up to four PWM outputs, depending on the selected operating mode. These outputs, designated PxA through PxD, are multiplexed with various I/O pins. Some ECCP pin assignments are constant, while others change based on device configuration. For those pins that do change, the controlling bits are:

- · CCP2MX configuration bit
- ECCPMX configuration bit (80-pin devices only)
- Program Memory Operating mode, set by the EMB configuration bits (80-pin devices only)

The pin assignments for the Enhanced CCP modules are summarized in Table 17-1, Table 17-2 and Table 17-3. To configure the I/O pins as PWM outputs, the proper PWM mode must be selected by setting the PxMx and CCPxMx bits (CCPxCON<7:6> and <3:0>, respectively). The appropriate TRIS direction bits for the corresponding port pins must also be set as outputs.

17.1.1 ECCP1/ECCP3 OUTPUTS AND PROGRAM MEMORY MODE

In 80-pin devices, the use of Extended Microcontroller mode has an indirect effect on the use ECCP1 and ECCP3 in Enhanced PWM modes. By default, PWM outputs P1B/P1C and P3B/P3C are multiplexed to PORTE pins, along with the high-order byte of the external memory bus. When the bus is active in Extended Microcontroller mode, it overrides the Enhanced CCP outputs and makes them unavailable. Because of this, ECCP1 and ECCP3 can only be used in compatible (single-output) PWM modes when the device is in Extended Microcontroller mode and default pin configuration.

An exception to this configuration is when a 12-bit address width is selected for the external bus (EMB1:EMB0 configuration bits = 01). In this case, the upper pins of PORTE continue to operate as digital I/O, even when the external bus is active; P1B/P1C and P3B/P3C remain available for use as Enhanced PWM outputs.

If an application requires the use of additional PWM outputs during Enhanced microcontroller operation, the P1B/P1C and P3B/P3C outputs can be reassigned to the upper bits of PORTH. This is done by clearing the ECCPMX configuration bit.

17.1.2 ECCP2 OUTPUTS AND PROGRAM MEMORY MODES

For 80-pin devices, the program memory mode of the device (Section 5.1.3 "PIC18F8XJ10/8XJ15 Program Memory Modes") also impacts pin multiplexing for the module.

The ECCP2 input/output (ECCP2/P2A) can be multiplexed to one of three pins. The default assignment (CCP2MX configuration bit is set) for all devices is RC1. Clearing CCP2MX reassigns ECCP2/P2A to RF7.

An additional option exists for 80-pin devices. When these devices are operating in Microcontroller mode, the multiplexing options described above still apply. In Extended Microcontroller mode, clearing CCP2MX reassigns ECCP2/P2A to RB3.

17.1.3 USE OF CCP4 AND CCP5 WITH ECCP1 AND ECCP3

Only the ECCP2 module has four dedicated output pins that are available for use. Assuming that the I/O ports or other multiplexed functions on those pins are not needed, they may be used whenever needed without interfering with any other CCP module.

ECCP1 and ECCP3, on the other hand, only have three dedicated output pins: ECCPx/PxA, PxB and PxC. Whenever these modules are configured for Quad PWM mode, the pin normally used for CCP4 or CCP5 becomes the PxD output pins for ECCP3 and ECCP1, respectively. The CCP4 and CCP5 modules remain functional but their outputs are overridden.

17.1.4 ECCP MODULES AND TIMER RESOURCES

Like the standard CCP modules, the ECCP modules can utilize Timers 1, 2, 3 or 4, depending on the mode selected. Timer1 and Timer3 are available for modules in Capture or Compare modes, while Timer2 and Timer4 are available for modules in PWM mode. Additional details on timer resources are provided in Section 16.1.1 "CCP Modules and Timer Resources".

TABLE 17-1: PIN CONFIGURATIONS FOR ECCP1

ECCP Mode	CCP1CON Configuration	RC2	RE6	RE5	RG4	RH7	RH6	
		All Pi	C18F6XJ10/6	KJ15 Devices				
Compatible CCP	00xx 11xx	ECCP1	RE6	RE5	RG4/CCP5	N/A	N/A	
Dual PWM	10xx 11xx	P1A	P1B	RE5	RG4/CCP5	N/A	N/A	
Quad PWM	x1xx 11xx	P1A	P1B	P1C	P1D	N/A	N/A	
	PIC18F8XJ10/8XJ15 Devices, ECCPMX = 0, Microcontroller mode:							
Compatible CCP	00xx 11xx	ECCP1	RE6/AD14	RE5/AD13	RG4/CCP5	RH7/AN15	RH6/AN14	
Dual PWM	10xx 11xx	P1A	RE6/AD14	RE5/AD13	RG4/CCP5	P1B	RH6/AN14	
Quad PWM	x1xx 11xx	P1A	RE6/AD14	RE5/AD13	P1D	P1B	P1C	
PIC18F8XJ10/8	XJ15 Devices, E	ECCPMX = 1,	Extended Mi	crocontroller	mode, 16-bit	or 20-bit Add	ress Width:	
Compatible CCP	00xx 11xx	ECCP1	RE6/AD14	RE5/AD13	RG4/CCP5	RH7/AN15	RH6/AN14	
		PIC18F8XJ	10/8XJ15 Dev	rices, ECCPM	X = 1,			
N	licrocontroller r	node or Exte	nded Microco	ontroller mod	e, 12-bit Addı	ress Width:		
Compatible CCP	00xx 11xx	ECCP1	RE6/AD14	RE5/AD13	RG4/CCP5	RH7/AN15	RH6/AN14	
Dual PWM	10xx 11xx	P1A	P1B	RE5/AD13	RG4/CCP5	RH7/AN15	RH6/AN14	
Quad PWM	x1xx 11xx	P1A	P1B	P1C	P1D	RH7/AN15	RH6/AN14	

Legend: x = Don't care, N/A = Not available. Shaded cells indicate pin assignments not used by ECCP1 in a given mode. **Note 1:** With ECCP1 in Quad PWM mode, CCP5's output is overridden by P1D; otherwise, CCP5 is fully operational.

TABLE 17-2: PIN CONFIGURATIONS FOR ECCP2

ECCP Mode	CCP2CON Configuration	RB3	RC1	RE7	RE2	RE1	RE0			
	All Devices, CCP2MX = 1, either operating mode:									
Compatible CCP	00xx 11xx	RB3/INT3	ECCP2	RE7	RE2	RE1	RE0			
Dual PWM	10xx 11xx	RB3/INT3	P2A	RE7	P2B	RE1	RE0			
Quad PWM	x1xx 11xx	RB3/INT3	P2A	RE7	P2B	P2C	P2D			
All Devices, CCP2MX = 0, Microcontroller mode:										
Compatible CCP	00xx 11xx	RB3/INT3	RC1/T1OS1	ECCP2	RE2	RE1	RE0			
Dual PWM	10xx 11xx	RB3/INT3	RC1/T1OS1	P2A	P2B	RE1	RE0			
Quad PWM	x1xx 11xx	RB3/INT3	RC1/T1OS1	P2A	P2B	P2C	P2D			
	PIC18F8XJ10/8	XJ15 Device	s, CCP2MX =	0, Extended	Microcontroll	er mode:				
Compatible CCP	00xx 11xx	ECCP2	RC1/T1OS1	RE7/AD15	RE2/CS	RE1/WR	RE0/RD			
Dual PWM	10xx 11xx	P2A	RC1/T1OS1	RE7/AD15	P2B	RE1/WR	RE0/RD			
Quad PWM	x1xx 11xx	P2A	RC1/T1OS1	RE7/AD15	P2B	P2C	P2D			

Legend: x = Don't care. Shaded cells indicate pin assignments not used by ECCP2 in a given mode.

TABLE 17-3: PIN CONFIGURATIONS FOR ECCP3

ECCP Mode	CCP3CON Configuration	RG0	RE4	RE3	RG3	RH5	RH4			
	All PIC18F6XJ10/6XJ15 Devices:									
Compatible CCP	00xx 11xx	ECCP3	RE4	RE3	RG3/CCP4	N/A	N/A			
Dual PWM	10xx 11xx	P3A	P3B	RE3	RG3/CCP4	N/A	N/A			
Quad PWM	x1xx 11xx	P3A	P3B	P3C	P3D	N/A	N/A			
	PIC18F8XJ10/8XJ15 Devices, ECCPMX = 0, Microcontroller mode:									
Compatible CCP	00xx 11xx	ECCP3	RE6/AD14	RE5/AD13	RG3/CCP4	RH7/AN15	RH6/AN14			
Dual PWM	10xx 11xx	P3A	RE6/AD14	RE5/AD13	RG3/CCP4	P3B	RH6/AN14			
Quad PWM	x1xx 11xx	P3A	RE6/AD14	RE5/AD13	P3D	P3B	P3C			
PIC18F8XJ10/8	XJ15 Devices, E	ECCPMX = 1,	Extended Mid	crocontroller	mode, 16-bit	or 20-bit Add	ress Width:			
Compatible CCP	00xx 11xx	ECCP3	RE6/AD14	RE5/AD13	RG3/CCP4	RH7/AN15	RH6/AN14			
N	PIC18F8XJ10/8XJ15 Devices, ECCPMX = 1, Microcontroller mode or Extended Microcontroller mode, 12-bit Address Width:									
Compatible CCP	00xx 11xx	ECCP3	RE4/AD12	RE3/AD11	RG3/CCP4	RH5/AN13	RH4/AN12			
Dual PWM	10xx 11xx	P3A	P3B	RE3/AD11	RG3/CCP4	RH5/AN13	RH4/AN12			
Quad PWM	x1xx 11xx	P3A	P3B	P3C	P3D	RH5/AN13	RH4/AN12			

Legend: x = Don't care, N/A = Not available. Shaded cells indicate pin assignments not used by ECCP3 in a given mode. **Note 1:** With ECCP3 in Quad PWM mode, CCP4's output is overridden by P1D; otherwise, CCP4 is fully operational.

17.2 Capture and Compare Modes

Except for the operation of the Special Event Trigger discussed below, the Capture and Compare modes of the ECCP module are identical in operation to that of CCP4. These are discussed in detail in Section 16.2 "Capture Mode" and Section 16.3 "Compare Mode".

17.2.1 SPECIAL EVENT TRIGGER

ECCP1 and ECCP2 incorporate an internal hardware trigger that is generated in Compare mode on a match between the CCPRx register pair and the selected timer. This can be used in turn to initiate an action. This mode is selected by setting CCPxCON<3:0> to '1011'.

The Special Event Trigger output of either ECCP1 or ECCP2 resets the TMR1 or TMR3 register pair, depending on which timer resource is currently selected. This allows the CCPRx register to effectively be a 16-bit programmable period register for Timer1 or Timer3. In addition, the ECCP2 Special Event Trigger will also start an A/D conversion if the A/D module is enabled.

Special Event Triggers are not implemented for ECCP3, CCP4 or CCP5. Selecting the Special Event mode for these modules has the same effect as selecting the Compare with Software Interrupt mode (CCPxM3:CCPxM0 = 1010).

Note: The Special Event Trigger from ECCP2 will not set the Timer1 or Timer3 interrupt flag bits.

17.3 Standard PWM Mode

When configured in Single Output mode, the ECCP module functions identically to the standard CCP module in PWM mode as described in **Section 16.4** "**PWM Mode**". This is also sometimes referred to as "Compatible CCP" mode as in Tables 17-1 through 17-3.

Note: When setting up single-output PWM operations, users are free to use either of the processes described in Section 16.4.3 "Setup for PWM Operation" or Section 17.4.9 "Setup for PWM Operation". The latter is more generic but will work for either single or multi-output PWM.

17.4 **Enhanced PWM Mode**

The Enhanced PWM mode provides additional PWM output options for a broader range of control applications. The module is a backward compatible version of the standard CCP module and offers up to four outputs, designated PxA through PxD. Users are also able to select the polarity of the signal (either active-high or active-low). The module's output mode and polarity are configured by setting the PxM1:PxM0 and CCPxM3CCPxM0 bits of the CCPxCON register (CCPxCON<7:6> and CCPxCON<3:0>, respectively).

For the sake of clarity, Enhanced PWM mode operation is described generically throughout this section with respect to ECCP1 and TMR2 modules. Control register names are presented in terms of ECCP1. All three Enhanced modules, as well as the two timer resources, can be used interchangeably and function identically. TMR2 or TMR4 can be selected for PWM operation by selecting the proper bits in T3CON.

Figure 17-1 shows a simplified block diagram of PWM operation. All control registers are double-buffered and are loaded at the beginning of a new PWM cycle (the period boundary when Timer2 resets) in order to prevent glitches on any of the outputs. The exception is the PWM Delay register, ECCP1DEL, which is loaded at either the duty cycle boundary or the boundary period (whichever comes first). Because of the buffering, the module waits until the assigned timer resets instead of starting immediately. This means that Enhanced PWM

waveforms do not exactly match the standard PWM waveforms but are instead offset by one full instruction cycle (4 Tosc).

As before, the user must manually configure the appropriate TRIS bits for output.

PWM PERIOD 17.4.1

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the equation:

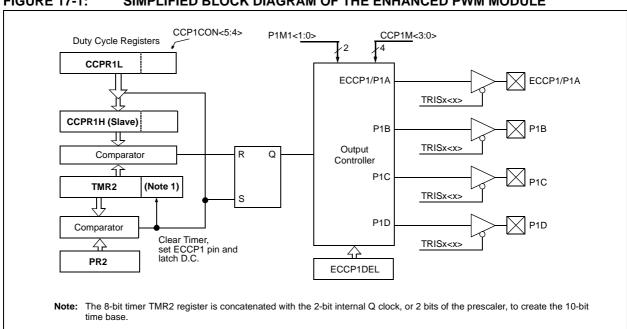
EQUATION 17-1:

PWM frequency is defined as 1/[PWM period]. When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- · TMR2 is cleared
- The ECCP1 pin is set (if PWM duty cycle = 0%, the ECCP1 pin will not be set)
- The PWM duty cycle is copied from CCPR1L into CCPR1H

The Timer2 postscaler (see Section 13.0 Note: "Timer2 Module") is not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

FIGURE 17-1: SIMPLIFIED BLOCK DIAGRAM OF THE ENHANCED PWM MODULE



17.4.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available. The CCPR1L contains the eight MSbs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPRxL:CCPxCON<5:4>. The PWM duty cycle is calculated by the equation:

EQUATION 17-2:

CCPR1L and CCP1CON<5:4> can be written to at any time but the duty cycle value is not copied into CCPR1H until a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read-only register.

The CCPRxH register and a 2-bit internal latch are used to double-buffer the PWM duty cycle. This double-buffering is essential for glitchless PWM operation. When the CCPR1H and 2-bit latch match TMR2, concatenated with an internal 2-bit Q clock or two bits of the TMR2 prescaler, the ECCP1 pin is cleared. The maximum PWM resolution (bits) for a given PWM frequency is given by the equation:

EQUATION 17-3:

PWM Resolution (max) =
$$\frac{\log\left(\frac{FOSC}{FPWM}\right)}{\log(2)}$$
 bits

Note: If the PWM duty cycle value is longer than the PWM period, the ECCP1 pin will not be cleared.

17.4.3 PWM OUTPUT CONFIGURATIONS

The P1M1:P1M0 bits in the CCP1CON register allow one of four configurations:

- · Single Output
- Half-Bridge Output
- · Full-Bridge Output, Forward mode
- Full-Bridge Output, Reverse mode

The Single Output mode is the standard PWM mode discussed in **Section 17.4** "Enhanced PWM Mode". The Half-Bridge and Full-Bridge Output modes are covered in detail in the sections that follow.

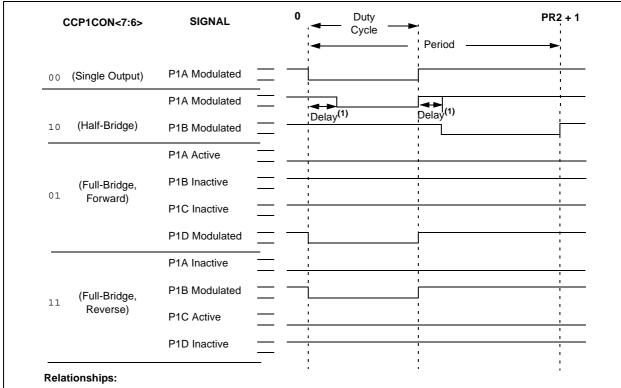
The general relationship of the outputs in all configurations is summarized in Figure 17-2.

TABLE 17-4: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 40 MHz

PWM Frequency	2.44 kHz	9.77 kHz	39.06 kHz	156.25 kHz	312.50 kHz	416.67 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	FFh	FFh	FFh	3Fh	1Fh	17h
Maximum Resolution (bits)	10	10	10	8	7	6.58

FIGURE 17-2: PWM OUTPUT RELATIONSHIPS (ACTIVE-HIGH STATE) PR2 + 1 Duty CCP1CON<7:6> **SIGNAL** Cycle Period 00 (Single Output) P1A Modulated Delay⁽¹⁾ Delay⁽¹⁾ P1A Modulated (Half-Bridge) 10 P1B Modulated P1A Active (Full-Bridge, P1B Inactive Forward) P1C Inactive P1D Modulated P1A Inactive P1B Modulated (Full-Bridge, Reverse) P1C Active P1D Inactive

FIGURE 17-3: PWM OUTPUT RELATIONSHIPS (ACTIVE-LOW STATE)



- Period = 4 * Tosc * (PR2 + 1) * (TMR2 Prescale Value)
- Duty Cycle = Tosc * (CCPR1L<7:0>:CCP1CON<5:4>) * (TMR2 Prescale Value)
- Delay = 4 * Tosc * (ECCP1DEL<6:0>)

Note 1: Dead-band delay is programmed using the ECCP1DEL register (Section 17.4.6 "Programmable Dead-Band Delay").

17.4.4 HALF-BRIDGE MODE

In the Half-Bridge Output mode, two pins are used as outputs to drive push-pull loads. The PWM output signal is output on the P1A pin, while the complementary PWM output signal is output on the P1B pin (Figure 17-4). This mode can be used for half-bridge applications, as shown in Figure 17-5, or for full-bridge applications, where four power switches are being modulated with two PWM signals.

In Half-Bridge Output mode, the programmable dead-band delay can be used to prevent shoot-through current in half-bridge power devices. The value of bits PDC6:PDC0 sets the number of instruction cycles before the output is driven active. If the value is greater than the duty cycle, the corresponding output remains inactive during the entire cycle. See **Section 17.4.6** "**Programmable Dead-Band Delay**" for more details on dead-band delay operations.

Since the P1A and P1B outputs are multiplexed with the PORTC<2> and PORTE<6> data latches, the TRISC<2> and TRISE<6> bits must be cleared to configure P1A and P1B as outputs.

FIGURE 17-4: HALF-BRIDGE PWM OUTPUT

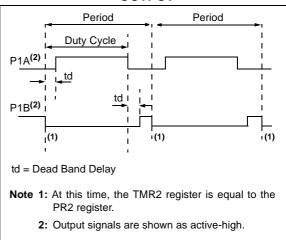
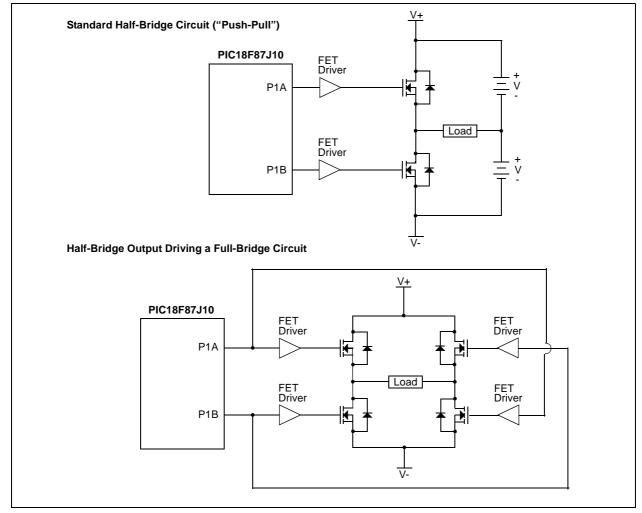


FIGURE 17-5: EXAMPLES OF HALF-BRIDGE OUTPUT MODE APPLICATIONS

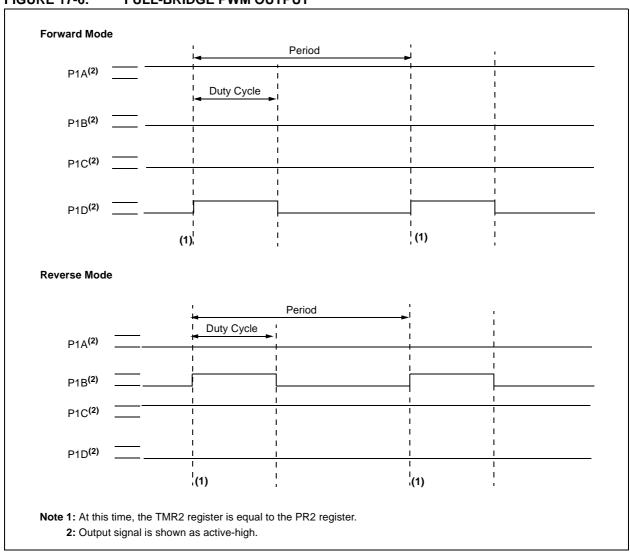


17.4.5 FULL-BRIDGE MODE

In Full-Bridge Output mode, four pins are used as outputs; however, only two outputs are active at a time. In the Forward mode, pin P1A is continuously active and pin P1D is modulated. In the Reverse mode, pin P1C is continuously active and pin P1B is modulated. These are illustrated in Figure 17-6.

P1A, P1B, P1C and P1D outputs are multiplexed with the PORTC<2>, PORTE<6:5> and PORTG<4> data latches. The TRISC<2>, TRISC<6:5> and TRISG<4> bits must be cleared to make the P1A, P1B, P1C and P1D pins outputs.

FIGURE 17-6: FULL-BRIDGE PWM OUTPUT



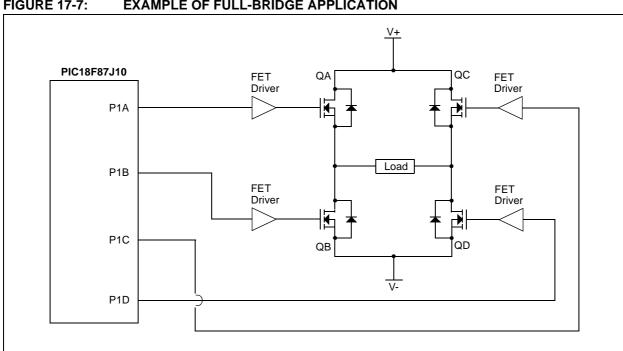


FIGURE 17-7: **EXAMPLE OF FULL-BRIDGE APPLICATION**

17.4.5.1 Direction Change in Full-Bridge Mode

In the Full-Bridge Output mode, the P1M1 bit in the CCP1CON register allows users to control the forward/ reverse direction. When the application firmware changes this direction control bit, the module will assume the new direction on the next PWM cycle.

Just before the end of the current PWM period, the modulated outputs (P1B and P1D) are placed in their inactive state, while the unmodulated outputs (P1A and P1C) are switched to drive in the opposite direction. This occurs in a time interval of (4 Tosc * (Timer2 Prescale Value) before the next PWM period begins. The Timer2 prescaler will be either 1, 4 or 16, depending on the value of the T2CKPS bit (T2CON<1:0>). During the interval from the switch of the unmodulated outputs to the beginning of the next period, the modulated outputs (P1B and P1D) remain inactive. This relationship is shown in Figure 17-8.

Note that in the Full-Bridge Output mode, the ECCP1 module does not provide any dead-band delay. In general, since only one output is modulated at all times, dead-band delay is not required. However, there is a situation where a dead-band delay might be required. This situation occurs when both of the following conditions are true:

- The direction of the PWM output changes when the duty cycle of the output is at or near 100%.
- The turn-off time of the power switch, including the power device and driver circuit, is greater than the turn-on time.

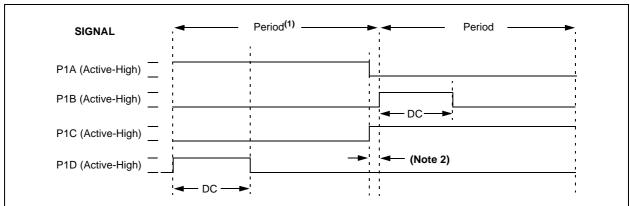
Figure 17-9 shows an example where the PWM direction changes from forward to reverse at a near 100% duty cycle. At time t1, the outputs P1A and P1D become inactive, while output P1C becomes active. In this example, since the turn-off time of the power devices is longer than the turn-on time, a shoot-through current may flow through power devices QC and QD (see Figure 17-7) for the duration of 't'. The same phenomenon will occur to power devices QA and QB for PWM direction change from reverse to forward.

If changing PWM direction at high duty cycle is required for an application, one of the following requirements must be met:

- Reduce PWM for a PWM period before changing directions.
- Use switch drivers that can drive the switches off faster than they can drive them on.

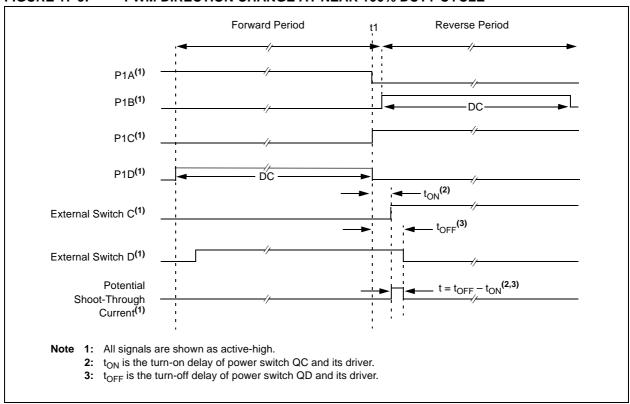
Other options to prevent shoot-through current may exist.

FIGURE 17-8: PWM DIRECTION CHANGE



- Note 1: The direction bit in the ECCP1 Control register (CCP1CON<7>) is written at any time during the PWM cycle.
 - 2: When changing directions, the P1A and P1C signals switch before the end of the current PWM cycle at intervals of 4 Tosc, 16 Tosc or 64 Tosc, depending on the Timer2 prescaler value. The modulated P1B and P1D signals are inactive at this time.

FIGURE 17-9: PWM DIRECTION CHANGE AT NEAR 100% DUTY CYCLE



17.4.6 PROGRAMMABLE DEAD-BAND DELAY

In half-bridge applications, where all power switches are modulated at the PWM frequency at all times, the power switches normally require more time to turn off than to turn on. If both the upper and lower power switches are switched at the same time (one turned on and the other turned off), both switches may be on for a short period of time until one switch completely turns off. During this brief interval, a very high current (shoot-through current) may flow through both power switches, shorting the bridge supply. To avoid this potentially destructive shoot-through current from flowing during switching, turning on either of the power switches is normally delayed to allow the other switch to completely turn off.

In the Half-Bridge Output mode, a digitally programmable dead-band delay is available to avoid shoot-through current from destroying the bridge power switches. The delay occurs at the signal transition from the non-active state to the active state. See Figure 17-4 for illustration. The lower seven bits of the ECCPxDEL register (Register 17-2) set the delay period in terms of microcontroller instruction cycles (Tcy or 4 Tosc).

17.4.7 ENHANCED PWM AUTO-SHUTDOWN

When the ECCP1 is programmed for any of the Enhanced PWM modes, the active output pins may be configured for auto-shutdown. Auto-shutdown immediately places the Enhanced PWM output pins into a defined shutdown state when a shutdown event occurs.

A shutdown event can be caused by either of the two comparator modules or the INT0 pin (or any combination of these three sources). The comparators may be used to monitor a voltage input proportional to a current being monitored in the bridge circuit. If the voltage exceeds a threshold, the comparator switches state and triggers a shutdown. Alternatively, a digital signal on the INT0 pin can also trigger a shutdown. The auto-shutdown feature can be disabled by not selecting any auto-shutdown sources. The auto-shutdown sources to be used are selected using the ECCP1AS2:ECCP1AS0 bits (bits<6:4> of the ECCP1AS register).

When a shutdown occurs, the output pins are asynchronously placed in their shutdown states, specified by the PSS1AC1:PSS1AC0 and PSS1BD1:PSS1BD0 bits (ECCP1AS3:ECCP1AS0). Each pin pair (P1A/P1C and P1B/P1D) may be set to drive high, drive low or be tri-stated (not driving). The ECCP1ASE bit (ECCP1AS<7>) is also set to hold the Enhanced PWM outputs in their shutdown states.

The ECCP1ASE bit is set by hardware when a shutdown event occurs. If automatic restarts are not enabled, the ECCPASE bit is cleared by firmware when the cause of the shutdown clears. If automatic restarts are enabled, the ECCPASE bit is automatically cleared when the cause of the auto-shutdown has cleared.

If the ECCPASE bit is set when a PWM period begins, the PWM outputs remain in their shutdown state for that entire PWM period. When the ECCPASE bit is cleared, the PWM outputs will return to normal operation at the beginning of the next PWM period.

Note: Writing to the ECCPASE bit is disabled while a shutdown condition is active.

REGISTER 17-2: ECCPxDEL: PWM CONFIGURATION REGISTER

PxRS	EN PxDC6	PxDC5	PxDC4	PxDC3	PxDC2	PxDC1	PxDC0
I XINO	LIN I XDC0	1 XDC3	T ADC4	1 ADC3	1 ADGZ	TADOT	1 ADG0

bit 7 PxRSEN: PWM Restart Enable bit

- 1 = Upon auto-shutdown, the ECCPxASE bit clears automatically once the shutdown event goes away; the PWM restarts automatically
- 0 = Upon auto-shutdown, ECCPxASE must be cleared in software to restart the PWM

bit 6-0 PxDC6:PxDC0: PWM Delay Count bits

Delay time, in number of Fosc/4 (4 * Tosc) cycles, between the scheduled and actual time for a PWM signal to transition to active.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 17-3: ECCPxAS: ENHANCED CCP AUTO-SHUTDOWN CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ECCPxASE	ECCPxAS2	ECCPxAS1	ECCPxAS0	PSSxAC1	PSSxAC0	PSSxBD1	PSSxBD0
bit 7							bit 0

bit 7 ECCPxASE: ECCP Auto-Shutdown Event Status bit

0 = ECCP outputs are operating

1 = A shutdown event has occurred; ECCP outputs are in shutdown state

bit 6-4 ECCPxAS2:ECCPxAS0: ECCP Auto-Shutdown Source Select bits

000 = Auto-shutdown is disabled
001 = Comparator 1 output
010 = Comparator 2 output
011 = Either Comparator 1 or 2

100 = INT0

101 = INT0 or Comparator 1 110 = INT0 or Comparator 2

111 = INT0 or Comparator 1 or Comparator 2

bit 3-2 **PSSxAC1:PSSxAC0:** Pins A and C Shutdown State Control bits

00 = Drive Pins A and C to '0' 01 = Drive Pins A and C to '1' 1x = Pins A and C tri-state

bit 1-0 PSSxBD1:PSSxBD0: Pins B and D Shutdown State Control bits

00 = Drive Pins B and D to '0' 01 = Drive Pins B and D to '1' 1x = Pins B and D tri-state

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

17.4.7.1 Auto-Shutdown and Automatic Restart

The auto-shutdown feature can be configured to allow automatic restarts of the module following a shutdown event. This is enabled by setting the P1RSEN bit of the ECCP1DEL register (ECCP1DEL<7>).

In Shutdown mode with P1RSEN = 1 (Figure 17-10), the ECCPASE bit will remain set for as long as the cause of the shutdown continues. When the shutdown condition clears, the ECCP1ASE bit is cleared. If P1RSEN = 0 (Figure 17-11), once a shutdown condition occurs, the ECCP1ASE bit will remain set until it is cleared by firmware. Once ECCP1ASE is cleared, the Enhanced PWM will resume at the beginning of the next PWM period.

Note: Writing to the ECCPASE bit is disabled while a shutdown condition is active.

Independent of the P1RSEN bit setting, if the auto-shutdown source is one of the comparators, the shutdown condition is a level. The ECCP1ASE bit cannot be cleared as long as the cause of the shutdown persists.

The Auto-Shutdown mode can be forced by writing a '1' to the ECCPASE bit.

17.4.8 START-UP CONSIDERATIONS

When the ECCP module is used in the PWM mode, the application hardware must use the proper external pull-up and/or pull-down resistors on the PWM output pins. When the microcontroller is released from Reset, all of the I/O pins are in the high-impedance state. The external circuits must keep the power switch devices in the OFF state until the microcontroller drives the I/O pins with the proper signal levels, or activates the PWM output(s).

The CCP1M1:CCP1M0 bits (CCP1CON<1:0>) allow the user to choose whether the PWM output signals are active-high or active-low for each pair of PWM output pins (P1A/P1C and P1B/P1D). The PWM output polarities must be selected before the PWM pins are configured as outputs. Changing the polarity configuration while the PWM pins are configured as outputs is not recommended since it may result in damage to the application circuits.

The P1A, P1B, P1C and P1D output latches may not be in the proper states when the PWM module is initialized. Enabling the PWM pins for output at the same time as the ECCP module may cause damage to the application circuit. The ECCP module must be enabled in the

proper output mode and complete a full PWM cycle before configuring the PWM pins as outputs. The completion of a full PWM cycle is indicated by the TMR2IF bit being set as the second PWM period begins.

FIGURE 17-10: PWM AUTO-SHUTDOWN (P1RSEN = 1, AUTO-RESTART ENABLED)

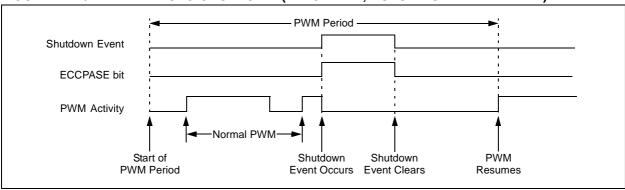
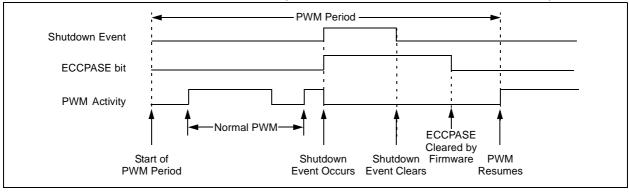


FIGURE 17-11: PWM AUTO-SHUTDOWN (P1RSEN = 0, AUTO-RESTART DISABLED)



17.4.9 SETUP FOR PWM OPERATION

The following steps should be taken when configuring the ECCPx module for PWM operation:

- Configure the PWM pins PxA and PxB (and PxC and PxD, if used) as inputs by setting the corresponding TRIS bits.
- 2. Set the PWM period by loading the PR2 (PR4) register.
- Configure the ECCPx module for the desired PWM mode and configuration by loading the CCPxCON register with the appropriate values:
 - Select one of the available output configurations and direction with the PxM1:PxM0 bits.
 - Select the polarities of the PWM output signals with the CCPxM3:CCPxM0 bits.
- Set the PWM duty cycle by loading the CCPRxL register and the CCPxCON<5:4> bits.
- 5. For auto-shutdown:
 - Disable auto-shutdown; ECCPAS = 0
 - · Configure auto-shutdown source
 - · Wait for Run condition
- For Half-Bridge Output mode, set the dead-band delay by loading ECCPxDEL<6:0> with the appropriate value.
- 7. If auto-shutdown operation is required, load the ECCPxAS register:
 - Select the auto-shutdown sources using the ECCPxAS2:ECCPxAS0 bits.
 - Select the shutdown states of the PWM output pins using PSSxAC1:PSSxAC0 and PSSxBD1:PSSxBD0 bits.
 - Set the ECCPxASE bit (ECCPxAS<7>).

- 8. If auto-restart operation is required, set the PxRSEN bit (ECCPxDEL<7>).
- 9. Configure and start TMRn (TMR2 or TMR4):
 - Clear the TMRn interrupt flag bit by clearing the TMRnIF bit (PIR1<1> for Timer2 or PIR3<3> for Timer4).
 - Set the TMRn prescale value by loading the TnCKPS bits (TnCON<1:0>).
 - Enable Timer2 (or Timer4) by setting the TMRnON bit (TnCON<2>).
- Enable PWM outputs after a new PWM cycle has started:
 - Wait until TMRn overflows (TMRnIF bit is set).
 - Enable the ECCPx/PxA, PxB, PxC and/or PxD pin outputs by clearing the respective TRIS bits.
 - Clear the ECCPASE bit (ECCPxAS<7>).

17.4.10 EFFECTS OF A RESET

Both Power-on Reset and subsequent Resets will force all ports to Input mode and the CCP registers to their Reset states

This forces the Enhanced CCP module to reset to a state compatible with the standard CCP module.

TABLE 17-5: REGISTERS ASSOCIATED WITH ECCP MODULES AND TIMER1 TO TIMER4

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
RCON	IPEN	_	_	RI	TO	PD	POR	BOR	50
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	TMR3IF	CCP2IF	51
PIE2	OSCFIE	CMIE	_	_	BCL1IE	_	TMR3IE	CCP2IE	51
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	TMR3IP	CCP2IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	52
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	52
TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	52
TRISG	_	_	_	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	52
TRISH	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	52
TMR1L	Timer1 Regis	ster Low Byte)						50
TMR1H	Timer1 Regis	ster High Byte	Э						50
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	50
TMR2	Timer2 Regis	ster							50
T2CON	_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	50
PR2	Timer2 Perio	d Register							50
TMR3L	Timer3 Regis	ster Low Byte)						51
TMR3H	Timer3 Regis	ster High Byte	е						51
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	T3SYNC	TMR3CS	TMR3ON	51
TMR4	Timer4 Regis	ster			•	•		•	53
T4CON	_	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0	53
PR4	Timer4 Perio	d Register			·				53
CCPRxL ⁽¹⁾	Capture/Con	npare/PWM F	Register x Lo	w Byte					51
CCPRxH ⁽¹⁾	Capture/Con	npare/PWM F	Register x Hiç	gh Byte					51,
CCPxCON ⁽¹⁾	PxM1	PxM0	DCxB1	DCxB0	CCPxM3	CCPxM2	CCPxM1	CCPxM0	51
ECCPxAS ⁽¹⁾	ECCPxASE	ECCPxAS2	ECCPxAS1	ECCPxAS0	PSSxAC1	PSSxAC0	PSSxBD1	PSSxBD0	51, 53
ECCPxDEL ⁽¹⁾	PxRSEN	PxDC6	PxDC5	PxDC4	PxDC3	PxDC2	PxDC1	PxDC0	53

Legend: — = unimplemented, read as '0'. Shaded cells are not used during ECCP operation.

Note 1: Generic term for all of the identical registers of this name for all Enhanced CCP modules, where 'x' identifies the individual module (ECCP1, ECCP2 or ECCP3). Bit assignments and Reset values for all registers of the same generic name are identical.

18.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP) MODULE

18.1 Master SSP (MSSP) Module Overview

The Master Synchronous Serial Port (MSSP) module is a serial interface, useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D converters, etc. The MSSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI™)
- Inter-Integrated Circuit (I²C[™])
 - Full Master mode
 - Slave mode (with general address call)

The I²C interface supports the following modes in hardware:

- Master mode
- · Multi-Master mode
- Slave mode

All members of the PIC18F87J10 family have two MSSP modules, designated as MSSP1 and MSSP2. Each module operates independently of the other.

Note: Throughout this section, generic references to an MSSP module in any of its operating modes may be interpreted as being equally applicable to MSSP1 or MSSP2. Register names and module I/O signals use the generic designator 'x' to indicate the use of a numeral to distinguish a particular module, when required. Control bit names are not individuated.

18.2 Control Registers

Each MSSP module has three associated control registers. These include a status register (SSPxSTAT) and two control registers (SSPxCON1 and SSPxCON2). The use of these registers and their individual configuration bits differ significantly depending on whether the MSSP module is operated in SPI or I²C mode.

Additional details are provided under the individual sections.

Note: In devices with more than one MSSP module, it is very important to pay close attention to SSPCON register names. SSP1CON1 and SSP1CON2 control different operational aspects of the same module, while SSP1CON1 and SSP2CON1 control the same features for two different modules.

18.3 SPI Mode

The SPI mode allows 8 bits of data to be synchronously transmitted and received simultaneously. All four modes of SPI are supported. To accomplish communication, typically three pins are used:

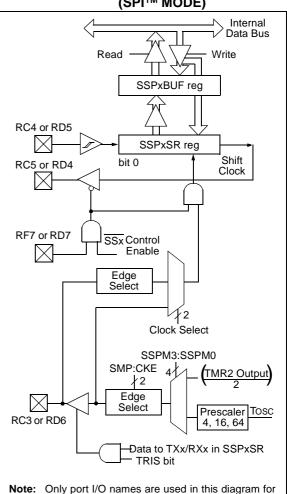
- Serial Data Out (SDOx) RC5/SDO1 or RD4/SDO2
- Serial Data In (SDIx) RC4/SDI1/SDA1 or RD5/SDI2/SDA2
- Serial Clock (SCKx) RC3/SCK1/SCL1 or RD6/SCK2/SCL2

Additionally, a fourth pin may be used when in a Slave mode of operation:

Slave Select (SSx) – RF7/SS1 or RD7/SS2

Figure 18-1 shows the block diagram of the MSSP module when operating in SPI mode.

FIGURE 18-1: MSSP BLOCK DIAGRAM (SPI™ MODE)



Note: Only port I/O names are used in this diagram for the sake of brevity. Refer to the text for a full list of multiplexed functions.

18.3.1 REGISTERS

Each MSSP module has four registers for SPI mode operation. These are:

- MSSP Control Register 1 (SSPxCON1)
- · MSSP Status Register (SSPxSTAT)
- Serial Receive/Transmit Buffer Register (SSPxBUF)
- MSSP Shift Register (SSPxSR) Not directly accessible

SSPxCON1 and SSPxSTAT are the control and status registers in SPI mode operation. The SSPxCON1 register is readable and writable. The lower 6 bits of the SSPxSTAT are read-only. The upper two bits of the SSPxSTAT are read/write.

SSPxSR is the shift register used for shifting data in or out. SSPxBUF is the buffer register to which data bytes are written to or read from.

In receive operations, SSPxSR and SSPxBUF together create a double-buffered receiver. When SSPxSR receives a complete byte, it is transferred to SSPxBUF and the SSPxIF interrupt is set.

During transmission, the SSPxBUF is not double-buffered. A write to SSPxBUF will write to both SSPxBUF and SSPxSR.

REGISTER 18-1: SSPxSTAT: MSSPx STATUS REGISTER (SPI MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/A	Р	S	R/W	UA	BF
bit 7							bit 0

bit 7 SMP: Sample bit

SPI Master mode:

- 1 = Input data sampled at end of data output time
- 0 = Input data sampled at middle of data output time

SPI Slave mode:

SMP must be cleared when SPI is used in Slave mode.

bit 6 CKE: SPI Clock Select bit

- 1 = Transmit occurs on transition from active to Idle clock state
- 0 = Transmit occurs on transition from Idle to active clock state

Note: Polarity of clock state is set by the CKP bit (SSPxCON1<4>).

bit 5 D/A: Data/Address bit

Used in I²C mode only.

bit 4 P: Stop bit

Used in I^2C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.

bit 3 S: Start bit

Used in I²C mode only.

bit 2 R/W: Read/Write Information bit

Used in I²C mode only.

bit 1 **UA:** Update Address bit

Used in I²C mode only.

bit 0 **BF:** Buffer Full Status bit (Receive mode only)

- 1 = Receive complete, SSPxBUF is full
- 0 = Receive not complete, SSPxBUF is empty

Leg		
1 60	er	ın.

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 18-2: SSPxCON1: MSSPx CONTROL REGISTER 1 (SPI MODE)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| WCOL | SSPOV | SSPEN | CKP | SSPM3 | SSPM2 | SSPM1 | SSPM0 |

bit 7 bit 0

- bit 7 WCOL: Write Collision Detect bit (Transmit mode only)
 - 1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software)
 - 0 = No collision
- bit 6 SSPOV: Receive Overflow Indicator bit

SPI Slave mode:

- 1 = A new byte is received while the SSPxBUF register is still holding the previous data. In case of overflow, the data in SSPxSR is lost. Overflow can only occur in Slave mode. The user must read the SSPxBUF, even if only transmitting data, to avoid setting overflow (must be cleared in software).
- 0 = No overflow

Note: In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPxBUF register.

- bit 5 SSPEN: Synchronous Serial Port Enable bit
 - 1 = Enables serial port and configures SCKx, SDOx, SDIx and \overline{SSx} as serial port pins
 - 0 = Disables serial port and configures these pins as I/O port pins

Note: When enabled, these pins must be properly configured as input or output.

- bit 4 CKP: Clock Polarity Select bit
 - 1 = Idle state for clock is a high level
 - 0 = Idle state for clock is a low level
- bit 3-0 SSPM3:SSPM0: Synchronous Serial Port Mode Select bits
 - 0101 = SPI Slave mode, clock = SCKx pin, SSx pin control disabled, SSx can be used as I/O pin
 - 0100 = SPI Slave mode, clock = SCKx pin, SSx pin control enabled
 - 0011 = SPI Master mode, clock = TMR2 output/2
 - 0010 = SPI Master mode, clock = Fosc/64
 - 0001 = SPI Master mode, clock = Fosc/16
 - 0000 = SPI Master mode, clock = Fosc/4

Note: Bit combinations not specifically listed here are either reserved or implemented in I^2C mode only.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

18.3.2 OPERATION

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPxCON1<5:0> and SSPxSTAT<7:6>). These control bits allow the following to be specified:

- Master mode (SCKx is the clock output)
- · Slave mode (SCKx is the clock input)
- Clock Polarity (Idle state of SCKx)
- Data Input Sample Phase (middle or end of data output time)
- Clock Edge (output data on rising/falling edge of SCKx)
- · Clock Rate (Master mode only)
- Slave Select mode (Slave mode only)

Each MSSP consists of a transmit/receive shift register (SSPxSR) and a buffer register (SSPxBUF). The SSPxSR shifts the data in and out of the device, MSb first. The SSPxBUF holds the data that was written to the SSPxSR until the received data is ready. Once the 8 bits of data have been received, that byte is moved to the SSPxBUF register. Then, the Buffer Full detect bit BF (SSPxSTAT<0>) and the interrupt flag bit SSPxIF are set. This double-buffering of the received data (SSPxBUF) allows the next byte to start reception before reading the data that was just received. Any

write to the SSPxBUF register during transmission/reception of data will be ignored and the Write Collision detect bit, WCOL (SSPxCON1<7>), will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPxBUF register completed successfully.

When the application software is expecting to receive valid data, the SSPxBUF should be read before the next byte of data to transfer is written to the SSPxBUF. The Buffer Full bit, BF (SSPxSTAT<0>), indicates when SSPxBUF has been loaded with the received data (transmission is complete). When the SSPxBUF is read, the BF bit is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally, the MSSP interrupt is used to determine when the transmission/reception has completed. The SSPxBUF must be read and/or written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 18-1 shows the loading of the SSP1BUF (SSP1SR) for data transmission.

The SSPxSR is not directly readable or writable and can only be accessed by addressing the SSPxBUF register. Additionally, the SSPxSTAT register indicates the various status conditions.

EXAMPLE 18-1: LOADING THE SSP1BUF (SSP1SR) REGISTER

LOOP	BTFSS BRA MOVF	SSP1STAT, BF LOOP SSP1BUF, W	;Has data been received (transmit complete)? ;No ;WREG reg = contents of SSP1BUF
	MOVWF	RXDATA	;Save in user RAM, if data is meaningful
	MOVF MOVWF	TXDATA, W SSP1BUF	;W reg = contents of TXDATA ;New data to xmit

18.3.3 ENABLING SPI I/O

To enable the serial port, SSP Enable bit, SSPEN (SSPxCON1<5>), must be set. To reset or reconfigure SPI mode, clear the SSPEN bit, reinitialize the SSPxCON registers and then set the SSPEN bit. This configures the SDIx, SDOx, SCKx and SSx pins as serial port pins. For the pins to behave as the serial port function, some must have their data direction bits (in the TRIS register) appropriately programmed as follows:

- SDIx is automatically controlled by the SPI module
- SDOx must have TRISC<5> (or TRISD<4>) bit cleared
- SCKx (Master mode) must have TRISC<3> (or TRISD<6>) bit cleared
- SCKx (Slave mode) must have TRISC<3> (or TRISD<6>) bit set
- SSx must have TRISF<7> (or TRISD<7>) bit set

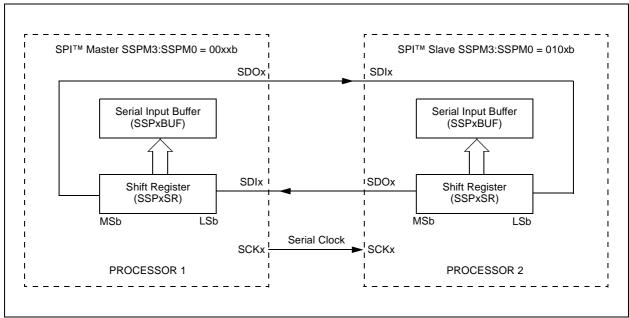
Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value.

18.3.4 TYPICAL CONNECTION

Figure 18-2 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCKx signal. Data is shifted out of both shift registers on their programmed clock edge and latched on the opposite edge of the clock. Both processors should be programmed to the same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application software. This leads to three scenarios for data transmission:

- Master sends data Slave sends dummy data
- Master sends data Slave sends data
- Master sends dummy data Slave sends data

FIGURE 18-2: SPI™ MASTER/SLAVE CONNECTION



18.3.5 MASTER MODE

The master can initiate the data transfer at any time because it controls the SCKx. The master determines when the slave (Processor 2, Figure 18-2) will broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPxBUF register is written to. If the SPI is only going to receive, the SDOx output could be disabled (programmed as an input). The SSPxSR register will continue to shift in the signal present on the SDIx pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPxBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "Line Activity Monitor" mode.

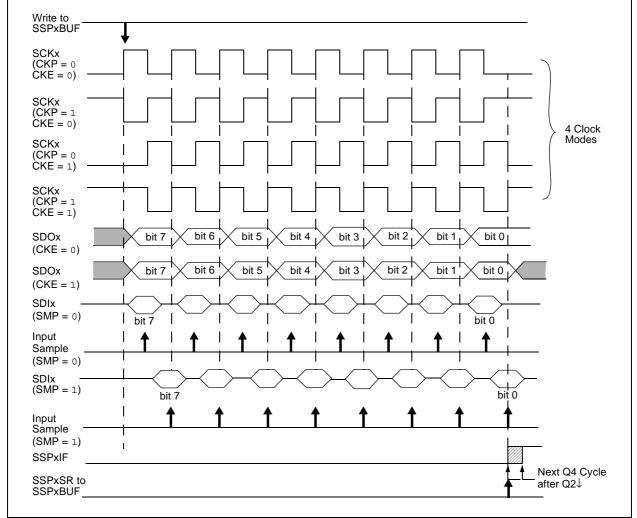
The clock polarity is selected by appropriately programming the CKP bit (SSPxCON1<4>). This then, would give waveforms for SPI communication as shown in Figure 18-3, Figure 18-5 and Figure 18-6, where the MSB is transmitted first. In Master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 Tcy)
- Fosc/64 (or 16 Tcy)
- Timer2 output/2

This allows a maximum data rate (at 40 MHz) of 10.00 Mbps.

Figure 18-3 shows the waveforms for Master mode. When the CKE bit is set, the SDOx data is valid before there is a clock edge on SCKx. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPxBUF is loaded with the received data is shown





18.3.6 **SLAVE MODE**

In Slave mode, the data is transmitted and received as the external clock pulses appear on SCKx. When the last bit is latched, the SSPxIF interrupt flag bit is set.

Before enabling the module in SPI Slave mode, the clock line must match the proper Idle state. The clock line can be observed by reading the SCKx pin. The Idle state is determined by the CKP bit (SSPxCON1<4>).

While in Slave mode, the external clock is supplied by the external clock source on the SCKx pin. This external clock must meet the minimum high and low times as specified in the electrical specifications.

While in Sleep mode, the slave can transmit/receive data. When a byte is received, the device will wake-up from Sleep.

SLAVE SELECT 18.3.7 **SYNCHRONIZATION**

The SSx pin allows a Synchronous Slave mode. The SPI must be in Slave mode with SSx pin control enabled (SSPxCON1<3:0> = 04h). When the \overline{SSx} pin is low, transmission and reception are enabled and the

SDOx pin is driven. When the SSx pin goes high, the SDOx pin is no longer driven, even if in the middle of a transmitted byte and becomes a floating output. External pull-up/pull-down resistors may be desirable depending on the application.

- **Note 1:** When the SPI is in Slave mode with \overline{SSx} pin control enabled (SSPxCON1<3:0> = 0100), the SPI module will reset if the SSx pin is set
 - 2: If the SPI is used in Slave mode with CKE set, then the \overline{SSx} pin control must be enabled.

When the SPI module resets, the bit counter is forced to '0'. This can be done by either forcing the SSx pin to a high level or clearing the SSPEN bit.

To emulate two-wire communication, the SDOx pin can be connected to the SDIx pin. When the SPI needs to operate as a receiver, the SDOx pin can be configured as an input. This disables transmissions from the SDOx. The SDIx can always be left as an input (SDIx function) since it cannot create a bus conflict.

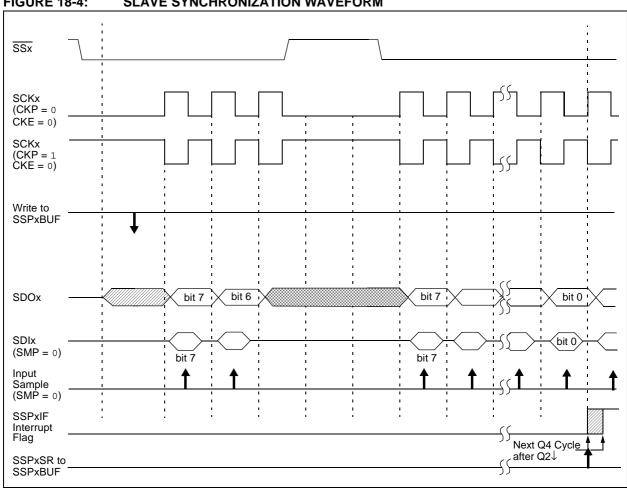


FIGURE 18-4: SLAVE SYNCHRONIZATION WAVEFORM

FIGURE 18-5: SPI™ MODE WAVEFORM (SLAVE MODE WITH CKE = 0)

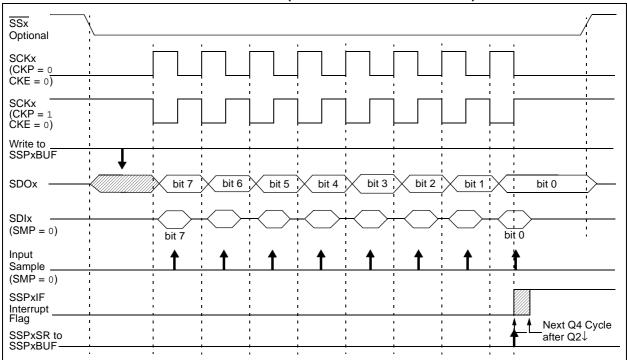
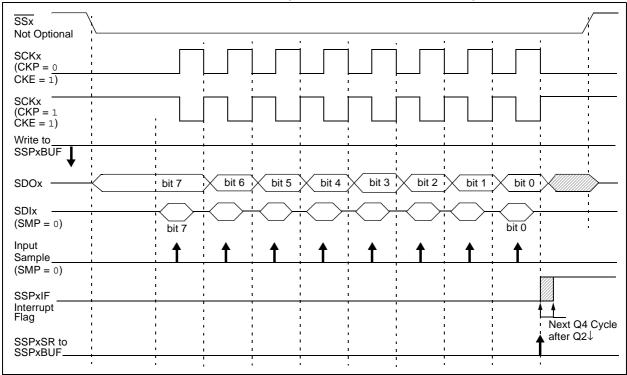


FIGURE 18-6: SPI™ MODE WAVEFORM (SLAVE MODE WITH CKE = 1)



18.3.8 OPERATION IN POWER-MANAGED MODES

In SPI Master mode, module clocks may be operating at a different speed than when in full power mode; in the case of Sleep mode, all clocks are halted.

In Idle modes, a clock is provided to the peripherals. That clock should be from the primary clock source, the secondary clock (Timer1 oscillator at 32.768 kHz) or the INTOSC source. See **Section 2.6** "Clock Sources and Oscillator Switching" for additional information.

In most cases, the speed that the master clocks SPI data is not important; however, this should be evaluated for each system.

If MSSP interrupts are enabled, they can wake the controller from Sleep mode, or one of the Idle modes, when the master completes sending data. If an exit from Sleep or Idle mode is not desired, MSSP interrupts should be disabled.

If the Sleep mode is selected, all module clocks are halted and the transmission/reception will remain in that state until the devices wakes. After the device returns to Run mode, the module will resume transmitting and receiving data.

In SPI Slave mode, the SPI Transmit/Receive Shift register operates asynchronously to the device. This allows the device to be placed in any power-managed mode and data to be shifted into the SPI Transmit/Receive Shift register. When all 8 bits have been received, the MSSP interrupt flag bit will be set and if enabled, will wake the device.

18.3.9 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

18.3.10 BUS MODE COMPATIBILITY

Table 18-1 shows the compatibility between the standard SPI modes and the states of the CKP and CKE control bits.

TABLE 18-1: SPI™ BUS MODES

Standard SPI™ Mode	Control Bits State			
Terminology	СКР	CKE		
0, 0	0	1		
0, 1	0	0		
1, 0	1	1		
1, 1	1	0		

There is also an SMP bit which controls when the data is sampled.

18.3.11 SPI CLOCK SPEED AND MODULE INTERACTIONS

Because MSSP1 and MSSP2 are independent modules, they can operate simultaneously at different data rates. Setting the SSPM3:SSPM0 bits of the SSPxCON1 register determines the rate for the corresponding module.

An exception is when both modules use Timer2 as a time base in Master mode. In this instance, any changes to the Timer2 operation will affect both MSSP modules equally. If different bit rates are required for each module, the user should select one of the other three time base options for one of the modules.

TABLE 18-2: REGISTERS ASSOCIATED WITH SPI™ OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	52
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	52
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	52
SSP1BUF	MSSP1 Re	ceive Buffer	/Transmit R	egister					50
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	50
SSP1STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	50
SSP2BUF	MSSP2 Receive Buffer/Transmit Register								53
SSP2CON1	CON1 WCOL SSPOV SSPEN CKP SSPM3 SSPM2 SSPM1 S					SSPM0	53		
SSP2STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	53

Legend: Shaded cells are not used by the MSSP module in SPI™ mode.

18.4 I²C Mode

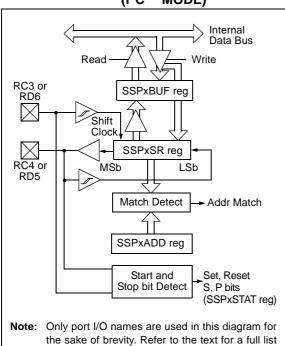
The MSSP module in I^2C mode fully implements all master and slave functions (including general call support) and provides interrupts on Start and Stop bits in hardware to determine a free bus (multi-master function). The MSSP module implements the standard mode specifications as well as 7-bit and 10-bit addressing.

Two pins are used for data transfer:

- Serial clock (SCLx) RC3/SCK1/SCL1 or RD6/SCK2/SCL2
- Serial data (SDAx) RC4/SDI1/SDA1 or RD5/SDI2/SDA2

The user must configure these pins as inputs by setting the TRISC<4:3> or TRISD<5:4> bits.

FIGURE 18-7: MSSP BLOCK DIAGRAM (I²CTM MODE)



of multiplexed functions.

18.4.1 REGISTERS

The MSSP module has six registers for I²C operation. These are:

- MSSP Control Register 1 (SSPxCON1)
- MSSP Control Register 2 (SSPxCON2)
- MSSP Status Register (SSPxSTAT)
- Serial Receive/Transmit Buffer Register (SSPxBUF)
- MSSP Shift Register (SSPxSR) Not directly accessible
- MSSP Address Register (SSPxADD)

SSPxCON1, SSPxCON2 and SSPxSTAT are the control and status registers in I^2C mode operation. The SSPxCON1 and SSPxCON2 registers are readable and writable. The lower 6 bits of the SSPxSTAT are read-only. The upper two bits of the SSPxSTAT are read/write.

SSPxSR is the shift register used for shifting data in or out. SSPxBUF is the buffer register to which data bytes are written to or read from.

SSPxADD register holds the slave device address when the SSP is configured in I^2C Slave mode. When the SSP is configured in Master mode, the lower seven bits of SSPxADD act as the Baud Rate Generator reload value.

In receive operations, SSPxSR and SSPxBUF together create a double-buffered receiver. When SSPxSR receives a complete byte, it is transferred to SSPxBUF and the SSPxIF interrupt is set.

During transmission, the SSPxBUF is not double-buffered. A write to SSPxBUF will write to both SSPxBUF and SSPxSR.

REGISTER 18-3: SSPxSTAT: MSSPx STATUS REGISTER (I²C MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/A	Р	S	R/W	UA	BF
bit 7							bit 0

SMP: Slew Rate Control bit

In Master or Slave mode:

- 1 = Slew rate control disabled for Standard Speed mode (100 kHz and 1 MHz)
- 0 = Slew rate control enabled for High-Speed mode (400 kHz)
- bit 6 CKE: SMBus Select bit

In Master or Slave mode:

- 1 = Enable SMBus specific inputs
- 0 = Disable SMBus specific inputs
- bit 5 D/A: Data/Address bit

In Master mode:

Reserved.

In Slave mode:

- 1 = Indicates that the last byte received or transmitted was data
- 0 = Indicates that the last byte received or transmitted was address
- bit 4 P: Stop bit

bit 7

- 1 = Indicates that a Stop bit has been detected last
- 0 = Stop bit was not detected last

Note: This bit is cleared on Reset and when SSPEN is cleared.

- bit 3 S: Start bit
 - 1 = Indicates that a Start bit has been detected last
 - 0 = Start bit was not detected last

Note: This bit is cleared on Reset and when SSPEN is cleared.

bit 2 R/W: Read/Write Information bit (I²C mode only)

In Slave mode:

- 1 = Read
- 0 = Write

Note: This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next Start bit, Stop bit or not ACK bit.

In Master mode:

- 1 = Transmit is in progress
- 0 = Transmit is not in progress

Note: ORing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSP is in Active mode.

- bit 1 **UA:** Update Address bit (10-bit Slave mode only)
 - 1 = Indicates that the user needs to update the address in the SSPxADD register
 - 0 = Address does not need to be updated
- bit 0 BF: Buffer Full Status bit

In Transmit mode:

- 1 = SSPxBUF is full
- 0 = SSPxBUF is empty

In Receive mode:

- 1 = SSPxBUF is full (does not include the \overline{ACK} and Stop bits)
- 0 = SSPxBUF is empty (does not include the \overline{ACK} and Stop bits)

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 18-4: SSPxCON1: MSSPx CONTROL REGISTER 1 (I²C MODE)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| WCOL | SSPOV | SSPEN | CKP | SSPM3 | SSPM2 | SSPM1 | SSPM0 |

bit 7

bit 7 WCOL: Write Collision Detect bit

In Master Transmit mode:

- 1 = A write to the SSPxBUF register was attempted while the I^2C conditions were not valid for a transmission to be started (must be cleared in software)
- 0 = No collision

In Slave Transmit mode:

- 1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software)
- 0 = No collision

In Receive mode (Master or Slave modes):

This is a "don't care" bit.

bit 6 SSPOV: Receive Overflow Indicator bit

In Receive mode:

- 1 = A byte is received while the SSPxBUF register is still holding the previous byte (must be cleared in software)
- 0 = No overflow

In Transmit mode:

This is a "don't care" bit in Transmit mode.

- bit 5 SSPEN: Synchronous Serial Port Enable bit
 - 1 = Enables the serial port and configures the SDAx and SCLx pins as the serial port pins
 - $_{
 m 0}$ = Disables serial port and configures these pins as I/O port pins

Note: When enabled, the SDAx and SCLx pins must be properly configured as input or output.

bit 4 CKP: SCKx Release Control bit

In Slave mode:

- 1 = Release clock
- 0 = Holds clock low (clock stretch), used to ensure data setup time

In Master mode:

Unused in this mode.

bit 3-0 SSPM3:SSPM0: Synchronous Serial Port Mode Select bits

- $1111 = I^2C$ Slave mode, 10-bit address with Start and Stop bit interrupts enabled
- $1110 = I^2C$ Slave mode, 7-bit address with Start and Stop bit interrupts enabled
- 1011 = I²C Firmware Controlled Master mode (Slave Idle)
- $1000 = I^2C$ Master mode, clock = Fosc/(4 * (SSPxADD + 1))
- $0111 = I^2C$ Slave mode, 10-bit address
- $0110 = I^2C$ Slave mode, 7-bit address

Bit combinations not specifically listed here are either reserved or implemented in SPI mode only.

Legend:						
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

REGISTER 18-5: SSPxCON2: MSSPx CONTROL REGISTER 2 (I²C MODE)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT	ACKEN ⁽¹⁾	RCEN ⁽¹⁾	PEN ⁽¹⁾	RSEN ⁽¹⁾	SEN ⁽¹⁾
bit 7							bit 0

- bit 7 GCEN: General Call Enable bit (Slave mode only)
 - 1 = Enable interrupt when a general call address (0000h) is received in the SSPxSR
 - 0 = General call address disabled
- bit 6 ACKSTAT: Acknowledge Status bit (Master Transmit mode only)
 - 1 = Acknowledge was not received from slave
 - 0 = Acknowledge was received from slave
- bit 5 ACKDT: Acknowledge Data bit (Master Receive mode only)
 - 1 = Not Acknowledge
 - 0 = Acknowledge

Note: Value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.

- bit 4 ACKEN: Acknowledge Sequence Enable bit (Master Receive mode only)⁽¹⁾
 - 1 = Initiate Acknowledge sequence on SDAx and SCLx pins and transmit ACKDT data bit. Automatically cleared by hardware.
 - 0 = Acknowledge sequence Idle
- bit 3 RCEN: Receive Enable bit (Master mode only)⁽¹⁾
 - 1 = Enables Receive mode for I^2C
 - 0 = Receive Idle
- bit 2 **PEN:** Stop Condition Enable bit (Master mode only)⁽¹⁾
 - 1 = Initiate Stop condition on SDAx and SCLx pins. Automatically cleared by hardware.
 - 0 = Stop condition Idle
- bit 1 RSEN: Repeated Start Condition Enable bit (Master mode only)⁽¹⁾
 - 1 = Initiate Repeated Start condition on SDAx and SCLx pins. Automatically cleared by hardware.
 - 0 = Repeated Start condition Idle
- bit 0 **SEN:** Start Condition Enable/Stretch Enable bit⁽¹⁾

In Master mode:

- 1 = Initiate Start condition on SDAx and SCLx pins. Automatically cleared by hardware.
- 0 = Start condition Idle

In Slave mode:

- 1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)
- 0 = Clock stretching is disabled
 - **Note 1:** For bits ACKEN, RCEN, PEN, RSEN, SEN: If the I²C module is not in the Idle mode, these bits may not be set (no spooling) and the SSPxBUF may not be written (or writes to the SSPxBUF are disabled).

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

18.4.2 OPERATION

The MSSP module functions are enabled by setting the MSSP Enable bit, SSPEN (SSPxCON1<5>).

The SSPxCON1 register allows control of the I^2C operation. Four mode selection bits (SSPxCON1<3:0>) allow one of the following I^2C modes to be selected:

- I²C Master mode, clock = (FOSC/4) x (SSPxADD + 1)
- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Slave mode (7-bit address) with Start and Stop bit interrupts enabled
- I²C Slave mode (10-bit address) with Start and Stop bit interrupts enabled
- I²C Firmware Controlled Master mode, slave is Idle

Selection of any I²C mode, with the SSPEN bit set, forces the SCLx and SDAx pins to be open-drain, provided these pins are programmed to inputs by setting the appropriate TRISC or TRISD bits. To ensure proper operation of the module, pull-up resistors must be provided externally to the SCLx and SDAx pins.

18.4.3 SLAVE MODE

In Slave mode, the SCLx and SDAx pins must be configured as inputs (TRISC<4:3> or TRISD<5:4> set). The MSSP module will override the input state with the output data when required (slave-transmitter).

The I²C Slave mode hardware will always generate an interrupt on an address match. Through the mode select bits, the user can also choose to interrupt on Start and Stop bits

When an address is matched, or the data transfer after an address match is received, the hardware automatically will generate the Acknowledge (ACK) pulse and load the SSPxBUF register with the received value currently in the SSPxSR register.

Any combination of the following conditions will cause the MSSP module not to give this \overline{ACK} pulse:

- The Buffer Full bit, BF (SSPxSTAT<0>), was set before the transfer was received.
- The overflow bit, SSPOV (SSPxCON1<6>), was set before the transfer was received.

In this case, the SSPxSR register value is not loaded into the SSPxBUF, but bit SSPxIF is set. The BF bit is cleared by reading the SSPxBUF register, while bit SSPOV is cleared through software.

The SCLx clock input must have a minimum high and low for proper operation. The high and low times of the I^2C specification, as well as the requirement of the MSSP module, are shown in timing parameter 100 and parameter 101.

18.4.3.1 Addressing

Once the MSSP module has been enabled, it waits for a Start condition to occur. Following the Start condition, the 8 bits are shifted into the SSPxSR register. All incoming bits are sampled with the rising edge of the clock (SCLx) line. The value of register SSPxSR<7:1> is compared to the value of the SSPxADD register. The address is compared on the falling edge of the eighth clock (SCLx) pulse. If the addresses match and the BF and SSPOV bits are clear, the following events occur:

- The SSPxSR register value is loaded into the SSPxBUF register.
- 2. The Buffer Full bit, BF, is set.
- 3. An \overline{ACK} pulse is generated.
- 4. The MSSP Interrupt Flag bit, SSPxIF, is set (and interrupt is generated, if enabled) on the falling edge of the ninth SCLx pulse.

In 10-bit Address mode, two address bytes need to be received by the slave. The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/\overline{W} (SSPxSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address, the first byte would equal '11110 A9 A8 0', where 'A9' and 'A8' are the two MSbs of the address. The sequence of events for 10-bit address is as follows, with steps 7 through 9 for the slave-transmitter:

- Receive first (high) byte of address (bits SSPxIF, BF and UA (SSPxSTAT<1>) are set).
- Update the SSPxADD register with second (low) byte of address (clears bit UA and releases the SCLx line).
- Read the SSPxBUF register (clears bit BF) and clear flag bit SSPxIF.
- Receive second (low) byte of address (bits SSPxIF, BF and UA are set).
- Update the SSPxADD register with the first (high) byte of address. If match releases SCLx line, this will clear bit UA.
- 6. Read the SSPxBUF register (clears bit BF) and clear flag bit SSPxIF.
- 7. Receive Repeated Start condition.
- Receive first (high) byte of address (bits SSPxIF and BF are set).
- Read the SSPxBUF register (clears bit BF) and clear flag bit SSPxIF.

18.4.3.2 Reception

When the R/\overline{W} bit of the address byte is clear and an address match occurs, the R/\overline{W} bit of the SSPxSTAT register is cleared. The received address is loaded into the SSPxBUF register and the SDAx line is held low (\overline{ACK}) .

When the address byte overflow condition exists, then the no Acknowledge (ACK) pulse is given. An overflow condition is defined as either bit BF (SSPxSTAT<0>) is set, or bit SSPOV (SSPxCON1<6>) is set.

An MSSP interrupt is generated for each data transfer byte. The interrupt flag bit, SSPxIF, must be cleared in software. The SSPxSTAT register is used to determine the status of the byte.

If SEN is enabled (SSPxCON2<0> = 1), SCKx/SCLx (RC3 or RD6) will be held low (clock stretch) following each data transfer. The clock must be released by setting bit, CKP (SSPxCON1<4>). See **Section 18.4.4** "Clock Stretching" for more details.

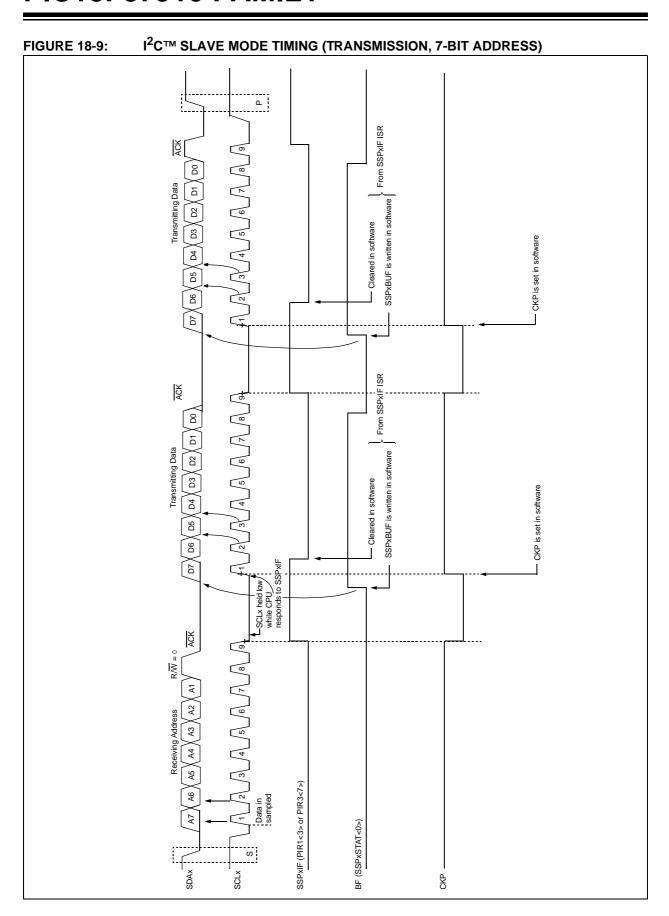
18.4.3.3 Transmission

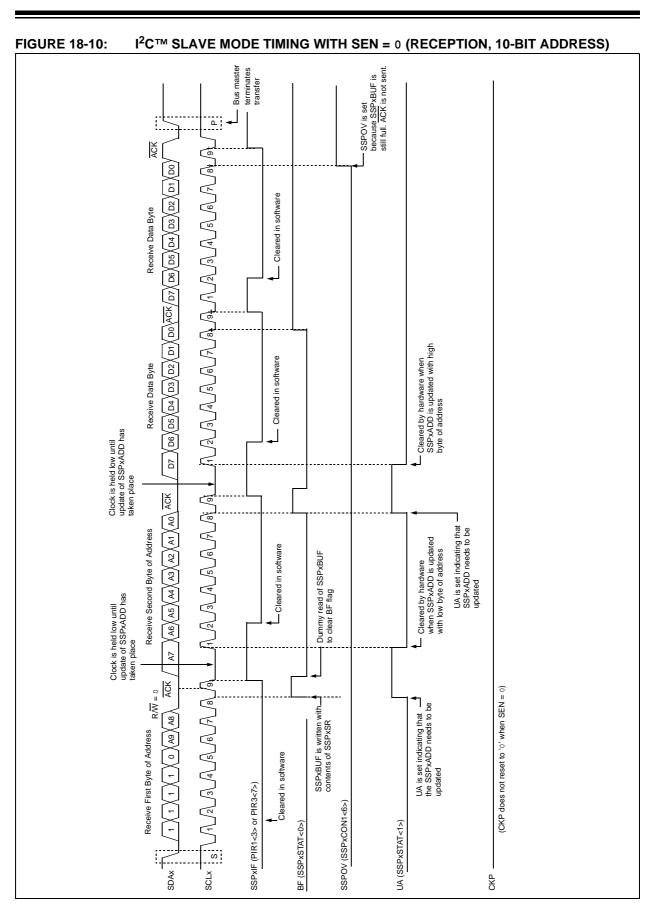
When the R/W bit of the incoming address byte is set and an address match occurs, the R/\overline{W} bit of the SSPxSTAT register is set. The received address is loaded into the SSPxBUF register. The ACK pulse will be sent on the ninth bit and pin RC3 or RD6 is held low, regardless of SEN (see Section 18.4.4 "Clock Stretching" for more details). By stretching the clock, the master will be unable to assert another clock pulse until the slave is done preparing the transmit data. The transmit data must be loaded into the SSPxBUF register which also loads the SSPxSR register. Then pin RC3 or RD6 should be enabled by setting bit, CKP (SSPxCON1<4>). The eight data bits are shifted out on the falling edge of the SCLx input. This ensures that the SDAx signal is valid during the SCLx high time (Figure 18-9).

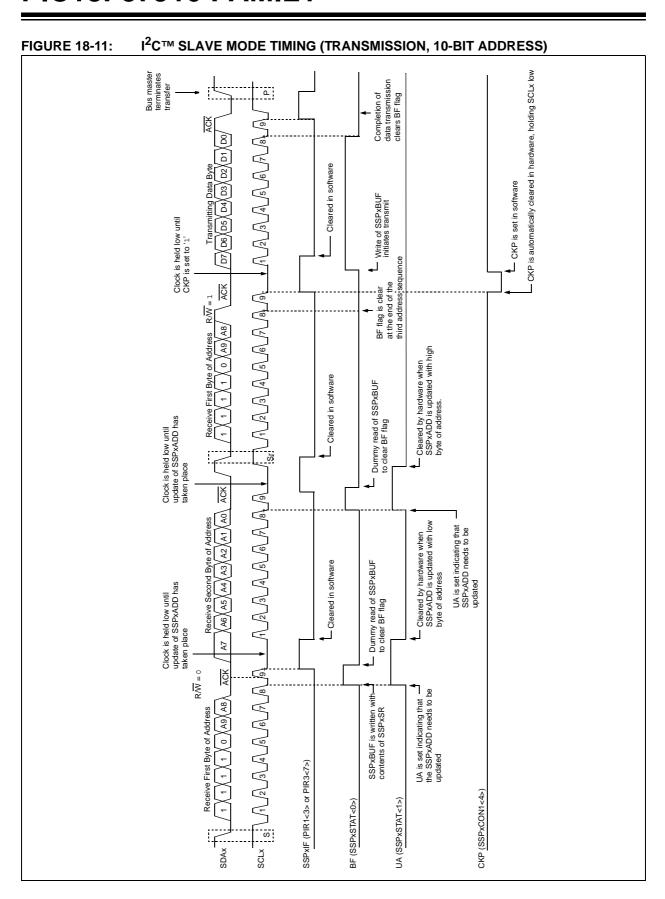
The ACK pulse from the master-receiver is latched on the rising edge of the ninth SCLx input pulse. If the SDAx line is high (not ACK), then the data transfer is complete. In this case, when the ACK is latched by the slave, the slave logic is reset (resets SSPxSTAT register) and the slave monitors for another occurrence of the Start bit. If the SDAx line was low (ACK), the next transmit data must be loaded into the SSPxBUF register. Again, pin RC3 or RD6 must be enabled by setting bit CKP.

An MSSP interrupt is generated for each data transfer byte. The SSPxIF bit must be cleared in software and the SSPxSTAT register is used to determine the status of the byte. The SSPxIF bit is set on the falling edge of the ninth clock pulse.

 I^2C^{TM} SLAVE MODE TIMING WITH SEN = 0 (RECEPTION, 7-BIT ADDRESS) **FIGURE 18-8:** SSPOV is set because SSPxBUF is still full. ACK is not sent. $R\overline{W} = 0$ ACK / CK / C(CKP does not reset to '0' when SEN = 0) SSPxIF (PIR1<3> or PIR3<7>) SSPOV (SSPxCON1<6>) BF (SSPxSTAT<0>) CKP







18.4.4 CLOCK STRETCHING

Both 7-bit and 10-bit Slave modes implement automatic clock stretching during a transmit sequence.

The SEN bit (SSPxCON2<0>) allows clock stretching to be enabled during receives. Setting SEN will cause the SCLx pin to be held low at the end of each data receive sequence.

18.4.4.1 Clock Stretching for 7-bit Slave Receive Mode (SEN = 1)

In 7-bit Slave Receive mode, on the falling edge of the ninth clock at the end of the \overline{ACK} sequence, if the BF bit is set, the CKP bit in the SSPxCON1 register is automatically cleared, forcing the SCLx output to be held low. The CKP being cleared to '0' will assert the SCLx line low. The CKP bit must be set in the user's ISR before reception is allowed to continue. By holding the SCLx line low, the user has time to service the ISR and read the contents of the SSPxBUF before the master device can initiate another receive sequence. This will prevent buffer overruns from occurring (see Figure 18-13).

- Note 1: If the user reads the contents of the SSPxBUF before the falling edge of the ninth clock, thus clearing the BF bit, the CKP bit will not be cleared and clock stretching will not occur.
 - 2: The CKP bit can be set in software regardless of the state of the BF bit. The user should be careful to clear the BF bit in the ISR before the next receive sequence in order to prevent an overflow condition.

18.4.4.2 Clock Stretching for 10-bit Slave Receive Mode (SEN = 1)

In 10-bit Slave Receive mode during the address sequence, clock stretching automatically takes place but CKP is not cleared. During this time, if the UA bit is set after the ninth clock, clock stretching is initiated. The UA bit is set after receiving the upper byte of the 10-bit address and following the receive of the second byte of the 10-bit address with the R/W bit cleared to '0'. The release of the clock line occurs upon updating SSPxADD. Clock stretching will occur on each data receive sequence as described in 7-bit mode.

Note: If the user polls the UA bit and clears it by updating the SSPxADD register before the falling edge of the ninth clock occurs and if the user hasn't cleared the BF bit by reading the SSPxBUF register before that time, then the CKP bit will still NOT be asserted low. Clock stretching on the basis of the state of the BF bit only occurs during a data sequence, not an address sequence.

18.4.4.3 Clock Stretching for 7-bit Slave Transmit Mode

The 7-bit Slave Transmit mode implements clock stretching by clearing the CKP bit after the falling edge of the ninth clock, if the BF bit is clear. This occurs regardless of the state of the SEN bit.

The user's ISR must set the CKP bit before transmission is allowed to continue. By holding the SCLx line low, the user has time to service the ISR and load the contents of the SSPxBUF before the master device can initiate another transmit sequence (see Figure 18-9).

- Note 1: If the user loads the contents of SSPxBUF, setting the BF bit before the falling edge of the ninth clock, the CKP bit will not be cleared and clock stretching will not occur.
 - **2:** The CKP bit can be set in software regardless of the state of the BF bit.

18.4.4.4 Clock Stretching for 10-bit Slave Transmit Mode

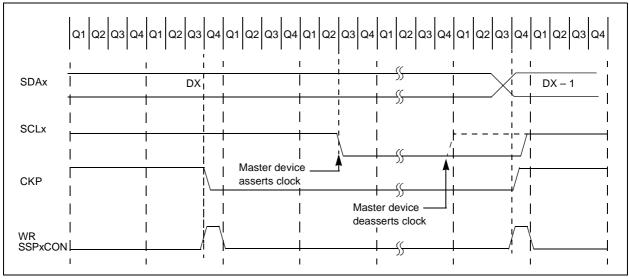
In 10-bit Slave Transmit mode, clock stretching is controlled during the first two address sequences by the state of the UA bit, just as it is in 10-bit Slave Receive mode. The first two addresses are followed by a third address sequence which contains the high-order bits of the 10-bit address and the R/W bit set to '1'. After the third address sequence is performed, the UA bit is not set, the module is now configured in Transmit mode and clock stretching is controlled by the BF flag as in 7-bit Slave Transmit mode (see Figure 18-11).

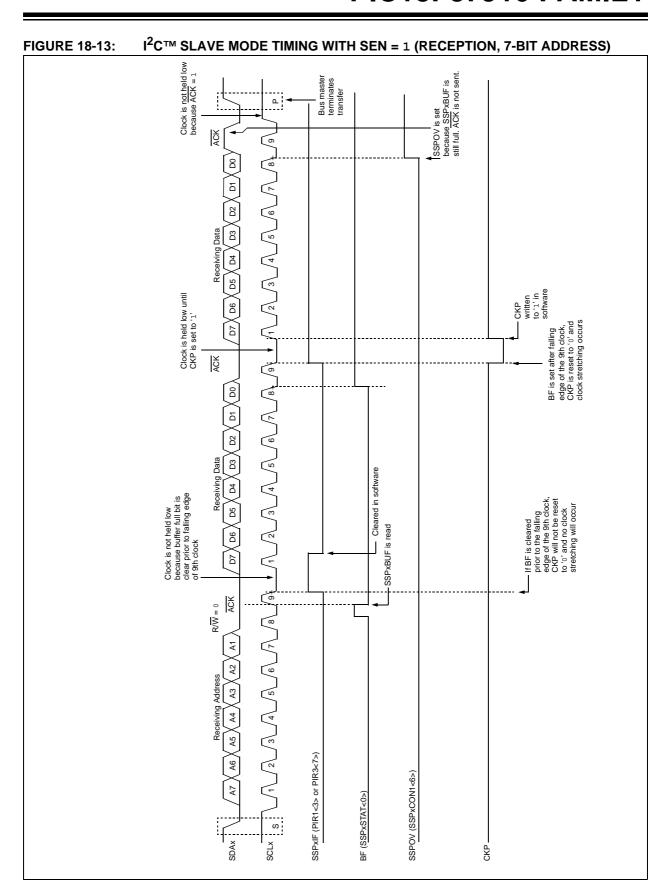
18.4.4.5 Clock Synchronization and the CKP bit

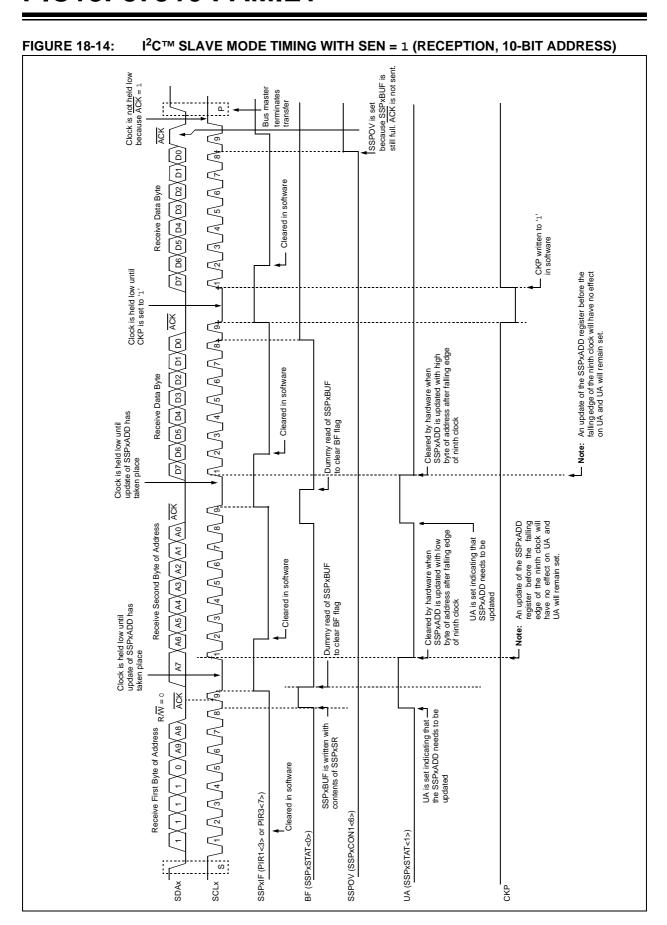
When the CKP bit is cleared, the SCLx output is forced to '0'. However, clearing the CKP bit will not assert the SCLx output low until the SCLx output is already sampled low. Therefore, the CKP bit will not assert the SCLx line until an external I²C master device has

already asserted the SCLx line. The SCLx output will remain low until the CKP bit is set and all other devices on the I²C bus have deasserted SCLx. This ensures that a write to the CKP bit will not violate the minimum high time requirement for SCLx (see Figure 18-12).

FIGURE 18-12: CLOCK SYNCHRONIZATION TIMING







18.4.5 GENERAL CALL ADDRESS SUPPORT

The addressing procedure for the I^2C bus is such that the first byte after the Start condition usually determines which device will be the slave addressed by the master. The exception is the general call address which can address all devices. When this address is used, all devices should, in theory, respond with an Acknowledge.

The general call address is one of eight addresses reserved for specific purposes by the I^2C protocol. It consists of all '0's with $R/\overline{W} = 0$.

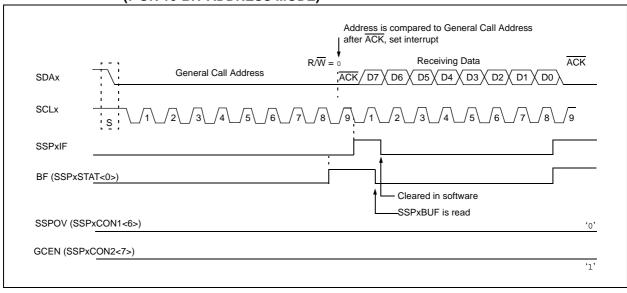
The general call address is recognized when the General Call Enable bit, GCEN, is enabled (SSPxCON2<7> set). Following a Start bit detect, 8 bits are shifted into the SSPxSR and the address is compared against the SSPxADD. It is also compared to the general call address and fixed in hardware.

If the general call address matches, the SSPxSR is transferred to the SSPxBUF, the BF flag bit is set (eighth bit) and on the falling edge of the ninth bit (ACK bit), the SSPxIF interrupt flag bit is set.

When the interrupt is serviced, the source for the interrupt can be checked by reading the contents of the SSPxBUF. The value can be used to determine if the address was device specific or a general call address.

In 10-bit mode, the SSPxADD is required to be updated for the second half of the address to match and the UA bit is set (SSPxSTAT<1>). If the general call address is sampled when the GCEN bit is set, while the slave is configured in 10-bit Address mode, then the second half of the address is not necessary, the UA bit will not be set and the slave will begin receiving data after the Acknowledge (Figure 18-15).





18.4.6 MASTER MODE

Master mode is enabled by setting and clearing the appropriate SSPM bits in SSPxCON1 and by setting the SSPEN bit. In Master mode, the SCLx and SDAx lines are manipulated by the MSSP hardware.

Master mode of operation is supported by interrupt generation on the detection of the Start and Stop conditions. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit is set, or the bus is Idle, with both the S and P bits clear.

In Firmware Controlled Master mode, user code conducts all I²C bus operations based on Start and Stop bit conditions.

Once Master mode is enabled, the user has six options.

- 1. Assert a Start condition on SDAx and SCLx.
- Assert a Repeated Start condition on SDAx and SCLx
- 3. Write to the SSPxBUF register initiating transmission of data/address.
- Configure the I²C port to receive data.
- Generate an Acknowledge condition at the end of a received byte of data.
- 6. Generate a Stop condition on SDAx and SCLx.

The MSSP module, when configured in I²C Master mode, does not allow queueing of events. For instance, the user is not allowed to initiate a Start condition and immediately write the SSPxBUF register to initiate transmission before the Start condition is complete. In this case, the SSPxBUF will not be written to and the WCOL bit will be set, indicating that a write to the SSPxBUF did not occur.

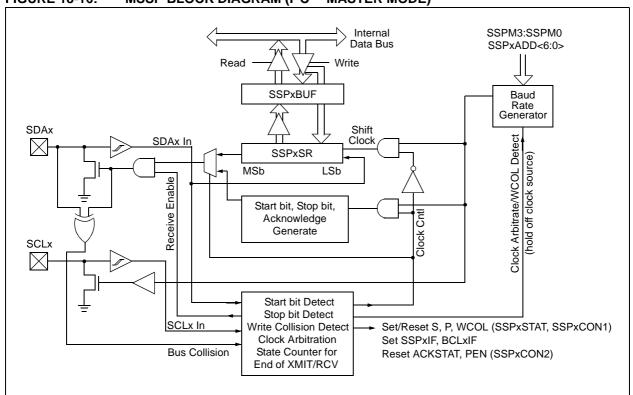
The following events will cause the SSP Interrupt Flag bit, SSPxIF, to be set (and SSP interrupt, if enabled):

· Start condition

Note:

- · Stop condition
- Data transfer byte transmitted/received
- · Acknowledge transmit
- Repeated Start

FIGURE 18-16: MSSP BLOCK DIAGRAM (I²C™ MASTER MODE)



18.4.6.1 I²C Master Mode Operation

The master device generates all of the serial clock pulses and the Start and Stop conditions. A transfer is ended with a Stop condition or with a Repeated Start condition. Since the Repeated Start condition is also the beginning of the next serial transfer, the I²C bus will not be released.

In Master Transmitter mode, serial data is output through SDAx, while SCLx outputs the serial clock. The first byte transmitted contains the slave address of the receiving device (7 bits) and the Read/Write (R/W) bit. In this case, the R/W bit will be logic '0'. Serial data is transmitted 8 bits at a time. After each byte is transmitted, an Acknowledge bit is received. Start and Stop conditions are output to indicate the beginning and the end of a serial transfer.

In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/\overline{W} bit. In this case, the R/\overline{W} bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address followed by a '1' to indicate the receive bit. Serial data is received via SDAx, while SCLx outputs the serial clock. Serial data is received 8 bits at a time. After each byte is received, an Acknowledge bit is transmitted. Start and Stop conditions indicate the beginning and end of transmission.

The Baud Rate Generator used for the SPI mode operation is used to set the SCLx clock frequency for either 100 kHz, 400 kHz or 1 MHz I²C operation. See **Section 18.4.7 "Baud Rate"** for more detail.

A typical transmit sequence would go as follows:

- The user generates a Start condition by setting the Start Enable bit, SEN (SSPxCON2<0>).
- SSPxIF is set. The MSSP module will wait the required start time before any other operation takes place.
- The user loads the SSPxBUF with the slave address to transmit.
- 4. Address is shifted out the SDAx pin until all 8 bits are transmitted.
- 5. The MSSP module shifts in the ACK bit from the slave device and writes its value into the SSPxCON2 register (SSPxCON2<6>).
- The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPxIF bit.
- The user loads the SSPxBUF with eight bits of data
- Data is shifted out the SDAx pin until all 8 bits are transmitted.
- The MSSP module shifts in the ACK bit from the slave device and writes its value into the SSPxCON2 register (SSPxCON2<6>).
- The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPxIF bit.
- 11. The user generates a Stop condition by setting the Stop Enable bit, PEN (SSPxCON2<2>).
- 12. Interrupt is generated once the Stop condition is complete.

18.4.7 BAUD RATE

In I²C Master mode, the Baud Rate Generator (BRG) reload value is placed in the lower 7 bits of the SSPxADD register (Figure 18-17). When a write occurs to SSPxBUF, the Baud Rate Generator will automatically begin counting. The BRG counts down to '0' and stops until another reload has taken place. The BRG count is decremented twice per instruction cycle (TCY) on the Q2 and Q4 clocks. In I²C Master mode, the BRG is reloaded automatically.

Once the given operation is complete (i.e., transmission of the last data bit is followed by \overline{ACK}), the internal clock will automatically stop counting and the SCLx pin will remain in its last state.

Table 18-3 demonstrates clock rates based on instruction cycles and the BRG value loaded into SSPxADD.

18.4.7.1 Baud Rate and Module Interdependence

Because MSSP1 and MSSP2 are independent, they can operate simultaneously in I²C Master mode at different baud rates. This is done by using different BRG reload values for each module.

Because this mode derives its basic clock source from the system clock, any changes to the clock will affect both modules in the same proportion. It may be possible to change one or both baud rates back to a previous value by changing the BRG reload value.

FIGURE 18-17: BAUD RATE GENERATOR BLOCK DIAGRAM

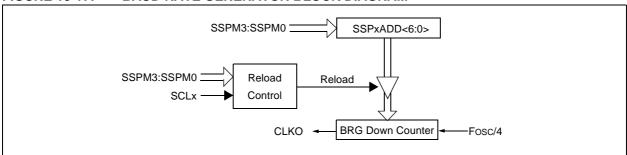


TABLE 18-3: I²C™ CLOCK RATE w/BRG

FcY	Fcy * 2	BRG Value	FSCL (2 Rollovers of BRG)
10 MHz	20 MHz	18h	400 kHz ⁽¹⁾
10 MHz	20 MHz	1Fh	312.5 kHz
10 MHz	20 MHz	63h	100 kHz
4 MHz	8 MHz	09h	400 kHz ⁽¹⁾
4 MHz	8 MHz	0Ch	308 kHz
4 MHz	8 MHz	27h	100 kHz
1 MHz	2 MHz	02h	333 kHz ⁽¹⁾
1 MHz	2 MHz	09h	100 kHz
1 MHz	2 MHz	00h	1 MHz ⁽¹⁾

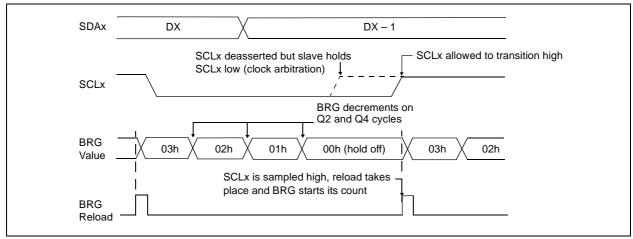
Note 1: The I²C[™] interface does not conform to the 400 kHz I²C specification (which applies to rates greater than 100 kHz) in all details, but may be used with care where higher rates are required by the application.

18.4.7.2 Clock Arbitration

Clock arbitration occurs when the master, during any receive, transmit or Repeated Start/Stop condition, deasserts the SCLx pin (SCLx allowed to float high). When the SCLx pin is allowed to float high, the Baud Rate Generator (BRG) is suspended from counting until the SCLx pin is actually sampled high. When the

SCLx pin is sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and begins counting. This ensures that the SCLx high time will always be at least one BRG rollover count in the event that the clock is held low by an external device (Figure 18-18).

FIGURE 18-18: BAUD RATE GENERATOR TIMING WITH CLOCK ARBITRATION



18.4.8 I²C MASTER MODE START CONDITION TIMING

To initiate a Start condition, the user sets the Start Enable bit, SEN (SSPxCON2<0>). If the SDAx and SCLx pins are sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and starts its count. If SCLx and SDAx are both sampled high when the Baud Rate Generator times out (TBRG), the SDAx pin is driven low. The action of the SDAx being driven low while SCLx is high is the Start condition and causes the S bit (SSPxSTAT<3>) to be set. Following this, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and resumes its count. When the Baud Rate Generator times out (TBRG), the SEN bit (SSPxCON2<0>) will be automatically cleared by hardware. The Baud Rate Generator is suspended, leaving the SDAx line held low and the Start condition is complete.

If at the beginning of the Start condition, the SDAx and SCLx pins are already sampled low, or if during the Start condition, the SCLx line is sampled low before the SDAx line is driven low, a bus collision occurs. The Bus Collision Interrupt Flag, BCLxIF, is set, the Start condition is aborted and the I²C module is reset into its Idle state.

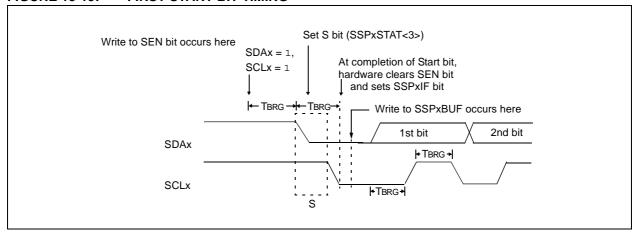
18.4.8.1 WCOL Status Flag

Note:

If the user writes the SSPxBUF when a Start sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing to the lower 5 bits of SSPxCON2 is disabled until the Start condition is complete.

FIGURE 18-19: FIRST START BIT TIMING



18.4.9 I²C MASTER MODE REPEATED START CONDITION TIMING

A Repeated Start condition occurs when the RSEN bit (SSPxCON2<1>) is programmed high and the I²C logic module is in the Idle state. When the RSEN bit is set, the SCLx pin is asserted low. When the SCLx pin is sampled low, the Baud Rate Generator is loaded with the contents of SSPxADD<6:0> and begins counting. The SDAx pin is released (brought high) for one Baud Rate Generator count (TBRG). When the Baud Rate Generator times out, if SDAx is sampled high, the SCLx pin will be deasserted (brought high). When SCLx is sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<6:0> and begins counting. SDAx and SCLx must be sampled high for one TBRG. This action is then followed by assertion of the SDAx pin (SDAx = 0) for one TBRG while SCLx is high. Following this, the RSEN bit (SSPxCON2<1>) will be automatically cleared and the Baud Rate Generator will not be reloaded, leaving the SDAx pin held low. As soon as a Start condition is detected on the SDAx and SCLx pins, the S bit (SSPxSTAT<3>) will be set. The SSPxIF bit will not be set until the Baud Rate Generator has timed out

Note 1: If RSEN is programmed while any other event is in progress, it will not take effect.

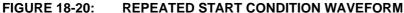
- **2:** A bus collision during the Repeated Start condition occurs if:
 - SDAx is sampled low when SCLx goes from low-to-high.
 - SCLx goes low before SDAx is asserted low. This may indicate that another master is attempting to transmit a data '1'.

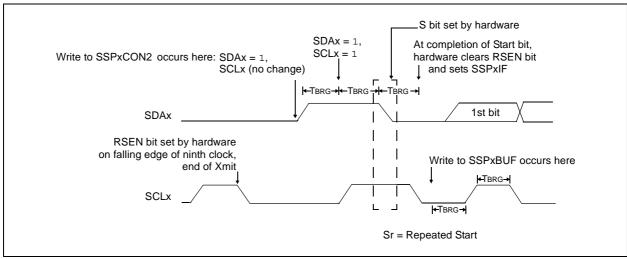
Immediately following the SSPxIF bit getting set, the user may write the SSPxBUF with the 7-bit address in 7-bit mode or the default first address in 10-bit mode. After the first eight bits are transmitted and an ACK is received, the user may then transmit an additional eight bits of address (10-bit mode) or eight bits of data (7-bit mode).

18.4.9.1 WCOL Status Flag

If the user writes the SSPxBUF when a Repeated Start sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing of the lower 5 bits of SSPxCON2 is disabled until the Repeated Start condition is complete.





18.4.10 I²C MASTER MODE TRANSMISSION

Transmission of a data byte, a 7-bit address or the other half of a 10-bit address is accomplished by simply writing a value to the SSPxBUF register. This action will set the Buffer Full flag bit, BF and allow the Baud Rate Generator to begin counting and start the next transmission. Each bit of address/data will be shifted out onto the SDAx pin after the falling edge of SCLx is asserted (see data hold time specification parameter 106). SCLx is held low for one Baud Rate Generator rollover count (TBRG). Data should be valid before SCLx is released high (see data setup time specification parameter 107). When the SCLx pin is released high, it is held that way for TBRG. The data on the SDAx pin must remain stable for that duration and some hold time after the next falling edge of SCLx. After the eighth bit is shifted out (the falling edge of the eighth clock), the BF flag is cleared and the master releases SDAx. This allows the slave device being addressed to respond with an ACK bit during the ninth bit time if an address match occurred, or if data was received properly. The status of ACK is written into the ACKDT bit on the falling edge of the ninth clock. If the master receives an Acknowledge, the Acknowledge Status bit, ACKSTAT, is cleared; if not, the bit is set. After the ninth clock, the SSPxIF bit is set and the master clock (Baud Rate Generator) is suspended until the next data byte is loaded into the SSPxBUF, leaving SCLx low and SDAx unchanged (Figure 18-21).

After the write to the SSPxBUF, each bit of the address will be shifted out on the falling edge of SCLx until all seven address bits and the R/W bit are completed. On the falling edge of the eighth clock, the master will deassert the SDAx pin, allowing the slave to respond with an Acknowledge. On the falling edge of the ninth clock, the master will sample the SDAx pin to see if the address was recognized by a slave. The status of the ACK bit is loaded into the ACKSTAT status bit (SSPxCON2<6>). Following the falling edge of the ninth clock transmission of the address, the SSPxIF is set, the BF flag is cleared and the Baud Rate Generator is turned off until another write to the SSPxBUF takes place, holding SCLx low and allowing SDAx to float.

18.4.10.1 BF Status Flag

In Transmit mode, the BF bit (SSPxSTAT<0>) is set when the CPU writes to SSPxBUF and is cleared when all 8 bits are shifted out.

18.4.10.2 WCOL Status Flag

If the user writes to the SSPxBUF when a transmit is already in progress (i.e., SSPxSR is still shifting out a data byte), the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur) after 2 TcY after the SSPBUF write. If SSPBUF is rewritten within 2 TcY, the WCOL bit is set and SSPBUF is updated. This may result in a corrupted transfer.

The user should verify that the WCOL is clear after each write to SSPBUF to ensure the transfer is correct. In all cases, WCOL must be cleared in software.

18.4.10.3 ACKSTAT Status Flag

In Transmit mode, the ACKSTAT bit (SSPxCON2<6>) is cleared when the slave has sent an Acknowledge $(\overline{ACK}=0)$ and is set when the slave does not Acknowledge $(\overline{ACK}=1)$. A slave sends an Acknowledge when it has recognized its address (including a general call), or when the slave has properly received its data.

18.4.11 I²C MASTER MODE RECEPTION

Master mode reception is enabled by programming the Receive Enable bit, RCEN (SSPxCON2<3>).

Note: The MSSP module must be in an Idle state before the RCEN bit is set or the RCEN bit will be disregarded.

The Baud Rate Generator begins counting and on each rollover, the state of the SCLx pin changes (high-to-low/low-to-high) and data is shifted into the SSPxSR. After the falling edge of the eighth clock, the receive enable flag is automatically cleared, the contents of the SSPxSR are loaded into the SSPxBUF, the BF flag bit is set, the SSPxIF flag bit is set and the Baud Rate Generator is suspended from counting, holding SCLx low. The MSSP is now in Idle state awaiting the next command. When the buffer is read by the CPU, the BF flag bit is automatically cleared. The user can then send an Acknowledge bit at the end of reception by setting the Acknowledge Sequence Enable bit, ACKEN (SSPxCON2<4>).

18.4.11.1 BF Status Flag

In receive operation, the BF bit is set when an address or data byte is loaded into SSPxBUF from SSPxSR. It is cleared when the SSPxBUF register is read.

18.4.11.2 SSPOV Status Flag

In receive operation, the SSPOV bit is set when 8 bits are received into the SSPxSR and the BF flag bit is already set from a previous reception.

18.4.11.3 WCOL Status Flag

If the user writes the SSPxBUF when a receive is already in progress (i.e., SSPxSR is still shifting in a data byte), the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).

FIGURE 18-21: I²C™ MASTER MODE WAVEFORM (TRANSMISSION, 7 OR 10-BIT ADDRESS) ACKSTAT in SSPxCON2 = 1 Cleared in software ACK From slave, clear ACKSTAT bit (SSPxCON2<6>) 8 Cleared in software service routine from SSP interrupt 5 SSPxBUF is written in software Transmitting Data or Second Half of 10-bit Address (D3 / Z 24) D2) | | | SCLx held low while CPU \ 07 <u>ACK</u> = 0 After Start condition, SEN cleared by hardware SSPxBUF written with 7-bit address and R/W start transmit (A5 X A4 X A3 X A2 X A1 Transmit Address to Slave Cleared in software Write SSPxCON2<0> (SEN = 1) SSPxBUF written Start condition begins $\langle A6 \rangle$ 4 BF (SSPXSTAT<0>) S SSPXIF SDAx SCLx SEN PEN R∭

Advance Information

I²C™ MASTER MODE WAVEFORM (RECEPTION, 7-BIT ADDRESS) FIGURE 18-22: Set SSPxIF interrupt at end of Acknow-ledge sequence terminates transfer Bus master Set P bit (SSPxSTAT<4>) and SSPxIF PEN bit = 1 written here Set ACKEN, start Acknowledge sequence SDAx = ACKDT = 1 ٦ ACK is not sent Set SSPxIF at end of receive SSPOV is set because SSPxBUF is still full 6 RCEN cleared automatically 8 11/2/3/4/45/6/7/8 D7\D6\D5\D4\D3\D2\D1\ Data shifted in on falling edge of CLK Receiving Data from Slave Set SSPxIF interrupt at end of Acknowledge sequence Cleared in software Last bit is shifted into SSPxSR and contents are unloaded into SSPxBUF Write to SSPxCON2<4> to start Acknowledge sequence SDAx = ACKDT (SSPxCON2<5>) = 0 RCEN = 1, start next receive ACK from Master, SDAx = ACKDT = 0 ACK 6 Cleared in software — RCEN cleared automatically 2 11/2/3/4/5\6\7\8L Master configured as a receiver by programming SSPxCON2<3> (RCEN = 1) /D7/D6/D5/D4/D3/D2/D1/ Set SSPxIF interrupt at end of receive Receiving Data from Slave Cleared in software ACK ACK from Slave $R\overline{M} = 0$ Transmit Address to Slave Fy A7 A6 A5 A4 A3 A2 A1Write to SSPxBUF occurs here, Cleared in software Write to SSPxCON2<0> (SEN = 1), start XMIT begin Start condition SDAx = 0, SCLx = 1 while CPU responds to SSPxIF <u></u> _] BF (SSPxSTAT<0>) SSPxIF ACKEN-SSPOV SDAx SCLx

18.4.12 ACKNOWLEDGE SEQUENCE TIMING

An Acknowledge sequence is enabled by setting the Sequence Enable bit. Acknowledge **ACKEN** (SSPxCON2<4>). When this bit is set, the SCLx pin is pulled low and the contents of the Acknowledge data bit are presented on the SDAx pin. If the user wishes to generate an Acknowledge, then the ACKDT bit should be cleared. If not, the user should set the ACKDT bit before starting an Acknowledge sequence. The Baud Rate Generator then counts for one rollover period (TBRG) and the SCLx pin is deasserted (pulled high). When the SCLx pin is sampled high (clock arbitration), the Baud Rate Generator counts for TBRG. The SCLx pin is then pulled low. Following this, the ACKEN bit is automatically cleared, the Baud Rate Generator is turned off and the MSSP module then goes into Idle mode (Figure 18-23).

18.4.12.1 WCOL Status Flag

If the user writes the SSPxBUF when an Acknowledge sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

18.4.13 STOP CONDITION TIMING

A Stop bit is asserted on the SDAx pin at the end of a receive/transmit by setting the Stop Sequence Enable bit, PEN (SSPxCON2<2>). At the end of a receive/transmit, the SCLx line is held low after the falling edge of the ninth clock. When the PEN bit is set, the master will assert the SDAx line low. When the SDAx line is sampled low, the Baud Rate Generator is reloaded and counts down to '0'. When the Baud Rate Generator times out, the SCLx pin will be brought high and one TBRG (Baud Rate Generator rollover count) later, the SDAx pin will be deasserted. When the SDAx pin is sampled high while SCLx is high, the P bit (SSPxSTAT<4>) is set. A TBRG later, the PEN bit is cleared and the SSPxIF bit is set (Figure 18-24).

18.4.13.1 WCOL Status Flag

If the user writes the SSPxBUF when a Stop sequence is in progress, then the WCOL bit is set and the contents of the buffer are unchanged (the write doesn't occur).

FIGURE 18-23: ACKNOWLEDGE SEQUENCE WAVEFORM

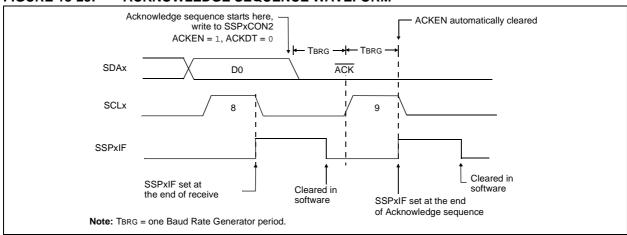
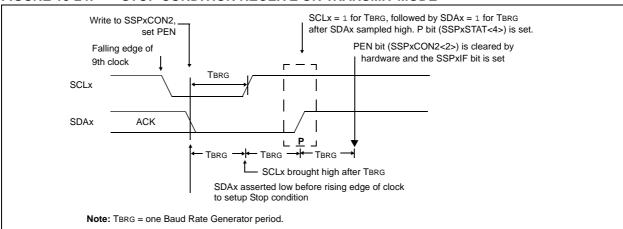


FIGURE 18-24: STOP CONDITION RECEIVE OR TRANSMIT MODE



18.4.14 SLEEP OPERATION

While in Sleep mode, the I²C module can receive addresses or data and when an address match or complete byte transfer occurs, wake the processor from Sleep (if the MSSP interrupt is enabled).

18.4.15 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

18.4.16 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions allows the determination of when the bus is free. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit (SSPxSTAT<4>) is set, or the bus is Idle, with both the S and P bits clear. When the bus is busy, enabling the SSP interrupt will generate the interrupt when the Stop condition occurs.

In multi-master operation, the SDAx line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed in hardware with the result placed in the BCLxIF bit.

The states where arbitration can be lost are:

- Address Transfer
- Data Transfer
- A Start Condition
- · A Repeated Start Condition
- An Acknowledge Condition

18.4.17 MULTI -MASTER COMMUNICATION, BUS COLLISION AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDAx pin, arbitration takes place when the master outputs a '1' on SDAx, by letting SDAx float high and another master asserts a '0'. When the SCLx pin floats high, data should be stable. If the expected data on SDAx is a '1' and the data sampled on the SDAx pin = 0, then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag, BCLxIF and reset the I²C port to its Idle state (Figure 18-25).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF flag is cleared, the SDAx and SCLx lines are deasserted and the SSPxBUF can be written to. When the user services the bus collision Interrupt Service Routine and if the $\rm I^2C$ bus is free, the user can resume communication by asserting a Start condition.

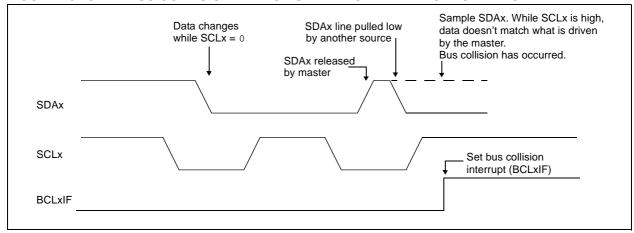
If a Start, Repeated Start, Stop or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDAx and SCLx lines are deasserted and the respective control bits in the SSPxCON2 register are cleared. When the user services the bus collision Interrupt Service Routine and if the I²C bus is free, the user can resume communication by asserting a Start condition.

The master will continue to monitor the SDAx and SCLx pins. If a Stop condition occurs, the SSPxIF bit will be set.

A write to the SSPxBUF will start the transmission of data at the first data bit regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of Start and Stop conditions allows the determination of when the bus is free. Control of the I^2C bus can be taken when the P bit is set in the SSPxSTAT register, or the bus is Idle and the S and P bits are cleared.





18.4.17.1 Bus Collision During a Start Condition

During a Start condition, a bus collision occurs if:

- a) SDAx or SCLx are sampled low at the beginning of the Start condition (Figure 18-26).
- b) SCLx is sampled low before SDAx is asserted low (Figure 18-27).

During a Start condition, both the SDAx and the SCLx pins are monitored.

If the SDAx pin is already low, or the SCLx pin is already low, then all of the following occur:

- the Start condition is aborted;
- · the BCLxIF flag is set; and
- the MSSP module is reset to its Idle state (Figure 18-26).

The Start condition begins with the SDAx and SCLx pins deasserted. When the SDAx pin is sampled high, the Baud Rate Generator is loaded from SSPxADD<6:0> and counts down to '0'. If the SCLx pin is sampled low while SDAx is high, a bus collision occurs, because it is assumed that another master is attempting to drive a data '1' during the Start condition.

If the SDAx pin is sampled low during this count, the BRG is reset and the SDAx line is asserted early (Figure 18-28). If, however, a '1' is sampled on the SDAx pin, the SDAx pin is asserted low at the end of the BRG count. The Baud Rate Generator is then reloaded and counts down to '0'. If the SCLx pin is sampled as '0' during this time, a bus collision does not occur. At the end of the BRG count, the SCLx pin is asserted low.

Note:

The reason that bus collision is not a factor during a Start condition is that no two bus masters can assert a Start condition at the exact same time. Therefore, one master will always assert SDAx before the other. This condition does not cause a bus collision because the two masters must be allowed to arbitrate the first address following the Start condition. If the address is the same, arbitration must be allowed to continue into the data portion, Repeated Start or Stop conditions.



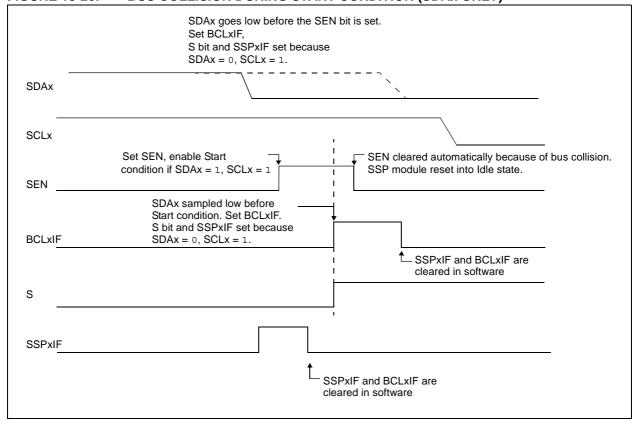


FIGURE 18-27: BUS COLLISION DURING START CONDITION (SCLx = 0)

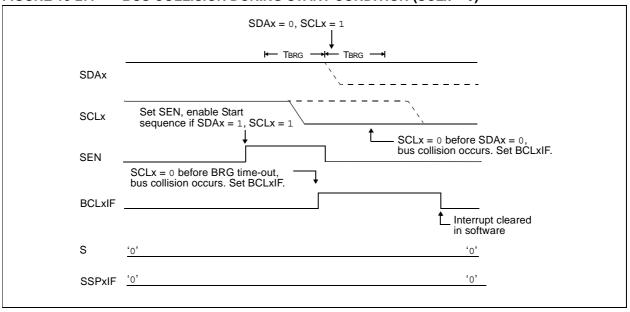
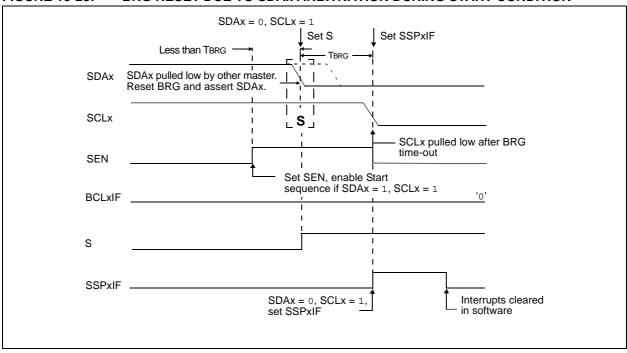


FIGURE 18-28: BRG RESET DUE TO SDAX ARBITRATION DURING START CONDITION



18.4.17.2 Bus Collision During a Repeated Start Condition

During a Repeated Start condition, a bus collision occurs if:

- A low level is sampled on SDAx when SCLx goes from low level to high level.
- b) SCLx goes low before SDAx is asserted low, indicating that another master is attempting to transmit a data '1'.

When the user deasserts SDAx and the pin is allowed to float high, the BRG is loaded with SSPxADD<6:0> and counts down to '0'. The SCLx pin is then deasserted and when sampled high, the SDAx pin is sampled.

If SDAx is low, a bus collision has occurred (i.e., another master is attempting to transmit a data '0', see Figure 18-29). If SDAx is sampled high, the BRG is reloaded and begins counting. If SDAx goes from high-to-low before the BRG times out, no bus collision occurs because no two masters can assert SDAx at exactly the same time.

If SCLx goes from high-to-low before the BRG times out and SDAx has not already been asserted, a bus collision occurs. In this case, another master is attempting to transmit a data '1' during the Repeated Start condition (see Figure 18-30).

If, at the end of the BRG time-out, both SCLx and SDAx are still high, the SDAx pin is driven low and the BRG is reloaded and begins counting. At the end of the count, regardless of the status of the SCLx pin, the SCLx pin is driven low and the Repeated Start condition is complete.



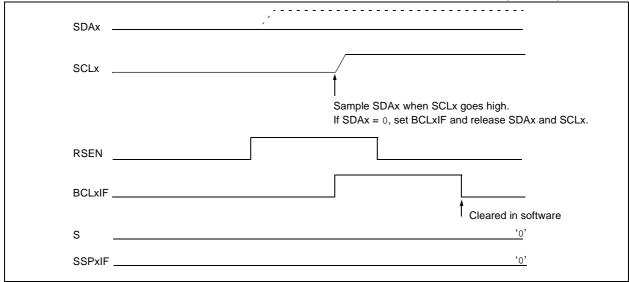
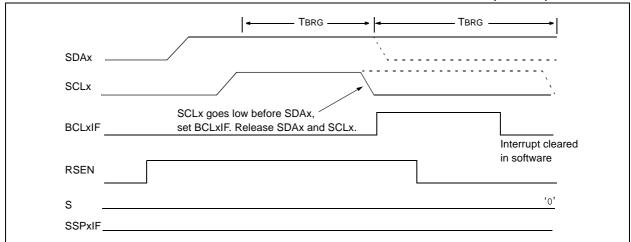


FIGURE 18-30: BUS COLLISION DURING REPEATED START CONDITION (CASE 2)



18.4.17.3 Bus Collision During a Stop Condition

Bus collision occurs during a Stop condition if:

- After the SDAx pin has been deasserted and allowed to float high, SDAx is sampled low after the BRG has timed out.
- b) After the SCLx pin is deasserted, SCLx is sampled low before SDAx goes high.

The Stop condition begins with SDAx asserted low. When SDAx is sampled low, the SCLx pin is allowed to float. When the pin is sampled high (clock arbitration), the Baud Rate Generator is loaded with SSPxADD<6:0> and counts down to '0'. After the BRG times out, SDAx is sampled. If SDAx is sampled low, a bus collision has occurred. This is due to another master attempting to drive a data '0' (Figure 18-31). If the SCLx pin is sampled low before SDAx is allowed to float high, a bus collision occurs. This is another case of another master attempting to drive a data '0' (Figure 18-32).

FIGURE 18-31: BUS COLLISION DURING A STOP CONDITION (CASE 1)

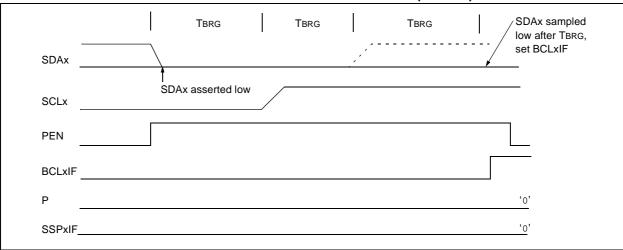


FIGURE 18-32: BUS COLLISION DURING A STOP CONDITION (CASE 2)

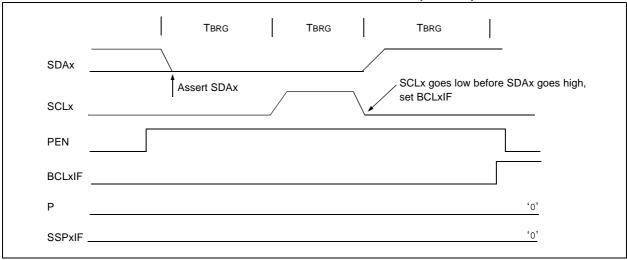


TABLE 18-4: REGISTERS ASSOCIATED WITH I²C™ OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	TMR3IF	CCP2IF	51
PIE2	OSCFIE	CMIE	_	_	BCL1IE	_	TMR3IE	CCP2IE	51
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	TMR3IP	CCP2IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	52
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	52
SSP1BUF	MSSP1 Re	ceive Buffer	/Transmit R	egister					50
SSP1ADD		dress Regist ud Rate Rel							53
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	50
SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	50
SSP1STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	50
SSP2BUF	MSSP2 Re	ceive Buffer	Transmit R	egister					50
SSP2ADD	MSSP2 Ad MSSP2 Ba	dress Regist ud Rate Rel	ter (I ² C Slav	ve mode), er (I ² C Maste	er mode)				53
SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	53
SSP2CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	53
SSP2STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	53

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the MSSP module in I^2C^{TM} mode.

NOTES:

19.0 ENHANCED UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (EUSART)

The Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART) module is one of two serial I/O modules. (Generically, the EUSART is also known as a Serial Communications Interface or SCI.) The EUSART can be configured as a full-duplex asynchronous system that can communicate with peripheral devices, such as CRT terminals and personal computers. It can also be configured as a half-duplex synchronous system that can communicate with peripheral devices, such as A/D or D/A integrated circuits, serial EEPROMs, etc.

The Enhanced USART module implements additional features, including automatic baud rate detection and calibration, automatic wake-up on Sync Break reception and 12-bit Break character transmit. These make it ideally suited for use in Local Interconnect Network bus (LIN bus) systems.

All members of the PIC18F87J10 family are equipped with two independent EUSART modules, referred to as EUSART1 and EUSART2. They can be configured in the following modes:

- Asynchronous (full duplex) with:
 - Auto-Wake-up on character reception
 - Auto-Baud calibration
 - 12-bit Break character transmission
- Synchronous Master (half duplex) with selectable clock polarity
- Synchronous Slave (half duplex) with selectable clock polarity

The pins of EUSART1 and EUSART2 are multiplexed with the functions of PORTC (RC6/TX1/CK1 and RC7/RX1/DT1) and PORTG (RG1/TX2/CK2 and RG2/RX2/DT2), respectively. In order to configure these pins as an EUSART:

- For EUSART1:
 - bit SPEN (RCSTA1<7>) must be set (= 1)
 - bit TRISC<7> must be set (= 1)
 - bit TRISC<6> must be cleared (= 0) for Asynchronous and Synchronous Master modes
 - bit TRISC<6> must be set (= 1) for Synchronous Slave mode
- For EUSART2:
 - bit SPEN (RCSTA2<7>) must be set (= 1)
 - bit TRISG<2> must be set (= 1)
 - bit TRISG<1> must be cleared (= 0) for Asynchronous and Synchronous Master modes
 - bit TRISC<6> must be set (= 1) for Synchronous Slave mode

Note: The EUSART control will automatically reconfigure the pin from input to output as needed.

The operation of each Enhanced USART module is controlled through three registers:

- Transmit Status and Control (TXSTAx)
- Receive Status and Control (RCSTAx)
- Baud Rate Control (BAUDCONx)

These are detailed on the following pages in Register 19-1, Register 19-2 and Register 19-3, respectively.

Note: Throughout this section, references to register and bit names that may be associated with a specific EUSART module are referred to generically by the use of 'x' in place of the specific module number. Thus, "RCSTAx" might refer to the Receive Status register for either EUSART1 or EUSART2.

REGISTER 19-1: TXSTAX: TRANSMIT STATUS AND CONTROL REGISTER

CSRC TX9 TXEN SYNC SENDB BRGH TRMT TX9D	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-1	R/W-0
	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D

bit 7 bit 0

bit 7 CSRC: Clock Source Select bit

Asynchronous mode:

Don't care.

Synchronous mode:

1 = Master mode (clock generated internally from BRG)

0 = Slave mode (clock from external source)

bit 6 TX9: 9-bit Transmit Enable bit

1 = Selects 9-bit transmission

0 = Selects 8-bit transmission

bit 5 TXEN: Transmit Enable bit

1 = Transmit enabled

0 = Transmit disabled

Note: SREN/CREN overrides TXEN in Sync mode.

bit 4 SYNC: EUSART Mode Select bit

1 = Synchronous mode

0 = Asynchronous mode

bit 3 SENDB: Send Break Character bit

Asynchronous mode:

1 = Send Sync Break on next transmission (cleared by hardware upon completion)

0 = Sync Break transmission completed

Synchronous mode:

Don't care.

bit 2 BRGH: High Baud Rate Select bit

Asynchronous mode:

1 = High speed

0 = Low speed

Synchronous mode:

Unused in this mode.

bit 1 TRMT: Transmit Shift Register Status bit

1 = TSR empty

0 = TSR full

bit 0 **TX9D:** 9th bit of Transmit Data

Can be address/data bit or a parity bit.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 19-2: RCSTAX: RECEIVE STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-x
SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D

bit 7 bit 0

bit 7 SPEN: Serial Port Enable bit

1 = Serial port enabled (configures RXx/DTx and TXx/CKx pins as serial port pins)

0 = Serial port disabled (held in Reset)

bit 6 RX9: 9-bit Receive Enable bit

1 = Selects 9-bit reception

0 = Selects 8-bit reception

bit 5 SREN: Single Receive Enable bit

Asynchronous mode:

Don't care.

Synchronous mode - Master:

1 = Enables single receive

0 = Disables single receive

This bit is cleared after reception is complete.

Synchronous mode - Slave:

Don't care.

bit 4 CREN: Continuous Receive Enable bit

Asynchronous mode:

1 = Enables receiver

0 = Disables receiver

Synchronous mode:

1 = Enables continuous receive until enable bit CREN is cleared (CREN overrides SREN)

0 = Disables continuous receive

bit 3 ADDEN: Address Detect Enable bit

Asynchronous mode 9-bit (RX9 = 1):

1 = Enables address detection, enables interrupt and loads the receive buffer when RSR<8> is set

0 = Disables address detection, all bytes are received and ninth bit can be used as parity bit

Asynchronous mode 9-bit (RX9 = 0):

Don't care.

bit 2 **FERR:** Framing Error bit

1 = Framing error (can be updated by reading RCREGx register and receiving next valid byte)

0 = No framing error

bit 1 OERR: Overrun Error bit

1 = Overrun error (can be cleared by clearing bit CREN)

0 = No overrun error

bit 0 RX9D: 9th bit of Received Data

This can be address/data bit or a parity bit and must be calculated by user firmware.

Legend	٠.
Legend	١.
_	

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

REGISTER 19-3: BAUDCONX: BAUD RATE CONTROL REGISTER

R/W-0) R-1	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
ABDO\	/F RCMT	_	SCKP	BRG16	_	WUE	ABDEN
bit 7			-	•			bit 0

bit 7 ABDOVF: Auto-Baud Acquisition Rollover Status bit

> 1 = A BRG rollover has occurred during Auto-Baud Rate Detect mode (must be cleared in software)

0 = No BRG rollover has occurred

bit 6 **RCMT:** Receive Operation Idle Status bit

1 = Receive operation is Idle

0 = Receive operation is active

bit 5 Unimplemented: Read as '0'

bit 4 SCKP: Synchronous Clock Polarity Select bit

> Asynchronous mode: Unused in this mode.

Synchronous mode:

1 = Idle state for clock (CKx) is a high level

0 = Idle state for clock (CKx) is a low level

bit 3 BRG16: 16-bit Baud Rate Register Enable bit

1 = 16-bit Baud Rate Generator - SPBRGHx and SPBRGx

0 = 8-bit Baud Rate Generator - SPBRGx only (Compatible mode), SPBRGHx value ignored

bit 2 Unimplemented: Read as '0'

bit 1 WUE: Wake-up Enable bit

Asynchronous mode:

1 = EUSART will continue to sample the RXx pin - interrupt generated on falling edge; bit cleared in hardware on following rising edge

0 = RXx pin not monitored or rising edge detected

Synchronous mode:

Unused in this mode.

bit 0 **ABDEN:** Auto-Baud Detect Enable bit

Asynchronous mode:

1 = Enable baud rate measurement on the next character. Requires reception of a Sync field (55h); cleared in hardware upon completion

0 = Baud rate measurement disabled or completed

Synchronous mode:

Unused in this mode.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

19.1 Baud Rate Generator (BRG)

The BRG is a dedicated 8-bit or 16-bit generator that supports both the Asynchronous and Synchronous modes of the EUSART. By default, the BRG operates in 8-bit mode; setting the BRG16 bit (BAUDCONx<3>) selects 16-bit mode.

The SPBRGHx:SPBRGx register pair controls the period of a free running timer. In Asynchronous mode, bits BRGH (TXSTAx<2>) and BRG16 (BAUDCONx<3>) also control the baud rate. In Synchronous mode, BRGH is ignored. Table 19-1 shows the formula for computation of the baud rate for different EUSART modes which only apply in Master mode (internally generated clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRGHx:SPBRGx registers can be calculated using the formulas in Table 19-1. From this, the error in baud rate can be determined. An example calculation is shown in Example 19-1. Typical baud rates and error values for the various Asynchronous modes are shown in Table 19-2. It may be advantageous to use

the high baud rate (BRGH = 1) or the 16-bit BRG to reduce the baud rate error, or achieve a slow baud rate for a fast oscillator frequency.

Writing a new value to the SPBRGHx:SPBRGx registers causes the BRG timer to be reset (or cleared). This ensures the BRG does not wait for a timer overflow before outputting the new baud rate.

19.1.1 OPERATION IN POWER-MANAGED MODES

The device clock is used to generate the desired baud rate. When one of the power-managed modes is entered, the new clock source may be operating at a different frequency. This may require an adjustment to the value in the SPBRGx register pair.

19.1.2 SAMPLING

The data on the RXx pin (either RC7/RX1/DT1 or RG2/RX2/DT2) is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RXx pin.

TABLE 19-1: BAUD RATE FORMULAS

C	Configuration Bits SYNC BRG16 BRGH		BRG/EUSART Mode	Baud Rate Formula		
SYNC			BRG/EUSART Mode			
0	0	0	8-bit/Asynchronous	Fosc/[64 (n + 1)]		
0	0	1	8-bit/Asynchronous	F000/[16 (n + 1)]		
0	1	0	16-bit/Asynchronous	Fosc/[16 (n + 1)]		
0	1	1	16-bit/Asynchronous			
1	0	х	8-bit/Synchronous	Fosc/[4 (n + 1)]		
1	1 x		16-bit/Synchronous	1		

Legend: x = Don't care, n = value of SPBRGHx:SPBRGx register pair

EXAMPLE 19-1: CALCULATING BAUD RATE ERROR

For a device with Fosc of 16 MHz, desired baud rate of 9600, Asynchronous mode, 8-bit BRG:

Desired Baud Rate = Fosc/(64 ([SPBRGHx:SPBRGx] + 1))

Solving for SPBRGHx:SPBRGx:

X = ((FOSC/Desired Baud Rate)/64) - 1

= ((16000000/9600)/64) - 1

= [25.042] = 25

Calculated Baud Rate = 16000000/(64(25+1))

= 9615

Error = (Calculated Baud Rate – Desired Baud Rate)/Desired Baud Rate

= (9615 - 9600)/9600 = 0.16%

TABLE 19-2: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page	
TXSTAx	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	51	
RCSTAx	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	51	
BAUDCONx	ABDOVF	RCMT	Г — SCKP BRG16 — WUE ABDEN							
SPBRGHx	EUSARTx	EUSARTx Baud Rate Generator Register High Byte								
SPBRGx	EUSARTx	Baud Rate	Generator F	Register Lov	w Byte				52	

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the BRG.

TABLE 19-3: BAUD RATES FOR ASYNCHRONOUS MODES

IADEL	13-3. BAOD KATEST OK ASTROMICOROUS MISSES												
					SYNC	= 0, BRGH	l = 0, BRG	316 = 0					
BAUD	Fosc	= 40.000) MHz	Fosc	= 20.000) MHz	Fosc = 10.000 MHz			Fosc = 8.000 MHz			
RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	
0.3	_	_	_	_	_	_	_	_	_		_	_	
1.2	_	_	_	1.221	1.73	255	1.202	0.16	129	1201	-0.16	103	
2.4	2.441	1.73	255	2.404	0.16	129	2.404	0.16	64	2403	-0.16	51	
9.6	9.615	0.16	64	9.766	1.73	31	9.766	1.73	15	9615	-0.16	12	
19.2	19.531	1.73	31	19.531	1.73	15	19.531	1.73	7	_	_	_	
57.6	56.818	-1.36	10	62.500	8.51	4	52.083	-9.58	2	_	_	_	
115.2	125.000	8.51	4	104.167	-9.58	2	78.125	-32.18	1	_	_	_	

		SYNC = 0, BRGH = 0, BRG16 = 0												
BAUD	Fos	c = 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz							
RATE (K)	Actual % Rate (K)		SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)					
0.3	0.300	0.16	207	300	-0.16	103	300	-0.16	51					
1.2	1.202	0.16	51	1201	-0.16	25	1201	-0.16	12					
2.4	2.404	0.16	25	2403	-0.16	12	_	_	_					
9.6	8.929	-6.99	6	_	_	_	_	_	_					
19.2	20.833	8.51	2	_	_	_	_	_	_					
57.6	62.500	8.51	0	_	_	_	_	_	_					
115.2	62.500	-45.75	0	_	_	_	_	_	_					

					SYNC	= 0, BRGH	l = 1, BRG	16 = 0				
BAUD RATE	Fosc	= 40.000) MHz	Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)
0.3	_	_	_	_	_	_	_	_	_	_	_	_
1.2	_	_	_	_	_	_	_	_	_	_	_	
2.4	_	_	_	_	_	_	2.441	1.73	255	2403	-0.16	207
9.6	9.766	1.73	255	9.615	0.16	129	9.615	0.16	64	9615	-0.16	51
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19230	-0.16	25
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55555	3.55	8
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	_	_	_

			S	YNC = 0, E	RGH = 1	L, BRG16 =	0			
BAUD RATE	Fosc	= 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz			
(K)	Actual Rate (K)	% Error	value Rate value		Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	_	_	_		_	_	300	-0.16	207	
1.2	1.202	0.16	207	1201	-0.16	103	1201	-0.16	51	
2.4	2.404	0.16	103	2403	-0.16	51	2403	-0.16	25	
9.6	9.615	0.16	25	9615	-0.16	12	_	_	_	
19.2	19.231	0.16	12	_	_	_	_	_	_	
57.6	62.500	8.51	3	_	_	_	_	_	_	
115.2	125.000	8.51	1	_	_	_	_	_	_	

TABLE 19-3: BAUD RATES FOR ASYNCHRONOUS MODES (CONTINUED)

					SYNC	= 0, BRGH	H = 0, BRG	16 = 1				
BAUD RATE	Fosc	= 40.000) MHz	Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz		
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)									
0.3	0.300	0.00	8332	0.300	0.02	4165	0.300	0.02	2082	300	-0.04	1665
1.2	1.200	0.02	2082	1.200	-0.03	1041	1.200	-0.03	520	1201	-0.16	415
2.4	2.402	0.06	1040	2.399	-0.03	520	2.404	0.16	259	2403	-0.16	207
9.6	9.615	0.16	259	9.615	0.16	129	9.615	0.16	64	9615	-0.16	51
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19230	-0.16	25
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55555	3.55	8
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	_	_	_

		SYNC = 0, BRGH = 0, BRG16 = 1										
BAUD RATE	Fosc	Fosc = 4.000 MHz			c = 2.000	MHz	Fos	c = 1.000	MHz			
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	0.300	0.04	832	300	-0.16	415	300	-0.16	207			
1.2	1.202	0.16	207	1201	-0.16	103	1201	-0.16	51			
2.4	2.404	0.16	103	2403	-0.16	51	2403	-0.16	25			
9.6	9.615	0.16	25	9615	-0.16	12	_	_	_			
19.2	19.231	0.16	12	_	_	_	_	_	_			
57.6	62.500	8.51	3	_	_	_	_	_	_			
115.2	125.000	8.51	1	_	_	_	_	_	_			

				SYNC = 0	, BRGH =	= 1, BRG16	= 1 or SY	NC = 1,	BRG16 = 1			
BAUD	FOSC = 40.000 MHZ		Fosc = 20.000 MHz			Fosc	= 10.000) MHz	Fosc	c = 8.000	MHz	
RATE (K)	Actual Rate (K)	% Error	SPBRG value (decimal)									
0.3	0.300	0.00	33332	0.300	0.00	16665	0.300	0.00	8332	300	-0.01	6665
1.2	1.200	0.00	8332	1.200	0.02	4165	1.200	0.02	2082	1200	-0.04	1665
2.4	2.400	0.02	4165	2.400	0.02	2082	2.402	0.06	1040	2400	-0.04	832
9.6	9.606	0.06	1040	9.596	-0.03	520	9.615	0.16	259	9615	-0.16	207
19.2	19.193	-0.03	520	19.231	0.16	259	19.231	0.16	129	19230	-0.16	103
57.6	57.803	0.35	172	57.471	-0.22	86	58.140	0.94	42	57142	0.79	34
115.2	114.943	-0.22	86	116.279	0.94	42	113.636	-1.36	21	117647	-2.12	16

		SYNC = 0, BRGH = 1, BRG16 = 1 or SYNC = 1, BRG16 = 1										
BAUD RATE	FOSC = 4.000 MHz				c = 2.000	MHz	Fosc = 1.000 MHz					
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	0.300	0.01	3332	300	-0.04	1665	300	-0.04	832			
1.2	1.200	0.04	832	1201	-0.16	415	1201	-0.16	207			
2.4	2.404	0.16	415	2403	-0.16	207	2403	-0.16	103			
9.6	9.615	0.16	103	9615	-0.16	51	9615	-0.16	25			
19.2	19.231	0.16	51	19230	-0.16	25	19230	-0.16	12			
57.6	58.824	2.12	16	55555	3.55	8	_	_	_			
115.2	111.111	-3.55	8	_	_	_	_	_	_			

19.1.3 AUTO-BAUD RATE DETECT

The Enhanced USART module supports the automatic detection and calibration of baud rate. This feature is active only in Asynchronous mode and while the WUE bit is clear.

The automatic baud rate measurement sequence (Figure 19-1) begins whenever a Start bit is received and the ABDEN bit is set. The calculation is self-averaging.

In the Auto-Baud Rate Detect (ABD) mode, the clock to the BRG is reversed. Rather than the BRG clocking the incoming RXx signal, the RXx signal is timing the BRG. In ABD mode, the internal Baud Rate Generator is used as a counter to time the bit period of the incoming serial byte stream.

Once the ABDEN bit is set, the state machine will clear the BRG and look for a Start bit. The Auto-Baud Rate Detect must receive a byte with the value 55h (ASCII "U", which is also the LIN bus Sync character) in order to calculate the proper bit rate. The measurement is taken over both a low and a high bit time in order to minimize any effects caused by asymmetry of the incoming signal. After a Start bit, the SPBRGx begins counting up, using the preselected clock source on the first rising edge of RXx. After eight bits on the RXx pin or the fifth rising edge, an accumulated value totalling the proper BRG period is left in the SPBRGHx:SPBRGx register pair. Once the 5th edge is seen (this should correspond to the Stop bit), the ABDEN bit is automatically cleared.

If a rollover of the BRG occurs (an overflow from FFFFh to 0000h), the event is trapped by the ABDOVF status bit (BAUDCONx<7>). It is set in hardware by BRG rollovers and can be set or cleared by the user in software. ABD mode remains active after rollover events and the ABDEN bit remains set (Figure 19-2).

While calibrating the baud rate period, the BRG registers are clocked at 1/8th the preconfigured clock rate. Note that the BRG clock will be configured by the BRG16 and BRGH bits. Independent of the BRG16 bit setting, both the SPBRGx and SPBRGHx will be used as a 16-bit counter. This allows the user to verify that no carry occurred for 8-bit modes by checking for 00h in the SPBRGHx register. Refer to Table 19-4 for counter clock rates to the BRG.

While the ABD sequence takes place, the EUSART state machine is held in Idle. The RCxIF interrupt is set once the fifth rising edge on RXx is detected. The value in the RCREGx needs to be read to clear the RCxIF interrupt. The contents of RCREGx should be discarded.

- **Note 1:** If the WUE bit is set with the ABDEN bit, Auto-Baud Rate Detection will occur on the byte *following* the Break character.
 - 2: It is up to the user to determine that the incoming character baud rate is within the range of the selected BRG clock source. Some combinations of oscillator frequency and EUSART baud rates are not possible due to bit error rates. Overall system timing and communication baud rates must be taken into consideration when using the Auto-Baud Rate Detection feature.

TABLE 19-4: BRG COUNTER CLOCK RATES

BRG16	BRGH	BRG Counter Clock
0	0	Fosc/512
0	1	Fosc/128
1	0	Fosc/128
1	1	Fosc/32

Note: During the ABD sequence, SPBRGx and SPBRGHx are both used as a 16-bit counter, independent of BRG16 setting.

19.1.3.1 ABD and EUSART Transmission

Since the BRG clock is reversed during ABD acquisition, the EUSART transmitter cannot be used during ABD. This means that whenever the ABDEN bit is set, TXREGx cannot be written to. Users should also ensure that ABDEN does not become set during a transmit sequence. Failing to do this may result in unpredictable EUSART operation.

FIGURE 19-1: AUTOMATIC BAUD RATE CALCULATION

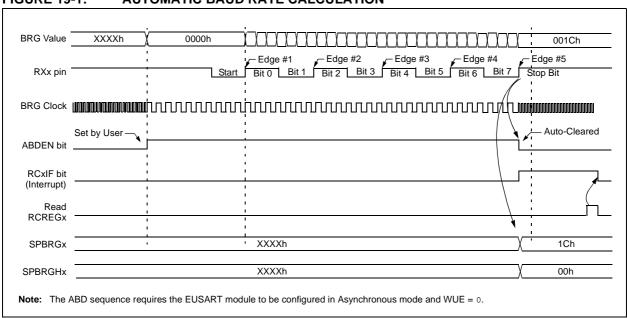
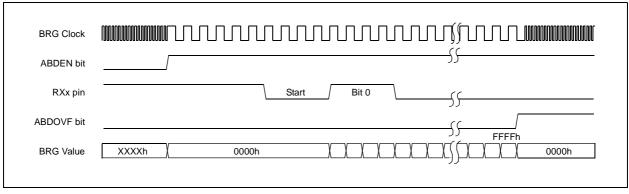


FIGURE 19-2: BRG OVERFLOW SEQUENCE



19.2 EUSART Asynchronous Mode

The Asynchronous mode of operation is selected by clearing the SYNC bit (TXSTAx<4>). In this mode, the EUSART uses standard Non-Return-to-Zero (NRZ) format (one Start bit, eight or nine data bits and one Stop bit). The most common data format is 8 bits. An on-chip dedicated 8-bit/16-bit Baud Rate Generator can be used to derive standard baud rate frequencies from the oscillator.

The EUSART transmits and receives the LSb first. The EUSART's transmitter and receiver are functionally independent but use the same data format and baud rate. The Baud Rate Generator produces a clock, either x16 or x64 of the bit shift rate, depending on the BRGH and BRG16 bits (TXSTAx<2> and BAUDCONx<3>). Parity is not supported by the hardware but can be implemented in software and stored as the 9th data bit.

When operating in Asynchronous mode, the EUSART module consists of the following important elements:

- · Baud Rate Generator
- Sampling Circuit
- · Asynchronous Transmitter
- · Asynchronous Receiver
- · Auto-Wake-up on Sync Break Character
- · 12-bit Break Character Transmit
- · Auto-Baud Rate Detection

19.2.1 EUSART ASYNCHRONOUS TRANSMITTER

The EUSART transmitter block diagram is shown in Figure 19-3. The heart of the transmitter is the Transmit (Serial) Shift Register (TSR). The Shift register obtains its data from the Read/Write Transmit Buffer register, TXREGx. The TXREGx register is loaded with data in software. The TSR register is not loaded until the Stop bit has been transmitted from the previous load. As soon as the Stop bit is transmitted, the TSR is loaded with new data from the TXREGx register (if available).

Once the TXREGx register transfers the data to the TSR register (occurs in one TcY), the TXREGx register is empty and the TX1IF flag bit (PIR1<4>) is set. This interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TX1IE (PIE1<4>). TX1IF will be set regardless of the state of TX1IE; it cannot be cleared in software. TX1IF is also not cleared immediately upon loading TXREGx, but becomes valid in the second instruction cycle following the load instruction. Polling TX1IF immediately following a load of TXREGx will return invalid results.

While TX1IF indicates the status of the TXREGx register, another bit, TRMT (TXSTAx<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR register is empty. No interrupt logic is tied to this bit so the user has to poll this bit in order to determine if the TSR register is empty.

- **Note 1:** The TSR register is not mapped in data memory, so it is not available to the user.
 - **2:** Flag bit TX1IF is set when enable bit TXEN is set.

To set up an Asynchronous Transmission:

- Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- 2. Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- 3. If interrupts are desired, set enable bit TXxIE.
- 4. If 9-bit transmission is desired, set transmit bit TX9. Can be used as address/data bit.
- Enable the transmission by setting bit TXEN which will also set bit TXxIF.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- 7. Load data to the TXREGx register (starts transmission).
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set

FIGURE 19-3: EUSART TRANSMIT BLOCK DIAGRAM

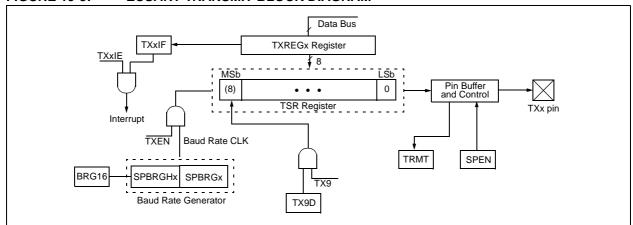


FIGURE 19-4: ASYNCHRONOUS TRANSMISSION

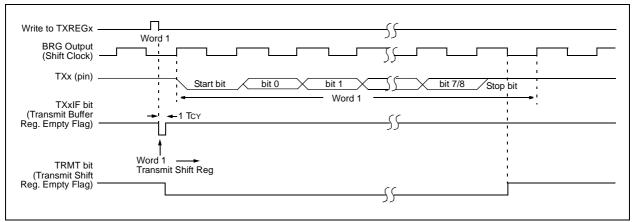


FIGURE 19-5: ASYNCHRONOUS TRANSMISSION (BACK TO BACK)

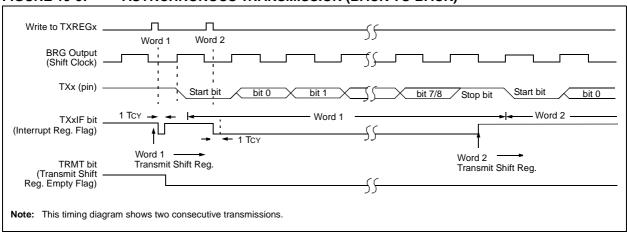


TABLE 19-5: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
RCSTAx	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	51
TXREGx	EUSARTx	Transmit Re	gister						51
TXSTAx	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	51
BAUDCONx	ABDOVF	ABDOVF RCMT — SCKP BRG16 — WUE ABDEN							
SPBRGHx	EUSARTx Baud Rate Generator Register High Byte								
SPBRGx	EUSARTx	Baud Rate (Generator R	egister Low	Byte				52

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous transmission.

19.2.2 EUSART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 19-6. The data is received on the RXx pin and drives the data recovery block. The data recovery block is actually a high-speed shifter operating at x16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at Fosc. This mode would typically be used in RS-232 systems.

To set up an Asynchronous Reception:

- Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- 2. Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- 3. If interrupts are desired, set enable bit RCxIE.
- 4. If 9-bit reception is desired, set bit RX9.
- 5. Enable the reception by setting bit CREN.
- Flag bit, RCxIF, will be set when reception is complete and an interrupt will be generated if enable bit, RCxIE, was set.
- 7. Read the RCSTAx register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- 8. Read the 8-bit received data by reading the RCREGx register.
- If any error occurred, clear the error by clearing enable bit CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

19.2.3 SETTING UP 9-BIT MODE WITH ADDRESS DETECT

This mode would typically be used in RS-485 systems. To set up an Asynchronous Reception with Address Detect Enable:

- Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRGH and BRG16 bits, as required, to achieve the desired baud rate.
- 2. Enable the asynchronous serial port by clearing the SYNC bit and setting the SPEN bit.
- If interrupts are required, set the RCEN bit and select the desired priority level with the RCxIP bit.
- 4. Set the RX9 bit to enable 9-bit reception.
- 5. Set the ADDEN bit to enable address detect.
- 6. Enable reception by setting the CREN bit.
- The RCxIF bit will be set when reception is complete. The interrupt will be Acknowledged if the RCxIE and GIE bits are set.
- 8. Read the RCSTAx register to determine if any error occurred during reception, as well as read bit 9 of data (if applicable).
- 9. Read RCREGx to determine if the device is being addressed.
- 10. If any error occurred, clear the CREN bit.
- 11. If the device has been addressed, clear the ADDEN bit to allow all received data into the receive buffer and interrupt the CPU.

FIGURE 19-6: EUSART RECEIVE BLOCK DIAGRAM

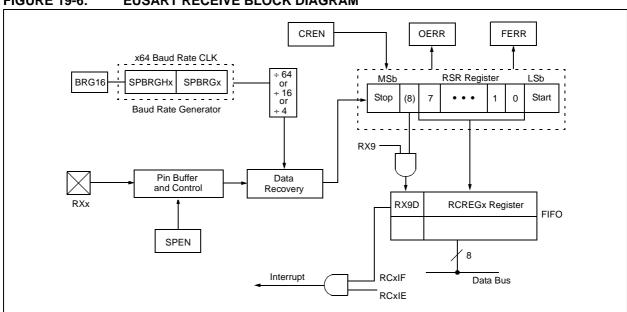


FIGURE 19-7: ASYNCHRONOUS RECEPTION

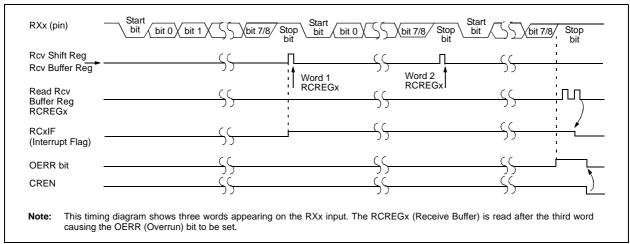


TABLE 19-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
RCSTAx	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	51
RCREGx	EUSARTx	Receive Reg	ister						51
TXSTAx	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	51
BAUDCONx	ABDOVF	RCMT	_	SCKP	BRG16	_	WUE	ABDEN	52
SPBRGHx	EUSARTx Baud Rate Generator Register High Byte								
SPBRGx	EUSARTx	Baud Rate G	enerator Re	egister Low	Byte				52

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous reception.

19.2.4 AUTO-WAKE-UP ON SYNC BREAK CHARACTER

During Sleep mode, all clocks to the EUSART are suspended. Because of this, the Baud Rate Generator is inactive and a proper byte reception cannot be performed. The auto-wake-up feature allows the controller to wake-up due to activity on the RXx/DTx line while the EUSART is operating in Asynchronous mode.

The auto-wake-up feature is enabled by setting the WUE bit (BAUDCONx<1>). Once set, the typical receive sequence on RXx/DTx is disabled and the EUSART remains in an Idle state, monitoring for a wake-up event independent of the CPU mode. A wake-up event consists of a high-to-low transition on

the RXx/DTx line. (This coincides with the start of a Sync Break or a Wake-up Signal character for the LIN protocol.)

Following a wake-up event, the module generates an RCxIF interrupt. The interrupt is generated synchronously to the Q clocks in normal operating modes (Figure 19-8) and asynchronously if the device is in Sleep mode (Figure 19-9). The interrupt condition is cleared by reading the RCREGx register.

The WUE bit is automatically cleared once a low-to-high transition is observed on the RXx line following the wake-up event. At this point, the EUSART module is in Idle mode and returns to normal operation. This signals to the user that the Sync Break event is over.

19.2.4.1 Special Considerations Using Auto-Wake-up

Since auto-wake-up functions by sensing rising edge transitions on RXx/DTx, information with any state changes before the Stop bit may signal a false end-of-character and cause data or framing errors. To work properly, therefore, the initial character in the transmission must be all '0's. This can be 00h (8 bytes) for standard RS-232 devices or 000h (12 bits) for LIN bus.

Oscillator start-up time must also be considered, especially in applications using oscillators with longer start-up intervals (i.e., HS or HSPLL mode). The Sync Break (or Wake-up Signal) character must be of sufficient length and be followed by a sufficient interval to allow enough time for the selected oscillator to start and provide proper initialization of the EUSART.

19.2.4.2 Special Considerations Using the WUE Bit

The timing of WUE and RCxIF events may cause some confusion when it comes to determining the validity of received data. As noted, setting the WUE bit places the EUSART in an Idle mode. The wake-up event causes a receive interrupt by setting the RCxIF bit. The WUE bit is cleared after this when a rising edge is seen on RXx/DTx. The interrupt condition is then cleared by reading the RCREGx register. Ordinarily, the data in RCREGx will be dummy data and should be discarded.

The fact that the WUE bit has been cleared (or is still set) and the RCxIF flag is set should not be used as an indicator of the integrity of the data in RCREGx. Users should consider implementing a parallel method in firmware to verify received data integrity.

To assure that no actual data is lost, check the RCMT bit to verify that a receive operation is not in process. If a receive operation is not occurring, the WUE bit may then be set just prior to entering the Sleep mode.

FIGURE 19-8: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING NORMAL OPERATION

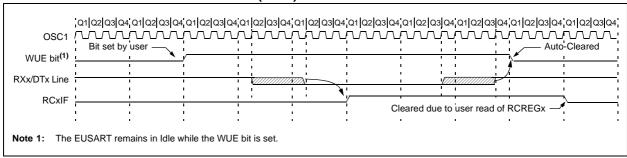
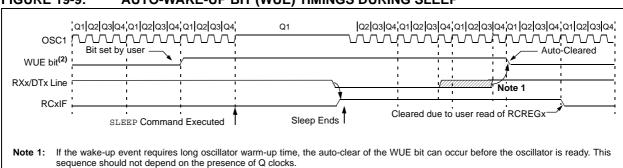


FIGURE 19-9: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING SLEEP

2: The EUSART remains in Idle while the WUE bit is set.



19.2.5 BREAK CHARACTER SEQUENCE

The EUSART module has the capability of sending the special Break character sequences that are required by the LIN bus standard. The Break character transmit consists of a Start bit, followed by twelve '0' bits and a Stop bit. The Frame Break character is sent whenever the SENDB and TXEN bits (TXSTAx<3> and TXSTAx<5>) are set while the Transmit Shift Register is loaded with data. Note that the value of data written to TXREGx will be ignored and all '0's will be transmitted.

The SENDB bit is automatically reset by hardware after the corresponding Stop bit is sent. This allows the user to preload the transmit FIFO with the next transmit byte following the Break character (typically, the Sync character in the LIN specification).

Note that the data value written to the TXREGx for the Break character is ignored. The write simply serves the purpose of initiating the proper sequence.

The TRMT bit indicates when the transmit operation is active or Idle, just as it does during normal transmission. See Figure 19-10 for the timing of the Break character sequence.

19.2.5.1 Break and Sync Transmit Sequence

The following sequence will send a message frame header made up of a Break, followed by an Auto-Baud Sync byte. This sequence is typical of a LIN bus master.

- 1. Configure the EUSART for the desired mode.
- Set the TXEN and SENDB bits to set up the Break character.
- 3. Load the TXREGx with a dummy character to initiate transmission (the value is ignored).
- Write '55h' to TXREGx to load the Sync character into the transmit FIFO buffer.
- After the Break has been sent, the SENDB bit is reset by hardware. The Sync character now transmits in the preconfigured mode.

When the TXREGx becomes empty, as indicated by the TXxIF, the next data byte can be written to TXREGx.

19.2.6 RECEIVING A BREAK CHARACTER

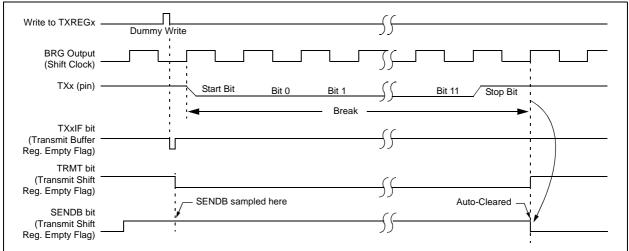
The Enhanced USART module can receive a Break character in two ways.

The first method forces configuration of the baud rate at a frequency of 9/13 the typical speed. This allows for the Stop bit transition to be at the correct sampling location (13 bits for Break versus Start bit and 8 data bits for typical data).

The second method uses the auto-wake-up feature described in **Section 19.2.4** "Auto-Wake-up on Sync Break Character". By enabling this feature, the EUSART will sample the next two transitions on RXx/DTx, cause an RCxIF interrupt and receive the next data byte followed by another interrupt.

Note that following a Break character, the user will typically want to enable the Auto-Baud Rate Detect feature. For both methods, the user can set the ABDEN bit once the TXxIF interrupt is observed.

FIGURE 19-10: SEND BREAK CHARACTER SEQUENCE



19.3 EUSART Synchronous Master Mode

The Synchronous Master mode is entered by setting the CSRC bit (TXSTAx<7>). In this mode, the data is transmitted in a half-duplex manner (i.e., transmission and reception do not occur at the same time). When transmitting data, the reception is inhibited and vice versa. Synchronous mode is entered by setting bit SYNC (TXSTAx<4>). In addition, enable bit SPEN (RCSTAx<7>) is set in order to configure the TXx and RXx pins to CKx (clock) and DTx (data) lines, respectively.

The Master mode indicates that the processor transmits the master clock on the CKx line. Clock polarity is selected with the SCKP bit (BAUDCONx<4>); setting SCKP sets the Idle state on CKx as high, while clearing the bit sets the Idle state as low. This option is provided to support Microwire devices with this module.

19.3.1 EUSART SYNCHRONOUS MASTER TRANSMISSION

The EUSART transmitter block diagram is shown in Figure 19-3. The heart of the transmitter is the Transmit (Serial) Shift Register (TSR). The Shift register obtains its data from the Read/Write Transmit Buffer register, TXREGx. The TXREGx register is loaded with data in software. The TSR register is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR is loaded with new data from the TXREGx (if available).

Once the TXREGx register transfers the data to the TSR register (occurs in one TcY), the TXREGx is empty and the TX1IF flag bit (PIR1<4>) is set. The interrupt can be enabled or disabled by setting or clearing the interrupt enable bit, TX1IE (PIE1<4>). TX1IF is set regardless of the state of enable bit TX1IE; it cannot be cleared in software. It will reset only when new data is loaded into the TXREGx register.

While flag bit TX1IF indicates the status of the TXREGx register, another bit, TRMT (TXSTAx<1>), shows the status of the TSR register. TRMT is a read-only bit which is set when the TSR is empty. No interrupt logic is tied to this bit, so the user must poll this bit in order to determine if the TSR register is empty. The TSR is not mapped in data memory so it is not available to the user.

To set up a Synchronous Master Transmission:

- Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
- Enable the synchronous master serial port by setting bits SYNC, SPEN and CSRC.
- 3. If interrupts are desired, set enable bit TXxIE.
- 4. If 9-bit transmission is desired, set bit TX9.
- 5. Enable the transmission by setting bit TXEN.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- 7. Start transmission by loading data to the TXREGx register.
- 8. If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 19-11: SYNCHRONOUS TRANSMISSION

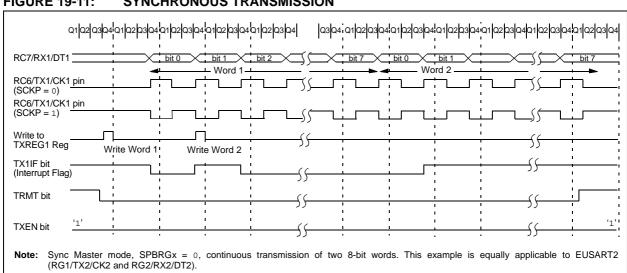


FIGURE 19-12: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)

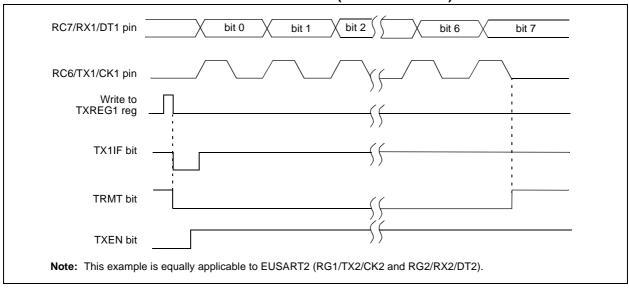


TABLE 19-7: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
RCSTAx	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	51
TXREGx	EUSARTx	Transmit Re	gister						51
TXSTAx	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	51
BAUDCONx	ABDOVF	ABDOVF RCMT — SCKP BRG16 — WUE ABDEN							
SPBRGHx	EUSARTx Baud Rate Generator Register High Byte								
SPBRGx	EUSARTx	Baud Rate C	Generator R	egister Low	Byte		•		52

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master transmission.

19.3.2 EUSART SYNCHRONOUS MASTER RECEPTION

Once Synchronous mode is selected, reception is enabled by setting either the Single Receive Enable bit, SREN (RCSTAx<5>) or the Continuous Receive Enable bit, CREN (RCSTAx<4>). Data is sampled on the RXx pin on the falling edge of the clock.

If enable bit SREN is set, only a single word is received. If enable bit CREN is set, the reception is continuous until CREN is cleared. If both bits are set, then CREN takes precedence.

To set up a Synchronous Master Reception:

- Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
- 2. Enable the synchronous master serial port by setting bits SYNC, SPEN and CSRC.
- 3. Ensure bits CREN and SREN are clear.

- 4. If interrupts are desired, set enable bit RCxIE.
- 5. If 9-bit reception is desired, set bit RX9.
- 6. If a single reception is required, set bit SREN. For continuous reception, set bit CREN.
- Interrupt flag bit, RCxIF, will be set when reception is complete and an interrupt will be generated if the enable bit, RCxIE, was set.
- Read the RCSTAx register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREGx register.
- If any error occurred, clear the error by clearing bit CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set



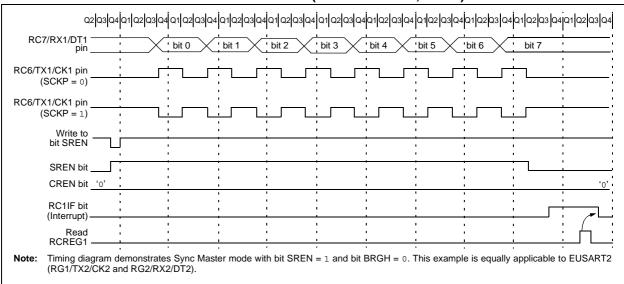


TABLE 19-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
RCSTAx	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	51
RCREGx	EUSARTx I	Receive Reg	gister						51
TXSTAx	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	51
BAUDCONx	ABDOVF	RCMT		SCKP	BRG16	_	WUE	ABDEN	52
SPBRGHx	EUSARTx Baud Rate Generator Register High Byte								
SPBRGx	EUSARTx I	Baud Rate G	Senerator Re	egister Low	Byte	·	·	·	52

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous master reception.

19.4 EUSART Synchronous Slave Mode

Synchronous Slave mode is entered by clearing bit, CSRC (TXSTAx<7>). This mode differs from the Synchronous Master mode in that the shift clock is supplied externally at the CKx pin (instead of being supplied internally in Master mode). This allows the device to transfer or receive data while in any low-power mode.

19.4.1 EUSART SYNCHRONOUS SLAVE TRANSMISSION

The operation of the Synchronous Master and Slave modes is identical, except in the case of Sleep mode.

If two words are written to the TXREGx and then the SLEEP instruction is executed, the following will occur:

- The first word will immediately transfer to the TSR register and transmit.
- The second word will remain in the TXREGx register.
- c) Flag bit, TXxIF, will not be set.
- d) When the first word has been shifted out of TSR, the TXREGx register will transfer the second word to the TSR and flag bit, TXxIF, will now be set.
- e) If enable bit TXxIE is set, the interrupt will wake the chip from Sleep. If the global interrupt is enabled, the program will branch to the interrupt vector.

To set up a Synchronous Slave Transmission:

- Enable the synchronous slave serial port by setting bits SYNC and SPEN and clearing bit CSRC.
- 2. Clear bits CREN and SREN.
- 3. If interrupts are desired, set enable bit TXxIE.
- 4. If 9-bit transmission is desired, set bit TX9.
- Enable the transmission by setting enable bit TXEN.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- Start transmission by loading data to the TXREGx register.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

TABLE 19-9: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
RCSTAx	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	51
TXREGx	EUSARTx	Transmit Re	gister						51
TXSTAx	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	51
BAUDCONx	ABDOVF	RCMT		SCKP	BRG16	_	WUE	ABDEN	52
SPBRGHx	EUSARTx Baud Rate Generator Register High Byte								
SPBRGx	EUSARTx	Baud Rate G	Senerator R	egister Low	Byte	•	•	•	52

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave transmission.

19.4.2 EUSART SYNCHRONOUS SLAVE RECEPTION

The operation of the Synchronous Master and Slave modes is identical, except in the case of Sleep, or any Idle mode and bit SREN, which is a "don't care" in Slave mode.

If receive is enabled by setting the CREN bit prior to entering Sleep or any Idle mode, then a word may be received while in this low-power mode. Once the word is received, the RSR register will transfer the data to the RCREGx register; if the RCxIE enable bit is set, the interrupt generated will wake the chip from the low-power mode. If the global interrupt is enabled, the program will branch to the interrupt vector.

To set up a Synchronous Slave Reception:

- Enable the synchronous master serial port by setting bits SYNC and SPEN and clearing bit CSRC.
- 2. If interrupts are desired, set enable bit RCxIE.
- 3. If 9-bit reception is desired, set bit RX9.
- 4. To enable reception, set enable bit CREN.
- Flag bit, RCxIF, will be set when reception is complete. An interrupt will be generated if enable bit, RCxIE, was set.
- Read the RCSTAx register to get the 9th bit (if enabled) and determine if any error occurred during reception.
- 7. Read the 8-bit received data by reading the RCREGx register.
- 8. If any error occurred, clear the error by clearing bit CREN.
- If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

TABLE 19-10: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	TMR4IF	CCP5IF	CCP4IF	CCP3IF	51
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	TMR4IE	CCP5IE	CCP4IE	CCP3IE	51
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	TMR4IP	CCP5IP	CCP4IP	CCP3IP	51
RCSTAx	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	51
RCREGx	EUSARTx	Receive Rec	gister						51
TXSTAx	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	51
BAUDCONx	ABDOVF	RCMT	_	SCKP	BRG16	_	WUE	ABDEN	52
SPBRGHx	EUSARTx Baud Rate Generator Register High Byte								
SPBRGx	EUSARTx	Baud Rate C	Senerator R	egister Low	Byte				52

Legend: — = unimplemented, read as '0'. Shaded cells are not used for synchronous slave reception.

20.0 10-BIT ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The analog-to-digital (A/D) converter module has 11 inputs for the 64-pin devices and 15 for the 80-pin devices. This module allows conversion of an analog input signal to a corresponding 10-bit digital number.

The module has five registers:

- A/D Result High Register (ADRESH)
- A/D Result Low Register (ADRESL)
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)
- A/D Control Register 2 (ADCON2)

The ADCON0 register, shown in Register 20-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 20-2, configures the functions of the port pins. The ADCON2 register, shown in Register 20-3, configures the A/D clock source, programmed acquisition time and justification.

REGISTER 20-1: ADCON0: A/D CONTROL REGISTER 0

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADCAL	_	CHS3	CHS2	CHS1	CHS0	GO/DONE	ADON
hit 7							hit 0

bit 7-6 ADCAL: A/D Calibration bit

1 = Calibration is performed on next A/D conversion

0 = Normal A/D converter operation (no conversion is performed)

bit 6 Unimplemented: Read as '0'

bit 5-2 CHS3:CHS0: Analog Channel Select bits

0000 = Channel 00 (AN0)

0001 = Channel 01 (AN1)

0010 = Channel 02 (AN2)

0011 = Channel 03 (AN3)

0100 = Channel 04 (AN4)

0101 = Unused

0110 = Channel 06 (AN6)

0111 = Channel 07 (AN7)

1000 = Channel 08 (AN8)

1001 = Channel 09 (AN9)

1010 = Channel 10 (AN10)

1011 = Channel 11 (AN11)

1100 = Channel 12 $(AN12)^{(1,2)}$

1101 = Channel 13 (AN13)(1,2)

1110 = Channel 14 (AN14) $^{(1,2)}$

1111 = Channel 15 (AN15)(1,2)

bit 1 GO/DONE: A/D Conversion Status bit

When ADON = 1:

1 = A/D conversion in progress

0 = A/D Idle

bit 0 ADON: A/D On bit

1 = A/D converter module is enabled

0 = A/D converter module is disabled

Note 1: These channels are not implemented on 64-pin devices.

2: Performing a conversion on unimplemented channels will return random values.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented b	oit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 20-2: ADCON1: A/D CONTROL REGISTER 1

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0

bit 7 bit 0

bit 7-6 Unimplemented: Read as '0'

bit 5 VCFG1: Voltage Reference Configuration bit (VREF- source)

1 = VREF- (AN2)

0 = AVss

bit 4 VCFG0: Voltage Reference Configuration bit (VREF+ source)

1 = VREF+ (AN3)

0 = AVDD

bit 3-0 **PCFG3:PCFG0:** A/D Port Configuration Control bits:

PCFG3: PCFG0	AN15 ⁽¹⁾	AN14 ⁽¹⁾	AN13 ⁽¹⁾	AN12 ⁽¹⁾	AN11	AN10	AN9	AN8	AN7	AN6	AN4	AN3	AN2	AN1	ANO
0000	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0001	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0010	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0011	D	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0100	D	D	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α
0101	D	D	D	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α	Α
0110	D	D	D	D	D	D	D	Α	Α	Α	Α	Α	Α	Α	Α
0111	D	D	D	D	D	D	D	D	Α	Α	Α	Α	Α	Α	Α
1000	D	D	D	D	D	D	D	D	D	Α	Α	Α	Α	Α	Α
1001	D	D	D	D	D	D	D	D	D	D	Α	Α	Α	Α	Α
1010	D	D	D	D	D	D	D	D	D	D	Α	Α	Α	Α	Α
1011	D	D	D	D	D	D	D	D	D	D	D	Α	Α	Α	Α
1100	D	D	D	D	D	D	D	D	D	D	D	D	Α	Α	Α
1101	D	D	D	D	D	D	D	D	D	D	D	D	D	Α	Α
1110	D	D	D	D	D	D	D	D	D	D	D	D	D	D	Α
1111	D	D	D	D	D	D	D	D	D	D	D	D	D	D	D

A = Analog input

D = Digital I/O

Note 1: AN12 through AN15 are available only in 80-pin devices.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 20-3: ADCON2: A/D CONTROL REGISTER 2

1 11 =		•		1	i i		1 '. 0
ADFM	_	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0
R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0

bit 7 bit 0

bit 7 ADFM: A/D Result Format Select bit

1 = Right justified0 = Left justified

bit 6 Unimplemented: Read as '0'

bit 5-3 ACQT2:ACQT0: A/D Acquisition Time Select bits

111 = 20 TAD 110 = 16 TAD 101 = 12 TAD 100 = 8 TAD 011 = 6 TAD 010 = 4 TAD 001 = 2 TAD 000 = 0 TAD⁽¹⁾

bit 2-0 ADCS2:ADCS0: A/D Conversion Clock Select bits

111 = FRC (clock derived from A/D RC oscillator)(1)

110 = Fosc/64 101 = Fosc/16

100 = Fosc/4

011 = FRC (clock derived from A/D RC oscillator)(1)

010 = Fosc/32 001 = Fosc/8

000 = Fosc/2

Note 1: If the A/D FRC clock source is selected, a delay of one TcY (instruction cycle) is added before the A/D clock starts. This allows the SLEEP instruction to be executed before starting a conversion.

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

The analog reference voltage is software selectable to either the device's positive and negative supply voltage (AVDD and AVSS), or the voltage level on the RA3/AN3/VREF+ and RA2/AN2/VREF- pins.

The A/D converter has a unique feature of being able to operate while the device is in Sleep mode. To operate in Sleep, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

The output of the sample and hold is the input into the converter, which generates the result via successive approximation.

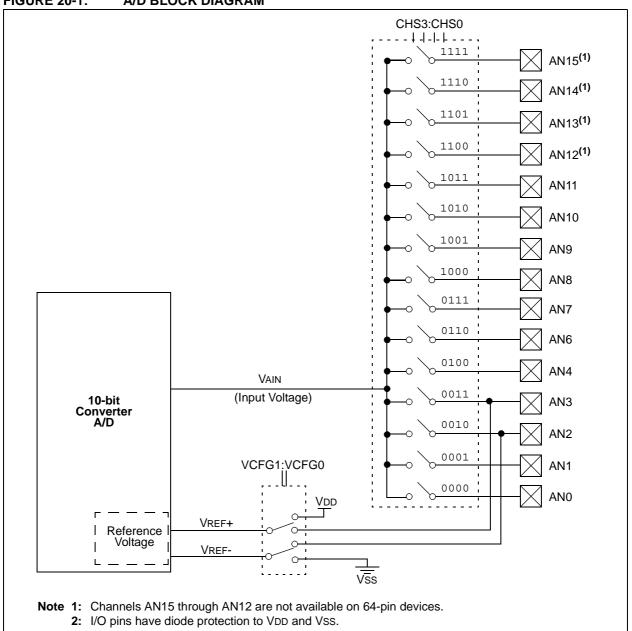
Each port pin associated with the A/D converter can be configured as an analog input or as a digital I/O. The ADRESH and ADRESL registers contain the result of

the A/D conversion. When the A/D conversion is complete, the result is loaded into the ADRESH:ADRESL register pair, the GO/DONE bit (ADCON0<1>) is cleared and A/D Interrupt Flag bit ADIF is set.

A device Reset forces all registers to their Reset state. This forces the A/D module to be turned off and any conversion in progress is aborted. The value in the ADRESH:ADRESL register pair is not modified for a Power-on Reset. These registers will contain unknown data after a Power-on Reset.

The block diagram of the A/D module is shown in Figure 20-1.

FIGURE 20-1: A/D BLOCK DIAGRAM



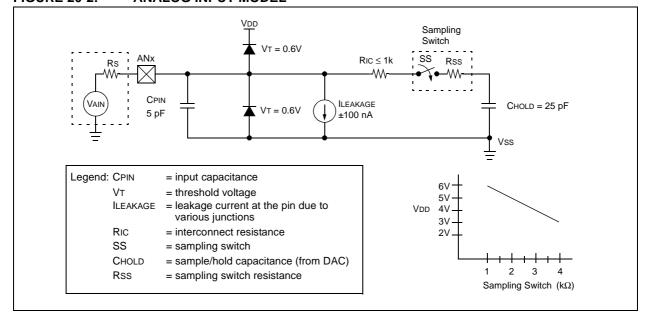
After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see Section 20.1 "A/D Acquisition Requirements". After this acquisition time has elapsed, the A/D conversion can be started. An acquisition time can be programmed to occur between setting the GO/DONE bit and the actual start of the conversion.

The following steps should be followed to do an A/D conversion:

- 1. Configure the A/D module:
 - Configure analog pins, voltage reference and digital I/O (ADCON1)
 - Select A/D input channel (ADCON0)
 - Select A/D acquisition time (ADCON2)
 - Select A/D conversion clock (ADCON2)
 - Turn on A/D module (ADCON0)
- 2. Configure A/D interrupt (if desired):
 - · Clear ADIF bit
 - Set ADIE bit
 - Set GIE bit

- 3. Wait the required acquisition time (if required).
- 4. Start conversion:
 - Set GO/DONE bit (ADCON0<1>)
- 5. Wait for A/D conversion to complete, by either:
 - Polling for the GO/DONE bit to be cleared OR
 - Waiting for the A/D interrupt
- Read A/D Result registers (ADRESH:ADRESL); clear bit ADIF, if required.
- For next conversion, go to step 1 or step 2, as required. The A/D conversion time per bit is defined as TAD. A minimum wait of 2 TAD is required before next acquisition starts.

FIGURE 20-2: ANALOG INPUT MODEL



20.1 A/D Acquisition Requirements

For the A/D converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 20-2. The source impedance (Rs) and the internal sampling switch (Rss) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (Rss) impedance varies over the device voltage (VDD). The source impedance affects the offset voltage at the analog input (due to pin leakage current). The maximum recommended impedance for analog sources is 2.5 k Ω . After the analog input channel is selected (changed), the channel must be sampled for at least the minimum acquisition time before starting a conversion.

Note: When the conversion is started, the holding capacitor is disconnected from the input pin.

To calculate the minimum acquisition time, Equation 20-1 may be used. This equation assumes that 1/2 LSb error is used (1024 steps for the A/D). The 1/2 LSb error is the maximum error allowed for the A/D to meet its specified resolution.

Equation 20-3 shows the calculation of the minimum required acquisition time, TACQ. This calculation is based on the following application system assumptions:

 $\begin{array}{lll} \text{CHOLD} & = & 25 \text{ pF} \\ \text{Rs} & = & 2.5 \text{ k}\Omega \\ \text{Conversion Error} & \leq & 1/2 \text{ LSb} \\ \end{array}$

VDD = $5V \rightarrow Rss = 2 \text{ k}\Omega$ Temperature = 85°C (system max.)

EQUATION 20-1: ACQUISITION TIME

```
TACQ = Amplifier Settling Time + Holding Capacitor Charging Time + Temperature Coefficient
= TAMP + TC + TCOFF
```

EQUATION 20-2: A/D MINIMUM CHARGING TIME

```
\begin{array}{lll} V_{HOLD} & = & (V_{REF} - (V_{REF}/2048)) \bullet (1 - e^{(-T_{C}/C_{HOLD}(R_{IC} + R_{SS} + R_{S}))}) \\ \text{or} \\ T_{C} & = & -(C_{HOLD})(R_{IC} + R_{SS} + R_{S}) \ln(1/2048) \end{array}
```

EQUATION 20-3: CALCULATING THE MINIMUM REQUIRED ACQUISITION TIME

```
TACO
                   TAMP + TC + TCOFF
TAMP
                   0.2 \, \mathrm{Hz}
TCOFF
                   (Temp - 25^{\circ}C)(0.02 \,\mu s/^{\circ}C)
                   (85^{\circ}C - 25^{\circ}C)(0.02 \ \mu s/^{\circ}C)
                   1.2 \mu s
Temperature coefficient is only required for temperatures > 25°C. Below 25°C, TCOFF = 0 ms.
TC
                   -(CHOLD)(RIC + RSS + RS) ln(1/2047) \mu s
                   -(25 pF) (1 k\Omega + 2 k\Omega + 2.5 k\Omega) ln(0.0004883) \mus
                   1.05 \,\mu s
TACO
                   0.2 \mu s + 1 \mu s + 1.2 \mu s
                   2.4 us
```

20.2 Selecting and Configuring Automatic Acquisition Time

The ADCON2 register allows the user to select an acquisition time that occurs each time the GO/DONE bit is set.

When the GO/DONE bit is set, sampling is stopped and a conversion begins. The user is responsible for ensuring the required acquisition time has passed between selecting the desired input channel and setting the GO/DONE bit. This occurs when the ACQT2:ACQT0 bits (ADCON2<5:3>) remain in their Reset state ('000') and is compatible with devices that do not offer programmable acquisition times.

If desired, the ACQT bits can be set to select a programmable acquisition time for the A/D module. When the GO/DONE bit is set, the A/D module continues to sample the input for the selected acquisition time, then automatically begins a conversion. Since the acquisition time is programmed, there may be no need to wait for an acquisition time between selecting a channel and setting the GO/DONE bit.

In either case, when the conversion is completed, the GO/DONE bit is cleared, the ADIF flag is set and the A/D begins sampling the currently selected channel again. If an acquisition time is programmed, there is nothing to indicate if the acquisition time has ended or if the conversion has begun.

20.3 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 11 TAD per 10-bit conversion. The source of the A/D conversion clock is software selectable.

There are seven possible options for TAD:

- 2 Tosc
- 4 Tosc
- 8 Tosc
- 16 Tosc
- 32 Tosc
- 64 Tosc
- · Internal RC Oscillator

For correct A/D conversions, the A/D conversion clock (TAD) must be as short as possible but greater than the minimum TAD (approximately 2 μ s, see parameter 130 for more information).

Table 20-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

TABLE 20-1: TAD vs. DEVICE OPERATING FREQUENCIES

AD Clock S	Source (TAD)	Maximum
Operation	ADCS2:ADCS0	Device Frequency
2 Tosc	000	1.25 MHz
4 Tosc	100	2.50 MHz
8 Tosc	001	5.00 MHz
16 Tosc	101	10.0 MHz
32 Tosc	010	20.0 MHz
64 Tosc	110	40.0 MHz
RC ⁽³⁾	x11	1.00 MHz ⁽¹⁾

- Note 1: The RC source has a typical TAD time of 4 ms.
 - 2: The RC source has a typical TAD time of 6 ms.
 - **3:** For device frequencies above 1 MHz, the device must be in Sleep mode for the entire conversion or the A/D accuracy may be out of specification.

20.4 Configuring Analog Port Pins

The ADCON1, TRISA, TRISF and TRISH registers control the operation of the A/D port pins. The port pins needed as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted

The A/D operation is independent of the state of the CHS3:CHS0 bits and the TRIS bits.

- Note 1: When reading the port register, all pins configured as analog input channels will read as cleared (a low level). Pins configured as digital inputs will convert an analog input. Analog levels on a digitally configured input will be accurately converted.
 - 2: Analog levels on any pin defined as a digital input may cause the digital input buffer to consume current out of the device's specification limits.

20.5 A/D Conversions

Figure 20-3 shows the operation of the A/D converter after the GO/DONE bit has been set and the ACQT2:ACQT0 bits are cleared. A conversion is started after the following instruction to allow entry into Sleep mode before the conversion begins.

Figure 20-4 shows the operation of the A/D converter after the GO/DONE bit has been set, the ACQT2:ACQT0 bits are set to '010' and selecting a 4 TAD acquisition time before the conversion starts.

Clearing the GO/DONE bit during a conversion will abort the current conversion. The A/D Result register pair will NOT be updated with the partially completed A/D conversion sample. This means the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers).

After the A/D conversion is completed or aborted, a 2 TAD wait is required before the next acquisition can be started. After this wait, acquisition on the selected channel is automatically started.

Note: The GO/DONE bit should **NOT** be set in the same instruction that turns on the A/D.

20.6 Use of the ECCP2 Trigger

An A/D conversion can be started by the "Special Event Trigger" of the ECCP2 module. This requires that the CCP2M3:CCP2M0 bits (CCP2CON<3:0>) programmed as '1011' and that the A/D module is enabled (ADON bit is set). When the trigger occurs, the GO/DONE bit will be set, starting the A/D acquisition and conversion and the Timer1 (or Timer3) counter will be reset to zero. Timer1 (or Timer3) is reset to automatically repeat the A/D acquisition period with minimal software overhead (moving ADRESH/ADRESL to the desired location). The appropriate analog input channel must be selected and the minimum acquisition period is either timed by the user, or an appropriate TACQ time is selected before the Special Event Trigger sets the GO/DONE bit (starts a conversion).

If the A/D module is not enabled (ADON is cleared), the Special Event Trigger will be ignored by the A/D module but will still reset the Timer1 (or Timer3) counter.

FIGURE 20-3: A/D CONVERSION TAD CYCLES (ACQT2:ACQT0 = 000, TACQ = 0)

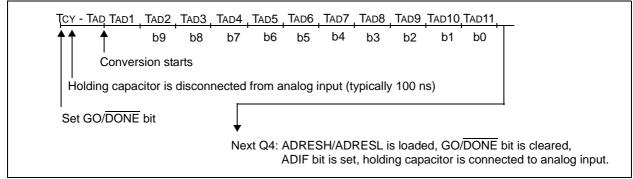
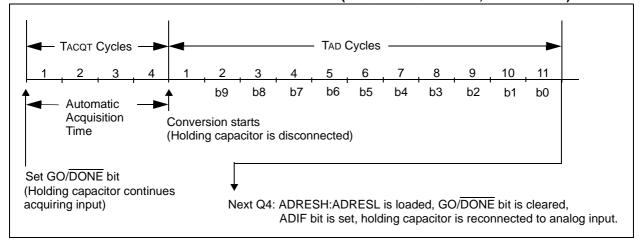


FIGURE 20-4: A/D CONVERSION TAD CYCLES (ACQT2:ACQT0 = 010, TACQ = 4 TAD)



20.7 A/D Converter Calibration

The A/D converter in the PIC18F87J10 family of devices includes a self-calibration feature which compensates for any offset generated within the module. The calibration process is automated and is initiated by setting the ADCAL bit (ADCON0<7>). The next time the GO/DONE bit is set, the module will perform a "dummy" conversion (that is, with reading none of the input channels) and store the resulting value internally to compensate for offset. Thus, subsequent offsets will be compensated.

The calibration process assumes that the device is in a relatively steady-state operating condition. If A/D calibration is used, it should be performed after each device Reset or if there are other major changes in operating conditions.

20.8 Operation in Power-Managed Modes

The selection of the automatic acquisition time and A/D conversion clock is determined in part by the clock source and frequency while in a power-managed mode.

If the A/D is expected to operate while the device is in a power-managed mode, the ACQT2:ACQT0 and ADCS2:ADCS0 bits in ADCON2 should be updated in accordance with the power-managed mode clock that will be used. After the power-managed mode is entered (either of the power-managed Run modes), an A/D acquisition or conversion may be started. Once an acquisition or conversion is started, the device should continue to be clocked by the same power-managed mode clock source until the conversion has been completed. If desired, the device may be placed into the corresponding power-managed Idle mode during the conversion.

If the power-managed mode clock frequency is less than 1 MHz, the A/D RC clock source should be selected.

Operation in the Sleep mode requires the A/D RC clock to be selected. If bits ACQT2:ACQT0 are set to '000' and a conversion is started, the conversion will be delayed one instruction cycle to allow execution of the SLEEP instruction and entry to Sleep mode. The IDLEN and SCS bits in the OSCCON register must have already been cleared prior to starting the conversion.

TABLE 20-2: SUMMARY OF A/D REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page	
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49	
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	51	
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	51	
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	51	
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	TMR3IF	CCP2IF	51	
PIE2	OSCFIE	CMIE	_	_	BCL1IE	_	TMR3IE	CCP2IE	51	
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	TMR3IP	CCP2IP	51	
ADRESH	A/D Result Register High Byte									
ADRESL	A/D Resul	t Register Lo	w Byte						50	
ADCON0	ADCAL	_	CHS3	CHS3	CHS1	CHS0	GO/DONE	ADON	50	
ADCON1	_	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	50	
ADCON2	ADFM	_	ACQT2	ACQT1	ACQT0	ADCS2	ADCS1	ADCS0	50	
CCP2CON	P2M1	P2M0	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	51	
PORTA	_	_	RA5	RA4	RA3	RA2	RA1	RA0	52	
TRISA	_	_	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	52	
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	52	
TRISF	TRISF5	TRISF4	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	52	
PORTH ⁽¹⁾	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	52	
TRISH ⁽¹⁾	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	52	

Legend: — = unimplemented, read as '0'. Shaded cells are not used for A/D conversion.

Note 1: This register is not implemented on 64-pin devices.

NOTES:

21.0 COMPARATOR MODULE

The analog comparator module contains two comparators that can be configured in a variety of ways. The inputs can be selected from the analog inputs multiplexed with pins RF1 through RF6, as well as the on-chip voltage reference (see **Section 22.0** "Comparator Voltage Reference Module"). The digital outputs (normal or inverted) are available at the pin level and can also be read through the control register.

The CMCON register (Register 21-1) selects the comparator input and output configuration. Block diagrams of the various comparator configurations are shown in Figure 21-1.

REGISTER 21-1: CMCON: COMPARATOR MODULE CONTROL REGISTER

R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-1	R/W-1	R/W-1
C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0
bit 7							bit 0

bit 7 C2OUT: Comparator 2 Output bit

When C2INV = 0:

1 = C2 VIN+ > C2 VIN-

0 = C2 VIN+ < C2 VIN-

When C2INV = 1:

1 = C2 VIN+ < C2 VIN-

0 = C2 VIN+ > C2 VIN-

bit 6 C10UT: Comparator 1 Output bit

When C1INV = 0:

1 = C1 VIN+ > C1 VIN-

0 = C1 VIN+ < C1 VIN-

When C1INV = 1:

1 = C1 VIN+ < C1 VIN-

0 = C1 VIN+ > C1 VIN-

bit 5 C2INV: Comparator 2 Output Inversion bit

1 = C2 output inverted

0 = C2 output not inverted

bit 4 C1INV: Comparator 1 Output Inversion bit

1 = C1 output inverted

0 = C1 output not inverted

bit 3 CIS: Comparator Input Switch bit

When CM2:CM0 = 110:

1 = C1 Vin- connects to RF5/AN10/CVREF

C2 VIN- connects to RF3/AN8

0 = C1 VIN- connects to RF6/AN11

C2 VIN- connects to RF4/AN9

bit 2-0 CM2:CM0: Comparator Mode bits

Figure 21-1 shows the Comparator modes and the CM2:CM0 bit settings.

Legend	:
--------	---

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

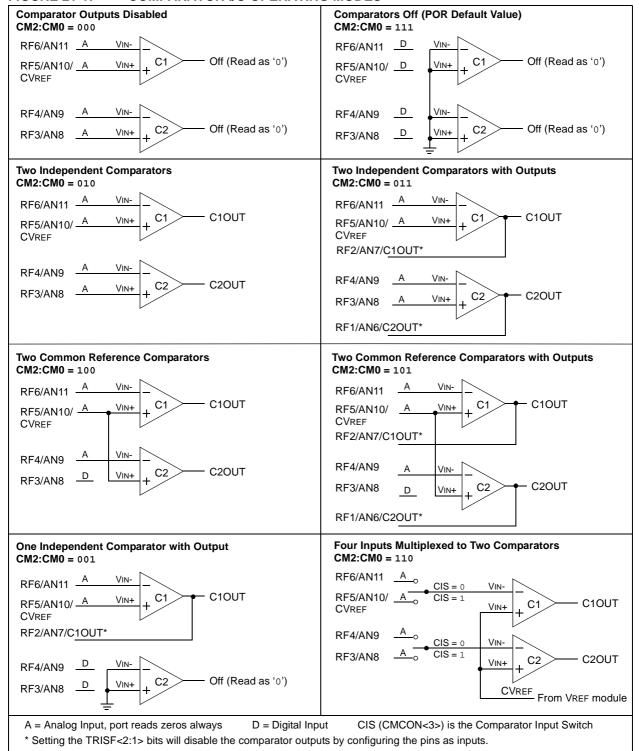
21.1 Comparator Configuration

There are eight modes of operation for the comparators, shown in Figure 21-1. Bits CM2:CM0 of the CMCON register are used to select these modes. The TRISF register controls the data direction of the comparator pins for each mode. If the Comparator

mode is changed, the comparator output level may not be valid for the specified mode change delay shown in **Section 26.0 "Electrical Characteristics"**.

Note: Comparator interrupts should be disabled during a Comparator mode change; otherwise, a false interrupt may occur.

FIGURE 21-1: COMPARATOR I/O OPERATING MODES



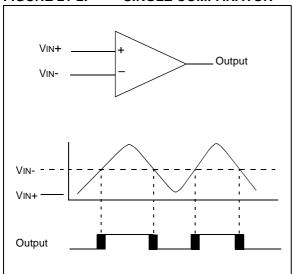
21.2 Comparator Operation

A single comparator is shown in Figure 21-2, along with the relationship between the analog input levels and the digital output. When the analog input at VIN+ is less than the analog input VIN-, the output of the comparator is a digital low level. When the analog input at VIN+ is greater than the analog input VIN-, the output of the comparator is a digital high level. The shaded areas of the output of the comparator in Figure 21-2 represent the uncertainty due to input offsets and response time.

21.3 Comparator Reference

Depending on the comparator operating mode, either an external or internal voltage reference may be used. The analog signal present at VIN- is compared to the signal at VIN+ and the digital output of the comparator is adjusted accordingly (Figure 21-2).

FIGURE 21-2: SINGLE COMPARATOR



21.3.1 EXTERNAL REFERENCE SIGNAL

When external voltage references are used, the comparator module can be configured to have the comparators operate from the same or different reference sources. However, threshold detector applications may require the same reference. The reference signal must be between VSS and VDD and can be applied to either pin of the comparator(s).

21.3.2 INTERNAL REFERENCE SIGNAL

The comparator module also allows the selection of an internally generated voltage reference from the comparator voltage reference module. This module is described in more detail in Section 22.0 "Comparator Voltage Reference Module".

The internal reference is only available in the mode where four inputs are multiplexed to two comparators (CM2:CM0 = 110). In this mode, the internal voltage reference is applied to the VIN+ pin of both comparators.

21.4 Comparator Response Time

Response time is the minimum time, after selecting a new reference voltage or input source, before the comparator output has a valid level. If the internal reference is changed, the maximum delay of the internal voltage reference must be considered when using the comparator outputs. Otherwise, the maximum delay of the comparators should be used (see **Section 26.0** "Electrical Characteristics").

21.5 Comparator Outputs

The comparator outputs are read through the CMCON register. These bits are read-only. The comparator outputs may also be directly output to the RF1 and RF2 I/O pins. When enabled, multiplexors in the output path of the RF1 and RF2 pins will switch and the output of each pin will be the unsynchronized output of the comparator. The uncertainty of each of the comparators is related to the input offset voltage and the response time given in the specifications. Figure 21-3 shows the comparator output block diagram.

The TRISF bits will still function as an output enable/ disable for the RF1 and RF2 pins while in this mode.

The polarity of the comparator outputs can be changed using the C2INV and C1INV bits (CMCON<5:4>).

- Note 1: When reading the port register, all pins configured as analog inputs will read as a '0'. Pins configured as digital inputs will convert an analog input according to the Schmitt Trigger input specification.
 - 2: Analog levels on any pin defined as a digital input may cause the input buffer to consume more current than is specified.

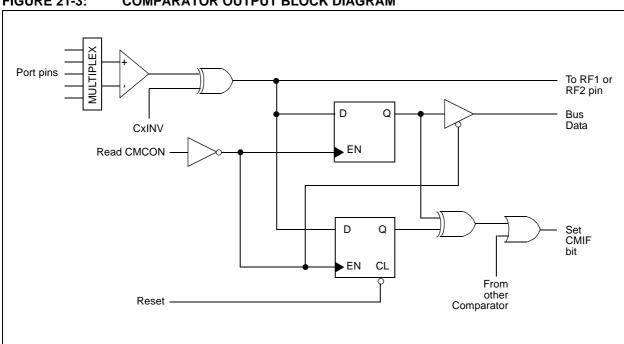


FIGURE 21-3: COMPARATOR OUTPUT BLOCK DIAGRAM

21.6 **Comparator Interrupts**

The comparator interrupt flag is set whenever there is a change in the output value of either comparator. Software will need to maintain information about the status of the output bits, as read from CMCON<7:6>, to determine the actual change that occurred. The CMIF bit (PIR2<6>) is the Comparator Interrupt Flag. The CMIF bit must be reset by clearing it. Since it is also possible to write a '1' to this register, a simulated interrupt may be initiated.

Both the CMIE bit (PIE2<6>) and the PEIE bit (INTCON<6>) must be set to enable the interrupt. In addition, the GIE bit (INTCON<7>) must also be set. If any of these bits are clear, the interrupt is not enabled, though the CMIF bit will still be set if an interrupt condition occurs.

If a change in the CMCON register Note: (C1OUT or C2OUT) should occur when a read operation is being executed (start of the Q2 cycle), then the CMIF (PIR2 register) interrupt flag may not get set.

The user, in the Interrupt Service Routine, can clear the interrupt in the following manner:

- Any read or write of CMCON will end the mismatch condition.
- Clear flag bit CMIF. b)

A mismatch condition will continue to set flag bit CMIF. Reading CMCON will end the mismatch condition and allow flag bit CMIF to be cleared.

21.7 **Comparator Operation During Sleep**

When a comparator is active and the device is placed in Sleep mode, the comparator remains active and the interrupt is functional, if enabled. This interrupt will wake-up the device from Sleep mode, when enabled. Each operational comparator will consume additional current, as shown in the comparator specifications. To minimize power consumption while in Sleep mode, turn off the comparators (CM2:CM0 = 111) before entering Sleep. If the device wakes up from Sleep, the contents of the CMCON register are not affected.

21.8 Effects of a Reset

A device Reset forces the CMCON register to its Reset state, causing the comparator modules to be turned off (CM2:CM0 = 111). However, the input pins (RF3 through RF6) are configured as analog inputs by default on device Reset. The I/O configuration for these pins is determined by the setting of the PCFG3:PCFG0 bits (ADCON1<3:0>). Therefore, device current is minimized when analog inputs are present at Reset time.

21.9 Analog Input Connection Considerations

A simplified circuit for an analog input is shown in Figure 21-4. Since the analog pins are connected to a digital output, they have reverse biased diodes to VDD and Vss. The analog input, therefore, must be between Vss and VDD. If the input voltage deviates from this

range by more than 0.6V in either direction, one of the diodes is forward biased and a latch-up condition may occur. A maximum source impedance of 10 k Ω is recommended for the analog sources. Any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current.

FIGURE 21-4: COMPARATOR ANALOG INPUT MODEL

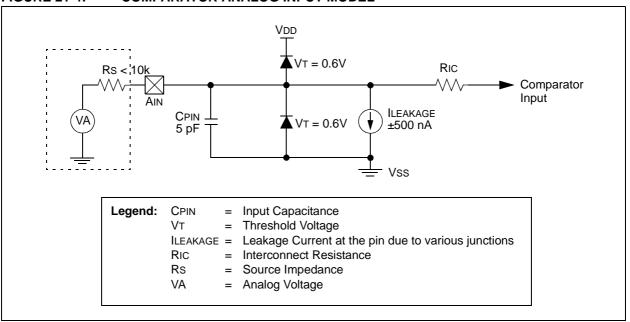


TABLE 21-1: REGISTERS ASSOCIATED WITH COMPARATOR MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page			
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	49			
PIR2	OSCFIF	CMIF	_	_	BCL1IF	_	TMR3IF	CCP2IF	51			
PIE2	OSCFIE	CMIE	_	_	BCL1IE	_	TMR3IE	CCP2IE	51			
IPR2	OSCFIP	CMIP	_	_	BCL1IP	_	TMR3IP	CCP2IP	51			
CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	51			
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	51			
PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	52			
LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	_	52			
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	52			

Legend: — = unimplemented, read as '0'. Shaded cells are unused by the comparator module.

NOTES:

22.0 COMPARATOR VOLTAGE REFERENCE MODULE

The comparator voltage reference is a 16-tap resistor ladder network that provides a selectable reference voltage. Although its primary purpose is to provide a reference for the analog comparators, it may also be used independently of them.

A block diagram of the module is shown in Figure 22-1. The resistor ladder is segmented to provide two ranges of CVREF values and has a power-down function to conserve power when the reference is not being used. The module's supply reference can be provided from either device VDD/VSS or an external voltage reference.

22.1 Configuring the Comparator Voltage Reference

The voltage reference module is controlled through the CVRCON register (Register 22-1). The comparator voltage reference provides two ranges of output voltage, each with 16 distinct levels. The range to be used

is selected by the CVRR bit (CVRCON<5>). The primary difference between the ranges is the size of the steps selected by the CVREF Selection bits (CVR3:CVR0), with one range offering finer resolution. The equations used to calculate the output of the comparator voltage reference are as follows:

If CVRR = 1:
CVREF = ((CVR3:CVR0)/24) x (CVRSRC)

If CVRR = 0:
CVREF = (CVRSRC/4) + ((CVR3:CVR0)/32) x
(CVRSRC)

The comparator reference supply voltage can come from either VDD and Vss, or the external VREF+ and VREF- that are multiplexed with RA2 and RA3. The voltage source is selected by the CVRSS bit (CVRCON<4>).

The settling time of the comparator voltage reference must be considered when changing the CVREF output (see Table 26-3 in **Section 26.0 "Electrical Characteristics"**).

REGISTER 22-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

CVREN CVROE ⁽¹⁾ CVRR CVRSS CVR3 CVR2 CVR1 CVR0		CVREN	CVROE ⁽¹⁾	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0
---	--	-------	----------------------	------	-------	------	------	------	------

bit 7 CVREN: Comparator Voltage Reference Enable bit

1 = CVREF circuit powered on

0 = CVREF circuit powered down

bit 6 CVROE: Comparator VREF Output Enable bit(1)

1 = CVREF voltage level is also output on the RF5/AN10/CVREF pin

0 = CVREF voltage is disconnected from the RF5/AN10/CVREF pin

Note 1: CVROE overrides the TRISF<5> bit setting.

bit 5 CVRR: Comparator VREF Range Selection bit

1 = 0 to 0.667 CVRSRC, with CVRSRC/24 step size (low range)

0 = 0.25 CVRSRC to 0.75 CVRSRC, with CVRSRC/32 step size (high range)

bit 4 CVRSS: Comparator VREF Source Selection bit

1 = Comparator reference source, CVRSRC = (VREF+) - (VREF-)

0 = Comparator reference source, CVRSRC = VDD - VSS

bit 3-0 **CVR3:CVR0:** Comparator VREF Value Selection bits $(0 \le (CVR3:CVR0) \le 15)$

When CVRR = 1:

CVREF = ((CVR3:CVR0)/24) • (CVRSRC)

When CVRR = 0:

CVREF = (CVRSRC/4) + ((CVR3:CVR0)/32) • (CVRSRC)

Legend:	
---------	--

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

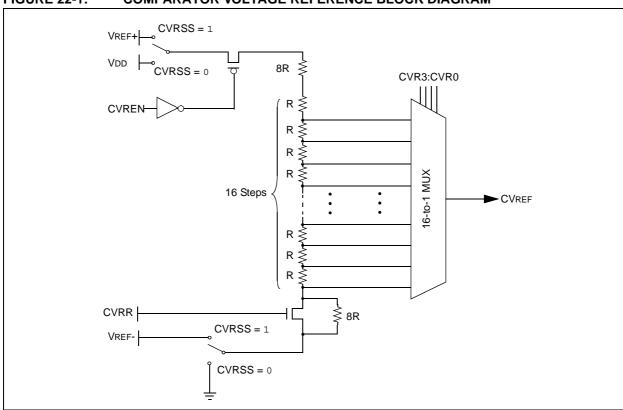


FIGURE 22-1: COMPARATOR VOLTAGE REFERENCE BLOCK DIAGRAM

22.2 Voltage Reference Accuracy/Error

The full range of voltage reference cannot be realized due to the construction of the module. The transistors on the top and bottom of the resistor ladder network (Figure 22-1) keep CVREF from approaching the reference source rails. The voltage reference is derived from the reference source; therefore, the CVREF output changes with fluctuations in that source. The tested absolute accuracy of the voltage reference can be found in **Section 26.0** "Electrical Characteristics".

22.3 Operation During Sleep

When the device wakes up from Sleep through an interrupt or a Watchdog Timer time-out, the contents of the CVRCON register are not affected. To minimize current consumption in Sleep mode, the voltage reference should be disabled.

22.4 Effects of a Reset

A device Reset disables the voltage reference by clearing bit, CVREN (CVRCON<7>). This Reset also disconnects the reference from the RA2 pin by clearing bit, CVROE (CVRCON<6>) and selects the high-voltage range by clearing bit, CVRR (CVRCON<5>). The CVR value select bits are also cleared.

22.5 Connection Considerations

The voltage reference module operates independently of the comparator module. The output of the reference generator may be connected to the RF5 pin if the CVROE bit is set. Enabling the voltage reference output onto RA2 when it is configured as a digital input will increase current consumption. Connecting RF5 as a digital output with CVRSS enabled will also increase current consumption.

The RF5 pin can be used as a simple D/A output with limited drive capability. Due to the limited current drive capability, a buffer must be used on the voltage reference output for external connections to VREF. Figure 22-2 shows an example buffering technique.

FIGURE 22-2: COMPARATOR VOLTAGE REFERENCE OUTPUT BUFFER EXAMPLE

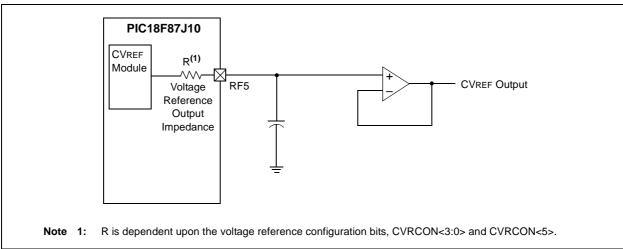


TABLE 22-1: REGISTERS ASSOCIATED WITH COMPARATOR VOLTAGE REFERENCE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
CVRCON	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	51
CMCON	C2OUT	C1OUT	C2INV	C1INV	CIS	CM2	CM1	CM0	51
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	52

Legend: — = unimplemented, read as '0'. Shaded cells are not used with the comparator voltage reference.

NOTES:

23.0 SPECIAL FEATURES OF THE CPU

PIC18F87J10 family devices include several features intended to maximize reliability and minimize cost through elimination of external components. These are:

- · Oscillator Selection
- · Resets:
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
 - Brown-out Reset (BOR)
- Interrupts
- · Watchdog Timer (WDT)
- · Fail-Safe Clock Monitor
- · Two-Speed Start-up
- Code Protection
- In-Circuit Serial Programming

The oscillator can be configured for the application depending on frequency, power, accuracy and cost. All of the options are discussed in detail in **Section 2.0** "Oscillator Configurations".

A complete discussion of device Resets and interrupts is available in previous sections of this data sheet.

In addition to their Power-up and Oscillator Start-up Timers provided for Resets, the PIC18F87J10 family of devices have a configurable Watchdog Timer which is controlled in software.

The inclusion of an internal RC oscillator also provides the additional benefits of a Fail-Safe Clock Monitor (FSCM) and Two-Speed Start-up. FSCM provides for background monitoring of the peripheral clock and automatic switchover in the event of its failure. Two-Speed Start-up enables code to be executed almost immediately on start-up, while the primary clock source completes its start-up delays.

All of these features are enabled and configured by setting the appropriate Configuration register bits.

23.1 Configuration Bits

The configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped starting at program memory location 300000h. A complete list is shown in Table 23-1. A detailed explanation of the various bit functions is provided in Register 23-1 through Register 23-6.

Note that address 300000h is beyond the user program memory space. In fact, it belongs to the configuration memory space (300000h-3FFFFFh) which can only be accessed using table reads and table writes.

23.1.1 CONSIDERATIONS FOR CONFIGURING THE PIC18F87J10 FAMILY DEVICES

Unlike previous PIC18 microcontrollers, devices of the PIC18F87J10 family do not use persistent memory registers to store configuration information. The configuration bytes are implemented as volatile memory which means that configuration data must be programmed each time the device is powered up.

Configuration data is stored in the four words at the top of the on-chip program memory space, known as the Flash Configuration Words. It is stored in program memory in the same order shown in Table 23-1, with CONFIG1L at the lowest address and CONFIG3H at the highest. The data is automatically loaded in the proper Configuration registers during device power-up.

When creating applications for these devices, users should always specifically allocate the location of the Flash Configuration Word for configuration data; this is to make certain that program code is not stored in this address when the code is compiled.

The volatile memory cells used for the configuration bits always reset to '1' on Power-on Resets. For all other type of Reset events, the previously programmed values are maintained and used without reloading from program memory.

The four Most Significant bits of CONFIG1H, CONFIG2H and CONFIG3H in program memory should also be '1111'. This makes these Configuration Words appear to be NOP instructions in the remote event that their locations are ever executed by accident. Since configuration bits are not implemented in the corresponding locations, writing '1's to these locations has no effect on device operation.

To prevent inadvertent configuration changes during code execution, all programmable configuration bits are write-once. After a bit is initially programmed during a power cycle, it cannot be written to again. Changing a device configuration requires that power to the device be cycled.

TABLE 23-1: CONFIGURATION BITS AND DEVICE IDs

File	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default/ Unprogrammed Value ⁽¹⁾
300000h	CONFIG1L	DEBUG	XINST	STVREN	_	_	_	_	WDTEN	1111
300001h	CONFIG1H	(2)	(2)	(2)	(2)	(3)	CP0	_	_	01
300002h	CONFIG2L	IESO	FCMEN	_	_	_	FOSC2	FOSC1	FOSC0	11111
300003h	CONFIG2H	(2)	(2)	(2)	(2)	WDTPS3	WDTPS2	WDTPS1	WDTPS0	1111
300004h	CONFIG3L	WAIT ⁽⁴⁾	BW ⁽⁴⁾	EMB1 ⁽⁴⁾	EMB0 ⁽⁴⁾	EASHFT(4)	_	_	_	1111 1
300005h	CONFIG3H	(2)	(2)	(2)	(2)	_	_	ECCPMX ⁽⁴⁾	CCP2MX	11
3FFFFEh	DEVID1	DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0	XXXX XXXX ⁽⁵⁾
3FFFFFh	DEVID2	DEV10	DEV9	DEV8	DEV7	DEV6	DEV5	DEV4	DEV3	0000 10x1 ⁽⁵⁾

Legend: x = unknown, u = unchanged, - = unimplemented. Shaded cells are unimplemented, read as '0'.

- **Note** 1: Values reflect the unprogrammed state as received from the factory and following Power-on Resets. In all other Reset states, the configuration bytes maintain their previously programmed states.
 - 2: The value of these bits in program memory should always be '1'. This ensures that the location is executed as a NOP if it is accidentally executed.
 - 3: This bit should always be maintained as '0'.
 - 4: Implemented in 80-pin devices only.
 - 5: See Register 23-7 and Register 23-8 for DEVID values. These registers are read-only and cannot be programmed by the user.

REGISTER 23-1: CONFIG1L: CONFIGURATION REGISTER 1 LOW (BYTE ADDRESS 300000h)

R/WO-1	R/WO-1	R/WO-1	U-0	U-0	U-0	U-0	R/WO-1
DEBUG	XINST	STVREN	_		1	_	WDTEN

bit 7 bit 0

bit 7 DEBUG: Background Debugger Enable bit

1 = Background debugger disabled; RB6 and RB7 configured as general purpose I/O pins

0 = Background debugger enabled; RB6 and RB7 are dedicated to In-Circuit Debug

bit 6 XINST: Extended Instruction Set Enable bit

1 = Instruction set extension and Indexed Addressing mode enabled

0 = Instruction set extension and Indexed Addressing mode disabled (Legacy mode)

bit 5 STVREN: Stack Overflow/Underflow Reset Enable bit

1 = Reset on stack overflow/underflow enabled

0 = Reset on stack overflow/underflow disabled

bit 4-1 Unimplemented: Read as '0'

bit 0 WDTEN: Watchdog Timer Enable bit

1 = WDT enabled

0 = WDT disabled (control is placed on SWDTEN bit)

Legend:

R = Readable bit WO = Write-once bit U = Unimplemented bit, read as '0' -n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

REGISTER 23-2: CONFIG1H: CONFIGURATION REGISTER 1 HIGH (BYTE ADDRESS 300001h)

U-0	U-0	U-0	U-0	U-0	R/WO-1	U-0	U-0
_	_	_	_	(1)	CP0	_	_
bit 7							bit 0

bit 7-3 Unimplemented: Read as '0'

bit 2 CP0: Code Protection bit

1 = Program memory is not code-protected

0 = Program memory is code-protected

bit 1-0 Unimplemented: Read as '0'

Note 1: This bit should always be maintained as '0'.

Legend:

R = Readable bit WO = Write-once bit U = Unimplemented bit, read as '0' -n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

REGISTER 23-3: CONFIG2L: CONFIGURATION REGISTER 2 LOW (BYTE ADDRESS 300002h)

R/WO-1	R/WO-1	U-0	U-0	U-0	R/WO-1	R/WO-1	R/WO-1
IESO	FCMEN	_	1	_	FOSC2	FOSC1	FOSC0

bit 7 bit 0

- bit 7 IESO: Two-Speed Start-up (Internal/External Oscillator Switchover) Control bit
 - 1 = Two-Speed Start-up enabled
 - 0 = Two-Speed Start-up disabled
- bit 6 FCMEN: Fail-Safe Clock Monitor Enable bit
 - 1 = Fail-Safe Clock Monitor enabled
 - 0 = Fail-Safe Clock Monitor disabled
- bit 5-3 Unimplemented: Read as '0'
- bit 2 FOSC2: Default/Reset System Clock Select bit
 - 1 = Clock selected by FOSC1:FOSC0 as system clock is enabled when OSCCON<1:0> = 00
 - 0 = INTRC enabled as system clock when OSCCON<1:0> = 00
- bit 1-0 FOSC1:FOSC0: Oscillator Selection bits
 - 11 = EC oscillator, PLL enabled and under software control, CLKO function on OSC2
 - 10 = EC oscillator, CLKO function on OSC2
 - 01 = HS oscillator, PLL enabled and under software control
 - 00 = HS oscillator

Legend:

R = Readable bit WO = Write-once bit U = Unimplemented bit, read as '0'
-n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

REGISTER 23-4: CONFIG2H: CONFIGURATION REGISTER 2 HIGH (BYTE ADDRESS 300003h)

U-0	U-0	U-0	U-0	R/WO-1	R/WO-1	R/WO-1	R/WO-1
_	_	_	_	WDTPS3	WDTPS2	WDTPS1	WDTPS0
bit 7							bit 0

bit 7-4 Unimplemented: Read as '0'

bit 3-0 WDTPS3:WDTPS0: Watchdog Timer Postscale Select bits

1111 = 1:32.768

1110 = 1:16,384

1101 = 1:8,192

1100 = 1:4.096

1011 = 1:2,048

1010 = 1:1,024

1001 = 1:512

1000 = 1:256

0111 = 1:128

0110 = 1:64

0101 = 1:32

0100 = 1:16

0011 = 1:8

0010 = 1:40001 = 1:2

0000 = 1:1

Legend:

R = Readable bit WO = Write-once bit U = Unimplemented bit, read as '0' -n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

REGISTER 23-5: CONFIG3L: CONFIGURATION REGISTER 3 LOW (BYTE ADDRESS 300004h)

R/WO-1	R/WO-1	R/WO-1	R/WO-1	R/WO-1	U-0	U-0	U-0		
WAIT ⁽¹⁾	BW ⁽¹⁾	EMB1 ⁽¹⁾	EMB0 ⁽¹⁾	EASHFT ⁽¹⁾	_	_	_		
127									

bit 7 bit 0

- bit 7 WAIT: External Bus Wait Enable bit (1)
 - 1 = Wait states for operations on external memory bus disabled0 = Wait states for operations on external memory bus enabled
- bit 6 **BW:** Data Bus Width Select bit⁽¹⁾
 - 1 = 16-bit External Bus mode
 - 0 = 8-bit External Bus mode
- bit 5-4 EMB1:EMB0: External Memory Bus Configuration bits (1)
 - 11 = Extended Microcontroller mode, 20-bit Address mode
 - 10 = Extended Microcontroller mode,16-bit Address mode
 - 01 = Extended Microcontroller mode,12-bit Address mode
 - 00 = Microcontroller mode external bus disabled
- bit 3 **EASHFT:** External Address Bus Shift Enable bit⁽¹⁾
 - 1 = Address shifting enabled; address on external bus is offset to start at 000000h
 - 0 = Address shifting disabled; address on external bus reflects the PC value
- bit 2-0 Unimplemented: Read as '0'

Note 1: Implemented only on 80-pin devices.

Legend:

R = Readable bit WO = Write-once bit U = Unimplemented bit, read as '0'
-n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

REGISTER 23-6: CONFIG3H: CONFIGURATION REGISTER 3 HIGH (BYTE ADDRESS 300005h)

	U-0	U-0	U-0	U-0	U-0	U-0	R/WO-1	R/WO-1
	_	_	_	_	_	_	ECCPMX ⁽¹⁾	CCP2MX
bi	: 7							bit 0

- bit 7-2 Unimplemented: Read as '0'
- bit 1 **ECCPMX:** ECCP Mux bit⁽¹⁾
 - 1 = ECCP1 outputs (P1B/P1C) are multiplexed with RE6 and RE5; ECCP3 outputs (P3B/P3C) are multiplexed with RE4 and RE3
 - 0 = ECCP1 outputs (P1B/P1C) are multiplexed with RH7 and RH6; ECCP3 outputs (P3B/P3C) are multiplexed with RH5 and RH4
- bit 0 CCP2MX: CCP2 Mux bit
 - 1 = ECCP2/P2A is multiplexed with RC1
 - 0 = ECCP2/P2A is multiplexed with RE7 in Microcontroller mode (all devices) or with RB3 in Extended Microcontroller mode (80-pin devices only)

Note 1: Available only on 80-pin devices.

Legend:

R = Readable bit WO = Write-once bit U = Unimplemented bit, read as '0' -n = Value when device is unprogrammed '1' = Bit is set '0' = Bit is cleared

DEVICE ID REGISTER 1 FOR PIC18F87J10 FAMILY DEVICES REGISTER 23-7:

R	R	R	R	R	R	R	R
DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0
bit 7							bit 0

bit 7-5 DEV2:DEV0: Device ID bits

111 = PIC18F85J10

101 = PIC18F67J10

100 = PIC18F66J15

011 = PIC18F66J10 or PIC18F87J10

010 = PIC18F65J15 or PIC18F86J15

001 = PIC18F65J10 or PIC18F86J10

000 = PIC18F85J15

Note: Where values for DEV2:DEV0 are shared by more than one device number, the

specific device is always identified by using the entire DEV10:DEV0 bit sequence.

bit 4-0 REV4:REV0: Revision ID bits

These bits are used to indicate the device revision.

Legend:

R = Read-only bit U = Unimplemented bit, read as '0' -n = Value when device is unprogrammed u = Unchanged from programmed state

DEVICE ID REGISTER 2 FOR PIC18F87J10 FAMILY DEVICES REGISTER 23-8:

R	R	R	R	R	R	R	R
DEV10	DEV9	DEV8	DEV7	DEV6	DEV5	DEV4	DEV3
bit 7							bit 0

bit 7-0 DEV10:DEV3: Device ID bits

These bits are used with the DEV2:DEV0 bits in the Device ID Register 1 to identify the part number.

0001 0101 = PIC18F65J10/65J15/66J10/66J15/67J10/85J10 devices

0001 0111 = PIC18F85J15/86J10/86J15/87J10 devices

The values for DEV10:DEV3 may be shared with other device families. The specific device is always identified by using the entire DEV10:DEV0 bit sequence.

Legend:

U = Unimplemented bit, read as '0' R = Read-only bit -n = Value when device is unprogrammed u = Unchanged from programmed state

23.2 Watchdog Timer (WDT)

For PIC18F87J10 family devices, the WDT is driven by the INTRC oscillator. When the WDT is enabled, the clock source is also enabled. The nominal WDT period is 4 ms and has the same stability as the INTRC oscillator.

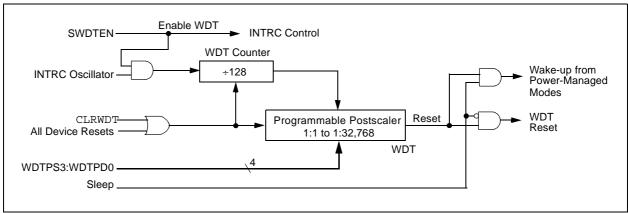
The 4 ms period of the WDT is multiplied by a 16-bit postscaler. Any output of the WDT postscaler is selected by a multiplexor, controlled by the WDTPS bits in Configuration Register 2H. Available periods range from 4 ms to 131.072 seconds (2.18 minutes). The WDT and postscaler are cleared whenever a SLEEP or CLRWDT instruction is executed, or a clock failure (primary or Timer1 oscillator) has occurred.

- **Note 1:** The CLRWDT and SLEEP instructions clear the WDT and postscaler counts when executed.
 - **2:** When a CLRWDT instruction is executed, the postscaler count will be cleared.

23.2.1 CONTROL REGISTER

The WDTCON register (Register 23-9) is a readable and writable register. The SWDTEN bit enables or disables WDT operation. This allows software to override the WDTEN configuration bit and enable the WDT only if it has been disabled by the configuration bit.

FIGURE 23-1: WDT BLOCK DIAGRAM



REGISTER 23-9: WDTCON: WATCHDOG TIMER CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	_	_	_	_	_	SWDTEN ⁽¹⁾
bit 7	•	•	•			•	bit 0

bit 7-1 Unimplemented: Read as '0'

bit 0 **SWDTEN:** Software Controlled Watchdog Timer Enable bit⁽¹⁾

- 1 = Watchdog Timer is on
- 0 = Watchdog Timer is off

Note 1: This bit has no effect if the configuration bit, WDTEN, is enabled.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	l bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

TABLE 23-2: SUMMARY OF WATCHDOG TIMER REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
RCON	IPEN	_	-	RI	TO	PD	POR	BOR	50
WDTCON	_					_	-	SWDTEN	50

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Watchdog Timer.

23.3 On-Chip Voltage Regulator

All of the PIC18F87J10 family devices power their core digital logic at a nominal 2.5V. This may create an issue for designs that are required to operate at a higher typical voltage, such as 3.3V. To simplify system design, all devices in the PIC18F87J10 family incorporate an on-chip regulator that allows the device to run its core logic from VDD.

The regulator is controlled by the ENVREG pin. Tying VDD to the pin enables the regulator, which in turn, provides power to the core from the other VDD pins. When the regulator is enabled, a low-ESR filter capacitor must be connected to the VDDCORE/VCAP pin (Figure 23-2). This helps to maintain the stability of the regulator. The recommended value for the filer capacitor is provided in Section 26.3 "DC Characteristics: PIC18F87J10 Family (Industrial)".

If ENVREG is tied to Vss, the regulator is disabled. In this case, separate power for the core logic at a nominal 2.5V must be supplied to the device on the VDDCORE/VCAP pin to run the I/O pins at higher voltage levels, typically 3.3V. Alternatively, the VDDCORE/VCAP and VDD pins can be tied together to operate at a lower nominal voltage. Refer to Figure 23-2 for possible configurations.

23.3.1 ON-CHIP REGULATOR AND BOR

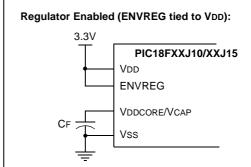
When the on-chip regulator is enabled, PIC18F87J10 family devices also have a simple brown-out capability. If the voltage supplied to the regulator is inadequate to maintain a regulated level, the regulator Reset circuitry will generate a BOR Reset. This event is captured by the BOR flag bit (RCON<0>).

The operation of the BOR is described in more detail in Section 4.4 "Brown-out Reset (BOR)" and Section 4.4.1 "Detecting BOR". The brown-out voltage levels are specific in Section 26.1 "DC Characteristics: Supply Voltage, PIC18F87J10 Family (Industrial)".

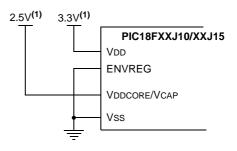
23.3.2 POWER-UP REQUIREMENTS

The on-chip regulator is designed to meet the power-up requirements for the device. If the application does not use the regulator, then strict power-up conditions must be adhered to. While powering up, VDDCORE must never exceed VDD by 0.3 volts.

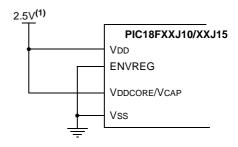
FIGURE 23-2: CONNECTIONS FOR THE ON-CHIP REGULATOR



Regulator Disabled (ENVREG tied to ground):



Regulator Disabled (VDD tied to VDDCORE):



Note 1: These are typical operating voltages. Refer to Section 26.1 "DC Characteristics: Supply Voltage" for the full operating ranges of VDD and VDDCORE.

23.4 Two-Speed Start-up

The Two-Speed Start-up feature helps to minimize the latency period, from oscillator start-up to code execution, by allowing the microcontroller to use the INTRC oscillator as a clock source until the primary clock source is available. It is enabled by setting the IESO configuration bit.

Two-Speed Start-up should be enabled only if the primary oscillator mode is HS or HSPLL (Crystal-based) modes. Since the EC and ECPLL modes do not require an OST start-up delay, Two-Speed Start-up should be disabled.

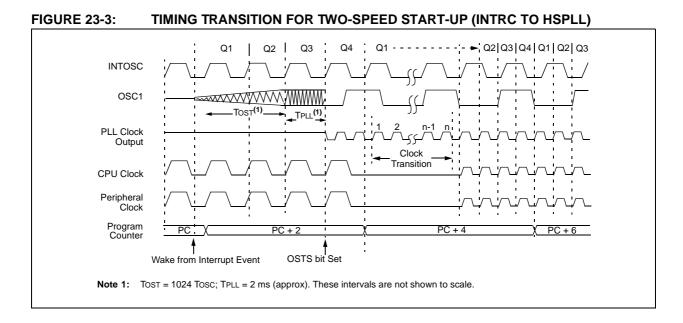
When enabled, Resets and wake-ups from Sleep mode cause the device to configure itself to run from the internal oscillator block as the clock source, following the time-out of the Power-up Timer after a POR Reset is enabled. This allows almost immediate code execution while the primary oscillator starts and the OST is running. Once the OST times out, the device automatically switches to PRI_RUN mode.

In all other power-managed modes, Two-Speed Start-up is not used. The device will be clocked by the currently selected clock source until the primary clock source becomes available. The setting of the IESO bit is ignored.

23.4.1 SPECIAL CONSIDERATIONS FOR USING TWO-SPEED START-UP

While using the INTRC oscillator in Two-Speed Start-up, the device still obeys the normal command sequences for entering power-managed modes, including serial SLEEP instructions (refer to Section 3.1.4 "Multiple Sleep Commands"). In practice, this means that user code can change the SCS1:SCS0 bit settings or issue SLEEP instructions before the OST times out. This would allow an application to briefly wake-up, perform routine "housekeeping" tasks and return to Sleep before the device starts to operate from the primary oscillator.

User code can also check if the primary clock source is currently providing the device clocking by checking the status of the OSTS bit (OSCCON<3>). If the bit is set, the primary oscillator is providing the clock. Otherwise, the internal oscillator block is providing the clock during wake-up from Reset or Sleep mode.

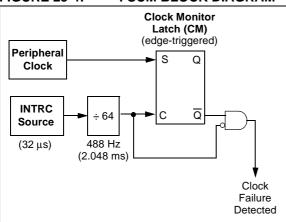


23.5 Fail-Safe Clock Monitor

The Fail-Safe Clock Monitor (FSCM) allows the microcontroller to continue operation in the event of an external oscillator failure by automatically switching the device clock to the internal oscillator block. The FSCM function is enabled by setting the FCMEN configuration bit

When FSCM is enabled, the INTRC oscillator runs at all times to monitor clocks to peripherals and provide a backup clock in the event of a clock failure. Clock monitoring (shown in Figure 23-4) is accomplished by creating a sample clock signal which is the INTRC output divided by 64. This allows ample time between FSCM sample clocks for a peripheral clock edge to occur. The peripheral device clock and the sample clock are presented as inputs to the Clock Monitor latch (CM). The CM is set on the falling edge of the device clock source but cleared on the rising edge of the sample clock.

FIGURE 23-4: FSCM BLOCK DIAGRAM



Clock failure is tested for on the falling edge of the sample clock. If a sample clock falling edge occurs while CM is still set, a clock failure has been detected (Figure 23-5). This causes the following:

- the FSCM generates an oscillator fail interrupt by setting bit OSCFIF (PIR2<7>);
- the device clock source is switched to the internal oscillator block (OSCCON is not updated to show the current clock source – this is the fail-safe condition); and
- the WDT is reset.

During switchover, the postscaler frequency from the internal oscillator block may not be sufficiently stable for timing sensitive applications. In these cases, it may be desirable to select another clock configuration and enter an alternate power-managed mode. This can be done to attempt a partial recovery or execute a controlled shutdown. See Section 3.1.4 "Multiple Sleep Commands" and Section 23.4.1 "Special Considerations for Using Two-Speed Start-up" for more details.

To use a higher clock speed on wake-up, the INTOSC or postscaler clock sources can be selected to provide a higher clock speed by setting bits IRCF2:IRCF0 immediately after Reset. For wake-ups from Sleep, the INTOSC or postscaler clock sources can be selected by setting IRCF2:IRCF0 prior to entering Sleep mode.

The FSCM will detect failures of the primary or secondary clock sources only. If the internal oscillator block fails, no failure would be detected, nor would any action be possible.

23.5.1 FSCM AND THE WATCHDOG TIMER

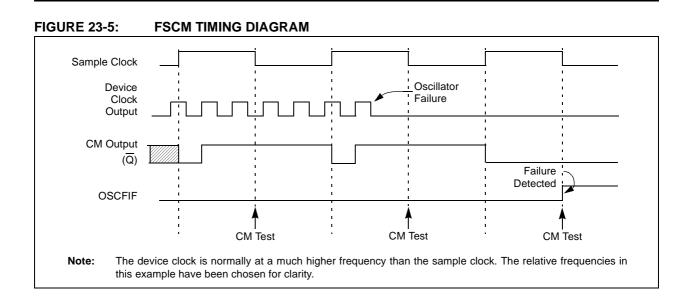
Both the FSCM and the WDT are clocked by the INTRC oscillator. Since the WDT operates with a separate divider and counter, disabling the WDT has no effect on the operation of the INTRC oscillator when the FSCM is enabled.

As already noted, the clock source is switched to the INTRC clock when a clock failure is detected; this may mean a substantial change in the speed of code execution. If the WDT is enabled with a small prescale value, a decrease in clock speed allows a WDT time-out to occur and a subsequent device Reset. For this reason, fail-safe clock events also reset the WDT and postscaler, allowing it to start timing from when execution speed was changed and decreasing the likelihood of an erroneous time-out.

23.5.2 EXITING FAIL-SAFE OPERATION

The fail-safe condition is terminated by either a device Reset or by entering a power-managed mode. On Reset, the controller starts the primary clock source specified in Configuration Register 2H (with any required start-up delays that are required for the oscillator mode, such as OST or PLL timer). The INTRC oscillator provides the device clock until the primary clock source becomes ready (similar to a Two-Speed Start-up). The clock source is then switched to the primary clock (indicated by the OSTS bit in the OSCCON register becoming set). The Fail-Safe Clock Monitor then resumes monitoring the peripheral clock.

The primary clock source may never become ready during start-up. In this case, operation is clocked by the INTRC oscillator. The OSCCON register will remain in its Reset state until a power-managed mode is entered.



23.5.3 FSCM INTERRUPTS IN POWER-MANAGED MODES

By entering a power-managed mode, the clock multiplexor selects the clock source selected by the OSCCON register. Fail-Safe Monitoring of the power-managed clock source resumes in the power-managed mode.

If an oscillator failure occurs during power-managed operation, the subsequent events depend on whether or not the oscillator failure interrupt is enabled. If enabled (OSCFIF = 1), code execution will be clocked by the INTOSC multiplexor. An automatic transition back to the failed clock source will not occur.

If the interrupt is disabled, subsequent interrupts while in Idle mode will cause the CPU to begin executing instructions while being clocked by the INTOSC source.

23.5.4 POR OR WAKE-UP FROM SLEEP

The FSCM is designed to detect oscillator failure at any point after the device has exited Power-on Reset (POR) or low-power Sleep mode. When the primary device clock is either EC or INTRC modes, monitoring can begin immediately following these events.

For HS or HSPLL modes, the situation is somewhat different. Since the oscillator may require a start-up time considerably longer than the FSCM sample clock time, a false clock failure may be detected. To prevent this, the internal oscillator block is automatically configured as the device clock and functions until the primary clock is stable (the OST and PLL timers have timed out). This is identical to Two-Speed Start-up mode. Once the primary clock is stable, the INTRC returns to its role as the FSCM source.

Note: The same logic that prevents false oscillator failure interrupts on POR, or wake from Sleep, will also prevent the detection of the oscillator's failure to start at all following these events. This can be avoided by monitoring the OSTS bit and using a timing routine to determine if the oscillator is taking too long to start. Even so, no oscillator failure interrupt will be flagged.

As noted in **Section 23.4.1 "Special Considerations for Using Two-Speed Start-up"**, it is also possible to select another clock configuration and enter an alternate power-managed mode while waiting for the primary clock to become stable. When the new power-managed mode is selected, the primary clock is disabled.

23.6 Program Verification and Code Protection

For all devices in the PIC18F87J10 family of devices, the on-chip program memory space is treated as a single block. Code protection for this block is controlled by one configuration bit, CP0. This bit inhibits external reads and writes to the program memory space. It has no direct effect in normal execution mode.

23.6.1 CONFIGURATION REGISTER PROTECTION

The Configuration registers are protected against untoward changes or reads in two ways. The primary protection is the write-once feature of the configuration bits which prevents reconfiguration once the bit has been programmed during a power cycle. To safeguard against unpredictable events, configuration bit changes resulting from individual cell-level disruptions (such as ESD events) will cause a parity error and trigger a device Reset.

The data for the Configuration registers is derived from the Flash Configuration Words in program memory. When the CP0 bit set, the source data for device configuration is also protected as a consequence.

23.7 In-Circuit Serial Programming

PIC18F87J10 family microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data and three other lines for power, ground and the programming voltage. This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

23.8 In-Circuit Debugger

When the DEBUG configuration bit is programmed to a '0', the In-Circuit Debugger functionality is enabled. This function allows simple debugging functions when used with MPLAB® IDE. When the microcontroller has this feature enabled, some resources are not available for general use. Table 23-3 shows which resources are required by the background debugger.

TABLE 23-3: DEBUGGER RESOURCES

I/O pins:	RB6, RB7
Stack:	2 levels
Program Memory:	512 bytes
Data Memory:	10 bytes

24.0 INSTRUCTION SET SUMMARY

The PIC18F87J10 family of devices incorporate the standard set of 75 PIC18 core instructions, as well as an extended set of 8 new instructions for the optimization of code that is recursive or that utilizes a software stack. The extended set is discussed later in this section.

24.1 Standard Instruction Set

The standard PIC18 instruction set adds many enhancements to the previous PICmicro® instruction sets, while maintaining an easy migration from these PICmicro instruction sets. Most instructions are a single program memory word (16 bits), but there are four instructions that require two program memory locations.

Each single-word instruction is a 16-bit word divided into an opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into four basic categories:

- · Byte-oriented operations
- · Bit-oriented operations
- Literal operations
- Control operations

The PIC18 instruction set summary in Table 24-2 lists byte-oriented, bit-oriented, literal and control operations. Table 24-1 shows the opcode field descriptions.

Most byte-oriented instructions have three operands:

- 1. The file register (specified by 'f')
- 2. The destination of the result (specified by 'd')
- 3. The accessed memory (specified by 'a')

The file register designator 'f' specifies which file register is to be used by the instruction. The destination designator 'd' specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the WREG register. If 'd' is one, the result is placed in the file register specified in the instruction.

All bit-oriented instructions have three operands:

- 1. The file register (specified by 'f')
- 2. The bit in the file register (specified by 'b')
- 3. The accessed memory (specified by 'a')

The bit field designator 'b' selects the number of the bit affected by the operation, while the file register designator 'f' represents the number of the file in which the bit is located.

The **literal** instructions may use some of the following operands:

- A literal value to be loaded into a file register (specified by 'k')
- The desired FSR register to load the literal value into (specified by 'f')
- No operand required (specified by '—')

The **control** instructions may use some of the following operands:

- A program memory address (specified by 'n')
- The mode of the CALL or RETURN instructions (specified by 's')
- The mode of the table read and table write instructions (specified by 'm')
- No operand required (specified by '—')

All instructions are a single word, except for four double-word instructions. These instructions were made double-word to contain the required information in 32 bits. In the second word, the 4 MSbs are 1's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

All single-word instructions are executed in a single instruction cycle, unless a conditional test is true or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles with the additional instruction cycle(s) executed as a NOP.

The double word instructions execute in two instruction cycles.

One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μ s. If a conditional test is true, or the program counter is changed as a result of an instruction, the instruction execution time is 2 μ s. Two-word branch instructions (if true) would take 3 μ s.

Figure 24-1 shows the general formats that the instructions can have. All examples use the convention 'nnh' to represent a hexadecimal number.

The Instruction Set Summary, shown in Table 24-2, lists the standard instructions recognized by the Microchip MPASM™ Assembler.

Section 24.1.1 "Standard Instruction Set" provides a description of each instruction.

OPCODE FIELD DESCRIPTIONS

TABLE 24-1: (DPCODE FIELD DESCRIPTIONS
Field	Description
a	RAM access bit:
	a = 0: RAM location in Access RAM (BSR register is ignored)
111	a = 1: RAM bank is specified by BSR register
bbb	Bit address within an 8-bit file register (0 to 7).
BSR	Bank Select Register. Used to select the current RAM bank.
C, DC, Z, OV, N	ALU status bits: Carry, Digit Carry, Zero, Overflow, Negative.
d	Destination select bit: d = 0: store result in WREG
	d = 1: store result in file register f
dest	Destination: either the WREG register or the specified register file location.
f	8-bit Register file address (00h to FFh), or 2-bit FSR designator (0h to 3h).
f _s	12-bit Register file address (000h to FFFh). This is the source address.
f _d	12-bit Register file address (000h to FFFh). This is the destination address.
GIE	Global Interrupt Enable bit.
k	Literal field, constant data or label (may be either an 8-bit, 12-bit or a 20-bit value).
label	Label name.
mm	The mode of the TBLPTR register for the table read and table write instructions.
	Only used with table read and table write instructions:
*	No Change to register (such as TBLPTR with table reads and writes)
*+	Post-Increment register (such as TBLPTR with table reads and writes)
* _	Post-Decrement register (such as TBLPTR with table reads and writes)
+*	Pre-Increment register (such as TBLPTR with table reads and writes)
n	The relative address (2's complement number) for relative branch instructions or the direct address for
	Call/Branch and Return instructions.
PC	Program Counter.
PCL	Program Counter Low Byte.
PCH	Program Counter High Byte.
PCLATH	Program Counter High Byte Latch.
PCLATU	Program Counter Upper Byte Latch.
PD	Power-Down bit.
PRODH	Product of Multiply High Byte.
PRODL	Product of Multiply Low Byte.
s	Fast Call/Return mode select bit:
	s = 0: do not update into/from shadow registers
mpi pmp	s = 1: certain registers loaded into/from shadow registers (Fast mode) 21-bit Table Pointer (points to a Program Memory location).
TBLPTR	8-bit Table Latch.
TABLAT	Time-out bit.
	Top-of-Stack.
TOS	Unused or Unchanged.
WDT	Watchdog Timer.
WREG	Working register (accumulator).
X	Don't care ('0' or '1'). The assembler will generate code with x = 0. It is the recommended form of use for
X	compatibility with all Microchip software tools.
z _s	7-bit offset value for indirect addressing of register files (source).
z _d	7-bit offset value for indirect addressing of register files (destination).
{ }	Optional argument.
[text]	Indicates an indexed address.
(text)	The contents of text.
[expr] <n></n>	Specifies bit n of the register indicated by the pointer expr.
→	Assigned to.
< >	Register bit field.
€	In the set of.
italics	User-defined term (font is Courier).
1041100	Took some form to obtain.

FIGURE 24-1: GENERAL FORMAT FOR INSTRUCTIONS

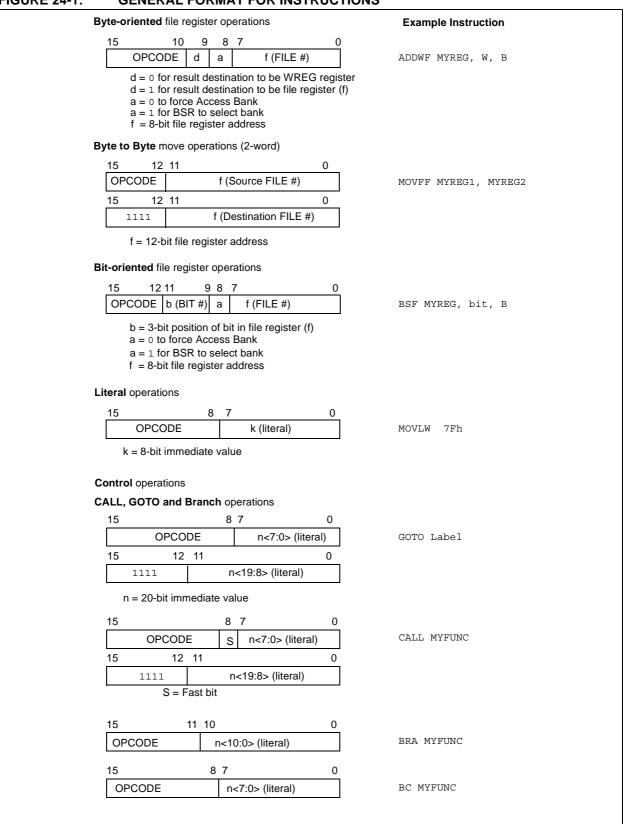


TABLE 24-2: PIC18F87J10 FAMILY INSTRUCTION SET

Mnemonic,		Description	Cycles	16-Bit Instruction Word				Status	Notes
Operand	ds	Description	Cycles	MSb			LSb	Affected	Notes
BYTE-ORIE	NTED C	PERATIONS							
ADDWF	f, d, a	Add WREG and f	1	0010	01da	ffff	ffff	C, DC, Z, OV, N	1, 2
ADDWFC	f, d, a	Add WREG and Carry bit to f	1	0010	00da	ffff	ffff	C, DC, Z, OV, N	1, 2
ANDWF	f, d, a	AND WREG with f	1	0001	01da	ffff	ffff	Z, N	1,2
CLRF	f, a	Clear f	1	0110	101a	ffff	ffff	Z	2
COMF	f, d, a	Complement f	1	0001	11da	ffff	ffff	Z, N	1, 2
CPFSEQ	f, a	Compare f with WREG, skip =	1 (2 or 3)	0110	001a	ffff	ffff	None	4
CPFSGT	f, a	Compare f with WREG, skip >	1 (2 or 3)	0110	010a	ffff	ffff	None	4
CPFSLT	f, a	Compare f with WREG, skip <	1 (2 or 3)	0110	000a	ffff	ffff	None	1, 2
DECF	f, d, a	Decrement f	1 `	0000	01da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
DECFSZ	f, d, a	Decrement f, Skip if 0	1 (2 or 3)	0010	11da	ffff	ffff	None	1, 2, 3, 4
DCFSNZ	f, d, a	Decrement f, Skip if Not 0	1 (2 or 3)	0100	11da	ffff	ffff	None	1, 2
INCF	f, d, a	Increment f	1 `	0010	10da	ffff	ffff	C, DC, Z, OV, N	1, 2, 3, 4
INCFSZ	f, d, a	Increment f, Skip if 0	1 (2 or 3)	0011	11da	ffff	ffff	None	4
	f, d, a	Increment f, Skip if Not 0	1 (2 or 3)	0100	10da	ffff	ffff	None	1, 2
	f, d, a	Inclusive OR WREG with f	1 ` ′	0001	00da	ffff	ffff	Z, N	1, 2
MOVF	f, d, a	Move f	1	0101	00da	ffff	ffff	Z, N	1
MOVFF	f_s, f_d	Move f _s (source) to 1st word	2	1100	ffff	ffff	ffff	None	
	o u	f _d (destination) 2nd word		1111	ffff	ffff	ffff		
MOVWF	f, a	Move WREG to f	1	0110	111a	ffff	ffff	None	
MULWF	f, a	Multiply WREG with f	1	0000	001a	ffff	ffff	None	1, 2
NEGF	f, a	Negate f	1	0110	110a	ffff	ffff	C, DC, Z, OV, N	
RLCF	f, d, a	Rotate Left f through Carry	1	0011	01da	ffff	ffff	C, Z, N	1, 2
	f, d, a	Rotate Left f (No Carry)	1	0100	01da	ffff	ffff	Z, N	
		Rotate Right f through Carry	1	0011	00da	ffff	ffff	C, Z, N	
RRNCF	f, d, a	Rotate Right f (No Carry)	1	0100	00da	ffff	ffff	Z, N	
SETF	f, a	Set f	1	0110	100a	ffff	ffff	None	1, 2
	f, d, a	Subtract f from WREG with borrow	1	0101	01da	ffff	ffff	C, DC, Z, OV, N	·
SUBWF	f, d, a	Subtract WREG from f	1	0101	11da	ffff	ffff	C, DC, Z, OV, N	1, 2
	f, d, a	Subtract WREG from f with	1	0101	10da	ffff	ffff		,
	, -,	borrow						, -, ,,	
SWAPF	f, d, a	Swap nibbles in f	1	0011	10da	ffff	ffff	None	4
_	f, a	Test f, skip if 0	1 (2 or 3)	0110	011a	ffff	ffff	None	1, 2
	f, d, a	Exclusive OR WREG with f	1		10da	ffff	ffff	Z, N	_

Note 1: When a port register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

- 2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.
- **3:** If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.
- **4:** Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16-bits. This ensures that all program memory locations have a valid instruction.
- 5: In normal execution modes, table write operations cannot be used to write to any on-chip memory space. For 80-pin devices, table write instructions may also be used to write to an external memory device. For more information, see Section 6.4 "Writing to Program Memory Space (PIC18F8XJ10/8XJ15 Devices Only)" and Section 6.6 "Writing and Erasing On-Chip Program Memory (ICSP Mode)".

TABLE 24-2: PIC18F87J10 FAMILY INSTRUCTION SET (CONTINUED)

Mnemo	onic,	Decembries	0	16-E	Bit Instr	uction V	Vord	Status	Natas
Opera	nds	Description	Cycles	MSb			LSb	Affected	Notes
BIT-ORIEN	TED OP	ERATIONS							
BCF	f, b, a	Bit Clear f	1	1001	bbba	ffff	ffff	None	1, 2
BSF	f, b, a	Bit Set f	1	1000	bbba	ffff	ffff	None	1, 2
BTFSC	f, b, a	Bit Test f, Skip if Clear	1 (2 or 3)	1011	bbba	ffff	ffff	None	3, 4
BTFSS	f, b, a	Bit Test f, Skip if Set	1 (2 or 3)	1010	bbba	ffff	ffff	None	3, 4
BTG	f, b, a	Bit Toggle f	1	0111	bbba	ffff	ffff	None	1, 2
CONTROL	OPERA	TIONS		•					
ВС	n	Branch if Carry	1 (2)	1110	0010	nnnn	nnnn	None	
BN	n	Branch if Negative	1 (2)	1110	0110	nnnn	nnnn	None	
BNC	n	Branch if Not Carry	1 (2)	1110	0011	nnnn	nnnn	None	
BNN	n	Branch if Not Negative	1 (2)	1110	0111	nnnn	nnnn	None	
BNOV	n	Branch if Not Overflow	1 (2)	1110	0101	nnnn	nnnn	None	
BNZ	n	Branch if Not Zero	1 (2)	1110	0001	nnnn	nnnn	None	
BOV	n	Branch if Overflow	1 (2)	1110	0100	nnnn	nnnn	None	
BRA	n	Branch Unconditionally	2	1101	0nnn	nnnn	nnnn	None	
BZ	n	Branch if Zero	1 (2)	1110	0000	nnnn	nnnn	None	
CALL	n, s	Call subroutine 1st word	2	1110	110s	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
CLRWDT	_	Clear Watchdog Timer	1	0000	0000	0000	0100	TO, PD	
DAW	_	Decimal Adjust WREG	1	0000	0000	0000	0111	С	
GOTO	n	Go to address 1st word	2	1110	1111	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
NOP	_	No Operation	1	0000	0000	0000	0000		
NOP	_	No Operation	1	1111		XXXX	xxxx		4
POP	_	Pop top of return stack (TOS)	1	0000	0000	0000		None	
PUSH	_	Push top of return stack (TOS)	1	0000	0000	0000		None	
RCALL	n	Relative Call	2	1101	1nnn	nnnn	nnnn		
RESET		Software device Reset	1	0000	0000	1111	1111	All	
RETFIE	S	Return from interrupt enable	2	0000	0000	0001	000s	,	
DET. 144		B						PEIE/GIEL	
RETLW	k	Return with literal in WREG	2	0000	1100	kkkk	kkkk		
RETURN	S	Return from Subroutine	2	0000	0000	0001	001s	None	
SLEEP	_	Go into Standby mode	1	0000	0000	0000	0011	TO, PD	

- Note 1: When a port register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.
 - 2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.
 - 3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.
 - 4: Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16-bits. This ensures that all program memory locations have a valid instruction.
 - 5: In normal execution modes, table write operations cannot be used to write to any on-chip memory space. For 80-pin devices, table write instructions may also be used to write to an external memory device. For more information, see Section 6.4 "Writing to Program Memory Space (PIC18F8XJ10/8XJ15 Devices Only)" and Section 6.6 "Writing and Erasing On-Chip Program Memory (ICSP Mode)".

TABLE 24-2: PIC18F87J10 FAMILY INSTRUCTION SET (CONTINUED)

Mnemonic, Operands		December (in the control of the cont	Cycles	16-Bit Instruction Word				Status	N 1.4.
		Description		MSb			LSb	Affected	Notes
LITERAL (DPERAT	IONS							
ADDLW	k	Add literal and WREG	1	0000	1111	kkkk	kkkk	C, DC, Z, OV, N	
ANDLW	k	AND literal with WREG	1	0000	1011	kkkk	kkkk	Z, N	
IORLW	k	Inclusive OR literal with WREG	1	0000	1001	kkkk	kkkk	Z, N	
LFSR	f, k	Move literal (12-bit) 2nd word	2	1110	1110	OOff	kkkk	None	
		to FSR(f) 1st word		1111	0000	kkkk	kkkk		
MOVLB	k	Move literal to BSR<3:0>	1	0000	0001	0000	kkkk	None	
MOVLW	k	Move literal to WREG	1	0000	1110	kkkk	kkkk	None	
MULLW	k	Multiply literal with WREG	1	0000	1101	kkkk	kkkk	None	
RETLW	k	Return with literal in WREG	2	0000	1100	kkkk	kkkk	None	
SUBLW	k	Subtract WREG from literal	1	0000	1000	kkkk	kkkk	C, DC, Z, OV, N	
XORLW	k	Exclusive OR literal with WREG	1	0000	1010	kkkk	kkkk	Z, N	
DATA MEMORY ↔ PROGRAM MEMORY OPERATIONS									
TBLRD*		Table Read	2	0000	0000	0000	1000	None	
TBLRD*+		Table Read with post-increment		0000	0000	0000	1001	None	
TBLRD*-		Table Read with post-decrement		0000	0000	0000	1010	None	
TBLRD+*		Table Read with pre-increment		0000	0000	0000	1011	None	
TBLWT*		Table Write	2	0000	0000	0000	1100	None	5
TBLWT*+		Table Write with post-increment		0000	0000	0000	1101	None	5
TBLWT*-		Table Write with post-decrement		0000	0000	0000	1110	None	5
TBLWT+*		Table Write with pre-increment		0000	0000	0000	1111	None	5

- Note 1: When a port register is modified as a function of itself (e.g., MOVF PORTB, 1, 0), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.
 - 2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.
 - **3:** If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.
 - **4:** Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16-bits. This ensures that all program memory locations have a valid instruction.
 - 5: In normal execution modes, table write operations cannot be used to write to any on-chip memory space. For 80-pin devices, table write instructions may also be used to write to an external memory device. For more information, see Section 6.4 "Writing to Program Memory Space (PIC18F8XJ10/8XJ15 Devices Only)" and Section 6.6 "Writing and Erasing On-Chip Program Memory (ICSP Mode)".

24.1.1 STANDARD INSTRUCTION SET

ADDLW		ADD Literal to W							
Syntax:		ADDLW	ADDLW k						
Operands:		$0 \le k \le 255$	$0 \le k \le 255$						
Operation:		(W) + k \rightarrow	$(W) + k \to W$						
Status Affected:		N, OV, C, [N, OV, C, DC, Z						
Encoding:		0000	1111	kkkl	k kkkk				
Description:			The contents of W are added to the 8-bit literal 'k' and the result is placed in W.						
Words:		1	1						
Cycles:		1	1						
Q Cycle Activity:									
	Q1	Q2	Q3	l	Q4				
	Decode	Read literal 'k'	Proce Data		Write to W				

Example: ADDLW 15h

Before Instruction W = 10hAfter Instruction W = 25h

ADDWF	ADD W to f						
Syntax:	ADDWF f {,d {,a}}						
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$						
Operation:	$(W) + (f) \rightarrow dest$						
Status Affected:	N, OV, C, DC, Z						
Encoding:	0010	01da	ffff	ffff			
Description:	Add W to register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).						
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).						
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.						
Words: 1							

Q Cycle Activity:

Q1 Q2

 Q1
 Q2
 Q3
 Q4

 Decode
 Read register 'f'
 Process P

Example: ADDWF REG, 0, 0

Before Instruction

Cycles:

W = 17h REG = 0C2h

After Instruction

W = 0D9hREG = 0C2h

Note: All PIC18 instructions may take an optional label argument preceding the instruction mnemonic for use in symbolic addressing. If a label is used, the instruction format then becomes: {label} instruction argument(s).

ADDWFC		ADD W and Carry bit to f						
Syntax:		ADDWFC	f {,d {,a	a}}				
Operands:		$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	d ∈ [0,1]					
Operation:		(W) + (f) +	$(W) + (f) + (C) \to dest$					
Status Affect	ed:	N,OV, C, D	N,OV, C, DC, Z					
Encoding:		0010	00da	ffff	ffff			
Description:		Add W, the Carry flag and data memory location 'f'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed in data memory location 'f'.						
		If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).						
		If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.						
Words:		1						
Cycles:		1						
Q Cycle Activity:								
Q ²	1	Q2	Q3		Q4			
Deco	de	Read register 'f'	Proces Data		Write to estination			

ANDLW		AND Literal with W							
Syntax:		ANDLW	ANDLW k						
Operands:		$0 \le k \le 255$	$0 \le k \le 255$						
Operation:		(W) .AND.	(W) .AND. $k \to W$						
Status Affected:		N, Z							
Encoding:		0000	1011	kkk	k	kkkk			
Description:			The contents of W are ANDed with the 8-bit literal 'k'. The result is placed in W.						
Words:		1	1						
Cycles:		1	1						
Q Cycle Activity:									
	Q1	Q2	Q3	Q3		Q4			
	Decode	Read literal	Proce	SS	W	/rite to			
		'k'	Data	a		W			

Example: ANDLW 05Fh

Before Instruction
W = A3h

After Instruction
W = 03h

ADDWFC

1 02h 4Dh

0 02h 50h REG, 0, 1

Example:

Before Instruction

Carry bit =

REG =

W =

After Instruction

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Carry bit = REG = W =

Branch if Carry

 $-128 \le n \le 127$

if Carry bit is '1' (PC) + 2 + $2n \rightarrow PC$

0010

incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a

two-cycle instruction.

If the Carry bit is '1', then the program

The 2's complement number '2n' is added to the PC. Since the PC will have

nnnn

BC n

None

1(2)

1110

will branch.

ANDWF	AND W w	ith f		
Syntax:	ANDWF	f {,d {,a}	}	
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	5		
Operation:	(W) .AND.	(f) \rightarrow des	st	
Status Affected:	N, Z			
Encoding:	0001	01da	ffff	ffff
Description:	The contents of W are ANDed with register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).			
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).			
	If 'a' is '0' and the extended instruction set is enabled, this instruction operation in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexe Literal Offset Mode" for details.			operates essing See ed and Indexed
Words:	1			
Cycles:	1			
Q Cycle Activity:				
Ω1	Q2	O.S	3	Ω4

	Bit-Oriented instructions in indexed			Q1	Q2	Q3	Q4	
	Literal Offs	set Mode" for	details.	С	ecode	Read literal	Process	Write to
S:	1					'n'	Data	PC
s:	1			or	No peration	No operation	No operation	No operation
cle Activity:				If No Jui		орегалоп	орогалогі	operation
Q1	Q2	Q3	Q4		Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination	D	ecode	Read literal 'n'	Process Data	No operation

вс

Syntax:

Operands:

Operation:

Encoding:

Words: Cycles:

Q Cycle Activity: If Jump:

Description:

Status Affected:

Example: ANDWF REG, 0, 0 Before Instruction W REG 17h C2h After Instruction W REG 02h C2h

	Decode	'n'		Data		P
	No operation	No operation	n	-	No ration	No opera
If No	Jump:	-				
	Q1	Q2			Q3	Q
	Decode	Read lite	ral	Pro	cess	No
		ʻn'		D	ata	opera
Exan	nple:	HERE		вс	5	
	Before Instruc PC After Instruction	=	ad	dress	(HERE)
	If Carry PC If Carry PC	= = = =	0;		(HERE	+ 12)

BCF	Bit Clear f	·		
Syntax:	BCF f, b	(,a)		
Operands:	$0 \le f \le 255$ $0 \le b \le 7$ $a \in [0,1]$			
Operation:	$0 \rightarrow f < b >$			
Status Affected:	None			
Encoding:	1001	bbba	ffff	ffff
Description:	Bit 'b' in re	gister 'f' i	s cleared.	
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).			
	If 'a' is '0' a			

Words: Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 24.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.

Example: BCF FLAG REG, 7, 0

Before Instruction FLAG_REG = C7h After Instruction FLAG_REG = 47h

BN	Branch if	Negative		
Syntax:	BN n			
Operands:	-128 ≤ n ≤	127		
Operation:	if Negative (PC) + 2 +		;	
Status Affected:	None			
Encoding:	1110	0110	nnnn	nnnn
Description:	If the Nega		'1', then t	he
	added to the increment instruction	ne PC. Sired to fetched, the new 2n. This in	address wastruction is	will have
Words:	1			
Cycles:	1(2)			
Q Cycle Activity: If Jump:				
Q1	Q2	Q3	3	Q4

	Q1	Q2	Q3	Q4			
	Decode	Read literal	Process	Write to			
		'n'	Data	PC			
	No	No	No	No			
	operation	operation	operation	operation			
No Jump							

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example: HERE BNJump

Before Instruction

PC address (HERE)

After Instruction

If Negative PC

1; address (Jump)

0; address (HERE + 2)

BNC	Branch if Not Carry			
Syntax:	BNC n			
Operands:	-128 ≤ n ≤ 127			
Operation:	if Carry bit is '0' $(PC) + 2 + 2n \rightarrow PC$			
Status Affected:	None			
Encoding:	1110 0011 nnnn nnnn			
Description:	If the Carry bit is '0', then the program will branch.			
	The 2's complement number '2n' is added to the PC. Since the PC will have			

incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.

Words: Cycles: 1(2)

Q Cycle Activity: If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to
	'n'	Data	PC
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example: HERE BNC Jump

Before Instruction

PC address (HERE)

After Instruction

If Carry PC

address (Jump)

address (HERE + 2)

BNN **Branch if Not Negative** Syntax: BNN n Operands: $-128 \le n \le 127$ Operation: if Negative bit is '0' $(PC) + 2 + 2n \rightarrow PC$ Status Affected: None Encoding: 1110 0111 nnnn nnnn Description: If the Negative bit is '0', then the program will branch. The 2's complement number '2n' is

added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a

two-cycle instruction.

Words: Cycles: 1(2)

Q Cycle Activity:

If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to
	'n'	Data	PC
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example: HERE BNN Jump

Before Instruction

PC address (HERE)

After Instruction

If Negative PC 0:

address (Jump)

address (HERE + 2)

BNOV	Branch if Not Overflow					
Syntax:	BNOV n					
Operands:	$-128 \le n \le 127$					
Operation:	if Overflow bit is '0' $(PC) + 2 + 2n \rightarrow PC$					
Status Affected:	None					
Encoding:	1110 0101 nnnn nnnn					
Description:	If the Overflow bit is '0', then the program will branch.					
	The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next					

incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a

two-cycle instruction.

Words: Cycles: 1(2)

Q Cycle Activity: If Jump:

Q1	Q2	Q3	Q4
Decode	Decode Read literal		Write to
	ʻn'		PC
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	ʻn'	Data	operation

Example: HERE BNOV Jump

Before Instruction

PC address (HERE)

After Instruction

If Overflow

PC address (Jump)

address (HERE + 2)

BNZ	Branch if Not Zero
Syntax:	BNZ n
Operands:	$-128 \le n \le 127$
Operation:	if Zero bit is '0' (PC) + 2 + 2n \rightarrow PC
01-1 1111	Maria

Status Affected: None

Encoding: 1110 0001 nnnn nnnn

Description: If the Zero bit is '0', then the program

will branch.

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a

two-cycle instruction.

Words: Cycles: 1(2)

Q Cycle Activity:

If Jump:

Q1	Q2	Q3	Q4	
Decode	Read literal	Process	Write to	
	ʻn'	Data	PC	
No	No	No	No	
operation	operation	operation	operation	

If No Jump:

Q1	Q2	Q3	Q4	
Decode	Read literal	Process	No	
	'n'	Data	operation	

Example: HERE BNZ Jump

Before Instruction

PC address (HERE)

After Instruction

If Zero 0:

address (Jump)

If Zero PC

address (HERE + 2)

DRA	Onconditional Branch
Syntax:	BRA n
Operands:	$-1024 \le n \le 1023$
Operation:	$(PC) + 2 + 2n \rightarrow PC$

Unaanditional Branch

Status Affected: None

DD A

Encoding: 1101 0nnn nnnn nnnn

Description: Add the 2's complement number '2n' to

the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is a

two-cycle instruction.

Words: 1 Cycles: 2

Q Cycle Activity:

	Q1	Q2	Q3	Q4	
ſ	Decode Read litera		Process	Write to	
		'n'		PC	
ĺ	No	No No		No	
	operation	operation	operation	operation	

Example: HERE BRA Jump

Before Instruction

PC = address (HERE)

After Instruction

PC = address (Jump)

BSF	Bit Set f				
Syntax:	BSF f, b {,a}				
Operands:	$0 \le f \le 255$ $0 \le b \le 7$ $a \in [0,1]$				
Operation:	$1 \rightarrow f < b >$				
Status Affected:	None				
Encoding:	1000	bbba	ffff	ffff	
Description:	Bit 'b' in register 'f' is set.				

If 'a' is '0', the Access Bank is selected.
If 'a' is '1', the BSR is used to select the

GPR bank (default).

in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.

If 'a' is '0' and the extended instruction

set is enabled, this instruction operates

Words: 1
Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: BSF FLAG REG, 7, 1

Before Instruction

FLAG_REG = 0Ah

After Instruction

FLAG_REG = 8Ah

BTFSC	Bit Test File	, Skip if Clear	r	BTFS	3	Bit Test File	, Skip if Set	
Syntax:	BTFSC f, b	{,a}		Syntax	α:	BTFSS f, b	{,a}	
Operands:	$0 \le f \le 255$ $0 \le b \le 7$ $a \in [0,1]$			Opera	nds:	$0 \le f \le 255$ $0 \le b < 7$ $a \in [0,1]$		
Operation:	skip if (f)	= 0		Opera	tion:	skip if (f)	= 1	
Status Affected:	None			Status	Affected:	None		
Encoding:	1011	bbba ff	ff ffff	Encod	ing:	1010	bbba ff	ff ffff
Description:	instruction is the next inst current instr and a NOP is	gister 'f' is '0', s skipped. If bit ruction fetched uction execution s executed instruction	'b' is '0', then d during the on is discarded read, making	Descri	ption:	instruction is the next inst current instru and a NOP is	gister 'f' is '1', to skipped. If bit ruction fetched uction execution executed instruction.	'b' is '1', then during the in is discarded ead, making
	•	BSR is used to	k is selected. If o select the			-	e Access Bank BSR is used to default).	
	is enabled, t Indexed Lite whenever for Section 24. Bit-Oriented	d the extended his instruction ral Offset Addi ≤ 95 (5Fh). See 2.3 "Byte-Orie d Instructions et Mode" for d	ressing mode e ented and in Indexed			set is enable Indexed Lite whenever f s Section 24.3 Bit-Oriented	d the extended d, this instructi ral Offset Addr ≤ 95 (5Fh). See 2.3 "Byte-Orie d Instructions et Mode" for d	on operates in essing mode e nted and in Indexed
Words:	1			Words	:	1		
Cycles:	•	cles if skip and 2-word instruc		Cycles	:		ycles if skip an a 2-word instru	
Q Cycle Activity:				Q Cyc	cle Activity:			
Q1	Q2	Q3	Q4	_	Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation		Decode	Read register 'f'	Process Data	No operation
If skip:	register r	Data	operation	L If skip):	register i	Data	operation
Q1	Q2	Q3	Q4	·	Q1	Q2	Q3	Q4
No	No	No	No		No	No	No	No
operation	operation	operation	operation		operation	operation	operation	operation
If skip and followe	ed by 2-word ins Q2		Q4	If skip		d by 2-word ins		Q4
Q1 No	No No	Q3 No	No No	Г	Q1 No	Q2 No	Q3 No	No No
operation	operation	operation	operation		operation	operation	operation	operation
No	No	No	No	Ī	No	No	No	No
operation	operation	operation	operation		operation	operation	operation	operation
Example:	HERE B' FALSE : TRUE :	rfsc flac	G, 1, 0	<u>Exam</u> p	ole:	HERE B' FALSE : TRUE :	IFSS FLAG	, 1, 0
Before Instru	ction			В	efore Instruc	tion		
PC		ress (HERE)			PC	= add	lress (HERE)	
After Instructi				Α	fter Instruction			
If FLAG PC If FLAG PC	= add <1> = 1;	lress (TRUE))		If FLAG< PC If FLAG< PC	= add 1> = 1;	ress (FALSE)	1

BTG Bit Toggle f Syntax: BTG f, b {,a} Operands: $0 \le f \le 255$ $0 \le b < 7$ $a \in [0,1]$ Operation: $(\overline{f < b >}) \rightarrow f < b >$ Status Affected: None Encoding: 0111 bbba ffff ffff Description: Bit 'b' in data memory location 'f' is inverted.

> If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

GPR bank (default).

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 24.2.3 "Byte-Oriented and **Bit-Oriented Instructions in Indexed** Literal Offset Mode" for details.

Words: Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: BTG PORTC, 4, 0

Before Instruction:

PORTC = 0111 0101 [75h]

After Instruction:

PORTC = 0110 0101 [65h]

BOV	Branch if Overflow				Branch if Overflow		
Syntax:	BOV n						
Operands:	$-128 \le n \le 127$						
Operation:	if Overflow bit is '1' (PC) + 2 + 2n \rightarrow PC						
Status Affected:	None						
Encoding:	1110 0100 nnnn nnn						
Description:	If the Overflow bit is '1', then the program will branch.						
	The 2's complement number '2n' i added to the PC. Since the PC will incremented to fetch the next instruction, the new address will b PC + 2 + 2n. This instruction is the two-cycle instruction.			will have			

Words: Cycles: 1(2)

Q Cycle Activity: If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	ʻn'	Data	
No	No	No	No
operation	operation	operation	operation
	Decode	Decode Read literal 'n' No No	Decode Read literal Process 'n' Data No No No No

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example: HERE BOV Jump

Before Instruction

PC address (HERE)

After Instruction

If Overflow

1; address (Jump) PC

If Overflow PC

address (HERE + 2)

BZ	Branch if Zero				
Syntax:	BZ n				
Operands:	-128 ≤ n ≤ 127				
Operation:	if Zero bit is '1' (PC) + 2 + 2n \rightarrow PC				
Status Affected:	None				
Encoding:	1110 0000 nnnn nnnn				
Description:	If the Zero bit is '1', then the program will branch.				
	The 2's complement number '2n' is				

added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.

Words: Cycles: 1(2)

Q Cycle Activity: If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to
	'n'	Data	PC
No	No	No	No
operation	operation	operation	operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	No
	'n'	Data	operation

Example:	HERE	BZ	Jump
----------	------	----	------

Before Instruction

PC address (HERE)

After Instruction

If Zero

address (Jump)

address (HERE + 2)

CALL	Subroutine Call		
Syntax:	CALL k {,s}		

Operands: $0 \leq k \leq 1048575$

 $s \in [0,1]$

(PC) + 4 \rightarrow TOS, Operation: $k \rightarrow PC < 20:1>$

if s = 1 $(W) \rightarrow WS$,

 $(STATUS) \rightarrow STATUSS,$

 $(\mathsf{BSR}) \to \mathsf{BSRS}$

Status Affected: None

Encodina: 1st word (k<7:0>)

kkkk₀ 1110 110s k₇kkk 2nd word(k<19:8>) 1111 k₁₉kkk kkkk kkkk₈

Description: Subroutine call of entire 2-Mbyte memory range. First, return address (PC+4)

is pushed onto the return stack. If 's' = 1, the W, STATUS and BSR registers are also pushed into their respective shadow registers, WS, STATUSS and BSRS. If 's' = 0, no update occurs (default). Then, the 20-bit value 'k' is loaded into PC<20:1>.

CALL is a two-cycle instruction.

Words: 2 2 Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal	Push PC to	Read literal
	'k'<7:0>,	stack	'k'<19:8>,
			Write to PC
No	No	No	No
operation	operation	operation	operation

Example: HERE THERE, 1

Before Instruction

РС address (HERE)

After Instruction

PC TOS address (THERE) address (HERE + 4)

WS BSRS BSR STATUSS = STATUS

CLRWDT

000h \rightarrow WDT,

None

 $1 \to \overline{TO}, \\ 1 \to PD$ $\overline{TO}, \overline{PD}$

0000

and \overline{PD} , are set.

Clear Watchdog Timer

 $000h \rightarrow WDT$ postscaler,

0000

CLRWDT instruction resets the Watchdog Timer. It also resets the postscaler of the WDT. Status bits, $\overline{\text{TO}}$

0000

0100

CLRWDT

Operands:

Operation:

Status Affected: Encoding:

 $\overline{\mathsf{PD}}$

Description:

Words:

Syntax:

CLRF	Clear f			
Syntax:	CLRF f {,a}			
Operands:	$0 \le f \le 255$ a \in [0,1]			
Operation:	$000h \rightarrow f$ $1 \rightarrow Z$			
Status Affected:	Z			
Encoding:	0110 101a ffff ffff			
Description:	Clears the contents of the specified register.			
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).			
	If 'a' is 'o' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f \leq 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			
Words:	1			
Cycles:	1			
Q Cycle Activity:				

Cycles:		1			
QC	ycle Activity:				
	Q1	Q2		Q3	Q4
	Decode	No		Process	No
		operation	n	Data	operation
Example: CLRWD					
	Before Instruc	tion			
	WDT Cou	ınter	=	?	
After Instruction					
WDT Counter			=	00h	
WDT Postscaler			=	0	
TO			=	1	

Before Instruction

FLAG_REG = 5Ah

After Instruction

FLAG_REG = 00h

Q2

Read

register 'f'

CLRF

Q3

Process

Data

FLAG REG, 1

Q4

Write

register 'f'

Q1

Decode

Example:

COM	F	Complement f			
Synta	X:	COMF f	{,d {,a}}		
Opera	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			
Opera	ation:	$(\overline{f}) \rightarrow de$	st		
Status	s Affected:	N, Z			
Enco	ding:	0001	11da f	ff fff	f
Desci	scription: The contents of register 'f' are complemented. If 'd' is '0', the result stored in W. If 'd' is '1', the result is stored back in register 'f' (default).			is	
		If 'a' is '0', the Access Bank is selected If 'a' is '1', the BSR is used to select the GPR bank (default).			
		If 'a' is '0' and the extended instruction set is enabled, this instruction operate in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			tes
Word	s:	1			
Cycle	s:	1			
Q Cy	cle Activity:				
-	Q1	Q2	Q3	Q4	
	Decode	Read register 'f'	Process Data	Write to destination	

Example: COMF REG, 0, 0

> Before Instruction REG 13h After Instruction

REG = W = 13h ECh

Syntax:	CPFSEQ	f {,a}				
Operands:	$0 \le f \le 255$ $a \in [0,1]$					
Operation:	(f) - (W), skip if $(f) =$ (unsigned	` '	on)			
Status Affected:	None					
Encoding:	0110	001a	ffff	ffff		
Description:	location 'f'	Compares the contents of data memory location 'f' to the contents of W by performing an unsigned subtraction.				
	If 'f' = W, then the fetched instruction is discarded and a NOP is executed instead, making this a two-cycle instruction.					
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).					
	If 'a' is '0' a set is enab in Indexed mode whe Section 24 Bit-Orient Literal Off	oled, this i Literal O never f ≤ 4.2.3 "By ed Instru	instruction ffset Addre 95 (5Fh). te-Oriente actions in	operates essing See ed and Indexed		
Words:	1					
Cycles:	1(2) Note : 3 cy by a		ip and follo			
Q Cycle Activity:						

Compare f with W, Skip if f = W

Q Cycle Activity:

CPFSEQ

	Q1	Q2	Q3	Q4		
	Decode	Read	Process	No		
		register 'f'	Data	operation		
If skip:						
	Q1	Q2	Q3	Q4		
	No	No	No	No		
	operation	operation	operation	operation		
If skip and followed by 2-word instruction:						

Q1	Q2	Q3	Q4
No	No	No	No
operation	peration operation		operation
No	No	No	No
operation	operation	operation	operation

Example: CPFSEQ REG, 0 HERE

NEQUAL EQUAL

Before Instruction

PC Address W REG HERE ? ? After Instruction

If REG PC If REG PC W;

Address (EQUAL) W; Address (NEQUAL)

CPFSGT	Compare f	with W, Skip	if f > W	CPF	SLT	Compare f	with W, Skip	if f < W
Syntax:	CPFSGT	f {,a}		Synt	ax:	CPFSLT f {,a}		
Operands:	$0 \le f \le 255$ $a \in [0,1]$			Орег	ands:	0 ≤ f ≤ 255 a ∈ [0,1]		
Operation:		(f) – (W), skip if (f) > (W) (unsigned comparison)		Oper	ration:	(f) – (W), skip if (f) < (W) (unsigned comparison)		
Status Affected:	None		Statu	s Affected:	None	, opaoo		
Encoding:	0110	010a ff	ff ffff				222 55	
Description:	location 'f' to performing	Compares the contents of data memory location 'f' to the contents of the W by performing an unsigned subtraction.			ding: ription:	location 'f' t	the contents of the contents an unsigned s	f data memory of W by
	If the contents of 'f' are greater than the contents of WREG, then the fetched instruction is discarded and a NOP is executed instead, making this a two-cycle instruction. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates					contents of instruction	nts of 'f' are le W, then the fe is discarded and the istead, making instruction.	etched nd a NOP is
							he Access Bar he BSR is use (default).	
				Word	ls:	1		
	in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed		Cycle			ycles if skip an a 2-word instru		
		set Mode" for		QC	ycle Activity:			•
Words:	1				Q1	Q2	Q3	Q4
Cycles:	1(2)				Decode	Read register 'f'	Process Data	No operation
•		cycles if skip a		lf sk	in·	register i	Data	operation
	by	a 2-word instr	uction.	11 31	.ρ. Q1	Q2	Q3	Q4
Q Cycle Activity:					No	No	No	No.
Q1	Q2	Q3	Q4		operation	operation	operation	operation
Decode	Read register 'f'	Process	No operation	lf sk	ip and followe	d by 2-word in	struction:	
If skip:	register i	Data	operation		Q1	Q2	Q3	Q4
Q1	Q2	Q3	Q4		No	No	No	No
No	No	No	No		operation	operation	operation	operation
operation	operation	operation	operation		No	No	No	No
If skip and follower	ed by 2-word in	struction:			operation	operation	operation	operation
Q1	Q2	Q3	Q4					
No	No	No	No	<u>Exar</u>	nple:	HERE	CPFSLT REG,	1
operation	operation	operation	operation				:	
No	No	No	No			LESS	:	
operation	operation	operation	operation		Before Instruc			
Example:	HERE NGREATER GREATER	CPFSGT RE	EG, O		PC W After Instruction If REG	= ?	ldress (HERE)
Before Instru PC		ldress (HERE)		PC If REG	≥ W		
W	= A0 = ?	IUICSS (HEKE	,		PC	= Ac	dress (NLES	S)

After Instruction
If REG
PC
If REG
PC

Address (GREATER) W; Address (NGREATER)

DAW	Decimal A	Decimal Adjust W Register				
Syntax:	DAW					
Operands:	None					
Operation:	If [W<3:0> > 9] or [DC = 1] then (W<3:0>) + 6 \rightarrow W<3:0>; else (W<3:0>) \rightarrow W<3:0>					
	If $[W<7:4> > 9]$ or $[C = 1]$ then $(W<7:4>) + 6 \rightarrow W<7:4>$; $C = 1$; else $(W<7:4>) \rightarrow W<7:4>$					
Status Affected:	С					
Encoding:	0000	0000	0000	0111		
Description:	DAW adjusts the eight-bit value in W, resulting from the earlier addition of two variables (each in packed BCD format) and produces a correct packed BCD result.					
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3	3	Q4		

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register W	Data	W

Example 1:	DA	AM.
Before Instru	uction	
W	=	A5h
С	=	0
DC	=	0
After Instruc	tion	
W	=	05h
С	=	1
DC	=	0

Example 2:

 $\begin{array}{cccc} \text{Before Instruction} & & & & \\ W & = & CEh \\ C & = & 0 \\ DC & = & 0 \\ \text{After Instruction} & & & \\ W & = & 34h \\ C & = & 1 \\ DC & = & 0 \\ \end{array}$

DECF	Decrement f				
Syntax:	DECF f {,c	d {,a}}			
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Operation:	$(f) - 1 \rightarrow de$	est			
Status Affected:	C, DC, N, C	OV, Z			
Encoding:	0000	01da	fff	f	ffff
Description:	result is sto	Decrement register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default)			
	If 'a' is '0', t If 'a' is '1', t GPR bank	he BSR is			
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				operates essing See ed and Indexed
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3			Q4
Decode	Read register 'f'	Proces Data			rite to stination

DECFSZ	Decrement	t f, Skip if 0		DCF	SNZ	Decrement	t f, Skip if not	: 0
Syntax:	DECFSZ	f {,d {,a}}		Synt	ax:	DCFSNZ	f {,d {,a}}	
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			Oper	rands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$		
Operation:	(f) $-1 \rightarrow de$ skip if resul	-		Орег	ration:	(f) $-1 \rightarrow de$ skip if resul		
Status Affected:	None			Statu	is Affected:	·		
Encoding:	0010	11da ff	ff ffff	Enco	oding:	0100	11da fff	ff ffff
Description:	decremente placed in W	ts of register 'ed. If 'd' is '0', /. If 'd' is '1', the in register 'f'	the result is ne result is	Desc	cription:	decremente placed in W	ts of register 'fed. If 'd' is '0', /. If 'd' is '1', the in register 'f'	the result is ne result is
	which is alr and a NOP i it a two-cyc	le instruction.	is discarded stead, making			instruction discarded a	is not '0', the which is alread and a NOP is ea aking it a two-d	dy fetched is xecuted
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).							nk is selected. d to select the
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				set is enabl in Indexed mode wher Section 24	nd the extended, this instructions the control of	ction operates Addressing Fh). See iented and	
Words:	1						set Mode" for	details.
Cycles:	1(2)			Word		1		
	•	cles if skip ar 2-word instru		Cycle	es:		ycles if skip a a 2-word instr	
Q Cycle Activity:	00	00	0.4	0.0	ycle Activity:	Бу	a 2-word msu	uction.
Q1 Decode	Q2 Read	Q3 Process	Q4 Write to]	Q1	Q2	Q3	Q4
Decode	register 'f'	Data	destination		Decode	Read	Process	Write to
If skip:				-		register 'f'	Data	destination
Q1	Q2	Q3	Q4	If sk				
No	No	No	No		Q1	Q2	Q3	Q4
	operation		operation]	No operation	No operation	No operation	No operation
If skip and followe Q1	ea by 2-wora in Q2	Struction: Q3	Q4	lf sk		d by 2-word in		operation
No	No	No No	No	1	Q1	Q2	Q3	Q4
operation	operation	operation	operation		No	No	No	No
No	No	No	No		operation	operation	operation	operation
operation	operation	operation	operation		No operation	No operation	No operation	No operation
Example:	HERE CONTINUE	DECFSZ GOTO	CNT, 1, 1 LOOP	<u>Exar</u>	nple:	ZERO	:	MP, 1, 0
Before Instruc	ction				5.		:	
PC After Instructi CNT If CNT	on = CNT - ' = 0;		-)		TEMP After Instruction TEMP	= on =	? TEMP – 1,	
PC If CNT PC	≠ 0;	S (CONTINUE S (HERE + 2			If TEMP PC If TEMP PC	= = ≠ =	0; Address (2 0; Address (1	

GOTO	Unconditional Branch			
Syntax:	GOTO k			
Operands:	$0 \le k \le 1048575$			
Operation:	$k \rightarrow PC < 20:1 >$			
Status Affected:	None			
Encoding: 1st word (k<7:0>) 2nd word(k<19:8>)	1110 1111	1111 k ₁₉ kkk	k ₇ kkk kkkk	kkkk ₀ kkkk ₈
Description:	GOTO allows an unconditional branch anywhere within entire 2-Mbyte memory range. The 20-bit value 'k' is loaded into			

instruction.

Words: 2

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'<7:0>,	No operation	Read literal 'k'<19:8>, Write to PC
No operation	No operation	No operation	No operation

PC<20:1>. GOTO is always a two-cycle

Example: GOTO THERE

After Instruction

PC = Address (THERE)

INCF	:	Increment f				
Synta	ax:	INCF f {,	d {,a}}			
Oper	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Oper	ation:	(f) + 1 \rightarrow d	est			
Statu	s Affected:	C, DC, N,	OV, Z			
Enco	ding:	0010	10da	fff	f	ffff
Description: The contents of register 'f' are incremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default).			ult is			
		If 'a' is '1',	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).			
		If 'a' is 'o' and the extended instruction ope in Indexed Literal Offset Addressin mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented an Bit-Oriented Instructions in Inde Literal Offset Mode" for details.			operates ssing See d and ndexed	
Word	ls:	1				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q3	1		Q4
	Decode	Read register 'f'	Proce Data			rite to tination

Example:	INCF		CNT,	1,	0
Before Instruc CNT Z C DC	tion = = = =	FFh 0 ?			
After Instruction	n				
CNT Z C DC	= = =	00h 1 1 1			

INCF	sz	Increment	f, Skip if 0		INFS	INZ	Increment	f, Skip if not	0
Synta	ax:	INCFSZ f	{,d {,a}}		Synta	ax:	INFSNZ f	{,d {,a}}	
Oper	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			·	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	$d \in [0,1]$	
Oper	ation:	(f) + 1 \rightarrow deskip if result	•		Oper	ation:	(f) + 1 \rightarrow dest, skip if result \neq 0		
Statu	s Affected:	None				is Affected:	None		
Enco	ding:	0011	11da ff:	ff ffff		oding:	0100	10da ff	
Desc	ription:	incremente placed in W	ts of register 'f d. If 'd' is '0', tl /. If 'd' is '1', th < in register 'f'.	ne result is e result is	I Desc	ription:	incremente placed in W placed back	ts of register 'I d. If 'd' is '0', t /. If 'd' is '1', th k in register 'f'	he result is ne result is (default).
		which is alread and a NOP i	is '0', the nex eady fetched i s executed ins le instruction.	s discarded			instruction discarded a	is not '0', the which is alread and a NOP is eaking it a two-d	dy fetched is xecuted
				nk is selected. d to select the				he BSR is use	nk is selected. d to select the
		set is enabl in Indexed I mode when Section 24 Bit-Oriente	nd the extended, this instruction of set for the control of the c	ction operates Addressing Fh). See iented and s in Indexed			set is enablin Indexed mode wher Section 24 Bit-Oriente	nd the extendied, this instructional Offset Alever f ≤ 95 (5 .2.3 "Byte-Ored Instruction set Mode" for	ction operates Addressing Fh). See iented and s in Indexed
Word	s:	1			Word	ds:	1		
Cycle	es:		cycles if skip a a 2-word instr		Cycle	es:		/cles if skip an a 2-word instru	
Q C	cle Activity:	,			0.0	ycle Activity:	~, \		
	Q1	Q2	Q3	Q4	40	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process Data	Write to destination		Decode	Read register 'f'	Process Data	Write to destination
If sk	ip:				If sk	ip:			
i	Q1	Q2	Q3	Q4	1	Q1	Q2	Q3	Q4
	No	No	No	No		No	No	No	No
lf ck	operation	operation d by 2-word in:	operation:	operation] If als	operation	operation d by 2-word in	operation	operation
II SK	Q1	Q2	Q3	Q4	11 51	up and followe Q1	Q2	Q3	Q4
	No No	No	No	No No]	No	No No	No.	No
	operation	operation	operation	operation		operation	operation	operation	operation
	No	No	No	No		No	No	No	No
	operation	operation	operation	operation	J	operation	operation	operation	operation
Exam	nple:	NZERO	INCFSZ CN : :	IT, 1, 0	<u>Exar</u>	nple:	HERE ZERO NZERO	INFSNZ REC	B, 1, 0
	Before Instruc PC After Instructio CNT If CNT PC If CNT	= Address on = CNT + 1 = 0;	G (HERE)			Before Instruction PC After Instruction REG If REG PC If REG	= Address on = REG +	s (HERE) 1 s (NZERO)	
	PC		(NZERO)			PC		S (ZERO)	

IORLW		Inclusive	Inclusive OR Literal with W				
Synta	ax:	IORLW k					
Oper	ands:	$0 \le k \le 255$;				
Oper	ation:	(W) .OR. k	$\to W$				
Statu	s Affected:	N, Z					
Enco	ding:	0000	1001	kkk	k	kkkk	
Description:			The contents of W are ORed with the eight-bit literal 'k'. The result is placed in W.				
Word	ls:	1	1				
Cycles:		1	1				
Q Cycle Activity:							
	Q1	Q2	Q3	3		Q4	
	Decode	Read	Proce	ess	W	rite to	
		literal 'k'	Data	a		W	

Example: IORLW 35h

 $\begin{array}{cccc} \text{Before Instruction} & & & \\ W & = & 9\text{Ah} \\ \text{After Instruction} & & \\ W & = & \text{BFh} \end{array}$

IORV	VF	Inclusive OR W with f				
Synta	ax:	IORWF f	f {,d {,a}}			
Oper	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Oper	ation:	(W) .OR. (f	\rightarrow dest			
Statu	s Affected:	N, Z				
Enco	oding:	0001	00da	fff	f	ffff
Desc	cription:	Inclusive OR W with register 'f'. If 'd' 'o', the result is placed in W. If 'd' is ': the result is placed back in register 'f' (default).				f 'd' is '1',
		If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).				
		If 'a' is '0' and the extended instructi set is enabled, this instruction opera in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Index Literal Offset Mode" for details.				operates essing See ed and Indexed
Word	ds:	1				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q3	3		Q4
	Decode	Read register 'f'	Proce Data			/rite to stination

Example: IORWF RESULT, 0, 1

 $\begin{array}{cccc} \text{Before Instruction} & & \\ \text{RESULT} & = & 13h \\ \text{W} & = & 91h \\ \text{After Instruction} & & \\ \text{RESULT} & = & 13h \\ \text{W} & = & 93h \\ \end{array}$

LFSR Load FSR Syntax: LFSR f, k $0 \le f \le 2$ Operands: $0 \le k \le 4095$ Operation: $k \rightarrow FSRf$ Status Affected: None Encoding: 1110 1110 OOff $k_{11}kkk$ 1111 0000 k₇kkk kkkk Description: The 12-bit literal 'k' is loaded into the file select register pointed to by 'f'.

Words: 2 Cycles: 2

Q Cycle Activity:

	Q1	Q2	Q3	Q4
	Decode	Read literal	Process	Write
		'k' MSB	Data	literal 'k'
				MSB to
				FSRfH
	Decode	Read literal	Process	Write literal
L		'k' LSB	Data	'k' to FSRfL

Example: LFSR 2, 3ABh

After Instruction

FSR2H = 03hFSR2L = ABh

MOV	'F	Move f					
Synta	ax:	MOVF f{	MOVF f {,d {,a}}				
Oper	ands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	d ∈ [0,1]				
Oper	ation:	$f \to dest \\$					
Statu	s Affected:	N, Z					
Enco	oding:	0101	00da	fff	f	ffff	
Desc	ription:	The contents of register 'f' are moved a destination dependent upon the status of 'd'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default). Location 'f' can be anywhere in the 256-byte bank.				the sult is sult is ault).	
		If 'a' is '0', the Access Bank is selected if 'a' is '1', the BSR is used to select the GPR bank (default).					
		If 'a' is '0' a set is enabl in Indexed mode wher Section 24 Bit-Oriente Literal Offs	led, this i Literal Of never f < 1 .2.3 "Byted Instru	nstruc ffset A 95 (5F te-Ori c	tion ddre h). ente s in	operates essing See ed and Indexed	
Word	ds:	1					
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q3	l .		Q4	
	Decode	Read	Proce	ss		Write	

Example: MOVF REG, 0, 0

register 'f'

Data

W

Before Instruction

 $\begin{array}{ccc} \mathsf{REG} & = & 22\mathsf{h} \\ \mathsf{W} & = & \mathsf{FFh} \end{array}$

After Instruction

REG = 22h W = 22h

MOVFF	Move f to f
Syntax:	MOVFF f _s ,f _d
Operands:	$0 \le f_s \le 4095$ $0 \le f_d \le 4095$
Operation:	$(f_s) \rightarrow f_d$
Status Affected:	None
Encoding: 1st word (source) 2nd word (destin.) Description:	1100 fffff fffff ffffs fffff fffff fffffd 1111 fffff fffff fffffd The contents of source register 'fs' are moved to destination register 'fd'. Location of source 'fs' can be anywhere in the 4096-byte data space (000h to FFFh) and location of destination 'fd' can also be anywhere from 000h to FFFh.
	Either source or destination can be W (a useful special situation).
	MOVFF is particularly useful for transferring a data memory location to a peripheral register (such as the transmit buffer or an I/O port).

destination register
Words: 2
Cycles: 2 (3)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f' (src)	Process Data	No operation
Decode	No operation No dummy read	No operation	Write register 'f' (dest)

The MOVFF instruction cannot use the

PCL, TOSU, TOSH or TOSL as the

Example: MOVFF REG1, REG2

Before Instruction

REG1 = 33h REG2 = 11h

After Instruction

REG1 = 33h REG2 = 33h

MOVLB	Move Lite	ral to Lov	w Nibble i	n BSR	
Syntax:	MOVLW	k			
Operands:	$0 \le k \le 25$	5			
Operation:	$k \to BSR$				
Status Affected:	None				
Encoding:	0000	0001	kkkk	kkkk	
Description:	The eight-bit literal 'k' is loaded into the Bank Select Register (BSR). The value of BSR<7:4> always remains '0' regardless of the value of k ₇ :k ₄ .				
Words:	1				
Cycles:	1				

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write literal 'k' to BSR

Example: MOVLB 5

Before Instruction

BSR Register = 02h

After Instruction

BSR Register = 05h

MOVLW	Move Literal to W			
Syntax:	MOVLW k			
Operands:	$0 \le k \le 255$			
Operation:	$k \to W$			
Status Affected:	None			
Encoding:	0000 1110 kkkk kkkk			
Description:	The eight-bit literal 'k' is loaded into W.			
Words:	1			
Cycles:	1			

Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	literal 'k'	Data	W

Example: MOVLW 5Ah

After Instruction

5Ah

MOVWF	Move W t	o f		
Syntax:	MOVWF	f {,a}		
Operands:	$0 \le f \le 255$ $a \in [0,1]$	5		
Operation:	$(W) \to f$			
Status Affected:	None			
Encoding:	0110	111a	ffff	ffff
Description:	Move data from W to register 'f'. Location 'f' can be anywhere in the 256-byte bank.			
	If 'a' is '0', If 'a' is '1', GPR bank	the BSR i	s used to	
	If 'a' is '0' set is enal in Indexed mode whe Section 2 Bit-Orient Literal Of	oled, this i I Literal Of enever f ≤ 4.2.3 "By ted Instru	nstruction ffset Addre 95 (5Fh). te-Oriente ctions in	operates essing See ed and Indexed

Words: Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: MOVWF REG, 0

Before Instruction

W REG 4Fh FFh

After Instruction

W REG 4Fh 4Fh

MULLW	Multiply Literal with W		
Syntax:	MULLW k		
Operands:	$0 \le k \le 255$		
Operation:	(W) $x k \rightarrow PRODH:PRODL$		
Status Affected:	None		
Encoding:	0000 1101 kkkk kkkk		
Description:	An unsigned multiplication is carried out between the contents of W and the 8-bit literal 'k'. The 16-bit result is placed in PRODH:PRODL register pair. PRODH contains the high byte. W is unchanged.		
	None of the status flags are affected.		
	Note that neither Overflow nor Carry is possible in this operation. A Zero result is possible but not detected.		
Words:	1		
Cycles:	1		
Q Cycle Activity:			

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write registers PRODH: PRODL

 Example:
 MULLW
 0 C4h

 Before Instruction
 W = E2h

 PRODH = ?
 PRODL = ?

 After Instruction
 W = E2h

 PRODH = ADh
 PRODL = 08h

MULWF	Multiply W	/ with f		
Syntax:	MULWF	f {,a}		
Operands:	$0 \le f \le 255$ $a \in [0,1]$			
Operation:	(W) $x (f) \rightarrow PRODH:PRODL$			
Status Affected:	None			
Encoding:	0000 001a ffff ffff			ffff
Description:	An unsigned multiplication is carried out between the contents of W and the register file location 'f'. The 16-bit result is stored in the PRODH:PRODL register pair. PRODH contains the high byte. Both W and 'f' are unchanged.			
	None of the	e status fla	igs are affe	ected.
	Note that neither Overflow nor Carry is possible in this operation. A Zero result is possible but not detected.			
	If 'a' is '0', 'a' is '1', th GPR bank	e BSR is u		
	If 'a' is '0' and the extended instruction se is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			ates in ng mode I and ndexed
Words:	1			
Cycles:	1			

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write registers PRODH: PRODL

```
        Example:
        MULWF
        REG, 1

        Before Instruction
        W
        = C4h

        REG
        = B5h
        PRODH

        PRODL
        = ?

        After Instruction
        W
        = C4h

        REG
        = B5h

        PRODH
        = 8Ah

        PRODL
        = 94h
```

Q Cycle Activity:

NEGF	Negate f				
Syntax:	NEGF f	{,a}			
Operands:	$0 \le f \le 255$ $a \in [0,1]$	_ * · *			
Operation:	$(\overline{f}) + 1 \rightarrow f$				
Status Affected:	N, OV, C, DC, Z				
Encoding:	0110 110a ffff ffff				
Description:	Location 'f' is negated using two's complement. The result is placed in the data memory location 'f'.				
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).				
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			operates essing See ed and Indexed	
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3	3	Q4	

NOP		No Operation				
Synta	ax:	NOP				
Oper	ands:	None	None			
Oper	ation:	No operation				
Statu	s Affected:	None				
Enco	ding:	0000	0000	000	0	0000
		1111	xxxx	XXX	ΧX	xxxx
Desc	ription:	No operati	on.			
Word	ls:	1				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q3	3		Q4
	Decode	No	No			No
		operation	operat	tion	ор	eration

Example:

None.

Example: NEGF REG, 1

Before Instruction

REG = 0011 1010 [3Ah]

Read

register 'f'

Process

Data

Write

register 'f'

After Instruction

Decode

REG = 1100 0110 [C6h]

POP		Pop Top o	Pop Top of Return Stack			
Synta	ax:	POP				
Oper	ands:	None				
Oper	ation:	$(TOS) \rightarrow b$	it bucket			
Statu	s Affected:	None	None			
Enco	ding:	0000	0000 0000 0000 0110			
Desc	ription:	The TOS value is pulled off the return stack and is discarded. The TOS value then becomes the previous value that was pushed onto the return stack. This instruction is provided to enable the user to properly manage the return stack to incorporate a software stack.				
Word	ls:	1				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q3	3		Q4
	Decode	No operation	POP T valu		ор	No eration
Exan	nple:	POP				

PUS	н	Push Top	Push Top of Return Stack			
Synta	ax:	PUSH				
Oper	ands:	None				
Oper	ation:	(PC + 2) -	→ TOS			
Statu	s Affected:	None				
Enco	ding:	0000	0000	0000	0101	
Word	ription: Is:	on: The PC + 2 is pushed onto the top of the return stack. The previous TOS value is pushed down on the stack. This instruction allows implementing a software stack by modifying TOS and then pushing it onto the return stack.				
Cycle	es:	1				
QC	ycle Activity:					
	Q1	Q2	Q3	3	Q4	
	Decode	PUSH PC + 2 onto return stack	No operat		No peration	
<u>Exan</u>	nple:	PUSH				

GOTO	NEW	Before Instruction		
Before Instruction TOS Stack (1 level down)	= 0031A2h = 014332h	TOS PC	=	345Ah 0124h
After Instruction TOS PC	= 014332h = NEW	After Instruction PC TOS Stack (1 level down)	= = =	0126h 0126h 345Ah

RCALL	Relative C	Call			
Syntax:	RCALL r	RCALL n			
Operands:	-1024 ≤ n	$-1024 \le n \le 1023$			
Operation:	$ (PC) + 2 \rightarrow TOS, $ $ (PC) + 2 + 2n \rightarrow PC $				
Status Affected:	None				
Encoding:	1101	1nnn	nnnn	nnnn	
Description:	Subroutine call with a jump up to 1K from the current location. First, return address (PC + 2) is pushed onto the stack. Then, add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next				

two-cycle instruction. Words: 1

Cycles:

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal	Process	Write to PC
	'n'	Data	
	PUSH PC		
	to stack		
No	No	No	No
operation	operation	operation	operation

instruction, the new address will be PC + 2 + 2n. This instruction is a

Example: HERE RCALL Jump

Before Instruction

PC = Address (HERE)

After Instruction

PC = Address (Jump) TOS = Address (HERE + 2)

RES	ET	Reset			
Synta	ax:	RESET			
Oper	ands:	None			
Oper	ation:	Reset all registers and flags that are affected by a MCLR Reset.			
Status Affected: All					
Enco	coding: 0000 0000 1111 111			1111	
Desc	ription:	This instruction			
Word	ls:	1			
Cycle	es:	1			
Q Cycle Activity:					
	Q1	Q2	Q3	3	Q4
	Decode	Start	No		No
			operat		operation

Example: RESET

After Instruction

Registers = Reset Value Flags* = Reset Value

RETFIE	Return from Interrupt
Syntax:	RETFIE {s}
Operands:	s ∈ [0,1]
Operation:	$(TOS) \rightarrow PC$, $1 \rightarrow GIE/GIEH$ or PEIE/GIEL, if $s = 1$ $(WS) \rightarrow W$, $(STATUSS) \rightarrow STATUS$, $(BSRS) \rightarrow BSR$, PCLATU, PCLATH are unchanged
Ctatus Affactade	CIE/CIELL DEIE/CIEL

Status Affected: GIE/GIEH, PEIE/GIEL.

Encoding: 0000 0000 0001

STATUS and BSR. If 's' = 0, no update of these registers occurs (default).

Words: 1 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No	No	POP PC
	operation	operation	from stack
			Set GIEH or
			GIEL
No	No	No	No
operation	operation	operation	operation

Example: RETFIE 1

After Interrupt

PC = TOS W = WS BSR = BSRS STATUS = STATUSS GIE/GIEH, PEIE/GIEL = 1

$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	RETI	ıw	Return Lite	eral to W	ı		
Operands: $0 \le k \le 255$ Operation: $k \to W$, $(TOS) \to PC$, $PCLATU$, $PCLATH$ are unchanged Status Affected: None Encoding: $0000 1100 kkkk kkkk$ Description: W is loaded with the eight-bit literal 'k'. The program counter is loaded from the top of the stack (the return address). The high address latch ($PCLATH$) remains unchanged. Words: 1 Cycles: 2 Q Cycle Activity: $Q1 Q2 Q3 Q4$ Decode Read Process $POPPC$				oral to vi			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Synta	ax:	REILW K				
(TOS) → PC, PCLATU, PCLATH are unchanged Status Affected: None Encoding: 0000 1100 kkkk kkkk Description: W is loaded with the eight-bit literal 'k'. The program counter is loaded from the top of the stack (the return address). The high address latch (PCLATH) remains unchanged. Words: 1 Cycles: 2 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process POP PC	Oper	ands:	$0 \le k \le 255$	$0 \le k \le 255$			
Encoding: Description: W is loaded with the eight-bit literal 'k'. The program counter is loaded from the top of the stack (the return address). The high address latch (PCLATH) remains unchanged. Words: 1 Cycles: 2 Q Cycle Activity: Q1 Q2 Q3 Q4 Q2 Q3 Q4 Q4 Q6 Q6 Q6 Q7 Q7 Q7 Q7 Q7	Oper	ation:	$(TOS) \xrightarrow{r} PC$,				
Description: W is loaded with the eight-bit literal 'k'. The program counter is loaded from the top of the stack (the return address). The high address latch (PCLATH) remains unchanged. Words: 1 Cycles: 2 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process POP PC	Status Affected: None						
The program counter is loaded from the top of the stack (the return address). The high address latch (PCLATH) remains unchanged. Words: 1 Cycles: 2 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process POP PC	Enco	ding:	0000	0000 1100 kkkk kkk			
Cycles: 2 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process POP PC	The program counter is loaded fron top of the stack (the return address The high address latch (PCLATH)				ed from the ddress).		
Q Cycle Activity:	Word	ls:	1				
Q1 Q2 Q3 Q4 Decode Read Process POP PC	Cycle	es:	2				
Decode Read Process POP PC	QC	ycle Activity:					
		Q1	Q2	Q3	3	Q4	
literal 'k' Data from stack,		Decode	Read	Proce	ess	POP PC	
			literal 'k'	Data	a fr	om stack,	
write to W					V	rite to W	

Example:

No

operation

```
CALL TABLE ; W contains table ; offset value ; W now has ; table value :

TABLE ADDWF PCL ; W = offset RETLW k0 ; Begin table RETLW k1 ; : : RETLW kn ; End of table
```

No

operation

No

operation

No

operation

Before Instruction
W = 07h
After Instruction

W = value of kn

RETURN **Return from Subroutine** Syntax: RETURN (s) Operands: $s \in [0,1]$ Operation: $(TOS) \rightarrow PC$, if s = 1 $(WS) \rightarrow W$ $(STATUSS) \rightarrow STATUS,$ $(BSRS) \rightarrow BSR$, PCLATU, PCLATH are unchanged Status Affected: None Encoding: 0000 0000 0001 001s Description: Return from subroutine. The stack is popped and the top of the stack (TOS) is loaded into the program counter. If 's'= 1, the contents of the shadow registers WS, STATUSS and BSRS are loaded into their corresponding registers W, STATUS and BSR. If 's' = 0, no update of these registers occurs (default). Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No	Process	POP PC
	operation	Data	from stack
No	No	No	No
operation	operation	operation	operation

Example: RETURN

After Instruction: PC = TOS

RLCF	Rotate Left f through Carry				
Syntax:	RLCF f {,d {,a}}				
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Operation:	$(f) \rightarrow dest, (f<7>) \rightarrow C, (C) \rightarrow dest<0>$				
Status Affected:	C, N, Z				
Encoding:	0011	01da	ffff	ffff	
Description:	The contents of register 'f' are rotated one bit to the left through the Carry flag. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register				

'f' (default).

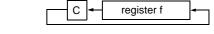
If 'a' is '0', the Access Bank is selected.

If 'a' is '1', the BSR is used to select the

GPR bank (default).

If 'a' is 'o' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f \leq 95 (5Fh). See

Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.



Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: RLCF REG, 0, 0

Before Instruction

REG = 1110 0110 C = 0

After Instruction

REG = 1110 0110 W = 1100 1100 C = 1

RLNCF	Rotate Let	otate Left f (no carry)			
Syntax:	RLNCF	f {,d {,a}}			
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$				
Operation:		$(f) \rightarrow dest,$ $(f<7>) \rightarrow dest<0>$			
Status Affected:	N, Z				
Encoding:	0100	01da ff	ff ffff		
Description:	one bit to t is placed ir	The contents of register 'f' are rotated one bit to the left. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f' (default).			
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).				
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.				
	 ◆	register f			
Words:	1				
Cycles:	1				
Q Cycle Activity:	•				
Q1	Q2	Q3	Q4		
Decode	Read register 'f'	Process Data	Write to destination		
Example:	RLNCF	REG, 1,	0		
Before Instruc REG		.011			
After Instruction					

RRCF	Rotate Rig	ht f thro	ugh Ca	irry		
Syntax:	RRCF f {,	d {,a}}				
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$	$d \in [0,1]$				
Operation:	$(f<0>) \rightarrow C$	$(f) \rightarrow dest,$ $(f<0>) \rightarrow C,$ $(C) \rightarrow dest<7>$				
Status Affected:	C, N, Z					
Encoding:	0011	00da	ffff	ffff		
Description:	one bit to the flag. If 'd' is If 'd' is '1', t	The contents of register 'f' are rotated one bit to the right through the Carry flag. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default).				
	If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default).					
	If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.					
	C	re	egister f	-		
Words:	1					
Cycles:	1					
Q Cycle Activity:						
Q1	Q2	Q3	3	Q4		
Decode	Read register 'f'	Proce Data		Write to destination		
Example:	RRCF	REG,	0, 0			
Before Instruction REG = 1110 0110 C = 0						

1110 0110 0111 0011 0

After Instruction

REG = W = C =

RRNCF	Rotate Right f (no carry)			
Syntax:	RRNCF	f {,d {,a}}		
Operands:	$0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$			
Operation:	$(f) \rightarrow dest,$ $(f<0>) \rightarrow dest<7>$			
Status Affected:	N, Z			
Encoding:	0100	00da	ffff	ffff
Description:	The contents of register 'f' are rotated one bit to the right. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default).			
	If 'a' is '0', the Access Bank will be selected, overriding the BSR value. If 'a' is '1', then the bank will be selected as per the BSR value (default).			
	If 'a' ic '∩'	and the e	vtandad in	etruction

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.



Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example 1: RRNCF REG, 1, 0

Before Instruction

REG = 1101 0111

After Instruction

REG = 1110 1011

Example 2: RRNCF REG, 0, 0

Before Instruction

W = ? REG = 1101 0111

After Instruction

W = 1110 1011 REG = 1101 0111

SETF	Set f			
Syntax:	SETF f{	,a}		
Operands:	$0 \le f \le 255$ a $\in [0,1]$			
Operation:	$FFh \to f$			
Status Affected:	None			
Encoding:	0110	100a	ffff	ffff
Description:	The conte		specified i	register
	If 'a' is '0', If 'a' is '1', GPR bank	the BSR	is used to	
	GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operate in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.			operates essing See ed and Indexed

Q Cycle Activity:

Words:

Cycles:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: SETF REG, 1

Before Instruction

REG = 5Ah

After Instruction

REG = FFh

SLEEP Enter Sleep Mode							
Synta	ax:	SLEEP	SLEEP				
Oper	ands:	None					
Oper	ation:						
Statu	s Affected:	$\overline{TO}, \overline{PD}$					
Enco	ding:	0000	0000	000	0	0011	
Desc	ription:	The Powe cleared. The is set. The postscaler	he Time-o Watchdo	out sta g Tim	atus	bit (TO)	
			The processor is put into Sleep mode with the oscillator stopped.				
Word	ls:	1	1				
Cycle	es:	1	1				
Q Cycle Activity:							
	Q1	Q2	Q3			Q4	
	Decode	No operation	Proces Data	ss		Go to Sleep	

Example:	SLEEP
Before Instruction	on ?
<u> </u>	?
After Instruction	1
TO =	1†
PD =	0

† If WDT causes wake-up, this bit is cleared.

SUBFWB Subtract f from W with Borrow Syntax: SUBFWB f {,d {,a}} Operands: $0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$ Operation: (W) − (f) − (\overline{C}) → dest Status Affected: N, OV, C, DC, Z Encoding: 0101 01da fffff ffff Description: Subtract register 'f' and Carry flag (borrow) from W (2's complement method). If 'd' is '0', the result is stored in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process Write to destination Example 1: SUBFWB REG, 1, 0 Before Instruction REG = 3 W = 2 C = 0 N = 1 N = 1 ; result is negative Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1 After Instruction						
Operands: $0 \le f \le 255$ $d \in [0,1]$ $a \in [0,1]$ $a \in [0,1]$ $a \in [0,1]$ Operation: $(W) - (f) - (\overline{C}) \rightarrow \text{dest}$ Status Affected: $N, \text{OV}, \text{C}, \text{DC}, \text{Z}$ Encoding: $0 101 0 1 da \text{fffff} \text{fffff}$ Description: Subtract register 'f' and Carry flag (borrow) from W (2's complement method). If 'd' is 'o', the result is stored in W. If 'd' is '1', the result is stored in register 'f' (default). If 'a' is 'o', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is 'o' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process Write to destination Example 1: SUBFWB REG, 1, 0 Before Instruction REG = 3 W = 2 C = 1 After Instruction REG = FF W = 2 C = 0 Z = 0 N = 1 ; result is negative Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1	SUBFWB	Subtract f fr	om W with Bo	orrow		
Operation: $(W) - (f) - (\overline{C}) \rightarrow \text{dest}$ Status Affected: N, OV, C, DC, Z Encoding: $0101 01da ffff ffff$ Description: Subtract register 'f' and Carry flag (borrow) from W (2's complement method). If 'd' is '0', the result is stored in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process Write to register 'f' Data destination Example 1: SUBFWB REG, 1, 0 Before Instruction REG = 3 W = 2 C = 1 After Instruction REG = FF W = 2 C = 0 Z = 0 N = 1 ; result is negative Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1 After Instruction REG = 2 W = 3 C = 1 After Instruction REG = 2 W = 3 C = 1	Syntax:	SUBFWB f	{,d {,a}}			
$a \in \boxed{[0,1]}$ Operation: $(W) - (f) - (\overline{C}) \rightarrow \text{dest}$ Status Affected: $N, \text{OV}, \text{C}, \text{DC}, \text{Z}$ Encoding: $0101 01 \text{da} \text{ffff} \text{ffff}$ Description: $0101 01 \text{da} \text{ffff} \text{ffff}$ Description: $0101 01 \text{da} \text{ffff} \text{ffff}$ $0101 01 \text{da} \text{ffff} \text{ffff}$ Description: $0101 0101 0101 \text{destinstruction}$ Rescription: $0101 010$	Operands:					
Operation: $(W) - (f) - (\overline{C}) \rightarrow \text{dest}$ Status Affected: N, OV, C, DC, Z Encoding: $0101 01da \text{fffff} \text{fffff}$ Description: Subtract register 'f' and Carry flag (borrow) from W (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '0', the result is stored in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \leq 95$ (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process Write to destination Example 1: SUBFWB REG, 1, 0 Before Instruction REG = 3 W = 2 C = 0 Z C = 0 Z = 0 N = 1 ; result is negative Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1 After Instruction REG = 2 W = 3 C = 1						
Status Affected: N, OV, C, DC, Z Encoding:	Operation:		:) → dest			
Encoding: Description: Subtract register 'f' and Carry flag (borrow) from W (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process Write to destination Example 1: SUBFWB REG, 1, 0 Before Instruction REG = 3 W = 2 C = 1 After Instruction REG = FF W = 2 C = 0 Z = 0 N = 1 ; result is negative Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1	•	. , ., .	•			
Description: Subtract register 'f' and Carry flag (borrow) from W (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process Write to destination Example 1: SUBFWB REG, 1, 0 Before Instruction REG = 3 W = 2 C = 1 After Instruction REG = FF W = 2 C = 0 Z = 0 N = 1 ; result is negative Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1						
(borrow) from W (2's complement method). If 'd' is 'o', the result is stored in W. If 'd' is '1', the result is stored in register 'f' (default). If 'a' is 'o', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is 'o' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process Write to register 'f' Data destination Example 1: SUBFWB REG, 1, 0 Before Instruction REG = 3 W = 2 C C = 1 After Instruction REG = FF W = 2 C C = 0 Z = 0 D Z = 0 N = 1 ; result is negative Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 O C = 1 After Instruction REG = 2 O C = 1 After Instruction REG = 2 O C = 1 After Instruction REG = 2 O C = 1 After Instruction REG = 2 O C = 1 After Instruction REG = 2 O C = 1 After Instruction REG = 2 O C = 1 After Instruction REG = 2 O C = 1 After Instruction REG = 2 O C = 1 After Instruction	· ·					
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$set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f \leq 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details. Words: 1 $		'a' is '1', the BSR is used to select the				
Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process Write to destination Example 1: SUBFWB REG, 1, 0 Before Instruction REG = 3 W = 2 C C = 1 After Instruction REG = FF W = 2 C C = 0 Z = 0 Z = 0 N = 1 ; result is negative Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1						
$ \begin{tabular}{lllllllllllllllllllllllllllllllllll$			•	•		
Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process Write to destination Example 1: SUBFWB REG, 1, 0 Before Instruction REG = 3 W = 2 C = 1 After Instruction REG = FF W = 2 C = 0 Z = 0 N = 1; result is negative Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1				•		
Literal Offset Mode" for details. Words: 1 Cycles: 1 Q Cycle Activity: Q1		Section 24.2	2.3 "Byte-Orie	nted and		
Words: 1 Cycles: 1 Q Cycle Activity: Q1						
Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read register 'f' Process Data Write to destination Example 1: SUBFWB REG, 1, 0 Before Instruction REG = 3 W = 2 C C = 1 After Instruction REG = FF W = 2 C C = 0 C C = 0 C C = 0 C C = 0 C C = 0 C C C = 0 C C C = 0 C C C = 0 C C C C	Words:		THOUS IOI U	o.ano.		
Q Cycle Activity: Q1		·				
Q1 Q2 Q3 Q4 Decode Read register 'f' Process Data Write to destination Example 1: SUBFWB REG, 1, 0 Before Instruction REG = 3 W = 2 C						
$ \begin{array}{ c c c c c } \hline Decode & Read \\ \hline register 'f' & Data & destination \\ \hline \hline Example 1: & SUBFWB & REG, 1, 0 \\ \hline Before Instruction & REG & = & 3 \\ W & = & 2 \\ C & = & 1 \\ \hline After Instruction & REG & = & FF \\ W & = & 2 \\ C & = & 0 \\ Z & = & 0 \\ X & = & 1 \\ \hline REG & = & 1 \\ \hline REG & = & 2 \\ C & = & 0 \\ \hline REG & = & 2 \\ $		02	O2	04		
register f' Data destination			1	1		
Before Instruction REG = 3 W = 2 C = 1 After Instruction REG = FF W = 2 C = 0 Z = 0 N = 1; result is negative Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 5 C = 1	Decode					
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	Example 1:	SUBFWB	REG, 1, 0			
$\begin{array}{cccccccccccccccccccccccccccccccccccc$						
After Instruction REG = FF W = 2 C = 0 Z = 0 N = 1 ; result is negative Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1		= 3 = 2				
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	~	· ·				
$\begin{array}{cccccccccccccccccccccccccccccccccccc$						
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	W	= 2				
Example 2: SUBFWB REG, 0, 0 Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1	Z	= 0				
Before Instruction REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1			•			
REG = 2 W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1			REG, 0, 0			
W = 5 C = 1 After Instruction REG = 2 W = 3 C = 1						
After Instruction REG = 2 W = 3 C = 1	W	= 5				
REG = 2 W = 3 C = 1	_	•				
C = 1	REG	= 2				
Z = 0	Z	= 0	- 10.2			
N = 0 ; result is positive	• •	•	•			
Example 3: SUBFWB REG, 1, 0 Before Instruction	<u> </u>		KEG, 1, 0			
REG = 1						
W = 2 C = 0		_				
After Instruction	_	•				
REG = 0		•				
W = 2 C = 1						
Z = 1 ; result is zero N = 0	7	= 1 : re	sult is zero			

SUBLW	Subtract W from I	teral	SUBWF	Subtract W from f
Syntax:	SUBLW k		Syntax:	SUBWF f {,d {,a}}
Operands:	$0 \le k \le 255$		Operands:	$0 \le f \le 255$
Operation:	$k-(W)\toW$			$d \in [0,1]$
Status Affected:	N, OV, C, DC, Z		0	a ∈ [0,1]
Encoding:	0000 1000	kkkk kkkk	Operation:	$(f) - (W) \rightarrow dest$
Description:	W is subtracted fro	m the eight-bit	Status Affected:	N, OV, C, DC, Z
·	literal 'k'. The resul	is placed in W.	Encoding:	0101 11da ffff ffff
Words:	1		Description:	Subtract W from register 'f' (2's complement method). If 'd' is '0', the
Cycles:	1			result is stored in W. If 'd' is '1', the res
Q Cycle Activity:				is stored back in register 'f' (default).
Q1	Q2 Q3	Q4		If 'a' is '0', the Access Bank is selected
Decode	Read Proce literal 'k' Data			If 'a' is '1', the BSR is used to select the GPR bank (default).
Example 1:	SUBLW 02h			If 'a' is '0' and the extended instruction
Before Instruct				set is enabled, this instruction operate in Indexed Literal Offset Addressing
W	= 01h			mode whenever f ≤ 95 (5Fh). See
C After Instruction	= ?			Section 24.2.3 "Byte-Oriented and
W	= 01h			Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.
C Z	= 1 ; result is p	oositive	Words:	1
N	= 0		Cycles:	1
Example 2:	SUBLW 02h		Q Cycle Activity:	·
Before Instruct			Q Oyole Activity.	Q2 Q3 Q4
W C	= 02h = ?		Decode	Read Process Write to
After Instruction				register 'f' Data destination
W C	= 00h = 1 ; result is 2	ero	Example 1:	SUBWF REG, 1, 0
Z N	= 1 = 0		Before Instru	
Example 3:	SUBLW 02h		REG W	= 3 = 2
Before Instruct			C After Instruct	= ?
W	= 03h		REG	= 1
C After Instructio	= ?		W C	= 2 = 1 ; result is positive
W Alter Instruction	n = FFh ; (2's com	olement)	Z	= 0
C Z	= 0 ; result is 1 = 0		N Example 2:	= 0
N	= 1		Example 2: Before Instru	SUBWF REG, 0, 0
			REG	= 2
			W C	= 2 = ?
			After Instruct	
			REG	= 2
			W C	= 0 = 1 ; result is zero
			Ž N	= 1 = 0
			Example 3:	SUBWF REG, 1, 0
			Before Instru	
			REG	= 1
			W C	= 2 = ?
			After Instruct	ion
			REG W	= FFh ;(2's complement) = 2
			C Z	= 0 ; result is negative
			Z	= 0

SUBWFB	Subtract W	/ from f with B	orrow	SWAPF	Swap f		
Syntax:	SUBWFB	f {,d {,a}}		Syntax:	SWAPF f	{,d {,a}}	
Operands:	0 ≤ f ≤ 255			Operands:	$0 \le f \le 255$		
	$d \in [0,1]$ $a \in [0,1]$				d ∈ [0,1]		
Operation:	$a \in [0,1]$ (f) - (W) - ((C) \ dest			a ∈ [0,1]		
Status Affected:	N, OV, C, E	. ,		Operation:	(f<3:0>) → (f<7:4>) →	dest<7:4>,	
Encoding:	0101	10da fff	f ffff	0	` ,	uesi<3.0>	
Description:		and the Carry		Status Affected		1	
Description.		er 'f' (2's comple		Encoding:	0011		ff ffff
	,	'd' is '0', the res		Description:		and lower nib anged. If 'd' is	
		s '1', the result is	s stored back			nanged. ii d is n W. If 'd' is '1	•
	in register "	` ,			•	egister 'f' (defa	
	•	he Access Ban he BSR is used			If 'a' is '0',	the Access Ba	ank is selecte
	GPR bank		to select the		•	the BSR is use	ed to select th
	If 'a' is '0' a	nd the extende	d instruction		GPR bank	` ,	
		led, this instruct	•			and the extend led, this instru	
		Literal Offset Ad never f ≤ 95 (5F	•			Literal Offset	•
		.2.3 "Byte-Orie			mode whe	never $f \le 95$ (5)	5Fh). See
	Bit-Oriente	ed Instructions	in Indexed			1.2.3 "Byte-O	
	Literal Offs	set Mode" for o	letails.			ed Instruction set Mode" for	
Words:	1			Words:	1		
Cycles:	1			Cycles:	1		
Q Cycle Activity:	00	00	0.4	Q Cycle Activ			
Q1 Decode	Q2 Read	Q3 Process	Q4 Write to	Q Cycle Activ	Q2	Q3	Q4
Decode	register 'f'	Data	destination	Decod		Process	Write to
Example 1:	SUBWFB	REG, 1, 0			register 'f'	Data	destination
Before Instruc	ction						
REG W	= 19h = 0Dh	(0001 100 (0000 110		Example:	SWAPF	REG, 1, 0	
Č	= 1	(0000 110	Ι)	Before In	struction		
After Instruction				REC			
REG W	= 0Ch = 0Dh	(0000 101 (0000 110		After Inst REG			
C Z	= 1 = 0				30		
N	= 0	; result is po	sitive				
Example 2:	SUBWFB	REG, 0, 0					
Before Instruc							
REG W	= 1Bh = 1Ah	(0001 101 (0001 101					
С	= 0	(0001 101	0)				
After Instruction		/0001 101	7.)				
W	= 1Bh = 00h	(0001 101	1)				
C Z	= 1 = 1	; result is ze	ro				
N	= 0	, 103011 13 20	10				
Example 3:	SUBWFB	REG, 1, 0					
Before Instruc			- >				
REG W	= 03h = 0Eh	(0000 001 (0000 110					
С	= 1	, 110	•				
After Instruction		(1111 010	0)				
DEC			VIII				
REG	= F5h	; [2's comp]					
W	= 0Eh						
		; [2's comp]	1)				

TBLRD	Table Read					
Syntax:	TBLRD (*;	TBLRD (*; *+; *-; +*)				
Operands:	None					
Operation:	if TBLRD *, (Prog Mem (TBLPTR)) → TABLAT; TBLPTR – No Change if TBLRD *+, (Prog Mem (TBLPTR)) → TABLAT; (TBLPTR) + 1 → TBLPTR if TBLRD *-, (Prog Mem (TBLPTR)) → TABLAT; (TBLPTR) – 1 → TBLPTR if TBLRD +*, (TBLPTR) + 1 → TBLPTR; (Prog Mem (TBLPTR)) → TABLAT					
Status Affected:	None					
Encoding:	0000	0000	0000	10nn nn=0 * =1 *+ =2 *- =3 +*		
Description:	This instruction is used to read the contents of Program Memory (P.M.). To address the program memory, a pointer called Table Pointer (TBLPTR) is used.					
	The TBLPT	R (a 21-bit	pointer) po	oints to		

TBLRD Table Read (Continued) Example 1: TBLRD *+; Before Instruction TABLAT TBLPTR 55h 00A356h 34h = MEMORY(00A356h) After Instruction TABLAT TBLPTR 34h 00A357h Example 2: TBLRD +*; Before Instruction TABLAT TBLPTR MEMORY(01A357h) MEMORY(01A358h) AAh 01A357h 12h = 34h = After Instruction TABLAT TBLPTR 34h 01A358h

has a 2-Mbyte address range.

TBLPTR[0] = 0: Least Significant Byte of Program Memory Word

each byte in the program memory. TBLPTR

TBLPTR[0] = 1: Most Significant Byte of Program Memory Word

The TBLRD instruction can modify the value of TBLPTR as follows:

• no change

post-increment

post-decrement

pre-increment

Words: 1 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No	No	No
	operation	operation	operation
No operation	No operation (Read Program Memory)	No operation	No operation (Write TABLAT)

TBLWT	Table Wri	te			
Syntax:	TBLWT ('	*; *+; *-; + [*]	·)		
Operands:	None				
Operation:	if TBLWT*, (TABLAT) → Holding Register; TBLPTR – No Change if TBLWT*+, (TABLAT) → Holding Register;				
	(TBLPTR) + 1 → TBLPTR if TBLWT*-, (TABLAT) → Holding Register;				
	(TBLPTR) – 1 → TBLPTR if TBLWT+*, (TBLPTR) + 1 → TBLPTR;				
	(TABLAT)				
Status Affected:	None				
Encoding:	0000	0000	0000	11nn nn=0 * =1 *+ =2 *- =3 +*	
Description:	This instru	o determir	ne which c	of the	
	to. The ho	_		T is written sed to	
	program tl (P.M.). (Re Organizat programm	efer to Sec t ion " for a	ction 5.0 ' additional d		
	The TBLP	_	• /) points to	
	each byte TBLPTR h The LSb of byte of the access.	nas a 2-Mb of the TBL	oyte addre	ess range. ets which	
	TBLPT	• •		nificant Byte m Memory	
	TBLPT			ificant Byte m Memory	
	The TBLW value of T			odify the	
	• no char	_			
	 post-ind 	crement crement			
	 post ac pre-incr 				
Words:	1				
Cycles:	2				
Q Cycle Activity:					
	Q1	Q2	Q3	Q4	
	Decode	No operation	No operation	No operation	
	No	No	No	No	
	operation	operation (Read	operation	operation (Write to	
		TÀBLAT)		Holding Register)	

TBLWT	Table Write (Conti	nued)
Example 1:	TBLWT *+;		
Before Instru	ıction		
TABLA ⁻ TBLPTI HOLDII		= =	55h 00A356h
(00A35		=	FFh
After Instruc	tions (table write	comp	oletion)
TABLA	•	=	55h
TBLPTI	R NG REGISTER	=	00A357h
(00A35		=	55h
Example 2:	TBLWT +*;		
Before Instru	ıction		
TABLA	=	=	34h
TBLPTI	· ·	=	01389Ah
(01389	NG REGISTER Ah) NG REGISTER	=	FFh
(01389	Bh)	=	FFh
After Instruc	tion (table write	compl	etion)
TABLA	•	=	34h
TBLPTI	R NG REGISTER	=	01389Bh
(01389)		=	FFh
(01389)	Bh)	=	34h

Note: The TBLWT instruction cannot be used in normal operating modes to write to on-chip program memory. It can only be used by PIC18F8XJ10/8XJ15 devices with the external memory interface when writing to an external memory device.

The TBLWT instruction can be used to write to on-chip program memory only in ICSPTM mode.

For more information, refer to Section 6.4 "Writing to Program Memory Space (PIC18F8XJ10/8XJ15 Devices Only)" and Section 6.7 "Flash Program Operation During Code Protection".

TSTFSZ Test f, Skip if 0 Syntax: TSTFSZ f {,a} Operands: $0 \le f \le 255$ $a \in [0,1]$ Operation: skip if f = 0Status Affected: None Encoding: 0110 011a ffff ffff Description: If 'f' = 0, the next instruction fetched during the current instruction execution is discarded and a NOP is executed,

making this a two-cycle instruction. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates

mode whenever f ≤ 95 (5Fh). See Section 24.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.

in Indexed Literal Offset Addressing

Words: 1
Cycles: 1(2)

Note: 3 cycles if skip and followed

by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	No
	register 'f'	Data	operation

If skip:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No	No	No	No
operation	operation	operation	operation
No	No	No	No
operation	operation	operation	operation

Example: HERE TSTFSZ CNT, 1

NZERO : ZERO :

Before Instruction

PC = Address (HERE)

After Instruction

If CNT = 00h,

 $\begin{array}{lll} PC & = & Add ress \ ({\tt ZERO}) \\ \text{If CNT} & \neq & 00h, \\ PC & = & Address \ ({\tt NZERO}) \end{array}$

XOR	LW	Exclusive OR Literal with W						
Synta	ax:	XORLW	XORLW k					
Oper	ands:	$0 \le k \le 25$	5					
Oper	ation:	(W) .XOR	$k \to W$					
Statu	s Affected:	N, Z						
Enco	ding:	0000 1010 kkkk kkkk						
Desc	ription:	The conte the 8-bit li in W.						
Word	ls:	1						
Cycle	es:	1						
QC	ycle Activity:							
	Q1	Q2	Q3		Q4			
	Decode	Read literal 'k'	Proce Data		Write to W			

Example: XORLW 0AFh

Before Instruction
W = B5h
After Instruction

W = 1Ah

XORWF	Exclusive OR W with f	

Syntax: XORWF f {,d {,a}}

Operands: $0 \le f \le 255 \\ d \in [0,1]$

 $a \in [0,1]$

Operation: (W) .XOR. (f) \rightarrow dest

Status Affected: N, Z

Encoding: 0001 10da ffff ffff

Description: Exclusive OR the contents of W with register 'f'. If 'd' is '0', the result is stored

in W. If 'd' is '1', the result is stored back in the register 'f' (default).

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

GPR bank (default).

If 'a' is 'o' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f \leq 95 (5Fh). See Section 24.2.3 "Byte-Oriented and

Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: XORWF REG, 1, 0

Before Instruction

REG = AFh W = B5h

After Instruction

REG = 1Ah W = B5h

24.2 Extended Instruction Set

In addition to the standard 75 instructions of the PIC18 instruction set, the PIC18F87J10 family of devices also provide an optional extension to the core CPU functionality. The added features include eight additional instructions that augment indirect and indexed addressing operations and the implementation of Indexed Literal Offset Addressing for many of the standard PIC18 instructions.

The additional features of the extended instruction set are enabled by default on unprogrammed devices. Users must properly set or clear the XINST configuration bit during programming to enable or disable these features.

The instructions in the extended set can all be classified as literal operations, which either manipulate the File Select Registers, or use them for indexed addressing. Two of the instructions, ADDFSR and SUBFSR, each have an additional special instantiation for using FSR2. These versions (ADDULNK and SUBULNK) allow for automatic return after execution.

The extended instructions are specifically implemented to optimize re-entrant program code (that is, code that is recursive or that uses a software stack) written in high-level languages, particularly C. Among other things, they allow users working in high-level languages to perform certain operations on data structures more efficiently. These include:

- dynamic allocation and deallocation of software stack space when entering and leaving subroutines
- function pointer invocation
- software stack pointer manipulation
- manipulation of variables located in a software stack

A summary of the instructions in the extended instruction set is provided in Table 24-3. Detailed descriptions are provided in **Section 24.2.2 "Extended Instruction Set"**. The opcode field descriptions in Table 24-1 (page 280) apply to both the standard and extended PIC18 instruction sets.

Note: The instruction set extension and the Indexed Literal Offset Addressing mode were designed for optimizing applications written in C; the user may likely never use these instructions directly in assembler. The syntax for these commands is provided as a reference for users who may be reviewing code that has been generated by a compiler.

24.2.1 EXTENDED INSTRUCTION SYNTAX

Most of the extended instructions use indexed arguments, using one of the File Select Registers and some offset to specify a source or destination register. When an argument for an instruction serves as part of indexed addressing, it is enclosed in square brackets ("[]"). This is done to indicate that the argument is used as an index or offset. The MPASMTM Assembler will flag an error if it determines that an index or offset value is not bracketed.

When the extended instruction set is enabled, brackets are also used to indicate index arguments in byte-oriented and bit-oriented instructions. This is in addition to other changes in their syntax. For more details, see Section 24.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands".

Note: In the past, square brackets have been used to denote optional arguments in the PIC18 and earlier instruction sets. In this text and going forward, optional arguments are denoted by braces ("{ }").

TABLE 24-3: EXTENSIONS TO THE PIC18 INSTRUCTION SET

Mnemonic,		Description	Cycles	16-E	16-Bit Instruction Word			Status	
Opera	nds	Description Cyc		MSb			LSb	Affected	
ADDFSR	f, k	Add literal to FSR	1	1110	1000	ffkk	kkkk	None	
ADDULNK	k	Add literal to FSR2 and return	2	1110	1000	11kk	kkkk	None	
CALLW		Call subroutine using WREG	2	0000	0000	0001	0100	None	
MOVSF	z_s , f_d	Move z _s (source) to 1st word	2	1110	1011	0zzz	ZZZZ	None	
		f _d (destination) 2nd word		1111	ffff	ffff	ffff		
MOVSS	z_s, z_d	Move z _s (source) to 1st word	2	1110	1011	1zzz	ZZZZ	None	
		z _d (destination) 2nd word		1111	xxxx	XZZZ	ZZZZ		
PUSHL	k	Store literal at FSR2, decrement FSR2	1	1110	1010	kkkk	kkkk	None	
SUBFSR	f, k	Subtract literal from FSR	1	1110	1001	ffkk	kkkk	None	
SUBULNK	k	Subtract literal from FSR2 and return	2	1110	1001	11kk	kkkk	None	

24.2.2 EXTENDED INSTRUCTION SET

ADD	FSR	Add Literal to FSR					
Synta	ax:	ADDFSR	f, k				
Oper	ands:		$0 \le k \le 63$ $f \in [0, 1, 2]$				
Oper	ation:	FSR(f) + k	$c \to FSR($	f)			
Statu	s Affected:	None					
Enco	ding:	1110	1110 1000 ffkk kkkk				
Description: The 6-bit literal 'k' is added to the contents of the FSR specified by 'f'							
Word	ls:	1					
Cycle	es:	1					
QC	ycle Activity:						
	Q1	Q2	Q3			Q4	
	Decode	Read literal 'k'	Proces Data		V	/rite to FSR	

Example: ADDFSR 2, 23h

Before Instruction

FSR2 = 03FFh

After Instruction

FSR2 = 0422h

ADDULNK	Add Literal to FSR2 and Return				
Syntax:	ADDULNK k				
Operands:	$0 \le k \le 63$				
Operation:	$FSR2 + k \rightarrow FSR2$,				
	$(TOS) \to$	PC			
Status Affected:	None				
Encoding:	1110	1000	11kk	kkkk	
Description:	The 6-bit literal 'k' is added to the contents of FSR2. A RETURN is then executed by loading the PC with the TOS.				
	The instruction takes two cycles to execute; a NOP is performed during the second cycle.				
	This may be thought of as a special case of the ADDFSR instruction, where f = 3 (binary '11'); it operates only on FSR2.				
Words:	1				
Cycles:	2				

	literal 'k'	Data	FSR
No	No	No	No
Operation	Operation	Operation	Operatio

Q3

Process

Q4

Write to

Q2

Read

Example: ADDULNK 23h

Before Instruction

FSR2 = 03FFh PC = 0100h

After Instruction

Q Cycle Activity:

Q1

Decode

FSR2 = 0422hPC = (TOS)

Note: All PIC18 instructions may take an optional label argument preceding the instruction mnemonic for use in symbolic addressing. If a label is used, the instruction format then becomes: {label} instruction argument(s).

CALLW	Subroutin	e Call us	ing WRE	3
Syntax:	CALLW			
Operands:	None			
Operation:	$(PC + 2) \rightarrow TOS,$ $(W) \rightarrow PCL,$ $(PCLATH) \rightarrow PCH,$ $(PCLATU) \rightarrow PCU$			
Status Affected:	None			
Encoding:	0000	0000	0001	0100
Description	First, the return address (PC + 2) is pushed onto the return stack. Next, the contents of W are written to PCL; the existing value is discarded. Then, the			

existing value is discarded. Then, the contents of PCLATH and PCLATU are latched into PCH and PCU, respectively. The second cycle is executed as a NOP instruction while the new next instruction is fetched.

Unlike $\mathtt{CALL},$ there is no option to update W, STATUS or BSR.

Words: 1 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Push PC to	No
	WREG	stack	operation
No	No	No	No
operation	operation	operation	operation

Example:	HE	RE (CALLW
Before Instruc	tion		
PC PCLATH PCLATU W		address 10h 00h 06h	(HERE)
After Instruction	n		
PC TOS PCLATH	= = =	001006h address 10h	(HERE + 2)

06h

MOVSF	Move Inde	xed to f		
Syntax:	MOVSF [z	z _s], f _d		
Operands:	$0 \le z_s \le 127$ $0 \le f_d \le 409$			
Operation:	((FSR2) + z	$(s) \rightarrow f_d$		
Status Affected:	None			
Encoding: 1st word (source) 2nd word (destin.)	1110 1111	1011 ffff	0zzz ffff	zzzz _s ffff _d
Description:	The contents of the source register are moved to destination register 'f _d '. The actual address of the source register is determined by adding the 7-bit literal offset 'z _s ', in the first word, to the value of FSR2. The address of the destination register is specified by the 12-bit literal 'f _d ' in the second word. Both addresses can be anywhere in the 4096-byte data space (000h to FFFh).			
	The MOVSF PCL, TOSU destination	J, TOSH		
	If the results an indirect a value return	addressi	ng registei	•

Words: 2
Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Determine	Determine	Read
	source addr	source addr	source reg
Decode	No	No	Write
	operation	operation	register 'f'
	No dummy		(dest)
	read		

Example: MOVSF [05h], REG2 Before Instruction FSR2 Contents of 85h 80h 33h REG2 11h After Instruction FSR2 Contents 80h of 85h 33h REG2 33h

MOVSS	Move Inde	exed to Ir	ndexed	
Syntax:	MOVSS $[z_s], [z_d]$			
Operands:	$0 \le z_s \le 127$ $0 \le z_d \le 127$			
Operation:	$((FSR2) + z_s) \rightarrow ((FSR2) + z_d)$			
Status Affected:	None			
Encoding: 1st word (source) 2nd word (dest.) Description	1110 1011 1zzz zzzzs 11111 xxxx xzzz zzzzd The contents of the source register are moved to the destination register. The addresses of the source and destination registers are determined by adding the			zzzz _d gister are ster. The estination
	registers are determined by adding the 7-bit literal offsets 'z _s ' or 'z _d ', respectively, to the value of FSR2. Both registers can be located anywhere in the 4096-byte data memory space (000h to FFFh).			

The MOVSS instruction cannot use the PCL, TOSU, TOSH or TOSL as the destination register.

If the resultant source address points to an indirect addressing register, the value returned will be 00h. If the resultant destination address points to an indirect addressing register, the instruction will execute as a NOP.

Words: 2 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Determine	Determine	Read
	source addr	source addr	source reg
Decode	Determine	Determine	Write
	dest addr	dest addr	to dest reg

Example: [05h], [06h] MOVSS Before Instruction FSR2 80h Contents of 85h Contents 33h of 86h 11h After Instruction FSR2 80h Contents 33h of 85h Contents 33h of 86h

PUSHL	Store Litera	al at FSR	2, Decre	ment FSR2
Syntax:	PUSHL k			
Operands:	$0 \le k \le 255$			
Operation:	•	$k \rightarrow (FSR2),$ FSR2 – 1 \rightarrow FSR2		
Status Affected:	None			
Encoding:	1111	1010	kkkk	kkkk
Description:	The 8-bit literal 'k' is written to the data memory address specified by FSR2. FSR2 is decremented by 1 after the operation. This instruction allows users to push values onto a software stack			
Words:	1	a sonwa	ic stack	•
Cycles:	1			
Q Cycle Activity:				
Q1	Q2	C	13	Q4
Decode	Read 'k'	Prod		Write to destination

Example: PUSHL 08h

Before Instruction

 $\begin{array}{lll} \mbox{FSR2H:FSR2L} & = & \mbox{01ECh} \\ \mbox{Memory (01ECh)} & = & \mbox{00h} \end{array}$

After Instruction

FSR2H:FSR2L = 01EBh Memory (01ECh) = 08h

SUBFSR Subtract Literal from FSR Syntax: SUBFSR f, k Operands: $0 \le k \le 63$ $f \in [0, 1, 2]$ Operation: $FSRf-k \to FSRf$ Status Affected: None Encoding: 1001 ffkk 1110 kkkk Description: The 6-bit literal 'k' is subtracted from the contents of the FSR specified by 'f'. Words: 1 1

Cycles: Q Cycle Activity:

> Q1 Q2 Q3 Q4 Decode Read Process Write to register 'f' Data destination

Example: SUBFSR 2, 23h

Before Instruction

FSR2 03FFh

After Instruction

FSR2 03DCh

SUBULNK	Subtract Literal from FSR2 and Return			
Syntax:	SUBULNK	C k		
Operands:	$0 \le k \le 63$			
Operation:	FSR2 - k	\rightarrow FSR2		
	$(TOS) \to PC$			
Status Affected:	None			
Encoding:	1110	1001	11kk	kkkk
Description:	The 6-bit literal 'k' is subtracted from the contents of the FSR2. A RETURN is then executed by loading the PC with the TOS.			
	The instruction takes two cycles to execute; a NOP is performed during the second cycle.			
	This may be thought of as a special case of the SUBFSR instruction, where f = 3 (binary '11'); it operates only on FSR2.			

Cycles: Q Cycle Activity: Q1 Q2 Q3 Q4 Decode Read Process

Write to register 'f' Data destination No No No No Operation Operation Operation Operation

Example: SUBULNK 23h

1

2

Before Instruction

Words:

FSR2 03FFh PC 0100h

After Instruction

03DCh FSR2 PC (TOS)

24.2.3 BYTE-ORIENTED AND BIT-ORIENTED INSTRUCTIONS IN INDEXED LITERAL OFFSET MODE

Note: Enabling the PIC18 instruction set extension may cause legacy applications to behave erratically or fail entirely.

In addition to eight new commands in the extended set, enabling the extended instruction set also enables Indexed Literal Offset Addressing (Section 5.6.1 "Indexed Addressing with Literal Offset"). This has a significant impact on the way that many commands of the standard PIC18 instruction set are interpreted.

When the extended set is disabled, addresses embedded in opcodes are treated as literal memory locations: either as a location in the Access Bank (a = 0) or in a GPR bank designated by the BSR (a = 1). When the extended instruction set is enabled and a = 0, however, a file register argument of 5Fh or less is interpreted as an offset from the pointer value in FSR2 and not as a literal address. For practical purposes, this means that all instructions that use the Access RAM bit as an argument – that is, all byte-oriented and bit-oriented instructions, or almost half of the core PIC18 instructions – may behave differently when the extended instruction set is enabled.

When the content of FSR2 is 00h, the boundaries of the Access RAM are essentially remapped to their original values. This may be useful in creating backward-compatible code. If this technique is used, it may be necessary to save the value of FSR2 and restore it when moving back and forth between C and assembly routines in order to preserve the Stack Pointer. Users must also keep in mind the syntax requirements of the extended instruction set (see Section 24.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands").

Although the Indexed Literal Offset mode can be very useful for dynamic stack and pointer manipulation, it can also be very annoying if a simple arithmetic operation is carried out on the wrong register. Users who are accustomed to the PIC18 programming must keep in mind that, when the extended instruction set is enabled, register addresses of 5Fh or less are used for Indexed Literal Offset Addressing.

Representative examples of typical byte-oriented and bit-oriented instructions in the Indexed Literal Offset mode are provided on the following page to show how execution is affected. The operand conditions shown in the examples are applicable to all instructions of these types.

24.2.3.1 Extended Instruction Syntax with Standard PIC18 Commands

When the extended instruction set is enabled, the file register argument 'f' in the standard byte-oriented and bit-oriented commands is replaced with the literal offset value 'k'. As already noted, this occurs only when 'f' is less than or equal to 5Fh. When an offset value is used, it must be indicated by square brackets ("[]"). As with the extended instructions, the use of brackets indicates to the compiler that the value is to be interpreted as an index or an offset. Omitting the brackets, or using a value greater than 5Fh within the brackets, will generate an error in the MPASM Assembler.

If the index argument is properly bracketed for Indexed Literal Offset Addressing, the Access RAM argument is never specified; it will automatically be assumed to be 'o'. This is in contrast to standard operation (extended instruction set disabled), when 'a' is set on the basis of the target address. Declaring the Access RAM bit in this mode will also generate an error in the MPASM Assembler.

The destination argument 'd' functions as before.

In the latest versions of the MPASM Assembler, language support for the extended instruction set must be explicitly invoked. This is done with either the command line option, /y, or the PE directive in the source listing.

24.2.4 CONSIDERATIONS WHEN ENABLING THE EXTENDED INSTRUCTION SET

It is important to note that the extensions to the instruction set may not be beneficial to all users. In particular, users who are not writing code that uses a software stack may not benefit from using the extensions to the instruction set.

Additionally, the Indexed Literal Offset Addressing mode may create issues with legacy applications written to the PIC18 assembler. This is because instructions in the legacy code may attempt to address registers in the Access Bank below 5Fh. Since these addresses are interpreted as literal offsets to FSR2 when the instruction set extension is enabled, the application may read or write to the wrong data addresses.

When porting an application to the PIC18F87J10 family, it is very important to consider the type of code. A large, re-entrant application that is written in C and would benefit from efficient compilation will do well when using the instruction set extensions. Legacy applications that heavily use the Access Bank will most likely not benefit from using the extended instruction set

ADDWF ADD W to Indexed (Indexed Literal Offset mode)

Syntax: ADDWF $[k] \{d\}$ Operands: $0 \le k \le 95$

d ∈ [0,1]

Operation: $(W) + ((FSR2) + k) \rightarrow dest$

Status Affected: N, OV, C, DC, Z

Encoding: 0010 01d0 kkkk kkkk

Description: The contents of W are added to the contents of the register indicated by

FSR2, offset by the value 'k'.

If 'd' is '0', the result is stored in W. If 'd'

is '1', the result is stored back in register 'f' (default).

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read 'k'	Process	Write to
		Data	destination

Example: ADDWF [OFST], 0

Before Instruction

W = 17h OFST = 2Ch FSR2 = 0A00h Contents of 0A2Ch = 20h

After Instruction

W = 37h Contents of 0A2Ch = 20h BSF Bit Set Indexed (Indexed Literal Offset mode)

Syntax: BSF [k], b Operands: $0 \le f \le 95$

 $0 \le b \le 7$ Operation: $1 \to ((FSR2) + k) < b >$

Status Affected: None

Encoding: 1000 bbb0 kkkk kkkk

Description: Bit 'b' of the register indicated by FSR2,

offset by the value 'k', is set.

Words: 1
Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write to
	register 'f'	Data	destination

Example: BSF [FLAG OFST], 7

Before Instruction

FLAG_OFST = 0Ah FSR2 = 0A00h Contents of 0A0Ah = 55h

After Instruction

Contents of 0A0Ah = D5h

SETF Set Indexed (Indexed Literal Offset mode)

Syntax: SETF [k] Operands: $0 \le k \le 95$

Operation: $FFh \rightarrow ((FSR2) + k)$

Status Affected: None

Encoding: 0110 1000 kkkk kkkk

Description: The contents of the register indicated by

FSR2, offset by 'k', are set to FFh.

Words: 1
Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read 'k'	Process	Write
		Data	register

Example: SETF [OFST]

Before Instruction

OFST = 2Ch FSR2 = 0A00h Contents of 0A2Ch = 00h

After Instruction

Contents of 0A2Ch = FFh

24.2.5 SPECIAL CONSIDERATIONS WITH MICROCHIP MPLAB® IDE TOOLS

The latest versions of Microchip's software tools have been designed to fully support the extended instruction set for the PIC18F87J10 family. This includes the MPLAB C18 C Compiler, MPASM assembly language and MPLAB Integrated Development Environment (IDE).

When selecting a target device for software development, MPLAB IDE will automatically set default configuration bits for that device. The default setting for the XINST configuration is '0', disabling the extended instruction set and Indexed Literal Offset Addressing. For proper execution of applications developed to take advantage of the extended instruction set, XINST must be set during programming.

To develop software for the extended instruction set, the user must enable support for the instructions and the Indexed Addressing mode in their language tool(s). Depending on the environment being used, this may be done in several ways:

- A menu option or dialog box within the environment that allows the user to configure the language tool and its settings for the project
- · A command line option
- · A directive in the source code

These options vary between different compilers, assemblers and development environments. Users are encouraged to review the documentation accompanying their development systems for the appropriate information.

25.0 DEVELOPMENT SUPPORT

The PICmicro[®] microcontrollers are supported with a full range of hardware and software development tools:

- Integrated Development Environment
 - MPLAB® IDE Software
- · Assemblers/Compilers/Linkers
 - MPASMTM Assembler
 - MPLAB C17 and MPLAB C18 C Compilers
 - MPLINK[™] Object Linker/ MPLIB[™] Object Librarian
 - MPLAB C30 C Compiler
 - MPLAB ASM30 Assembler/Linker/Library
- Simulators
 - MPLAB SIM Software Simulator
 - MPLAB dsPIC30 Software Simulator
- Emulators
 - MPLAB ICE 2000 In-Circuit Emulator
 - MPLAB ICE 4000 In-Circuit Emulator
- In-Circuit Debugger
 - MPLAB ICD 2
- · Device Programmers
 - PRO MATE® II Universal Device Programmer
 - PICSTART® Plus Development Programmer
 - MPLAB PM3 Device Programmer
- · Low-Cost Demonstration Boards
 - PICDEM™ 1 Demonstration Board
 - PICDEM.net™ Demonstration Board
 - PICDEM 2 Plus Demonstration Board
 - PICDEM 3 Demonstration Board
 - PICDEM 4 Demonstration Board
 - PICDEM 17 Demonstration Board
 - PICDEM 18R Demonstration Board
 - PICDEM LIN Demonstration Board
 - PICDEM USB Demonstration Board
- Evaluation Kits
 - KEELOQ® Evaluation and Programming Tools
 - PICDEM MSC
 - microID® Developer Kits
 - CAN
 - PowerSmart® Developer Kits
 - Analog

25.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16-bit microcontroller market. The MPLAB IDE is a Windows® based application that contains:

- · An interface to debugging tools
 - simulator
 - programmer (sold separately)
 - emulator (sold separately)
 - in-circuit debugger (sold separately)
- · A full-featured editor with color coded context
- · A multiple project manager
- Customizable data windows with direct edit of contents
- · High-level source code debugging
- Mouse over variable inspection
- · Extensive on-line help

The MPLAB IDE allows you to:

- Edit your source files (either assembly or C)
- One touch assemble (or compile) and download to PICmicro emulator and simulator tools (automatically updates all project information)
- · Debug using:
 - source files (assembly or C)
 - mixed assembly and C
 - machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increasing flexibility and power.

25.2 MPASM Assembler

The MPASM assembler is a full-featured, universal macro assembler for all PICmicro MCUs.

The MPASM assembler generates relocatable object files for the MPLINK object linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM assembler features include:

- Integration into MPLAB IDE projects
- User defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

25.3 MPLAB C17 and MPLAB C18 C Compilers

The MPLAB C17 and MPLAB C18 Code Development Systems are complete ANSI C compilers for Microchip's PIC17CXXX and PIC18CXXX family of microcontrollers. These compilers provide powerful integration capabilities, superior code optimization and ease of use not found with other compilers.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

25.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK object linker combines relocatable objects created by the MPASM assembler and the MPLAB C17 and MPLAB C18 C compilers. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB object librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

25.5 MPLAB C30 C Compiler

The MPLAB C30 C compiler is a full-featured, ANSI compliant, optimizing compiler that translates standard ANSI C programs into dsPIC30F assembly language source. The compiler also supports many command line options and language extensions to take full advantage of the dsPIC30F device hardware capabilities and afford fine control of the compiler code generator.

MPLAB C30 is distributed with a complete ANSI C standard library. All library functions have been validated and conform to the ANSI C library standard. The library includes functions for string manipulation, dynamic memory allocation, data conversion, time-keeping and math functions (trigonometric, exponential and hyperbolic). The compiler provides symbolic information for high-level source debugging with the MPLAB IDE.

25.6 MPLAB ASM30 Assembler, Linker and Librarian

MPLAB ASM30 assembler produces relocatable machine code from symbolic assembly language for dsPIC30F devices. MPLAB C30 compiler uses the assembler to produce it's object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire dsPIC30F instruction set
- Support for fixed-point and floating-point data
- Command line interface
- · Rich directive set
- · Flexible macro language
- MPLAB IDE compatibility

25.7 MPLAB SIM Software Simulator

The MPLAB SIM software simulator allows code development in a PC hosted environment by simulating the PICmicro series microcontrollers on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a file, or user defined key press, to any pin. The execution can be performed in Single-Step, Execute Until Break or Trace mode.

The MPLAB SIM simulator fully supports symbolic debugging using the MPLAB C17 and MPLAB C18 C Compilers, as well as the MPASM assembler. The software simulator offers the flexibility to develop and debug code outside of the laboratory environment, making it an excellent, economical software development tool.

25.8 MPLAB SIM30 Software Simulator

The MPLAB SIM30 software simulator allows code development in a PC hosted environment by simulating the dsPIC30F series microcontrollers on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a file, or user defined key press, to any of the pins.

The MPLAB SIM30 simulator fully supports symbolic debugging using the MPLAB C30 C Compiler and MPLAB ASM30 assembler. The simulator runs in either a Command Line mode for automated tasks, or from MPLAB IDE. This high-speed simulator is designed to debug, analyze and optimize time intensive DSP routines.

25.9 MPLAB ICE 2000 High-Performance Universal In-Circuit Emulator

The MPLAB ICE 2000 universal in-circuit emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PICmicro microcontrollers. Software control of the MPLAB ICE 2000 in-circuit emulator is advanced by the MPLAB Integrated Development Environment, which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICE 2000 is a full-featured emulator system with enhanced trace, trigger and data monitoring features. Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the MPLAB ICE in-circuit emulator allows expansion to support new PICmicro microcontrollers.

The MPLAB ICE 2000 in-circuit emulator system has been designed as a real-time emulation system with advanced features that are typically found on more expensive development tools. The PC platform and Microsoft[®] Windows 32-bit operating system were chosen to best make these features available in a simple, unified application.

25.10 MPLAB ICE 4000 High-Performance Universal In-Circuit Emulator

The MPLAB ICE 4000 universal in-circuit emulator is intended to provide the product development engineer with a complete microcontroller design tool set for highend PICmicro microcontrollers. Software control of the MPLAB ICE in-circuit emulator is provided by the MPLAB Integrated Development Environment, which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICD 4000 is a premium emulator system, providing the features of MPLAB ICE 2000, but with increased emulation memory and high-speed performance for dsPIC30F and PIC18XXXX devices. Its advanced emulator features include complex triggering and timing, up to 2 Mb of emulation memory and the ability to view variables in real-time.

The MPLAB ICE 4000 in-circuit emulator system has been designed as a real-time emulation system with advanced features that are typically found on more expensive development tools. The PC platform and Microsoft Windows 32-bit operating system were chosen to best make these features available in a simple, unified application.

25.11 MPLAB ICD 2 In-Circuit Debugger

Microchip's In-Circuit Debugger, MPLAB ICD 2, is a powerful, low-cost, run-time development tool, connecting to the host PC via an RS-232 or high-speed USB interface. This tool is based on the Flash PICmicro MCUs and can be used to develop for these and other PICmicro microcontrollers. The MPLAB ICD 2 utilizes the in-circuit debugging capability built into the Flash devices. This feature, along with Microchip's In-Circuit Serial Programming™ (ICSP™) protocol, offers cost effective in-circuit Flash debugging from the graphical user interface of the MPLAB Integrated Development Environment. This enables a designer to develop and debug source code by setting breakpoints, single-stepping and watching variables, CPU status and peripheral registers. Running at full speed enables testing hardware and applications in real-time. MPLAB ICD 2 also serves as a development programmer for selected PICmicro devices.

25.12 PRO MATE II Universal Device Programmer

The PRO MATE II is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features an LCD display for instructions and error messages and a modular detachable socket assembly to support various package types. In Stand-Alone mode, the PRO MATE II device programmer can read, verify and program PICmicro devices without a PC connection. It can also set code protection in this mode.

25.13 MPLAB PM3 Device Programmer

The MPLAB PM3 is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages and a modular detachable socket assembly to support various package types. The ICSP™ cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 device programmer can read, verify and program PICmicro devices without a PC connection. It can also set code protection in this mode. MPLAB PM3 connects to the host PC via an RS-232 or USB cable. MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices and incorporates an SD/MMC card for file storage and secure data applications

25.14 PICSTART Plus Development Programmer

The PICSTART Plus development programmer is an easy-to-use, low-cost, prototype programmer. It connects to the PC via a COM (RS-232) port. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. The PICSTART Plus development programmer supports most PICmicro devices up to 40 pins. Larger pin count devices, such as the PIC16C92X and PIC17C76X, may be supported with an adapter socket. The PICSTART Plus development programmer is CE compliant.

25.15 PICDEM 1 PICmicro Demonstration Board

The PICDEM 1 demonstration board demonstrates the capabilities of the PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The sample microcontrollers provided with the PICDEM 1 demonstration board can be programmed with a PRO MATE II device programmer or a PICSTART Plus development programmer. The PICDEM 1 demonstration board can be connected to the MPLAB ICE in-circuit emulator for testing. A prototype area extends the circuitry for additional application components. Features include an RS-232 interface, a potentiometer for simulated analog input, push button switches and eight LEDs.

25.16 PICDEM.net Internet/Ethernet Demonstration Board

The PICDEM.net demonstration board is an Internet/ Ethernet demonstration board using the PIC18F452 microcontroller and TCP/IP firmware. The board supports any 40-pin DIP device that conforms to the standard pinout used by the PIC16F877 or PIC18C452. This kit features a user friendly TCP/IP stack, web server with HTML, a 24L256 Serial EEPROM for Xmodem download to web pages into Serial EEPROM, ICSP/MPLAB ICD 2 interface connector, an Ethernet interface, RS-232 interface and a 16 x 2 LCD display. Also included is the book and CD-ROM "TCP/IP Lean, Web Servers for Embedded Systems." by Jeremy Bentham

25.17 PICDEM 2 Plus Demonstration Board

The PICDEM 2 Plus demonstration board supports many 18, 28 and 40-pin microcontrollers, including PIC16F87X and PIC18FXX2 devices. All the necessary hardware and software is included to run the demonstration programs. The sample microcontrollers provided with the PICDEM 2 demonstration board can be programmed with a PRO MATE II device programmer, PICSTART Plus development programmer, or MPLAB ICD 2 with a Universal Programmer Adapter. The MPLAB ICD 2 and MPLAB ICE in-circuit emulators may also be used with the PICDEM 2 demonstration board to test firmware. A prototype area extends the circuitry for additional application components. Some of the features include an RS-232 interface, a 2 x 16 LCD display, a piezo speaker, an on-board temperature sensor, four LEDs and sample PIC18F452 and PIC16F877 Flash microcontrollers.

25.18 PICDEM 3 PIC16C92X Demonstration Board

The PICDEM 3 demonstration board supports the PIC16C923 and PIC16C924 in the PLCC package. All the necessary hardware and software is included to run the demonstration programs.

25.19 PICDEM 4 8/14/18-Pin Demonstration Board

The PICDEM 4 can be used to demonstrate the capabilities of the 8, 14 and 18-pin PIC16XXXX and PIC18XXXX MCUs, including the PIC16F818/819, PIC16F87/88. PIC16F62XA and the PIC18F1320 family of microcontrollers. PICDEM 4 is intended to showcase the many features of these low pin count parts, including LIN and Motor Control using ECCP. Special provisions are made for low-power operation with the supercapacitor circuit and jumpers allow onboard hardware to be disabled to eliminate current draw in this mode. Included on the demo board are provisions for Crystal, RC or Canned Oscillator modes, a five volt regulator for use with a nine volt wall adapter or battery, DB-9 RS-232 interface, ICD connector for programming via ICSP and development with MPLAB ICD 2, 2 x 16 liquid crystal display, PCB footprints for H-Bridge motor driver, LIN transceiver and EEPROM. Also included are: header for expansion, eight LEDs, four potentiometers, three push buttons and a prototyping area. Included with the kit is a PIC16F627A and a PIC18F1320. Tutorial firmware is included along with the User's Guide.

25.20 PICDEM 17 Demonstration Board

The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. A programmed sample is included. The PRO MATE II device programmer, or the PICSTART Plus development programmer, can be used to reprogram the device for user tailored application development. The PICDEM 17 demonstration board supports program download and execution from external on-board Flash memory. A generous prototype area is available for user hardware expansion.

25.21 PICDEM 18R PIC18C601/801 Demonstration Board

The PICDEM 18R demonstration board serves to assist development of the PIC18C601/801 family of Microchip microcontrollers. It provides hardware implementation of both 8-bit Multiplexed/Demultiplexed and 16-bit Memory modes. The board includes 2 Mb external Flash memory and 128 Kb SRAM memory, as well as serial EEPROM, allowing access to the wide range of memory types supported by the PIC18C601/801.

25.22 PICDEM LIN PIC16C43X Demonstration Board

The powerful LIN hardware and software kit includes a series of boards and three PICmicro microcontrollers. The small footprint PIC16C432 and PIC16C433 are used as slaves in the LIN communication and feature on-board LIN transceivers. A PIC16F874 Flash microcontroller serves as the master. All three microcontrollers are programmed with firmware to provide LIN bus communication.

25.23 PICkit[™] 1 Flash Starter Kit

A complete "development system in a box", the PICkit™ Flash Starter Kit includes a convenient multi-section board for programming, evaluation and development of 8/14-pin Flash PIC® microcontrollers. Powered via USB, the board operates under a simple Windows GUI. The PICkit 1 Starter Kit includes the User's Guide (on CD ROM), PICkit 1 tutorial software and code for various applications. Also included are MPLAB® IDE (Integrated Development Environment) software, software and hardware "Tips 'n Tricks for 8-pin Flash PIC® Microcontrollers" Handbook and a USB interface cable. Supports all current 8/14-pin Flash PIC microcontrollers, as well as many future planned devices.

25.24 PICDEM USB PIC16C7X5 Demonstration Board

The PICDEM USB Demonstration Board shows off the capabilities of the PIC16C745 and PIC16C765 USB microcontrollers. This board provides the basis for future USB products.

25.25 Evaluation and Programming Tools

In addition to the PICDEM series of circuits, Microchip has a line of evaluation kits and demonstration software for these products.

- KEELOQ evaluation and programming tools for Microchip's HCS Secure Data Products
- CAN developers kit for automotive network applications
- Analog design boards and filter design software
- PowerSmart battery charging evaluation/ calibration kits
- IrDA[®] development kit
- microID development and rfLab[™] development software
- SEEVAL® designer kit for memory evaluation and endurance calculations
- PICDEM MSC demo boards for Switching mode power supply, high-power IR driver, delta sigma ADC and flow rate sensor

Check the Microchip web page and the latest Product Selector Guide for the complete list of demonstration and evaluation kits.

NOTES:

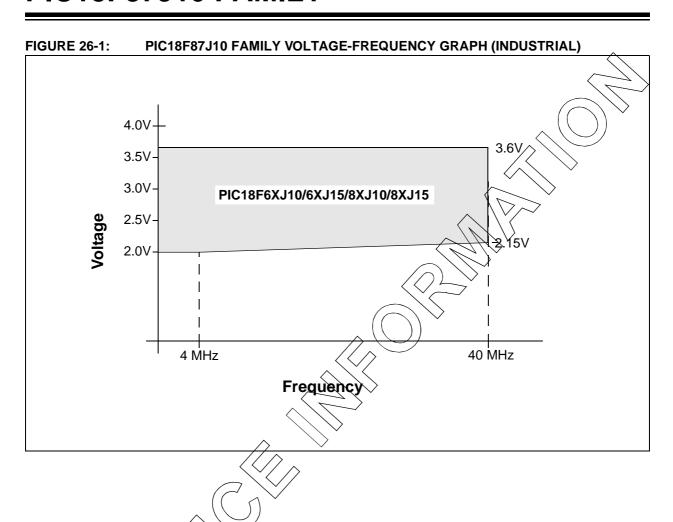
26.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings ^(†)
Ambient temperature under bias
Storage temperature
Voltage on any digital-only I/O pin with respect to Vss (except VDD and MCLR)0.3V to 5.5V
Voltage on any combined digital and analog pin with respect to Vss (except VDD and MCLR)0.3Vto (VDD + 0.3V)
Voltage on VDDCORE with respect to Vss0.3V to 2.75V
Voltage on VDD with respect to Vss0.3V to 3.6V
Voltage on MCLR with respect to Vss (Note 2)
Total power dissipation (Note 1)
Maximum current out of Vss pin
Maximum current into VDD pin
Input clamp current, IiK (VI < 0 or VI > VDD)±20 mA
Output clamp current, IOK (VO < 0 or VO > VDD)
Maximum output current sunk by PORTB and PORTC I/O prins
Maximum output current sunk by PORTD, PORTE and PORTY / //O pins
Maximum output current sunk by PORTA, PORTF, PORTG and PORTH I/O pins
Maximum output current sourced by PORTB and PORTC VO pins
Maximum output current sourced by PORTD, PORTE and PORTJ I/O pins
Maximum output current sourced by PORTA, PORTF, PORTG and PORTH I/O pins2 mA
Maximum current sunk by all ports
Maximum current sourced by all ports 200 mA

Note 1: Power dissipation is calculated as follows: Pdis = VDD x { $\{DD = \Sigma OH\} + \sum \{(VDD - VOH) \times IOH\} + \sum \{VOL \times IOL\} \}$

2: Voltage spikes below Vss at the MCLR pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR pin, rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.



26.1 DC Characteristics: Supply Voltage, PIC18F87J10 Family (Industrial)

PIC18F8	7J10 Fami l strial)	у	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial						
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions		
D001	Vdd	Supply Voltage	VDDCORE	_	3.6	V			
D001B	VDDCORE	External Supply for Microcontroller Core	1.8	_	2.75	V			
D002	VDR	RAM Data Retention Voltage ⁽¹⁾	1.5	_	_	V			
D003	VPOR	VDD Start Voltage to ensure internal Power-on Reset signal	_	_	0.7	V.	See Section 4.3 "Power-on Reset (POR)" for details		
D004	SVDD	VDD Rise Rate to ensure internal Power-on Reset signal	0.05	-		V/ms	See Section 4.3 "Power-on Reset (POR)" for details		
D005A	VBOR	Brown-out Reset Voltage	TBD		TBD) v	On-chip voltage regulator enabled. See Section 4.4 "Brown-out Reset (BOR)" for details.		

Legend: TBD = To Be Determined

Note 1: This is the limit to which VDD can be lowered in Sleep mode, or during a device Reset, without losing RAM

26.2 DC Characteristics: Power-Down and Supply Current PIC18F87J10 Family (Industrial)

PIC18F8	-	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial									
Param No.	Тур	Max	Units	Conditions							
Power-Down Current (IPD) ⁽¹⁾											
	All devices	TBD	TBD	μА	-40°C						
		TBD	TBD	μΑ	+25°C	$\begin{array}{c} VDQ = 2.0V, \\ \textbf{(Sleep mode)} \end{array}$					
		TBD	TBD	μΑ	+85°C	(Dicep-mode)					
	All devices	TBD	TBD	μΑ	-40°C <	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\					
		TBD	TBD	μΑ	+25°C	VDD = 2.5V, (Sleep mode)					
		TBD	TBD	μΑ	+85°C	(Ciccp mode)					
	All devices	TBD	TBD	μΑ	-40°C	, , , , , , , , , , , , , , , , , , ,					
		TBD	TBD	μΑ	+25°@	VDD = 3.3V, (Sleep mode)					
		TBD	TBD	μΑ	+85°C	(Giodp Mode)					

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in (1).

4: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.



26.2 DC Characteristics: Power-Down and Supply Current PIC18F87J10 Family (Industrial) (Continued)

PIC18F87	7J10 Family strial)	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial							
Param No.	Device	Тур	Max	Units		Condit	ions		
	Supply Current (IDD) ^(2,3)								
	All devices	TBD	TBD	μΑ	-40°C				
		TBD	TBD	μΑ	+25°C	VDD = 2.0V			
		TBD	TBD	μΑ	+85°C				
	All devices	TBD	TBD	μΑ	-40°C		Fosc = 31 kHz		
		TBD	TBD	μΑ	+25°C	VDD = 2.5∀	(RC_RUN mode,		
		TBD	TBD	μΑ	+85°C		Internal oscillator source)		
	All devices	TBD	TBD	μΑ	-40°C				
		TBD	TBD	μΑ	+25°C	ABD = 3:3X			
		TBD	TBD	μΑ	+85°C				
	All devices	TBD	TBD	μΑ	-40°C				
		TBD	TBD	μΑ	+25°C	∀ ₽0 = 2.0V			
		TBD	TBD	μΑ	+85°C	\triangleright			
	All devices	TBD	TBD	μΑ	(-40°C))		Fosc = 31 kHz		
		TBD	TBD	μΑ	-25°C	VDD = 2.5V	(RC_IDLE mode,		
		TBD	TBD	μA	√/+85°C		Internal oscillator source)		
	All devices	TBD	TBD	'nА	-40°C				
		TBD	TBD	LIA	+25°C	VDD = 3.3V			
		TBD	TÉD	μA	→+85°C				

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Time 1 oscillator, BOR, etc.).
2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all lop measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; MCLR = ₩ps; WDT enabled/disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula L = VDD/2REXT (mA) with REXT in $k\Omega$.

4: Standard low-bost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

26.2 DC Characteristics: Power-Down and Supply Current PIC18F87J10 Family (Industrial) (Continued)

PIC18F8	7J10 Family strial)		rd Oper ng temp			s otherwise state ≤ +85°C for indu	
Param No.	Device	Тур	Max	Units		Conditi	ions
	Supply Current (IDD) ^(2,3)						
	All devices	TBD	TBD	μΑ	-40°C		\ (\)
		TBD	TBD	μΑ	+25°C	VDD = 2.0V	
		TBD	TBD	μΑ	+85°C		
	All devices	TBD	TBD	μΑ	-40°C	<u> </u>	Fosc = 1 MHz
		TBD	TBD	μΑ	+25°C	VDD = 2.5V	(PRI_RUN mode,
		TBD	TBD	μΑ	+85°C	\sim	EC oscillator)
	All devices	TBD	TBD	mA	-40°C		>
		TBD	TBD	mA	+25°C	(NOD=13/3V)	
		TBD	TBD	mA	+85°C		
	All devices	TBD	TBD	mA	-40°C		
		TBD	TBD	mA	+25°C	VDD = 2.0V	
		TBD	TBD	mA	+85°C	<u> </u>	
	All devices	TBD	TBD	mA	<u> </u>		Fosc = 4 MHz
		TBD	TBD	mA/	+25°€	VDD = 2.5V	(PRI_RUN mode,
		TBD	TBD	mA \	[∼] < +85°C		EC oscillator)
	All devices	TBD	TBD	/Am	√-40°C		
		TBD	TBD	Aud	→ +25°C	VDD = 3.3V	
		TBD	TBQ	mA	+85°C		
	All devices	TBD	TBD `	'nΑ	-40°C		
		TRID	TBD	mA	+25°C	VDD = 2.5V	F000 - 40 MHz
		_µ8p.<	TBD	mA	+85°C		FOSC = 40 MHz (PRI_RUN mode,
	All devices	√TBD\	TBD	mA	-40°C		EC oscillator)
		твр	TBD	mA	+25°C	VDD = 3.3V	
			TBD	mA	+85°C		

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled such as WDT, Timer1 oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

 $\underline{\mathsf{OSC1}}$ = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in $k\Omega$.

Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

26.2 DC Characteristics: Power-Down and Supply Current PIC18F87J10 Family (Industrial) (Continued)

PIC18F8	7J10 Family strial)	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial							
Param No.	Device	Тур	Max	Units	Conditions				
Supply Current (IDD) ⁽²⁾									
	All devices	TBD	TBD	mA	-40°C		Fosc = 4)MHz.		
		TBD	TBD	mA	+25°C	VDD = 2.5V	16 MHz internal		
		TBD	TBD	mA	+85°C		(PRI_RUN HSPLL mode)		
	All devices	TBD	TBD	mA	-40°C	<	Fosc = 4 MHz,		
		TBD	TBD	mA	+25°C	VDD = 3.3√	76 MHz internal		
		TBD	TBD	mA	+85°C	. \	(PRI_RUN HSPLL mode)		
	All devices	TBD	TBD	mA	-40°C		Fosc = 10 MHz,		
		TBD	TBD	mA	+25°C	VBD = 2.5X	40 MHz internal		
		TBD	TBD	mA	+85°C		(PRI_RUN HSPLL mode)		
	All devices	TBD	TBD	mA	-40°C		Fosc = 10 MHz,		
		TBD	TBD	mA	+25°C	VDD = 3.3V	40 MHz internal		
		TBD	TBD	mA	+85°C	\triangleright	(PRI_RUN HSPLL mode)		

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kΩ.

4: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

26.2 DC Characteristics: Power-Down and Supply Current PIC18F87J10 Family (Industrial) (Continued)

PIC18F87	7J10 Family strial)		rd Oper ng temp			s otherwise state ≤ +85°C for indus		
Param No.	Device	Тур	Max	Units		Conditi	ions	
	Supply Current (IDD) ^(2,3)							
	All devices	TBD	TBD	μΑ	-40°C			
		TBD	TBD	μΑ	+25°C	VDD = 2.0V		
		TBD	TBD	μΑ	+85°C			
	All devices	TBD	TBD	μΑ	-40°C		Fosc = 1 MHz	
		TBD	TBD	μΑ	+25°C	VDD = 2.5♥	RI_IDLE mode,	
		TBD	TBD	μΑ	+85°C	. \\	EC oscillator)	
	All devices	TBD	TBD	μΑ	-40°C		,	
		TBD	TBD	μΑ	+25°C	ABO = 3:3/V		
		TBD	TBD	μΑ	+85°C			
	All devices	TBD	TBD	μΑ	-40°C			
		TBD	TBD	μΑ	+25°C	VD 0 = 2.0V		
		TBD	TBD	μΑ	+85°C	\supset		
	All devices	TBD	TBD	μΑ	(-40°C))		Fosc = 4 MHz	
		TBD	TBD	μΑ	+25°C	VDD = 2.5V	(PRI_IDLE mode,	
		TBD	TBD	μA	//+85°C		EC oscillator)	
	All devices	TBD	TBD	MM	-40°C			
		TBD	TBD	mA	+25°C	VDD = 3.3V		
		TBD	TED	Amy	+85°C			
	All devices	TBD	TBD	mA	-40°C			
		тво	TBD	ΜA	+25°C	VDD = 2.5V	Fosc = 40 MHz	
		(TRD/	TBD	mA	+85°C		FOSC = 40 MHz (PRI_IDLE mode,	
	All devices	TBD)	TRD	mA	-40°C		EC oscillator)	
		TBID	* TBD	mA	+25°C	VDD = 3.3V		
Lamandi	TDD. To Do Dotorminad	-7BD	TBD	mA	+85°C			

Legend: TBD = To Be Determined

Note 1: The power-down sument in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, Timer1 oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching vate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

<u>OSC1</u> = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

3: For AC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kΩ.

≪ Mandard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

26.2 **DC Characteristics: Power-Down and Supply Current** PIC18F87J10 Family (Industrial) (Continued)

PIC18F87		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial							
Param No.	Device	Тур	Max	Units		Conditions			
	Supply Current (IDD)(2,3)								
	All devices	TBD	TBD	μΑ	-10°C				
		TBD	TBD	μΑ	+25°C	VDD = 2.0V			
		TBD	TBD	μΑ	+70°C		\wedge		
	All devices	TBD	TBD	μΑ	-10°C	/	Foso = 32 kHz ⁽⁴⁾		
		TBD	TBD	μΑ	+25°C	VDD = 2.5V	SEC_RUN mode,		
		TBD	TBD	μΑ	+70°C		Timer1 as clock)		
	All devices	TBD	TBD	μΑ	-10°C				
		TBD	TBD	μΑ	+25°C	VDD =\3.3V \)		
		TBD	TBD	μΑ	+70°C	(1/1/1)			
	All devices	TBD	TBD	μΑ	-10°C				
		TBD	TBD	μΑ	+25°C(<	VDD = 2.0V			
		TBD	TBD	μΑ	+70°C				
	All devices	TBD	TBD	μΑ	(-10°C	\nearrow	Fosc = 32 kHz ⁽⁴⁾		
		TBD	TBD	μΑ	√ +25°C //	VDD = 2.5V	(SEC_IDLE mode,		
		TBD	TBD	μA .	∕>+70°C		Timer1 as clock)		
	All devices	TBD	TBD	/AM	Č< -10°C				
		TBD	TBD	μA	√+25°C	VDD = 3.3V			
		TBD	TBD	T/A-	→ +70°C				

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT Timer1 oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator-type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all \pb measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; MCLR = VDD; WDT enabled/disabled as specified.

For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula K = VDN/2REXT (mA) with REXT in $k\Omega$.

Standard, low cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

26.2 DC Characteristics: Power-Down and Supply Current PIC18F87J10 Family (Industrial) (Continued)

PIC18F8	7J10 Family strial)	Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial								
Param No.	Device	Тур	Max	Units		Condit	ions			
	Module Differential Currents (Δ lw DT, Δ	\loscb,	∆lad)						
D022	Watchdog Timer	TBD	TBD	μΑ	-40°C					
(∆lwdt)		TBD	TBD	μΑ	+25°C	VDD = 2.0V				
		TBD	TBD	μΑ	+85°C					
		TBD	TBD	μΑ	-40°C					
		TBD	TBD	μΑ	+25°C	VDD = 2.5V ⟨	/			
		TBD	TBD	μΑ	+85°C	\				
		TBD	TBD	μΑ	-40°C		\geqslant			
		TBD	TBD	μΑ	+25°C	VDØ=3.3\\ \				
		TBD	TBD	μΑ	+85°C	$\sim M \sim$				
D025	Timer1 Oscillator	TBD	TBD	μΑ	-40°C	(1/2/1/)				
(∆loscb)		TBD	TBD	μΑ	+25°C	VDQ ≥ 2.0V	32 kHz on Timer1 ⁽³⁾			
		TBD	TBD	μΑ	+85°C/ 〈 /)				
		TBD	TBD	μΑ	-40°C					
		TBD	TBD	μΑ	/+25°6	\bigvee VDD = 2.5V	32 kHz on Timer1 ⁽³⁾			
		TBD	TBD	μΑ	(+&5°C))					
		TBD	TBD	μΑ	/40°C					
		TBD	TBD	μA	√/+25°C	VDD = 3.3V	32 kHz on Timer1 ⁽³⁾			
		TBD	TBD	NA,	+85°C					
D026	A/D Converter	TBD	TBD/	μA	40°C to +85°C	VDD = 2.0V				
(ΔIAD)		TBD	TBD \	PAL	-40°C to +85°C	VDD = 2.5V	A/D on, not converting			
		TBD	TBD	\µA>	-40°C to +85°C	VDD = 3.3V				

Legend: TBD = To Be Determined

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all Vo pins in high-impedance state and tied to VDD or Vss and all features that add delta current disabled (such as WDT, TimeN oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all 100 measurements in active operation mode are:

OSC = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDR; WDT enabled/disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula V = VDD/2REXT (mA) with REXT in kΩ.

4: Standard, low cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

26.3 DC Characteristics: PIC18F87J10 Family (Industrial)

DC CHA	ARACTE	RISTICS				ınless otherwise stated) ≤ +85°C for industrial
Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
	VIL	Input Low Voltage				
		I/O ports:				
D030		with TTL buffer	Vss	0.15 VDD	V	VDD < 3.3V
D030A			_	0.8	V	$3.3V \le VDD \le 3.6V$
D031		with Schmitt Trigger buffer	Vss	0.2 VDD	V	
D032		MCLR	Vss	0.2 VDD	V	
D033		OSC1	Vss	0.3 VDD	V	HS, HSPLL modes
D033A		OSC1	Vss	0.2 VDD	V	EC modes ⁽¹⁾
D034		T13CKI	Vss	0.3 VDD	V	
	VIH	Input High Voltage				
		I/O ports:				
D040		with TTL buffer	0.25 VDD + 0.8V	VDD	V	VDD < 3.3V
D040A			2.0	VDD	V	$3.3V \le VDD \le 3.6V$
D041		with Schmitt Trigger buffer	0.8 VDD	VDD	V	
D042		MCLR	0.8 VDD	VDD	V	
D043		OSC1	0.7 VDD	VDD	V	HS, HSPLL modes
D043A		OSC1	0.8 VDD	VDD	V	EC mode
D044		T13CKI	1.6	VDD	V	
	lı∟	Input Leakage Current ^(2,3)				
D060		I/O ports	_	±1	μА	Vss ≤ VPIN ≤ VDD, Pin at high-impedance
D061		MCLR	_	±5	μΑ	Vss ≤ Vpin ≤ Vdd
D063		OSC1	_	±5	μΑ	Vss ≤ VPIN ≤ VDD
	IPU	Weak Pull-up Current				
D070	IPURB	PORTB weak pull-up current	50	400	μΑ	VDD = 3.3V, VPIN = VSS

Note 1: In RC oscillator configuration, the OSC1/CLKI pin is a Schmitt Trigger input. It is not recommended that the PICmicro[®] device be driven with an external clock while in RC mode.

^{2:} The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as current sourced by the pin.

26.3 DC Characteristics: PIC18F87J10 Family (Industrial) (Continued)

DC CHA	RACTE	RISTICS	Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial					
Param No.	Symbol	Characteristic	Min	Max	Units	Conditions		
	Vol	Output Low Voltage						
D080		I/O ports	_	0.6	V	IOL = 8.5 mA , $VD = 3.3V$, -40°C to $+85^{\circ}\text{C}$		
D083		OSC2/CLKO (EC, ECIO modes)	_	0.6	V	IOL = 1.6 mA, VDD = 3.3V, -40°C to +85°C		
	Vон	Output High Voltage ⁽³⁾			/			
D090		I/O ports	VDD - 0.7	_	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	10H = -3.0 mA, VDD = 3.3V, -40°C to +85°C		
D092		OSC2/CLKO (RC, RCIO, EC, ECIO modes)	VDD - 0.7	-		10H = -1.3 mA, VDD = 3.3V, -40°C to +85°C		
		Capacitive Loading Specs on Output Pins						
D100 ⁽⁴⁾	Cosc ₂	OSC2 pin	- <	15	pF	In HS mode when external clock is used to drive OSC1		
D101	Cio	All I/O pins and OSC2 (in RC mode)		50	pF	To meet the AC Timing Specifications		
D102	Св	SCLx, SDAx		400	pF	I ² C™ Specification		

Note 1: In RC oscillator configuration, the OSC1/CLK1 pin is a Schmitt Trigger input. It is not recommended that the PICmicro® device be driven with an external clock while in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

TABLE 26-1: MEMORY PROGRAMMING REQUIREMENTS

DC CH	ARACTE	ERISTICS	Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial					
Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions	
		Program Flash Memory					\wedge	
D130	ЕР	Cell Endurance	100	1K	_	E/W	-40°C to +85°C	
D131	VPR	VDD for Read	VMIN	_	3.6	V	VMIN = Minimum operating	
D132B	VPEW	VDD for Self-Timed Write ⁽¹⁾	VMIN	_	3.6	V	Voltage VMIN = Minimum operating voltage	
D133A	Tıw	Self-Timed Write Cycle Time(1)	_	10	_	ms		
D134	TRETD	Characteristic Retention	10	20	_	Year	Provided no other	
D135	IDDP	Supply Current during Programming	_	10	_ <	mA	specifications are violated	

† Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: These specifications apply only to devices in programming modes

TABLE 26-2: COMPARATOR SPECIFICATIONS

Operating Conditions: 3.0V < VDD < 3.6V, -40°C < TA < +85°C (unless otherwise stated)

_							
Param No.	Sym	Characteristics	Min	Тур	Max	Units	Comments
D300	VIOFF	Input Offset Voltage	_	± 5.0	± 10	mV	
D301	VICM	Input Common Mode Voltage*	0	_	VDD - 1.5	V	
D302	CMRR	Common Mode Rejection Ratio*	55	_	_	dB	
300	TRESP	Response Time ^{(1)*}	_	150	400	ns	
301	TMC2OV	Comparator Mode Change to Output Valid*	_	_	10	Jus	

^{*} These parameters are characterized but not tested.

Note 1: Response time measured with one comparator input at (VDD – 1.5)/2, while the other input transitions from Vss to VDD.

TABLE 26-3: VOLTAGE REFERENCE SPECIFICATIONS

Operating	Operating Conditions: 3.0V < VDD < 3.6V, -40°C < TA < +85°C (unless otherwise stated)										
Param No.	Sym	Characteristics	Min	Typ	Max	Units	Comments				
D310	VRES	Resolution	VDD/24		VDD/32	LSb					
D311	VRAA	Absolute Accuracy	$\downarrow \checkmark \checkmark$	/ _	1/2	LSb					
D312	VRur	Unit Resistor Value (R)	17	> 2k	_	Ω					
310	TSET	Settling Time ⁽¹⁾		_	10	μs					

Note 1: Settling time measured while CVRR = 1 and CVR3:CVR0 transitions from '0000' to '1111'.

TABLE 26-4: INTERNAL VOLTAGE REGULATOR SPECIFICATIONS

Operatin	Operating Conditions: -40°C < TA(< +85°C (unless otherwise stated)										
Param No.	Sym	Characteristics	Min	Тур	Max	Units	Comments				
	VRGOUT	Regulator Output Voltage	_	2.5	_	V					
	CEFC	External Filter Capacitor Value	1	10		μF	Capacitor must be low series resistance				

^{*} These parameters are characterized but not tested. Parameter numbers not yet assigned for these specifications.

26.4 AC (Timing) Characteristics

26.4.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created following one of the following formats:

1. TppS2pp	S	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowercase	letters (pp) and their meanings:		
рр			
СС	CCP1	osc	OSC1
ck	CLKO	rd	RD
cs	CS	rw	\overline{RD} or \overline{WR}
di	SDI	sc	SCK
do	SDO	SS	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T13CKI
mc	MCLR	wr	WR
Uppercase	letters and their meanings:		
S			
F	Fall	Р	Period
Н	High	R	Rise
1	Invalid (High-impedance)	V	Valid
L	Low	Z	High-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
TCC:ST (I ² C	specifications only)		
CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	Stop condition
STA	Start condition		

26.4.2 TIMING CONDITIONS

The temperature and voltages specified in Table 26-5 apply to all timing specifications unless otherwise noted. Figure 26-2 specifies the load conditions for the timing specifications.

TABLE 26-5: TEMPERATURE AND VOLTAGE SPECIFICATIONS - AC

Standard Operating Conditions (unless otherwise stated)

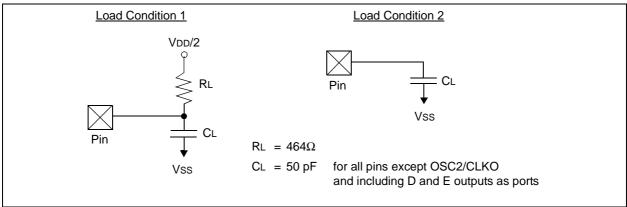
AC CHARACTERISTICS

Operating temperature -40°C ≤ TA ≤ +85°C for industrial

Operating voltage VDD range as described in DC spec Section 26.1 and

Section 26.3.

FIGURE 26-2: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



26.4.3 TIMING DIAGRAMS AND SPECIFICATIONS



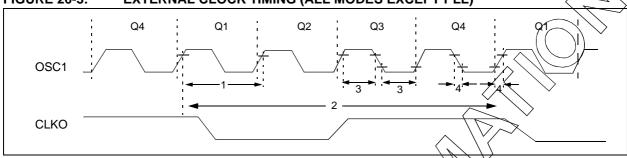


TABLE 26-6: EXTERNAL CLOCK TIMING REQUIREMENTS,

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
1A	Fosc	External CLKI Frequency ⁽¹⁾	DC 🔿	(40)	MHz	HS Oscillator mode
		Oscillator Frequency ⁽¹⁾	DC//	→ 40	MHz	HS Oscillator mode
1	Tosc	External CLKI Period ⁽¹⁾	25		ns	HS Oscillator mode
		Oscillator Period ⁽¹⁾	25	→ 250	ns	HS Oscillator mode
2	Tcy	Instruction Cycle Time(1)	100	_	ns	Tcy = 4/Fosc, Industrial
3	TosL, TosH	External Clock in (OSC1) High or Low Time	10	_	ns	HS Oscillator mode
4	TosR, TosF	External Clock in (OSC1) Rise or Fall Time	> -	7.5	ns	HS Oscillator mode

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time base period for all configurations except PLL. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKI pin. When an external clock input is used, the "max." cycle time limit is "DC" (no clock) for all devices.

TABLE 26-7: PLL CLOCK TIMING SPECIFICATIONS (VDD = 2.5V TO 3.6V)

Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
F10	Fosc	Oscillator Frequency Range	4	_	10	MHz/	HS mode only
F11	Fsys	On-Chip VCO System Frequency	16	_	40	MHz	HS mode only
F12	t _{rc}	PLL Start-up Time (Lock Time)	_	_	2	ms	
F13	Δ CLK	CLKO Stability (Jitter)	-2	_	+2 /	(%	

Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are to design guidance only and are not tested.

AC CHARACTERISTICS: INTERNAL RC ACCURAÇX **TABLE 26-8:** PIC18F87J10 FAMILY (INDUSTRIAL)

Param No.	Characteristic Min Typ		Max	Units	Conditions	
	INTRC Accuracy @ Freq = 31 kHz ⁽¹⁾	26.562	_	35.938	kHz	-40°C to +85°C, VDD = 2.0-3.3V

Note 1: INTRC frequency after calibration. Change of INTRC frequency as VDD changes.

FIGURE 26-4: CLKO AND I/O TIMING

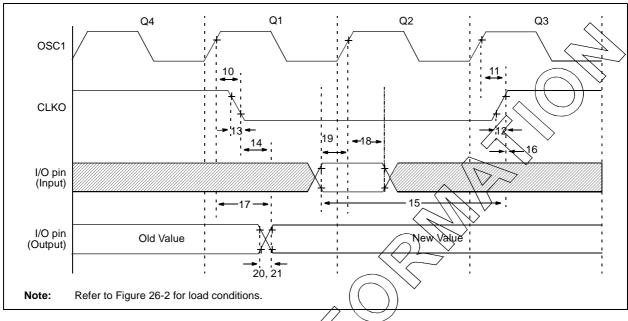


TABLE 26-9: CLKO AND I/O TIMING REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
10	TosH2cĸL	OSC1 ↑ to CLKO↓	_	TBD	TBD	ns	
11	TosH2ckH	OSC1 ↑ to CLKO ↑//	_	TBD	TBD	ns	
12	TCKR	CLKO Rise Time	_	TBD	TBD	ns	
13	TCKF	CLKO Fall Time	_	TBD	TBD	ns	
14	TckL2ioV	CLKO ↓ to Ron Out Valid	_	_	0.5 Tcy + 20	ns	
15	TioV2ckH	Port In Valid before CLKO ↑	0.25 Tcy + 25	_	_	ns	
16	TckH2iol	Port In Hold after CLKO ↑	0	_	_	ns	
17	TosH2IOV	OSC1 (Q1 eycle) to Port Out Valid	_	50	150	ns	
18	TosH2iol (QSC17 (Q2 cycle) to Port Input Invalid	100	_	_	ns	
18A		(I/O in hold time)	200	_	_	ns	VDD = 2.0V
19	TioV2osH	Port Input Valid to OSC1 ↑ (I/O in setup time)	0	_	_	ns	
20	TIOR	Port Output Rise Time	_	10	25	ns	
20A			_	_	60	ns	VDD = 2.0V
21	7/0F	Port Output Fall Time	_	10	25	ns	
21A \	\rangle		_	_	60	ns	VDD = 2.0V
22†	TINP	INT pin High or Low Time	Tcy	_	_	ns	
23†	TRBP	RB7:RB4 Change INT High or Low Time	Tcy	_	_	ns	

Legend: TBD = To Be Determined

[†] These parameters are asynchronous events not related to any internal clock edges.

FIGURE 26-5: PROGRAM MEMORY READ TIMING DIAGRAM

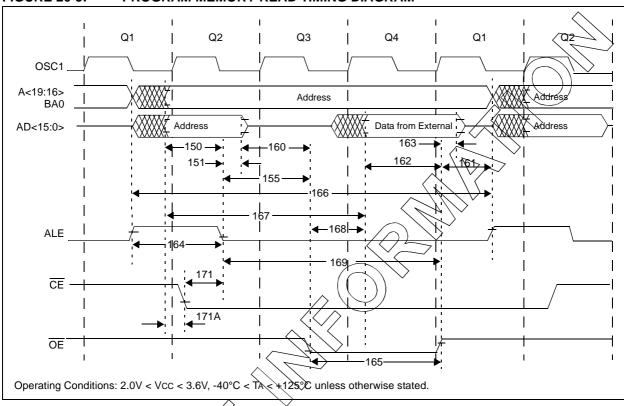


TABLE 26-10: CLKO AND I/O TIMING REQUIREMENTS

Param. No	Symbol	Characteristics	Min	Тур	Max	Units
150	TadV2alL	Address Out Valid to ALE ↓ (address setup time)	0.25 Tcy - 10	_	_	ns
151	TalL2adl	ATE to Address Out Invalid (address hold time)	5		_	ns
155	Tall2oeL	ALE ↓ to OE ↓	10	0.125 TcY	_	ns
160	TadZ2oeL	AD high-Z to OE ↓ (bus release to OE)	0	-	_	ns
161	ToeH2adD	OE ↑ to AD Driven	0.125 Tcy - 5	_	_	ns
162	TadV2oeH	LS Data Valid before OE ↑ (data setup time)	20	_	_	ns
163	ToeH2adl	OE ↑ to Data In Invalid (data hold time)	0 —		_	ns
164	TalH2alL	ALE Pulse Width	_	Tcy	_	ns
165	ToeL2oeH	OE Pulse Width	0.5 Tcy - 5	0.5 Tcy	_	ns
166	TalH2alH	ALE ↑ to ALE ↑ (cycle time)	_	0.25 TcY	_	ns
167	Tacc	Address Valid to Data Valid	0.75 Tcy - 25		_	ns
168	Toe	OE ↓ to Data Valid		-	0.5 Tcy - 25	ns
169	TalL2oeH	ALE ↓ to OE ↑	0.625 Tcy - 10	_	0.625 Tcy + 10	ns
171	TalH2csL	Chip Enable Active to ALE ↓	0.25 Tcy - 20		_	ns
171A	TubL2oeH	AD Valid to Chip Enable Active	_	_	10	ns

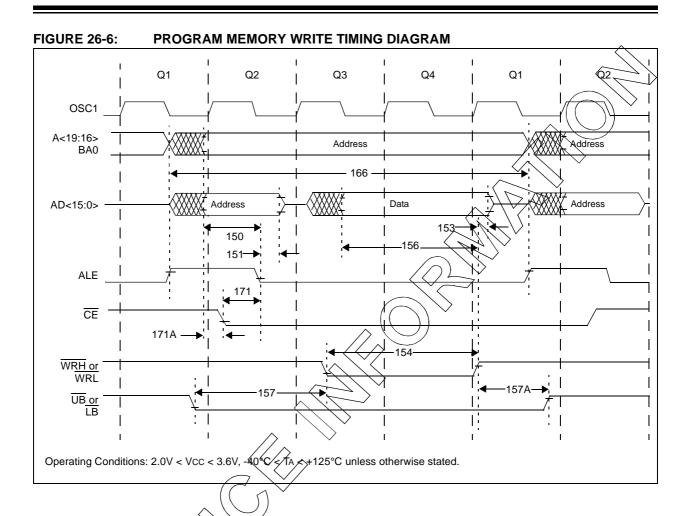


TABLE 26-11: PROGRAM MEMORY WRITE TIMING REQUIREMENTS

Param. No	Symbol	Characteristics	Min	Тур	Max	Units
150	TadV2alL \	Address Out Valid to ALE ↓ (address setup time)	0.25 Tcy - 10	_	_	ns
151	TalL2adl	ALE Vto Address Out Invalid (address hold time)	5	_	_	ns
153	TwrH2adl	WRn ↑ to Data Out Invalid (data hold time)	5	_	_	ns
154	TWIL))	WRn Pulse Width	0.5 Tcy - 5	0.5 Tcy	_	ns
156/	TadV2wrH	Data Valid before WRn ↑ (data setup time)	0.5 Tcy - 10	_	_	ns
157	Tbs√2wrL	Byte Select Valid before $\overline{\text{WRn}} \downarrow$ (byte select setup time)	0.25 TcY			ns
157A	TwrH2bsI	WRn ↑ to Byte Select Invalid (byte select hold time)	0.125 Tcy - 5	_	_	ns
166	TalH2alH ALE ↑ to ALE ↑ (cycle time)		_	0.25 TcY	_	ns
171	TalH2csL	TalH2csL Chip Enable Active to ALE ↓		_	_	ns
171A	TubL2oeH	AD Valid to Chip Enable Active	_	_	10	ns

FIGURE 26-7: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

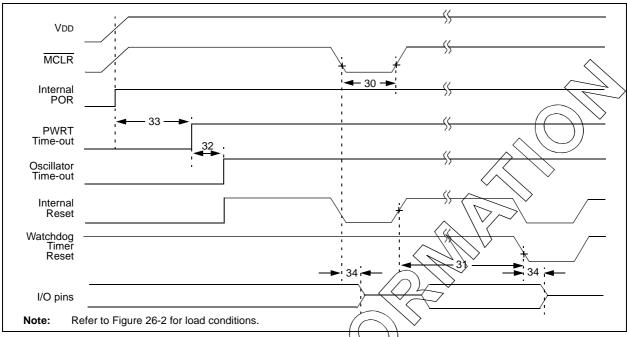


FIGURE 26-8: BROWN-OUT RESET TIMING

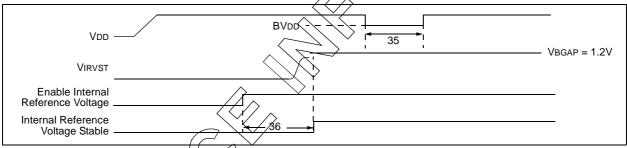


TABLE 26-12: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
30	TMCL _	MCLR Pulse Width (low)	2	_	_	μs	
31	TWDT	Watchdog Timer Time-out Period (no postscaler)	3.4	4.0	4.6	ms	
32	TOST	scillation Start-up Timer Period	1024 Tosc	_	1024 Tosc	_	Tosc = OSC1 period
33 🥎	TPWRT	Power-up Timer Period	55.6	65.5	75	ms	
34	Ť10Z	I/O High-Impedance from MCLR Low or Watchdog Timer Reset	_	2	_	μs	
38	TCSD	CPU Start-up Time	_	200	_	μs	
39	TIOBST	Time for INTOSC to Stabilize	_	1	_	μs	

FIGURE 26-9: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

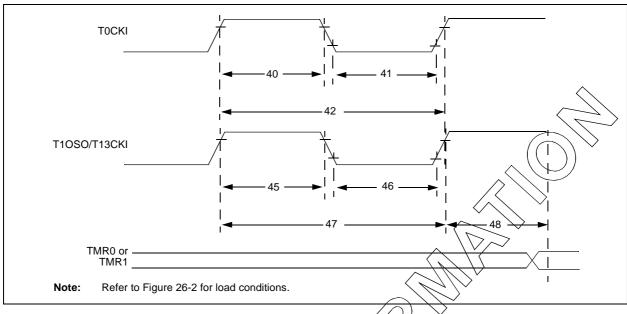


TABLE 26-13: TIMERO AND TIMER1 EXTERNAL CLOCK-REQUIREMENTS

Param No.	Symbol		Characteristic		Min	Max	Units	Conditions
40	T⊤0H	T0CKI High P	ulse Width	No prescaler	0.5 Tcy + 20	_	ns	
				With prescaler	10	_	ns	
41	TT0L	\ \		No prescaler	0.5 Tcy + 20	_	ns	
				With prescaler	10	_	ns	
42	Тт0Р	T0CKI Period	\nearrow	No prescaler	Tcy + 10	_	ns	
				With prescaler	Greater of: 20 ns or (TcY + 40)/N	_	ns	N = prescale value (1, 2, 4,, 256)
45	T⊤1H	T13CKI High Synchronous, no		o prescaler	0.5 Tcy + 20	_	ns	
		Time	Synchronous, w	Synchronous, with prescaler		_	ns	
			Asynchronous		30	_	ns	
46	T⊤1L	136KI rgm	Synchronous, n	o prescaler	0.5 Tcy + 5	_	ns	
	\land	Time	Synchronous, w	ith prescaler	10	_	ns	
			Asynchronous		30	_	ns	
47 <	TT1P	T13CKI Input Period	Synchronous		Greater of: 20 ns or (TcY + 40)/N	_	ns	N = prescale value (1, 2, 4, 8)
	Asynchronous			60	_	ns		
	FT1	T13CKI Oscill	ator Input Frequency Range		DC	50	kHz	
48	TCKE2TMRI	Delay from Ex Timer Increme	ternal T13CKI C ent	lock Edge to	2 Tosc	7 Tosc	_	

FIGURE 26-10: CAPTURE/COMPARE/PWM TIMINGS (INCLUDING ECCP MODULES)

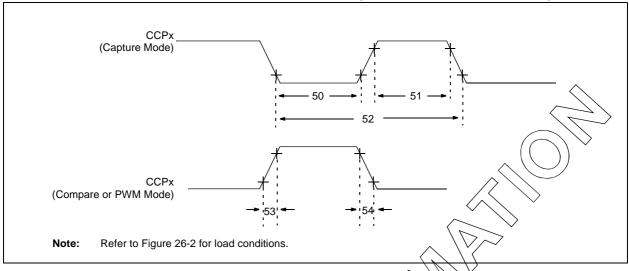


TABLE 26-14: CAPTURE/COMPARE/PWM REQUIREMENTS (INCLUDING ECCP MODULES)

THE ELECTION OF THE PROPERTY O										
Param No.	Symbol	С	haracteristic	Min	Max	Units	Conditions			
50	TCCL	CCPx Input Low Time	No prescaler	0.5 TcY + 20	_	ns				
			With prescaler	10	_	ns				
51	TccH	CCPx Input High Time	No prescaler	0.5 Tcy + 20		ns				
			With prescaler	10	_	ns				
52	TCCP	CCPx Input Period		3 Tcy + 40	_	ns	N = prescale			
			N			value (1, 4 or 16)				
53	TCCR	CCPx Output Fall Time		_	25	ns				
54	TccF	CCPx Output Fall Time		_	25	ns				

TABLE 26-15: PARALLEL SLAVE PORT REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
62	TdtV2wrH\	Data In Valid before WR ↑ or CS ↑ (setup time)	20	_	ns	
63	TwrH2dtl\	WR ↑ or CS ↑ to Data–In Invalid (hold time)	20		ns	
64	TrdC2dtV\	RD ↓ and CS ↓ to Data–Out Valid		80	ns	
65	Transati	RD ↑ or CS ↓ to Data–Out Invalid	10	30	ns	
66	TibfliviH	Inhibit of the IBF Flag bit being Cleared from WR ↑ or CS ↑		3 Tcy		

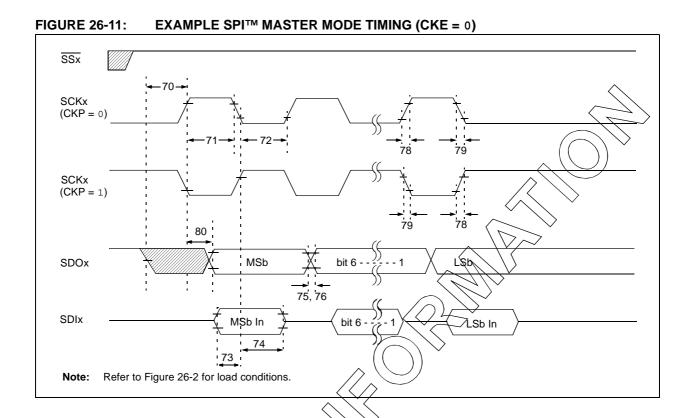


TABLE 26-16: EXAMPLE SPI™ MODE REQUIREMENTS (MASTER MODE, CKE = 0)

Param No.	Symbol	Characterist	Characteristic		Max	Units	Conditions
70	TssL2scH, TssL2scL	SSx ↓ to SCKx ↓ or SCKx↑ Input		Tcy	_	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx tnput Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73	TDIV2SCH, TDIV2SCL	Setup Time of SDIx Data Input to SCKx Edge		100	_	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to to find the state of Byte 2	he 1st Clock Edge	1.5 Tcy + 40	_	ns	(Note 2)
74 (TSCH2DIL, TSCL2DIL	Hold Time of SDIx Data Input	to SCKx Edge	100	_	ns	
75/	TDOR	SDOx Data Output Rise Time		_	25	ns	
76	TBOF	SDOx Data Output Fall Time		_	25	ns	
78	TscR	SCKx Output Rise Time (Master mode)		_	25	ns	
79	TscF	SCKx Output Fall Time (Maste	SCKx Output Fall Time (Master mode)		25	ns	
80	TscH2DoV, TscL2DoV	SDOx Data Output Valid after	SCKx Edge	_	50	ns	

Note 1: Requires the use of Parameter #73A.

FIGURE 26-12: EXAMPLE SPI™ MASTER MODE TIMING (CKE = 1)

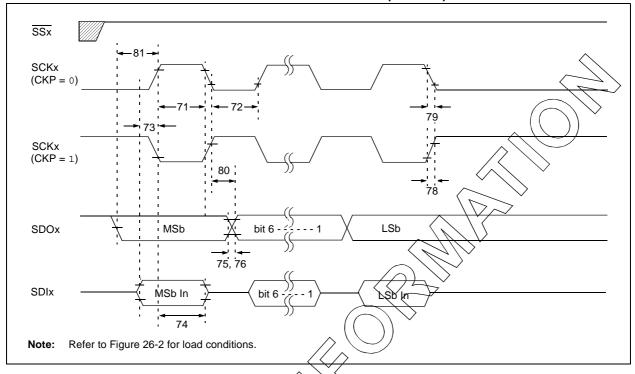


TABLE 26-17: EXAMPLE SPI™ MODE REQUIREMENTS (MASTER MODE, CKE = 1)

Param. No.	Symbol	Characterist	Characteristic		Max	Units	Conditions
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge		100	_	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the 1st Clock Edge ON Byte 2		1.5 Tcy + 40	_	ns	(Note 2)
74	TSCH2DIL, TSCL2BIL	Hold Time of SDIx Data Input	to SCKx Edge	100	_	ns	
75	TOOR	SDOx Data Output Rise Time		_	25	ns	
76	(TDQF)	SDOx Data Output Fall Time		_	25	ns	
78/	TSCR	SCKx Output Rise Time (Mas	ter mode)	_	25	ns	
79 💙	TscF	SCKx Output Fall Time (Maste	er mode)	_	25	ns	
80	TscH2DoV, TscL2DoV	SDOx Data Output Valid after SCKx Edge		_	50	ns	
81	TDOV2SCH, TDOV2SCL	SDOx Data Output Setup to S	CKx Edge	Tcy	_	ns	

Note 1: Requires the use of Parameter #73A.

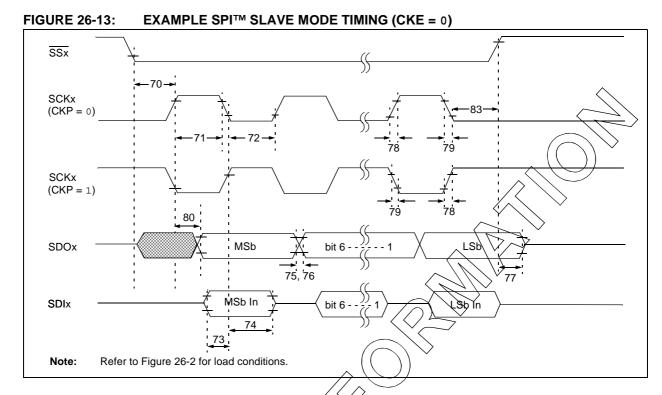


TABLE 26-18: EXAMPLE SPI™ MODE REQUIREMENTS (SLAVE MODE TIMING, CKE = 0)

Param No.	Symbol	Characteristic	<u> </u>	Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	SSx ↓ to SCKx ↓ or SCKx ↑ Input		Tcy	_	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
73	TDIV2SCH, TDIV2SCL	Setup Time of SDIx Data Input to SCKx Edge		100	_	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the First Clock	1.5 Tcy + 40	_	ns	(Note 2)	
74	TSCH2DIL, TSCL2DIL	Hold Time of SDIx Data Input to SCKx I	Edge	100	_	ns	
75	TDOR	SDOx Data Output Rise Time		_	25	ns	
76	TOOF	SDOx Data Output Fall Time		_	25	ns	
77 ~	TSSH200Z	SSx ↑ to SDOx Output High-impedance	•	10	50	ns	
78	TSCR/	SCKx Output Rise Time (Master mode)		_	25	ns	
79 🗸	TscF	SCKx Output Fall Time (Master mode)		_	25	ns	
80 💙	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge		_	50	ns	
83	TscH2ssH, TscL2ssH	SSx ↑ after SCKx Edge		1.5 Tcy + 40	_	ns	

Note 1: Requires the use of Parameter #73A.

FIGURE 26-14: EXAMPLE SPI™ SLAVE MODE TIMING (CKE = 1)

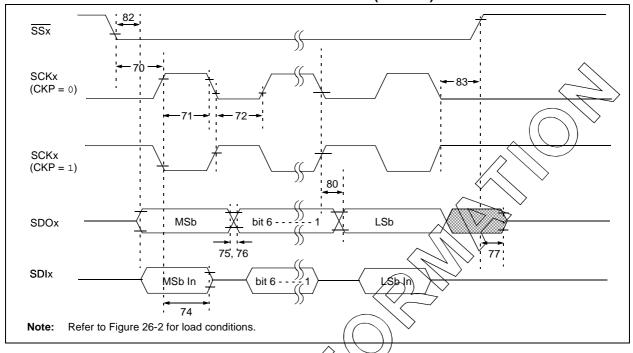


TABLE 26-19: EXAMPLE SPI™ SLAVE MODE REQUIREMENTS (CKE = 1)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	SSx ↓ to SCKx ↓ or SCKx ↑Input	or SCKx Nnput		1	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	1	ns	
71A		(Slave mode)	Single Byte	40	1	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30		ns	
72A		(Slave mode)	Single Byte	40	1	ns	(Note 1)
73A	Тв2в	Last Clock Edge of Byte 1 to the First	t Clock Edge of Byte 2	1.5 Tcy + 40	1	ns	(Note 2)
74	TSCH2DIL, TSCL2DIL	Hold Time of SDIx Data Input to SC	CKx Edge	100	I	ns	
75	TDOR _	SDO Data Output Rise Time		_	25	ns	
76	TDOF \	SDOX Data Output Fall Time			25	ns	
77	TssH2boZ	SSx 1 to SDOx Output High-Imped	ance	10	50	ns	
78	TSCR\	SCKx Output Rise Time (Master mo	ode)	_	25	ns	
79	TSOF	SCKx Output Fall Time (Master mo	de)	_	25	ns	
80	Tsch2doV, Tscl2doV	SDOx Data Output Valid after SCKx Edge		_	50	ns	
82 \	TssL2doV	SDOx Data Output Valid after SSx	Data Output Valid after SSx ↓ Edge		50	ns	
83	TscH2ssH, TscL2ssH	SSx ↑ after SCKx Edge		1.5 Tcy + 40	_	ns	

Note 1: Requires the use of Parameter #73A.

FIGURE 26-15: I²C™ BUS START/STOP BITS TIMING

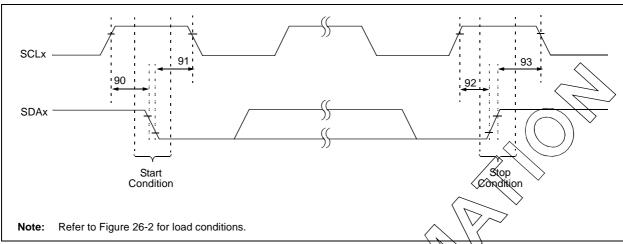


TABLE 26-20: I²C™ BUS START/STOP BITS REQUIREMENTS (SLAVE MODE)

Param. No.	Symbol	Characte	ristic	Min	Max	Units	Conditions
90	Tsu:sta	Start Condition	100 kHz mode	4700)) —	ns	Only relevant for Repeated
		Setup Time	400 kHz mode	/600			Start condition
91	THD:STA	Start Condition	100 kHz møde	4000	_	ns	After this period, the first
		Hold Time	400 kHz mode	600	_		clock pulse is generated
92	Tsu:sto	Stop Condition	100 kHz mode	² 4700		ns	
		Setup Time	400 kHz mode	600	_		
93	THD:STO	Stop Condition	100 kHz mode	4000		ns	
		Hold Time	400 kHz mode	600	_		

FIGURE 26-16: I²C™ BUS DATA TIMING

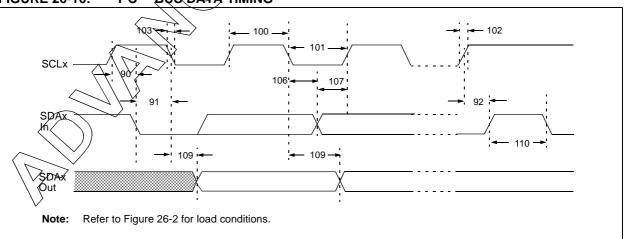


TABLE 26-21: I²C™ BUS DATA REQUIREMENTS (SLAVE MODE)

Param. No.	Symbol	Characteris	tic	Min	Max	Units	Conditions
100	THIGH	Clock High Time	100 kHz mode	4.0	I	μs	PIC18F87J10 must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6		μs	PIC18F87J10 must operate at a minimum of 10 MHz
			SSP Module	1.5 TcY	_		
101	TLOW	Clock Low Time	100 kHz mode	4.7	1	μs	PIC18F87U10 must operate at a minimum of 1.5 MHz
			400 kHz mode	1.3	1	μs	PIO18F87J10 must operate at a minimum of 10 MHz
			SSP Module	1.5 TCY	_	~	
102	TR	SDAx and SCLx Rise Time	100 kHz mode		1000	ns	\
			400 kHz mode	20 + 0.1 CB	300	ng P	CB is specified to be from 10 to 400 pF
103	TF	SDAx and SCLx Fall Time	100 kHz mode	_	300	ns	
			400 kHz mode	20 + 0.1 CB	300	√ns >	CB is specified to be from 10 to 400 pF
90	Tsu:sta	Start Condition Setup Time	100 kHz mode	4.7		μs	Only relevant for Repeated
			400 kHz mode	0.6	\rightarrow	μs	Start condition
91	THD:STA	Start Condition Hold Time	100 kHz mode	((4.0))	_	μs	After this period, the first clock
			400 kHz mode/	0.6	_	μs	pulse is generated
106	THD:DAT	Data Input Hold Time	100 kHz mode	/ 0	_	ns	
			400 kHz mode	0	0.9	μs	
107	TSU:DAT	Data Input Setup Time	100 kHz mode	250	_	ns	(Note 2)
			400 kHz mode	100	_	ns	
92	Tsu:sto	Stop Condition Setup Time	100 kHz mode	4.7	_	μs	
			400 kHz mode	0.6	_	μs	
109	TAA	Output Valid from Clock	100 kHz mode	_	3500	ns	(Note 1)
			400 kHz mode	_	_	ns	
110	TBUF	Bus Free Time (100 kHz mode	4.7	_	μs	Time the bus must be free
			400 kHz mode	1.3	_	μs	before a new transmission can start
D102	Св	Bus Capacitive Loading			400	pF	

Note 1:

As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCLx to avoid unintended generation of Start or Stop conditions.

A Fast mode ¹/₂C TM bus device can be used in a Standard mode I²C bus system, but the requirement, Tsu:DAT ≥ 250 ns, must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SDAx line, TR max. + Asu:DAT = 1000 + 250 = 1250 ns (according to the Standard mode I²C bus specification), before the SCLx line is released.

FIGURE 26-17: MASTER SSP I²C™ BUS START/STOP BITS TIMING WAVEFORMS

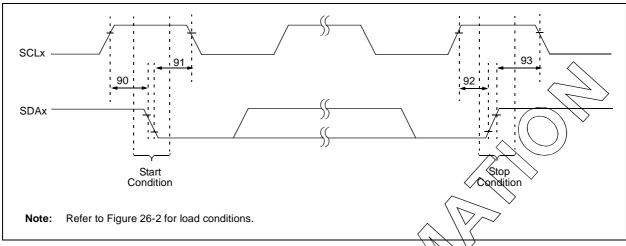


TABLE 26-22: MASTER SSP I²C™ BUS START/STOP BITS REQUIREMENTS

Param. No.	Symbol	Characte	ristic	Min	Max	Units	Conditions
90	Tsu:sta	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	Only relevant for
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		Repeated Start
			1 MHz mode ⁽¹⁾	2(10sc)(BRG + 1)	_		condition
91	THD:STA	Start Condition	100 kHz mode	2(Tøsc)(BRG + 1)	_	ns	After this period, the
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_		first clock pulse is
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_		generated
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_		
93	THD:STO	Stop Condition (100 kHz mode	2(Tosc)(BRG + 1)	_	ns	
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_		
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_		

Note 1: Maximum pin capacitance = 10 pF for all I^2C^{TM} pins.

FIGURE 26-48:\\ MASTER SSP I²C™ BUS DATA TIMING

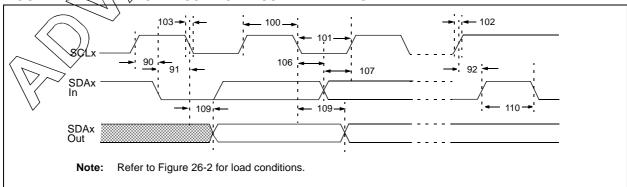


TABLE 26-23: MASTER SSP I²C™ BUS DATA REQUIREMENTS

	-OW	Clock High Time Clock Low Time SDAx and SCLx Rise Time	100 kHz mode 400 kHz mode 1 MHz mode ⁽¹⁾ 100 kHz mode 400 kHz mode 1 MHz mode ⁽¹⁾ 100 kHz mode 400 kHz mode	2(Tosc)(BRG + 1)		ms ms ms ms ms	CB is specified to be from
	3	SDAx and SCLx Rise Time	1 MHz mode ⁽¹⁾ 100 kHz mode 400 kHz mode 1 MHz mode ⁽¹⁾ 100 kHz mode 400 kHz mode	2(Tosc)(BRG + 1) 2(Tosc)(BRG + 1) 2(Tosc)(BRG + 1) 2(Tosc)(BRG + 1) —	_	ms ms ms	CR is specified to be from
	3	SDAx and SCLx Rise Time	100 kHz mode 400 kHz mode 1 MHz mode ⁽¹⁾ 100 kHz mode 400 kHz mode	2(Tosc)(BRG + 1) 2(Tosc)(BRG + 1) 2(Tosc)(BRG + 1) —	_	ms ms ms	CR is specified to be from
	3	SDAx and SCLx Rise Time	400 kHz mode 1 MHz mode ⁽¹⁾ 100 kHz mode 400 kHz mode	2(Tosc)(BRG + 1) 2(Tosc)(BRG + 1)	_	ms ms	CR is specified to be from
102 TR		Rise Time	1 MHz mode ⁽¹⁾ 100 kHz mode 400 kHz mode	2(Tosc)(BRG + 1)	— — 1000	ms	CR is specified to be from
102 TR		Rise Time	100 kHz mode 400 kHz mode		— 1000		Chis specified to be from
102 TR		Rise Time	400 kHz mode	— 20 + 0.1 Св	1000	ns </td <td>CR is specified to be from</td>	CR is specified to be from
	=			20 + 0.1 CB			
	=		4 MILE - 1 (1)		300	ns_	10 to 400 pF
	=		1 MHz mode ⁽¹⁾	_	300	\\\	\supset
103 TF		SDAx and SCLx	100 kHz mode	_	300 √	na	CB is specified to be from
		Fall Time	400 kHz mode	20 + 0.1 CB	(300)	KO/	10 to 400 pF
			1 MHz mode ⁽¹⁾	- (100	√ns	
90 Ts		Start Condition	100 kHz mode	2(Tosc)(BRG(+1)/		ms	Only relevant for
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_	ms	Repeated Start
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	/ _	ms	condition
91 TH	HD:STA	Start Condition	100 kHz mode	2(To\$c)(BRG+1)	_	ms	After this period, the first
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_	ms	clock pulse is generated
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
106 TH	HD:DAT	Data Input	100 kHz mode	7/0	_	ns	
		Hold Time	400 kHz mode	0	0.9	ms	
			1 MHz mode(1)	TBD	_	ns	
107 Ts	SU:DAT	Data Input	100 kHz mode	250	_	ns	(Note 2)
		Setup Time	400 kHz môde	100	_	ns	
			1 MHz mode ⁽¹⁾	TBD	_	ns	
92 Ts		Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ms	
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_	ms	
			1 MHz mode ⁽¹⁾	2(Tosc)(BRG + 1)	_	ms	
109 TA		Output Valid	100 kHz mode	_	3500	ns	
		from Clock	400 kHz mode	_	1000	ns	
	_ \		1 MHz mode ⁽¹⁾	_	_	ns	
110 TB	BUF	Bus Free Time	100 kHz mode	4.7		ms	Time the bus must be free
		\checkmark	400 kHz mode	1.3	_	ms	before a new transmission
, <u> </u>	<u>\</u>))		1 MHz mode ⁽¹⁾	TBD	_	ms	can start
D102 CB	B 🗸	Bus Capacitive Lo	pading	_	400	pF	

Legend: TBD = To Be Determined

Note\1; Maximum pin capacitance = 10 pF for all I^2C^{TM} pins.

2: A Fast mode I²C bus device can be used in a Standard mode I²C bus system, but parameter #107 ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line, parameter #102 + parameter #107 = 1000 + 250 = 1250 ns (for 100 kHz mode), before the SCLx line is released.

FIGURE 26-19: EUSART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

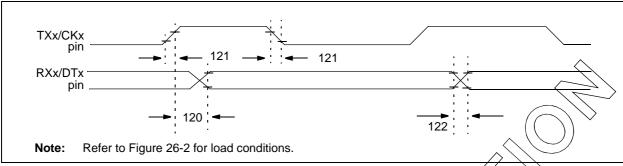


TABLE 26-24: EUSART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
120	TCKH2DTV	SYNC XMIT (MASTER and SLAVE) Clock High to Data Out Valid		40	ns	
121	TCKRF	Clock Out Rise Time and Fall Time (Master mode)		20	ns	
122	TDTRF	Data Out Rise Time and Fall Time	\supset $-$	20	ns	

FIGURE 26-20: EUSART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

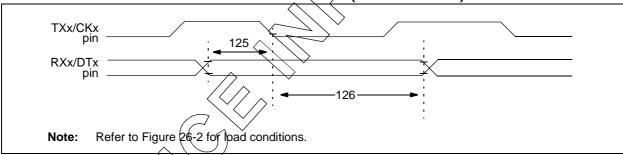


TABLE 26-25: EUSART SYNCHRONOUS RECEIVE REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
125	TDTV26KL	SYNC RCV (MASTER and SLAVE) Data Hold before CKx ↓ (DTx hold time)	10	_	ns	
126	TCKL2DTL	Data Hold after CKx ↓ (DTx hold time)	15		ns	

TABLE 26-26: A/D CONVERTER CHARACTERISTICS: PIC18F87J10 FAMILY (INDUSTRIAL)

Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
A01	NR	Resolution	_		10	bit	$\Delta VREF \ge 3.0V$
A03	EIL	Integral Linearity Error	_	_	<±1	LSb	$\Delta VREF \ge 3.0V_{\wedge}$
A04	EDL	Differential Linearity Error	_	_	<±1	LSb	ΔVREF ≥ 3.0V
A06	Eoff	Offset Error	_	_	<±1.5	LSb	ΔVREF ≥ 3.0V
A07	Egn	Gain Error	_	_	<±1	LSb	ΔVREF≥3:0V
A10	_	Monotonicity	Gı	uarantee	d ⁽¹⁾	_	VSS(
A20	$\Delta VREF$	Reference Voltage Range (VREFH – VREFL)	1.8 3	_	_ _	V V/2	VDQ ≥ 3.0V VDQ ≥ 3.0V
A21	VREFH	Reference Voltage High	Vss		VREFH	(N)	<u> </u>
A22	VREFL	Reference Voltage Low	Vss - 0.3V		VDD - 3.0V	V	\triangleright
A25	VAIN	Analog Input Voltage	VREFL	_	VREEH	Vy~	
A30	ZAIN	Recommended Impedance of Analog Voltage Source	_	_	2.5	kΩ	
A50	IREF	VREF Input Current ⁽²⁾			150	μA μA	During VAIN acquisition. During A/D conversion cycle.

Note 1: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

^{2:} VREFH current is from RA3/AN3/VREF+ pin or VDD, whichever is selected as the VREFH source. VREFL current is from RA2/AN2/VREF- pin or VSS, whichever is selected as the VREFL source.



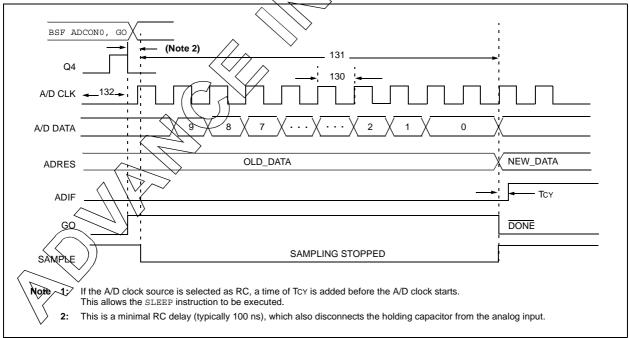


TABLE 26-27: A/D CONVERSION REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
130	TAD	A/D Clock Period	0.7	25.0 ⁽¹⁾	μs	Tosc based, VREF ≥ 3.0V
			TBD	1	μs	A/D RC mode
131	TCNV	Conversion Time (not including acquisition time) (Note 2)	11	12	TAD	
132	TACQ	Acquisition Time (Note 3)	1.4 TBD	_	μs μs	-40°C to +85°C 0°C ≤ to ≤ +85°C
135	Tswc	Switching Time from Convert → Sample	_	(Note 4)		\wedge
TBD	TDIS	Discharge Time	0.2	_	μs	

Legend: TBD = To Be Determined

Note 1: The time of the A/D clock period is dependent on the device frequency and the Tab clock divider.

2: ADRES registers may be read on the following Tcy cycle.

3: The time for the holding capacitor to acquire the "New" input voltage when the voltage changes full scale after the conversion (VDD to Vss or Vss to VDD). The source impedance (Rs) on the input channels is 50Ω .

4: On the following cycle of the device clock.



NOTES:

27.0 PACKAGING INFORMATION

27.1 Package Marking Information

64-Lead TQFP



Example



80-Lead TQFP



Example



Legend: XX...X Customer-specific information

Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')
NNN Alphanumeric traceability code

e3 Pb-free JEDEC designator for Matte Tin (Sn)

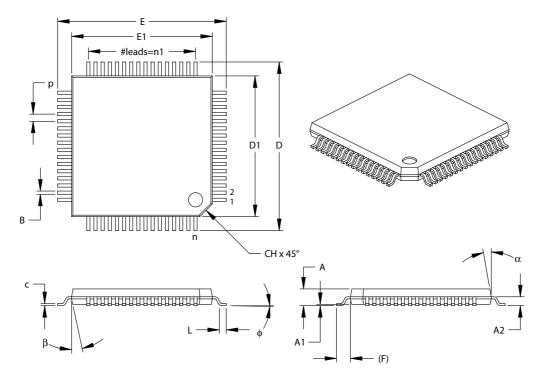
This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

27.2 Package Details

The following sections give the technical details of the packages.

64-Lead Plastic Thin Quad Flatpack (PT) 10x10x1 mm Body, 1.0/0.10 mm Lead Form (TQFP)



	Units	Inits INCHES			M		
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		64			64	
Pitch	р		.020			0.50	
Pins per Side	n1		16			16	
Overall Height	Α	.039	.043	.047	1.00	1.10	1.20
Molded Package Thickness	A2	.037	.039	.041	0.95	1.00	1.05
Standoff	A1	.002	.006	.010	0.05	0.15	0.25
Foot Length	L	.018	.024	.030	0.45	0.60	0.75
Footprint (Reference)	(F)		.039			1.00	
Foot Angle	ф	0	3.5	7	0	3.5	7
Overall Width	E	.463	.472	.482	11.75	12.00	12.25
Overall Length	D	.463	.472	.482	11.75	12.00	12.25
Molded Package Width	E1	.390	.394	.398	9.90	10.00	10.10
Molded Package Length	D1	.390	.394	.398	9.90	10.00	10.10
Lead Thickness	С	.005	.007	.009	0.13	0.18	0.23
Lead Width	В	.007	.009	.011	0.17	0.22	0.27
Pin 1 Corner Chamfer	CH	.025	.035	.045	0.64	0.89	1.14
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

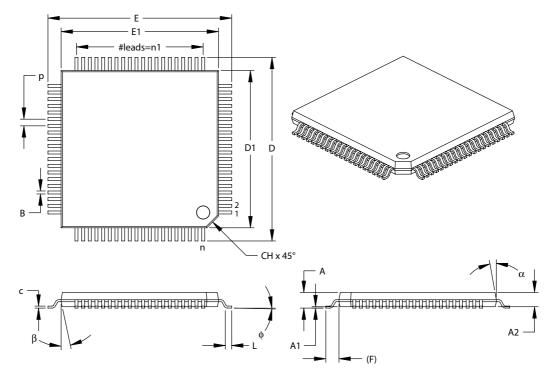
^{*}Controlling Parameter

Notes:

Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-026 Drawing No. C04-085

80-Lead Plastic Thin Quad Flatpack (PT) 12x12x1 mm Body, 1.0/0.10 mm Lead Form (TQFP)



	Units	INCHES			М		
Dimension Lim	its	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		80			80	
Pitch	р		.020			0.50	
Pins per Side	n1		20			20	
Overall Height	Α	.039	.043	.047	1.00	1.10	1.20
Molded Package Thickness	A2	.037	.039	.041	0.95	1.00	1.05
Standoff	A1	.002	.004	.006	0.05	0.10	0.15
Foot Length	L	.018	.024	.030	0.45	0.60	0.75
Footprint (Reference)	(F)		.039			1.00	
Foot Angle	ф	0	3.5	7	0	3.5	7
Overall Width	E	.541	.551	.561	13.75	14.00	14.25
Overall Length	D	.541	.551	.561	13.75	14.00	14.25
Molded Package Width	E1	.463	.472	.482	11.75	12.00	12.25
Molded Package Length	D1	.463	.472	.482	11.75	12.00	12.25
Lead Thickness	С	.004	.006	.008	0.09	0.15	0.20
Lead Width	В	.007	.009	.011	0.17	0.22	0.27
Pin 1 Corner Chamfer	CH	.025	.035	.045	0.64	0.89	1.14
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

*Controlling Parameter

Notes:

Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-026 Drawing No. C04-092

NOTES:

APPENDIX A: MIGRATION BETWEEN HIGH-END DEVICE FAMILIES

Devices in the PIC18F87J10 and PIC18F8722 families are very similar in their functions and feature sets. However, there are some potentially important differences which should be considered when migrating an application across device families to achieve a new design goal. These are summarized in Table A-1. The areas of difference which could be a major impact on migration are discussed in greater detail later in this section.

TABLE A-1: NOTABLE DIFFERENCES BETWEEN PIC18F8722 AND PIC18F87J10 FAMILIES

Characteristic	PIC18F87J10 Family	PIC18F8722 Family
Operating Frequency	40 MHz @ 2.15V	40 MHz @ 4.2V
Supply Voltage	2.0V-3.6V, dual voltage requirement	2.0V-5.5V
Operating Current	Low	Lower
Program Memory Endurance	1,000 write/erase cycles (typical)	100,000 write/erase cycles (typical)
I/O Sink/Source at 25 mA	PORTB and PORTC only	All ports
Input Voltage Tolerance on I/O pins	5.5V on digital only pins	VDD on all I/O pins
I/O	66 (RA7, RA6, RE3 and RF0 not available)	70
Pull-ups	PORTB, PORTD, PORTE and PORTJ	PORTB
Oscillator Options	Limited options (EC, HS, PLL, fixed 32 kHz INTRC)	More options (EC, HS, XT, LP, RC, PLL, flexible INTRC)
Program Memory Retention	10 years (minimum)	40 years (minimum)
Self-Writes to Program Memory	Not available	Available
Programming Time (Normalized)	156 μs/byte (10 ms/64-byte block)	15.6 μs/byte (1 ms/64-byte block)
Programming Entry	Low Voltage, Key Sequence	VPP and LVP
Code Protection	Single block, all or nothing	Multiple code protection blocks
Configuration Words	Stored in last 4 words of Program Memory space	Stored in Configuration Space, starting at 300000h
Start-up Time from Sleep	200 μs (typical)	10 μs (typical)
Power-up Timer	Always on	Configurable
Data EEPROM	Not available	Available
BOR	Simple BOR with Voltage Regulator	Programmable BOR
LVD	Not available	Available
A/D Channels	15	16
A/D Calibration	Required	Not required
Microprocessor mode (EMB)	Not available	Available
External Memory Addressing	Address shifting available	Address shifting not available
In-Circuit Emulation	Not available	Available

A.1 Power Requirement Differences

The most significant difference between the PIC18F87J10 and PIC18F8722 device families is the power requirements. PIC18F87J10 devices are designed on a smaller process; this results in lower maximum voltage and higher leakage current.

The operating voltage range for PIC18F87J10 devices is 2.0V to 3.6V. In addition, these devices have split power requirements: one for the core logic and one for the I/O. One of the VDD pins is separated for the core logic supply (VDDCORE). This pin has specific voltage and capacitor requirements as described in **Section 26.0 "Electrical Characteristics"**.

The current specifications for PIC18F87J10 devices are yet to be determined.

A.2 Pin Differences

There are several differences in the pinouts between the PIC18F87J10 and the PIC18F8722 families:

- Input voltage tolerance
- · Output current capabilities
- Available I/O

Pins on the PIC18F87J10 that have digital only input capability will tolerate voltages up to 5.5V and are thus tolerant to voltages above VDD. Table 10-1 in **Section 10.0 "I/O Ports"** contains the complete list.

In addition to input differences, there are output differences as well. PIC18F87J10 devices have three classes of pin output current capability: high, medium and low. Not all I/O pins can source or sink equal levels of current. Only PORTB and PORTC support the 25 mA source/sink capability that is supported by all output pins on the PIC18F8722. Table 10-2 in **Section 10.0 "I/O Ports"** contains the complete list of output capabilities.

There are additional differences in how some pin functions are implemented on PIC18F87J10 devices. First, the OSC1/OSC2 oscillator pins are strictly dedicated to the external oscillator function; there is no option to re-allocate these pins to I/O (RA6 or RA7) as on PIC18F8722 devices. Second, the $\overline{\text{MCLR}}$ pin is dedicated only to $\overline{\text{MCLR}}$ and cannot be configured as an input (RG5). Finally, RF0 does not exist on PIC18F87J10 devices.

All of these pin differences (including power pin differences) should be accounted for when making a conversion between PIC18F8722 and PIC18F87J10 devices.

A.3 Oscillator Differences

PIC18F8722 devices have a greater range of oscillator options than PIC18F87J10 devices. The latter family is limited primarily to operating modes that support HS and EC oscillators.

In addition, the PIC18F87J10 has an internal RC oscillator with only a fixed 32 kHz output. The higher frequency RC modes of the PIC18F8722 family are not available.

Both device families have an internal PLL. For the PIC18F87J10 family, however, the PLL must be enabled in software.

The clocking differences should be considered when making a conversion between the PIC18F8722 and PIC18F87J10 device families.

A.4 Peripherals

Peripherals must also be considered when making a conversion between the PIC18F87J10 and the PIC18F8722 families:

- External Memory Bus: The external memory bus on the PIC18F87J10 does not support Microcontroller mode; however, it does support external address offset.
- A/D Converter: There are only 15 channels on PIC18F87J10 devices. The converters for these devices also require a calibration step prior to normal operation.
- Data EEPROM: PIC18F87J10 devices do not have this module.
- BOR: PIC18F87J10 devices do not have a programmable BOR. Simple brown-out capability is provided through the use of the internal voltage regulator.
- LVD: PIC18F87J10 devices do not have this module.

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Temperature Range	I = -40 °C to $+85$ °C (Industrial)	
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